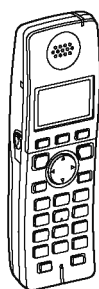


Service Manual

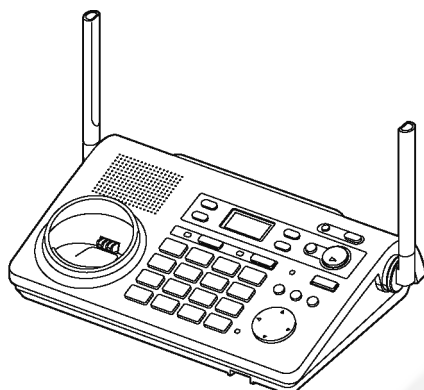
Telephone Equipment

Caller ID Compatible

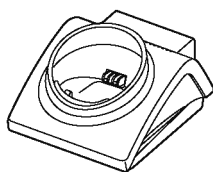
2LINE



(Handset) × 2



(Base Unit)



(Charger Unit)

Model shown is KX-TG6702.

Configuration for each model

Model No	Base Unit	Handset	Charger Unit	Expandable
KX-TG6700	1	1 (TGA670)		Expandable to 8
KX-TG6702	1	2 (TGA670)	1	Expandable to 8
KX-TGA670*		1	1	

* KX-TGA670 is also an optional accessory, which contains a handset and a charger.

KX-TG6700B

KX-TG6702B

KX-TGA670B

5.8 GHz Expandable Digital Cordless Answering System

5.8 GHz Expandable Digital Cordless Answering System with Two Handsets

Black Version

(for U.S.A.)

 WARNING

This service information is designed for experienced repair technicians only and is not designed for use by the general public. It does not contain warnings or cautions to advise non-technical individuals of potential dangers in attempting to service a product. Products powered by electricity should be serviced or repaired only by experienced professional technicians. Any attempt to service or repair the product or products dealt with in this service information by anyone else could result in serious injury or death.

IMPORTANT SAFETY NOTICE

There are special components used in this equipment which are important for safety. These parts are marked by  in the Schematic Diagrams, Circuit Board Diagrams, Exploded Views and Replacement Parts List. It is essential that these critical parts should be replaced with manufacturer's specified parts to prevent shock, fire or other hazards. Do not modify the original design without permission of manufacturer.

IMPORTANT INFORMATION ABOUT LEAD FREE, (PbF), SOLDERING

If lead free solder was used in the manufacture of this product the printed circuit boards will be marked PbF. Standard leaded, (Pb), solder can be used as usual on boards without the PbF mark. When this mark does appear, please read and follow the special instructions described in this manual on the use of PbF and how it might be permissible to use Pb solder during service and repair work.

- When you note the serial number, write down all 11 digits. The serial number may be found on the bottom of the unit.
- The illustrations in this Service Manual may vary slightly from the actual product.

Note for TABLE OF CONTENTS:

Because TABLE OF CONTENTS 5, 6 and 7 are the extracts from the Operating Instructions of this model, it is subject to change without notice. You can download and refer to the original Operating Instructions on TSN Server for further information.

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1 Safety Precautions

1.1. For Service Technicians

ICs and LSIs are vulnerable to static electricity.

When repairing, the following precautions will help prevent recurring malfunctions.

1. Cover plastic parts boxes with aluminum foil.
2. Ground the soldering irons.
3. Use a conductive mat on worktable.
4. Do not grasp IC or LSI pins with bare fingers.

2 Warning

2.1. Battery Caution

1. Danger of explosion if battery is incorrectly replaced.
2. Replace only with the same or equivalent type recommended by the manufacturer.
3. Dispose of used batteries according to the manufacturer's Instructions.

2.2. About Lead Free Solder (Pbf: Pb free)

Note:

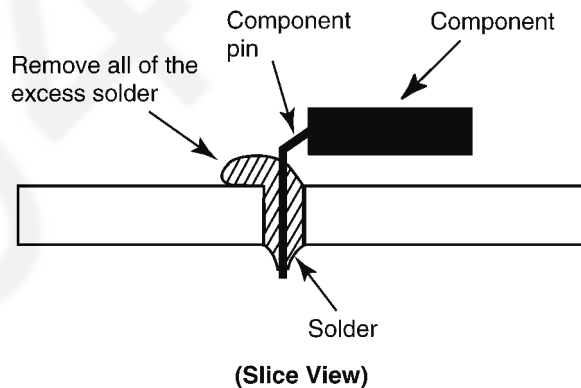
In the information below, Pb, the symbol for lead in the periodic table of elements, will refer to standard solder or solder that contains lead.

We will use PbF solder when discussing the lead free solder used in our manufacturing process which is made from Tin (Sn), Silver (Ag), and Copper (Cu).

This model, and others like it, manufactured using lead free solder will have PbF stamped on the PCB. For service and repair work we suggest using the same type of solder.

Caution

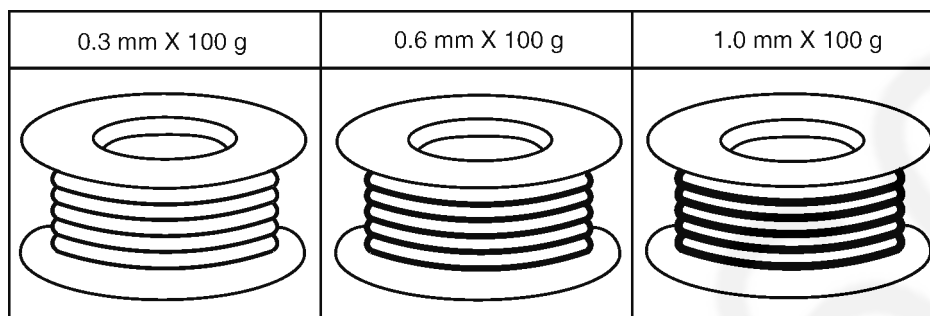
- PbF solder has a melting point that is 50°F ~ 70° F (30°C ~ 40°C) higher than Pb solder. Please use a soldering iron with temperature control and adjust it to 700°F ± 20° F (370°C ± 10°C).
- Exercise care while using higher temperature soldering irons.:
Do not heat the PCB for too long time in order to prevent solder splash or damage to the PCB.
- PbF solder will tend to splash if it is heated much higher than its melting point, approximately 1100°F (600°C).
- When applying PbF solder to double layered boards, please check the component side for excess which may flow onto the opposite side (See the figure below).



2.2.1. Suggested PbF Solder

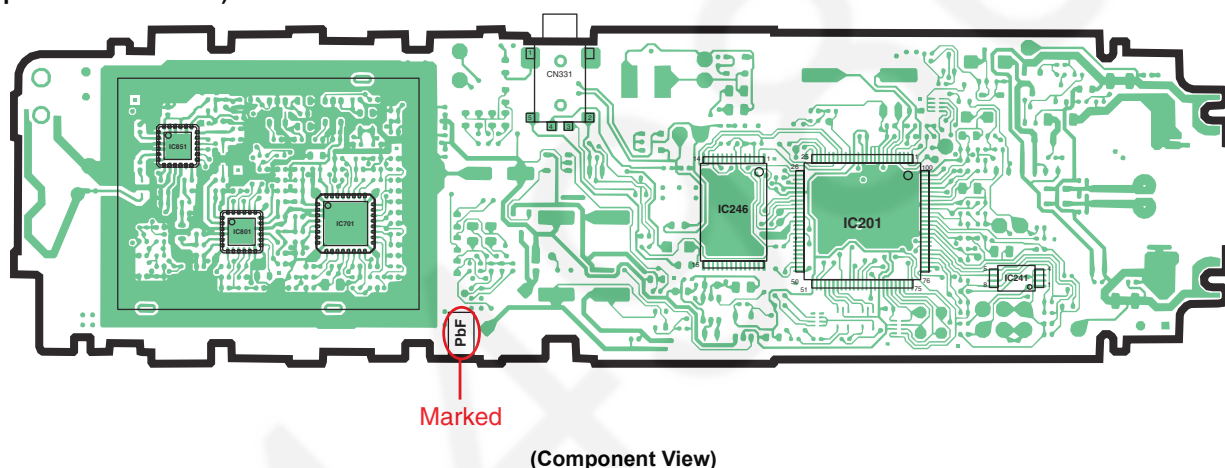
There are several types of PbF solder available commercially. While this product is manufactured using Tin, Silver, and Copper (Sn+Ag+Cu), you can also use Tin and Copper (Sn+Cu), or Tin, Zinc, and Bismuth (Sn+Zn+Bi). Please check the manufacturer's specific instructions for the melting points of their products and any precautions for using their product with other materials.

The following lead free (PbF) solder wire sizes are recommended for service of this product: 0.3 mm, 0.6 mm and 1.0 mm.



2.2.2. How to Recognize that Pb Free Solder is Used

(Example: Handset P.C.B.)



Note:

The location of the "PbF" mark is subject to change without notice.

3 Specifications

	Base Unit	Handset	Charger
Power Supply	AC Adaptor (PQLV207Z, 120 V AC, 60 Hz)	Rechargeable Ni-MH battery (2.4 V, 830 mAh) HHR-P105	AC Adaptor (PQLV207Z, 120 V AC, 60 Hz)
Receiving/Transmitting Frequency	89 channels within 5.76 GHz-5.84 GHz	89 channels within 5.76 GHz-5.84 GHz	_____
Receiving Method	Super Heterodyne	Super Heterodyne	_____
Oscillation Method	PLL synthesizer	PLL synthesizer	_____
Detecting Method	Quadrature Discriminator	Quadrature Discriminator	_____
Tolerance of OSC Frequency	13.824 MHz±270 Hz	13.824 MHz±100 Hz	_____
Modulation Method	Frequency Modulation	Frequency Modulation	_____
Spread spectrum Method	Frequency Hopping Spread spectrum	Frequency Hopping Spread spectrum	_____
ID Code	19 bit	22 bit	_____
Security Codes	_____	1,000,000	_____
Ringer Equivalence No. (REN)	0.2B	_____	_____
Dialing Mode	_____	Tone (DTMF)/Pulse	_____
Redial	_____	Up to 48 digits	_____
Speed Dialer	Up to 32 digits (10 stations)	Up to 32 digits (Phonebook)	_____
Power Consumption	Standby: Approx. 2.1 W, Maximum: Approx. 5.2 W	7 days at Standby, 5 hours at Talk	Standby: Approx. 1.1 W, Maximum: Approx. 3.4 W
Power Output	200 mW (max.)	200 mW (max.)	_____
Operating Environment	5°C - 40 °C (41 °F - 104 °F)	5°C - 40 °C (41 °F - 104 °F)	5°C - 40 °C (41 °F - 104 °F)
Dimensions (H x W x D)	Approx. 55 mm×230 mm×140 mm (2 ⁵ / ₃₂ "×9 ¹ / ₁₆ "×5 ¹ / ₂ ")	Approx. 156 mm×49 mm×35 mm (6 ¹ / ₈ "×1 ¹⁵ / ₁₆ "×1 ³ / ₈ ")	Approx. 58 mm×87 mm×95 mm (2 ⁹ / ₃₂ "×3 ⁷ / ₁₆ "×3 ³ / ₄ ")
Mass (Weight)	Approx. 460 g (1.01 lb.)	Approx. 150 g (0.33 lb.)	Approx. 90 g (0.20 lb.)

- Optional Headset: KX-TCA60, KX-TCA86, KX-TCA88HA, KX-TCA91, KX-TCA92, KX-TCA93, KX-TCA94, KX-TCA95, or KX-TCA98
- Design and specifications are subject to change without notice.

4 Technical Descriptions

4.1. FHSS Description

4.1.1. Frequency

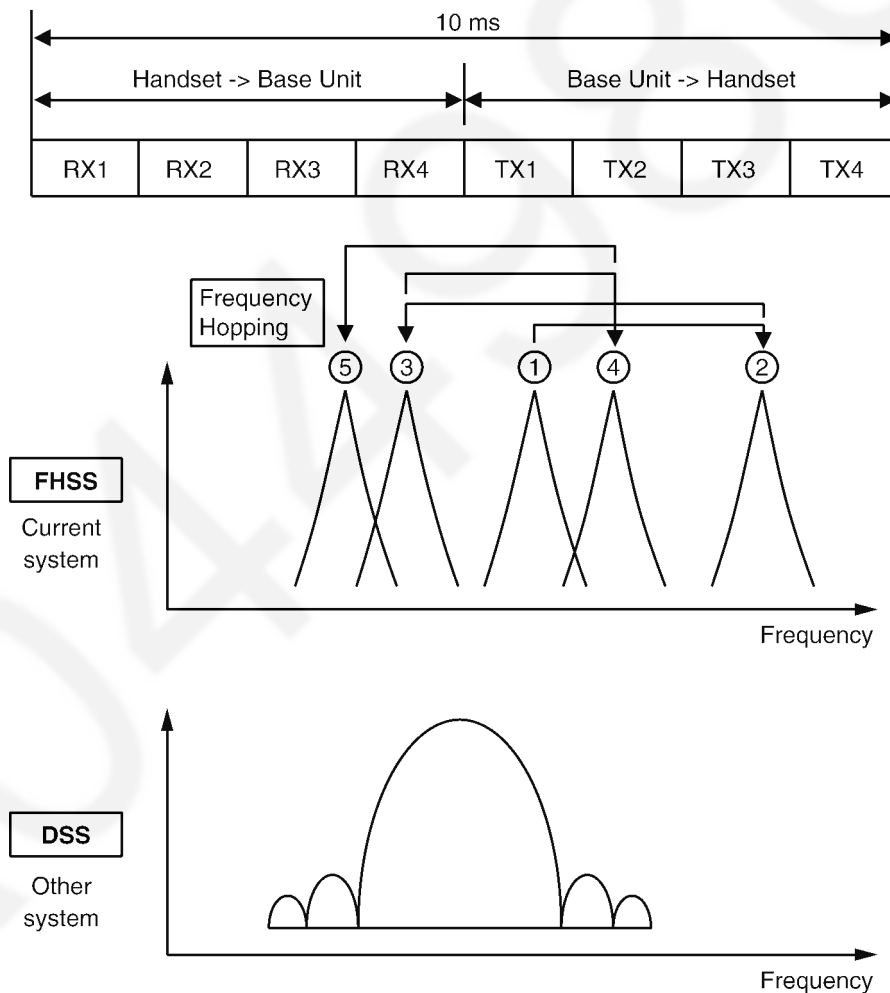
The frequency range of 5.76 GHz-5.84 GHz is used. Transmitting and receiving channel between Base Unit and Handset is same frequency. Refer to **Frequency Table** (P.88).

4.1.2. FHSS (Frequency Hopping Spread Spectrum)

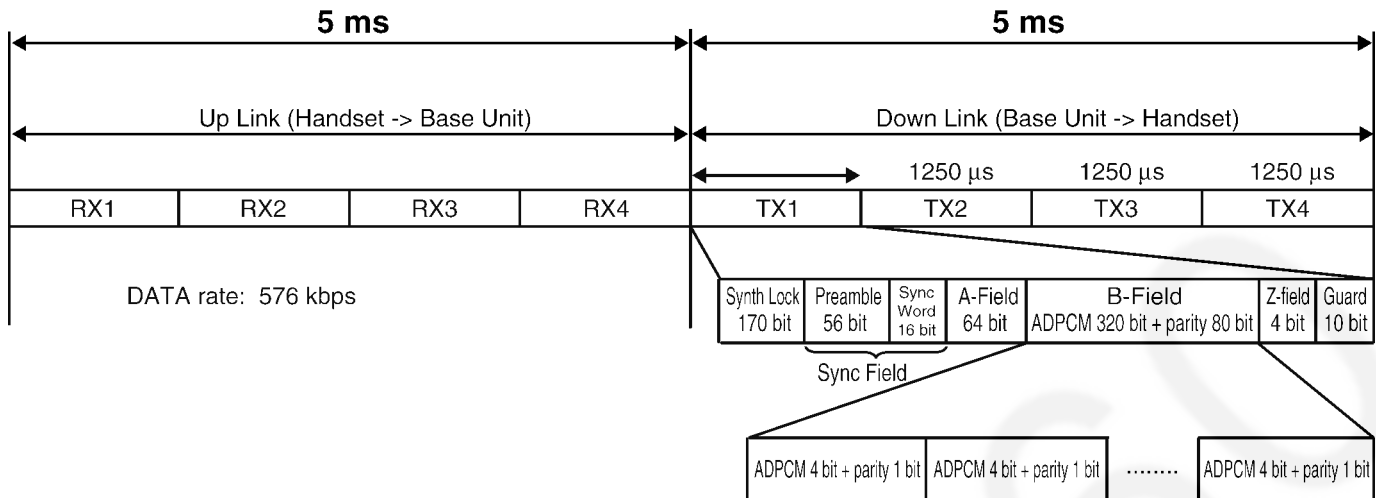
This telephone is using an IC chip which has similar specification to WDCT (World Digital Cordless Telephone) and is the telephone system that can use multiple portable unit simultaneously. The explanation of this system is mentioned below. This system uses a Time Division Multiple Access/Time Division Duplex (**TDMA/TDD**) scheme:

transmitting and receiving frequencies of the Base Unit and Handset are shared in the same frequency. The construction of RX/TX frequency data is shown below. It consists of 4 slots from the Base Unit to the Handset, and 4 slots from the Handset to the Base Unit, total 8 slots in 10 ms. By this slot system, simultaneous air link and communication between 4 Handsets and the Base Unit can be realized. One communication between Handset and the Base Unit is done by one slot from the Base Unit to Handset, and another slot from Handset to the Base Unit.

DSS makes spectrum spread by multiplying carrier signal by PN code. The purpose to make spectrum spread is to reduce power density per time and per band. On the other hand, **FHSS** makes spectrum spread by changing channel every 10 ms according to Hopping table. Also the purpose to make spectrum spread is to reduce power density per time and per band.



4.1.2.1. TDD Frame Format



Sync Field (72 bit): Preamble 56 bit + SyncWord 16 bit

Base Unit (Handset) adjusts the timing of reception so that reception of Base Unit (Handset) can correspond to transmission of Handset (Base Unit).

It is necessary for sync-field that Handset gets synchronization.

A - field (64 bit): Each kinds of DATA: ch data, line condition, etc.

B - field (320 bit + 80 bit): Sound data + parity

Z - field (4 bit): Parity Check

4.1.2.2. TDMA system

This system is the cycles of 10 ms, and has four duplex paths, so it is possible to perform four duplex communications simultaneously.

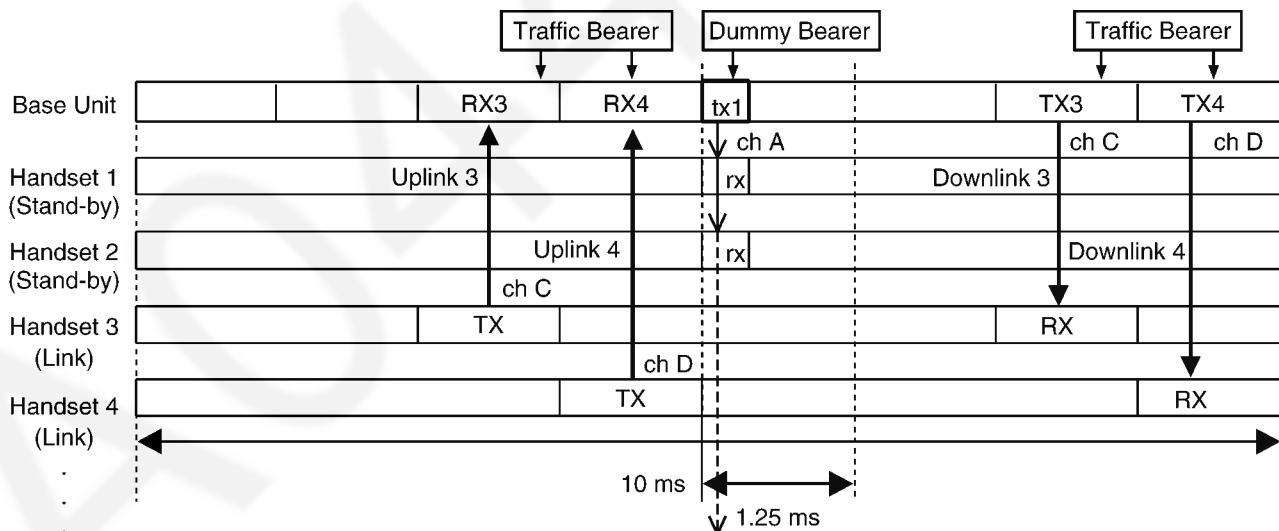
(Up to eight Handsets can be registered)

In 1 slot 1.25 ms, the 10 ms of voice data is transmitted.

Each slot makes every frame frequency hop. (100 hops/sec.)

Although each slot (UpLink3 and UpLink4) uses different frequency, UpLink3 and DownLink3 use the same frequency.

• 2 - Handsets Link



Traffic Bearer

A link is established between Base Unit and Handset.

The state where duplex communication is performed.

The hopping pattern of a 3000 hops (30 seconds) cycle.

Dummy Bearer

The Base Unit sends Dummy-data to the all stand-by state Handsets.

The Handsets receive that data for keeping synchronization and monitoring request from the Base Unit.

Dummy Bearer doesn't contain B-field (sound) data.

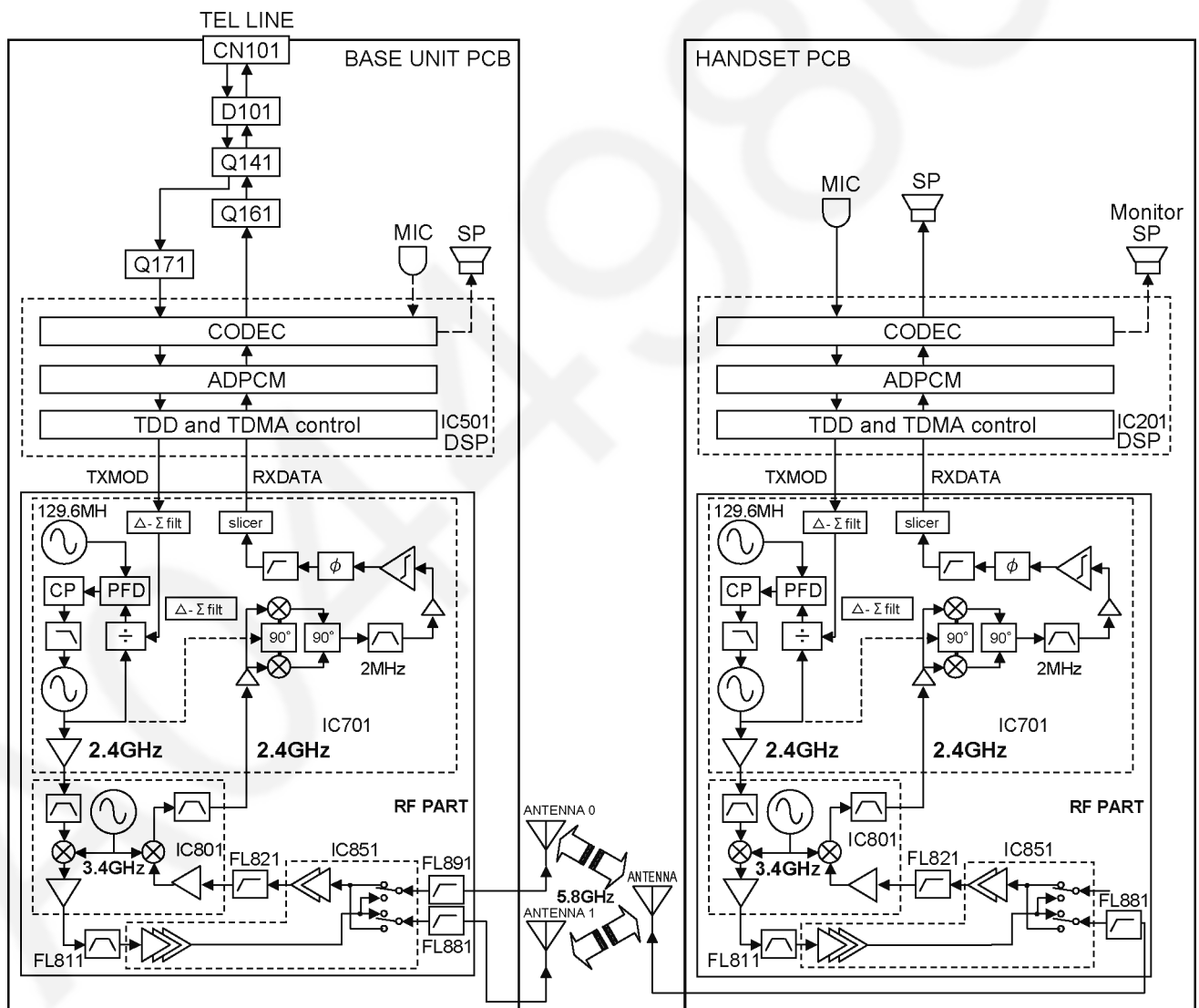
4.1.3. Signal Flowchart in the Whole System

Reception

CN101 of the Base Unit is connected to the TEL line, and signal is enter through the bridge diode D101. While talking, the relay (Q141) is turned ON and amplified at the Q171, then led to DSP (IC501). The DSP encodes ADPCM and TDD/TDMA with FHSS to TXMOD. The TXMOD signal is enter to IC701 of RF PART, and modulated to 2.4 GHz. The 2.4 GHz signal is up-converted to 5.8 GHz RF signal by IC801. The RF signal is amplified by the power amplifier (IC851) and fed to Antennas. As for the Handset, RF signal from the antenna is amplified by LNA (IC851). The amplified signal is down-converted to 2.4 GHz signal by IC801 and led to IC701. The 2.4 GHz is down-converted to IF signal in IC701. The IF signal passing through internal filter is demodulated into RXDATA, then enter to DSP (IC201). The DSP performs TDD/TDMA and ADPCM decoding to convert the RXDATA into the voice signal, then it is output to the speaker.

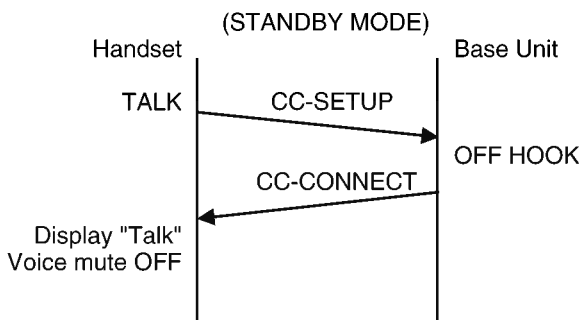
Transmission

The voice signal entering from the Handset microphone is led to DSP (IC201). The DSP encodes ADPCM and TDD/TDMA with FHSS to TXMOD. The TXMOD signal is enter to IC701 of RF PART, and modulated to 2.4 GHz. The 2.4 GHz signal is up-converted to 5.8 GHz RF signal by IC801. The RF signal is amplified by the power amplifier (IC851) and fed to Antenna. As for the Base Unit, RF signal from the Antennas is amplified by LNA (IC851). The amplified signal is down-converted to 2.4 GHz signal by IC801 and led to IC701. The 2.4 GHz is down-converted to IF signal in IC701. The IF signal passing through internal filter is demodulated into RXDATA, then enter to DSP (IC501). The DSP performs TDD/TDMA and ADPCM decoding to convert the RXDATA into the voice signal. The voice signal is amplified at the TX amplifier (Q161), then output to the TEL line CN101 through the relay (Q141) and bridge (D101).



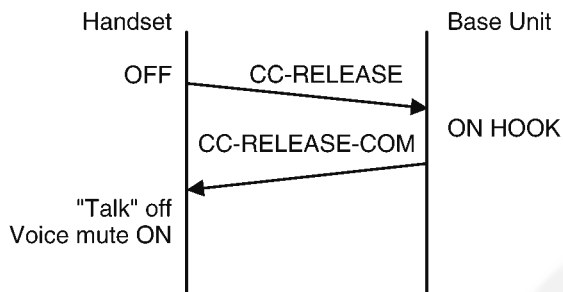
4.2. Explanation of Link Data Communication

4.2.1. Calling



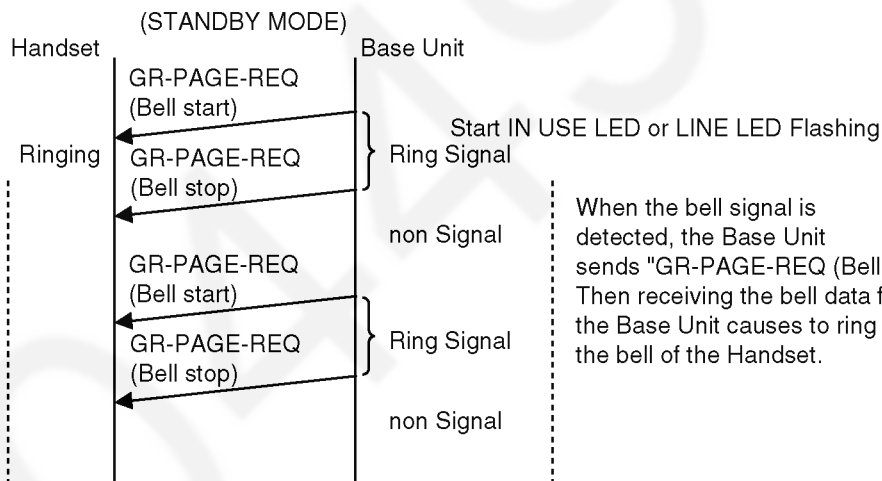
When calling, a communication request DATA (CC-SETUP) is transmitted from the Handset, and a permitting DATA (CC-CONNECT) is returned from the Base Unit to it. At that time the audio path opens.

4.2.2. To Terminate Communication



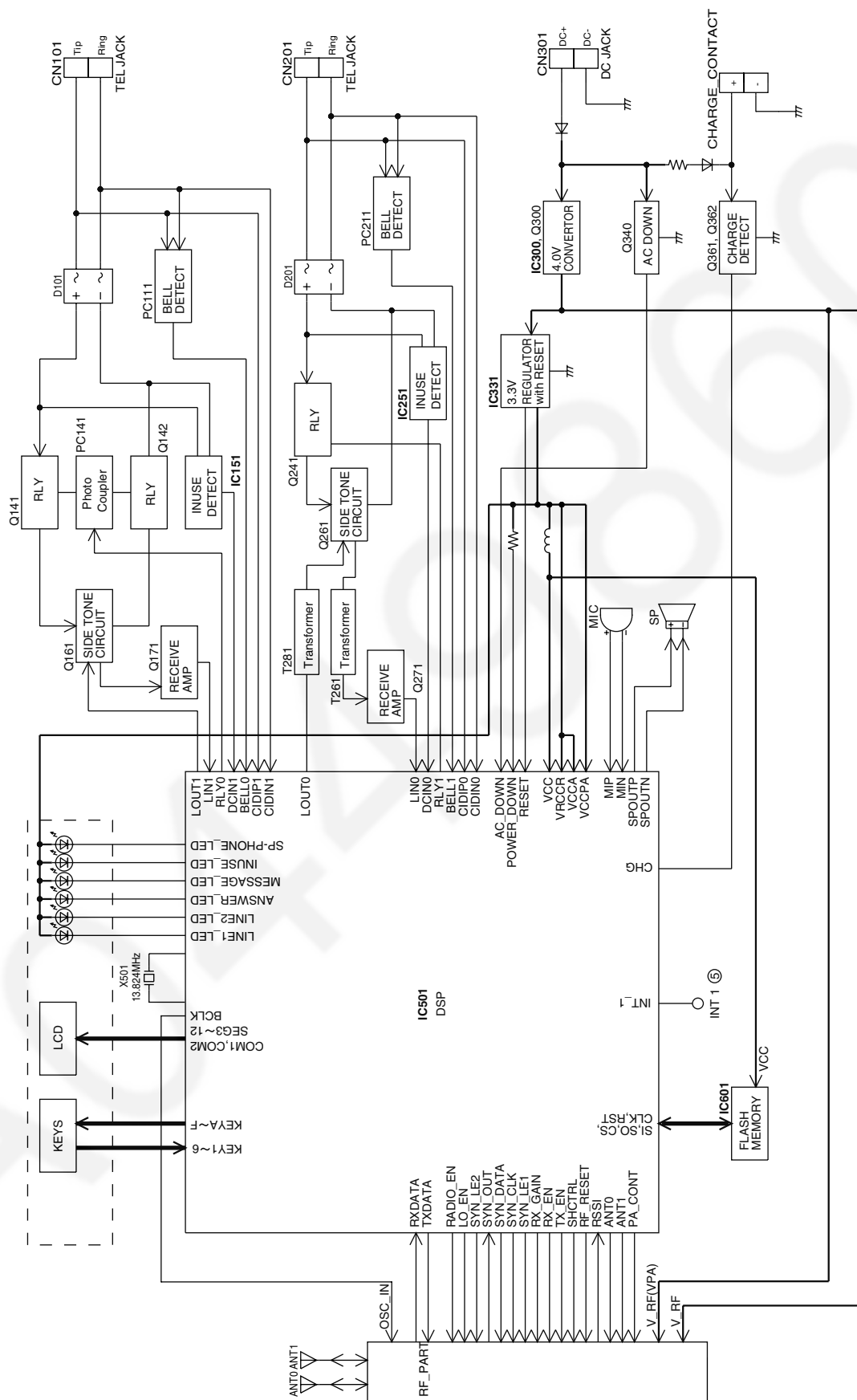
When the OFF button on the Handset is pressed during communication, a LINK terminating DATA (CC-RELEASE) is sent to terminate the communication. Then DATA (CC-RELEASE-COM) is returned from Base Unit. Handset receives it and reset the link.

4.2.3. Ringing



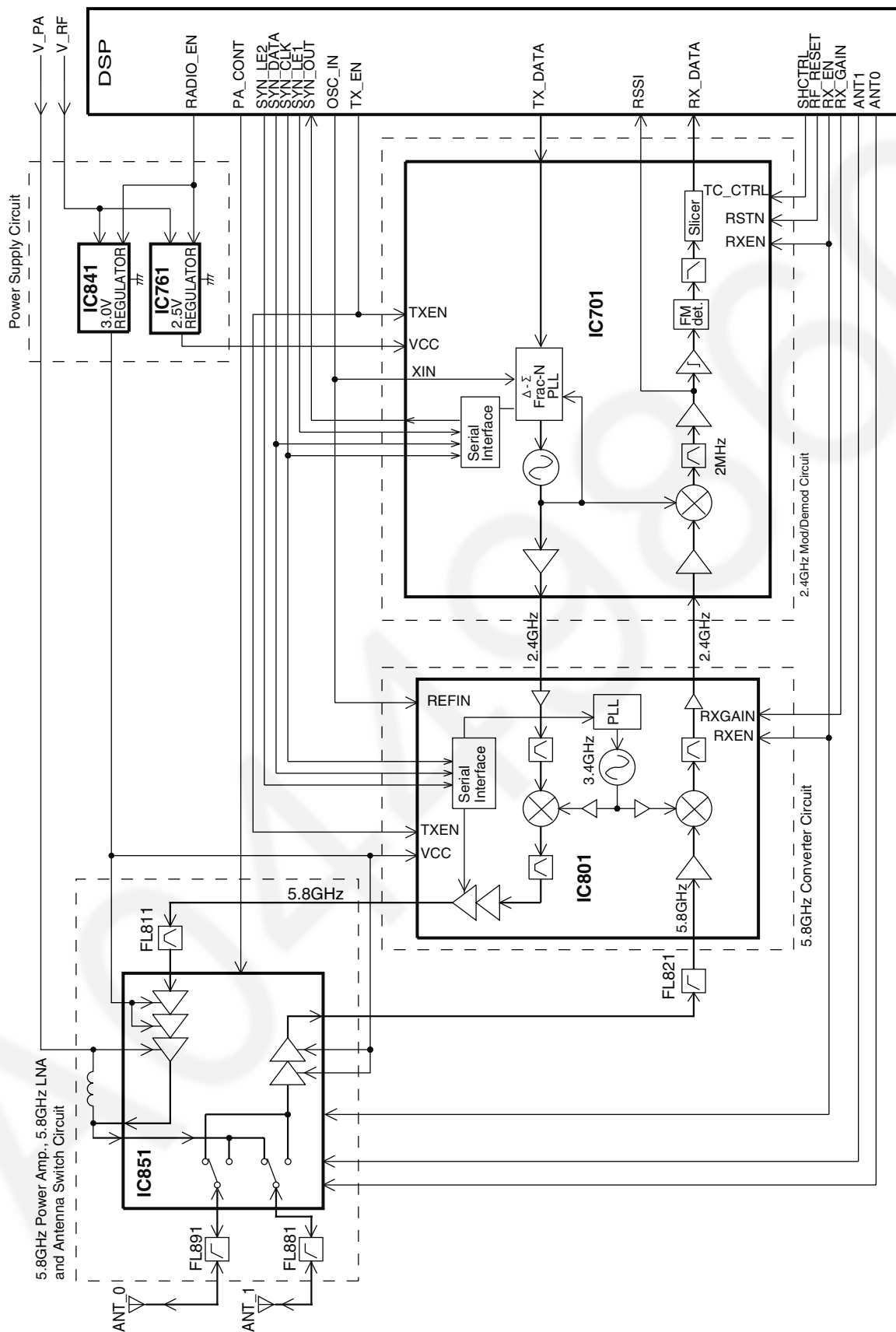
When the bell signal is detected, the Base Unit sends "GR-PAGE-REQ (Bell start)". Then receiving the bell data from the Base Unit causes to ring the bell of the Handset.

4.3. Block Diagram (Base Unit_Main)



KX-TG6700/6702 BLOCK DIAGRAM (Base Unit_Main)

4.4. Block Diagram (Base Unit_RF Part)



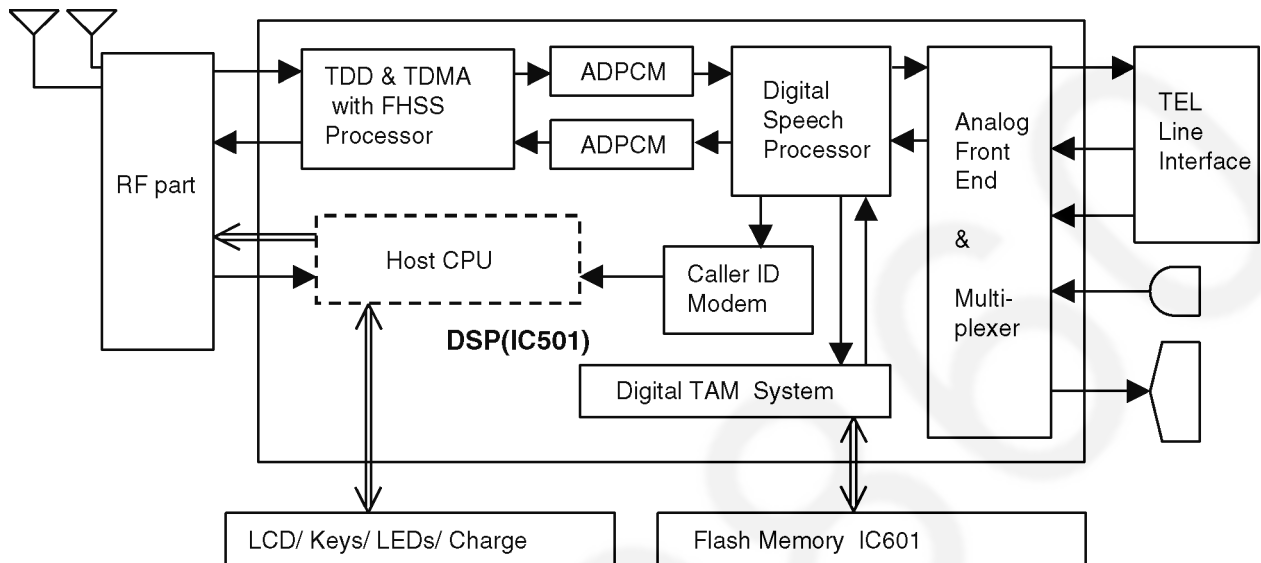
KX-TG6700/6702 BLOCK DIAGRAM (Base Unit_RF Part)

4.5. Circuit Operation (Base Unit)

General Description:

(DSP, Flash Memory) is a digital speech/signal processing system that implements all the functions of speech compression, record and playback, and memory management required in a digital telephone answering machine.

The DSP system is fully controlled by a host processor DSP. The host processor provides activation and control of all that functions as follows.



4.5.1. DSP (Digital Speech/Signal Processing: IC501)

- **Voice Message Recording/Play back**

The DSP system use a proprietary speech compression technique to record and store voice message in Flash Memory. An error correction algorithm is used to enable playback of these messages from the Flash Memory.

- **DTMF Detection/Generator**

The DTMF detection is implemented by the DSP system in software. The DTMF detection is performed during Record, Play back, and Line Monitoring modes of operation.

When the DTMF data from the Handset is received, the DTMF signal is output.

- **Synthesized Voice (Pre-recorded message)**

The DSP implements synthesized Voice, utilizing the built in speech detector and a Flash Memory, which stored the vocabulary.

- **Caller ID and Call Waiting CID demodulation**

The DSP implements monitor and demodulate the FSK signals that provide CID information from the Central Office.

- **Analog Switching**

The voice signal from telephone line is transmitted to the speaker or the voice signal from speakerphone microphone is transmitted to the Telephone line, etc. They are determined by the signal path route operation of voice signal.

- **Block Interface Circuit**

RF part, LED, Key scan, Speaker, Microphone, Telephone line, LCD.

4.5.2. Flash Memory (IC601)

Following information data is stored.

- **Voice signal**

ex: Pre-recorded Greeting message, Incoming message

- **Settings**

ex: message numbers, ID code, Flash Time, Tone/Pulse

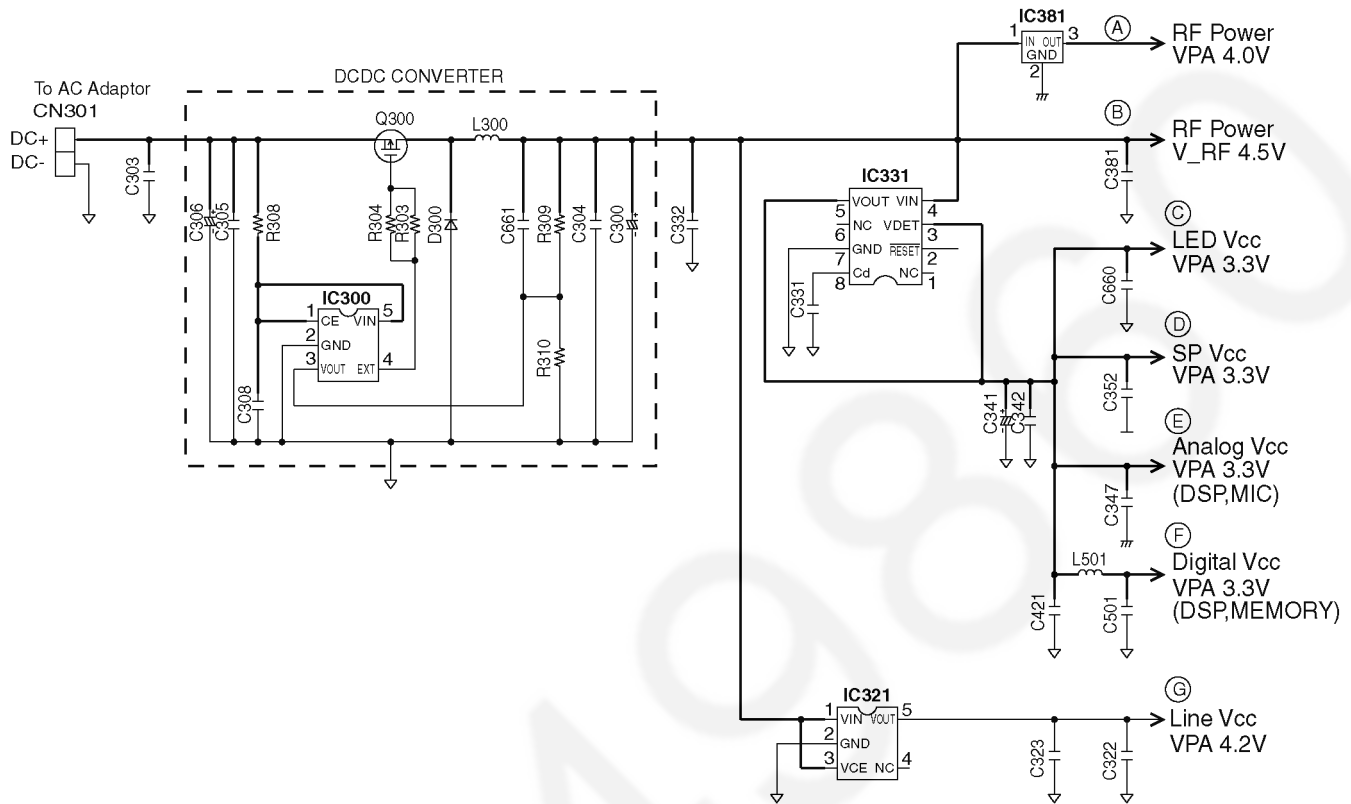
4.5.3. Power Supply Circuit

Function:

The power supply voltage from AC adaptor is converted to the desired voltage of each block.

Circuit Operation:

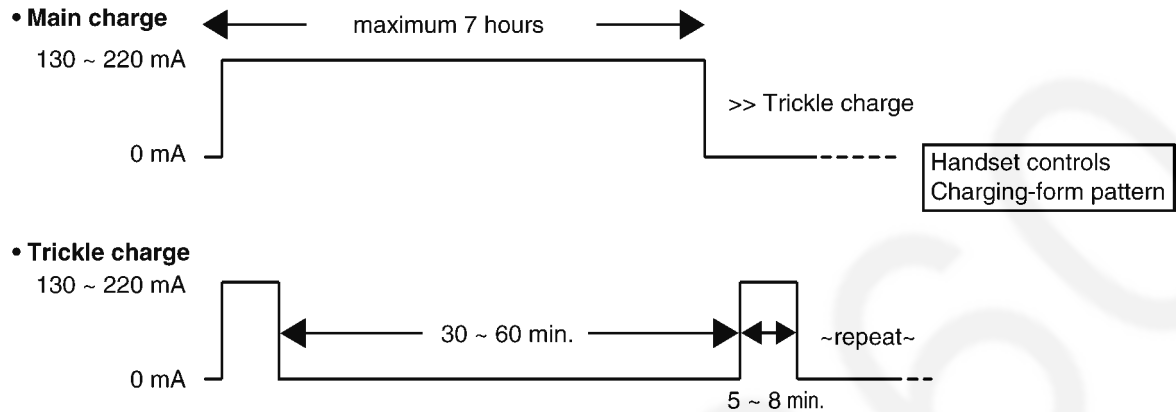
- Q300 and IC300: 4.5 V DCDC Converter
- IC331: 3.3 V Regulator



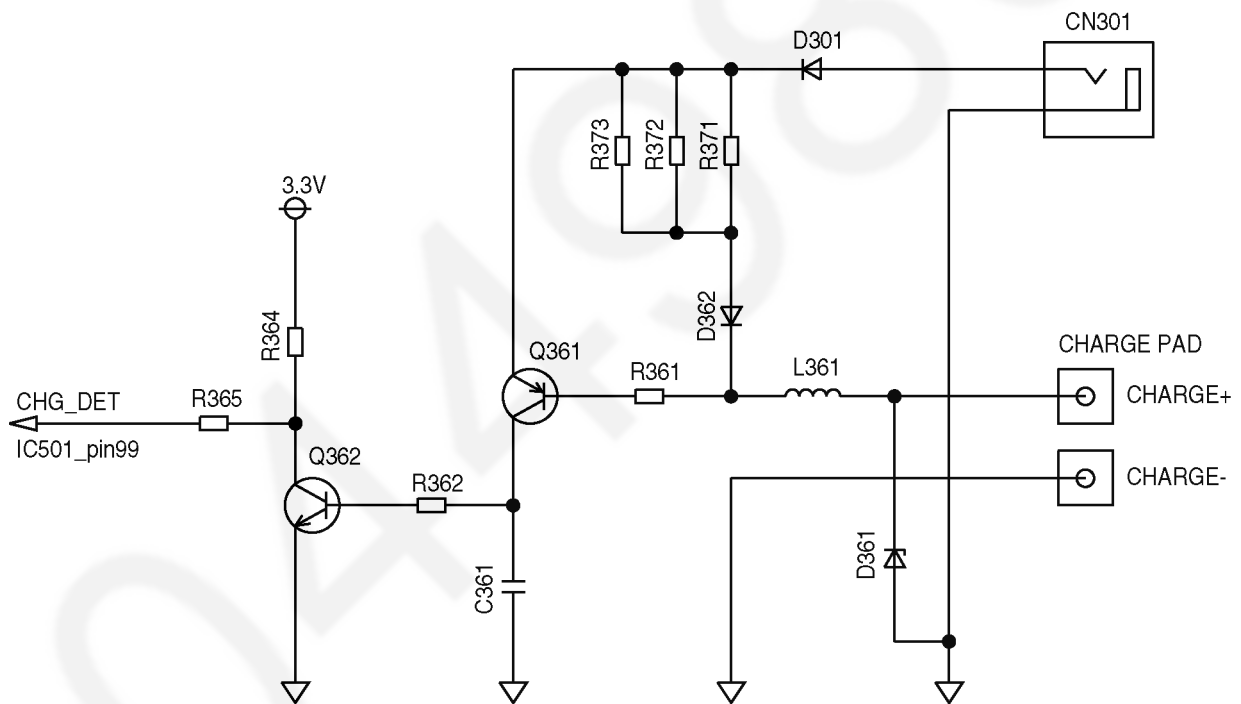
4.5.3.1. Charge Circuit

The voltage from the AC adaptor is supplied to the charge circuits. Main charge (130 ~ 220 mA at the Battery) of maximum 7-hours is started soon after the Handset is placed on the Base Unit. Then it changes to Trickle charge to prevent from overcharging.

Charging-form



Q361 and Q362 detect the ON-HOOK state (Handset is placed on Base Unit).



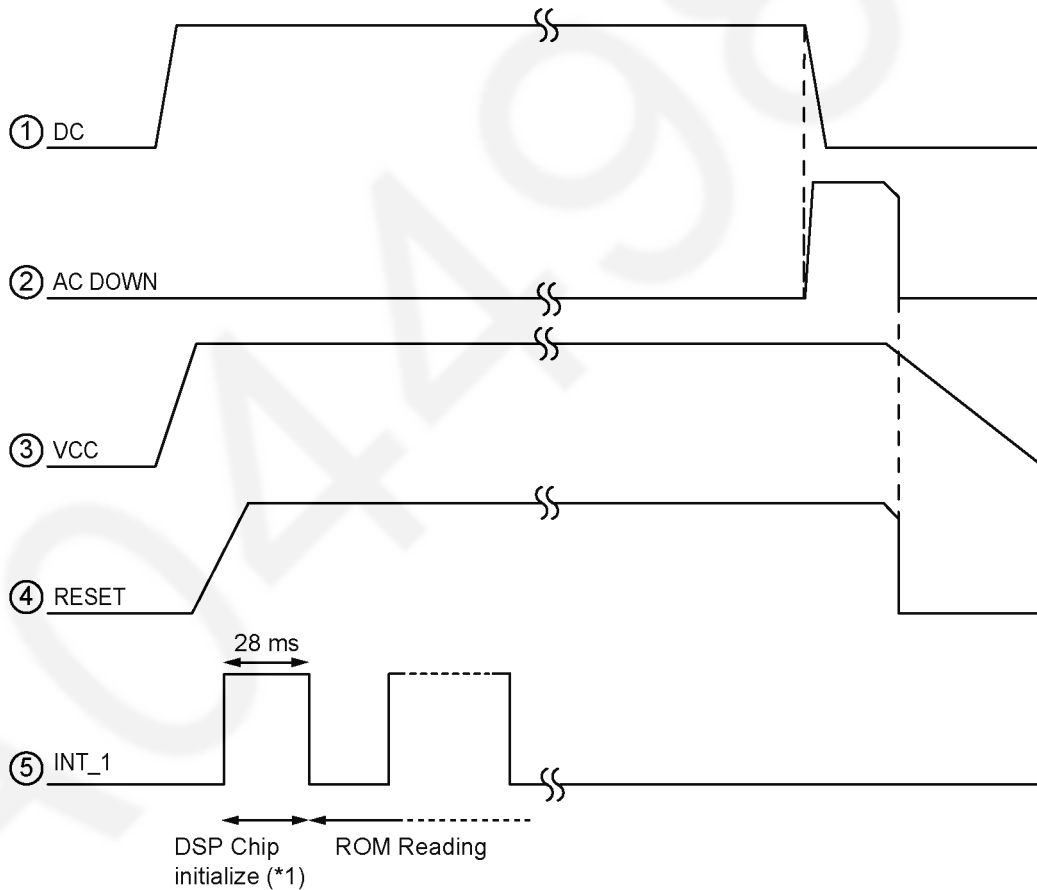
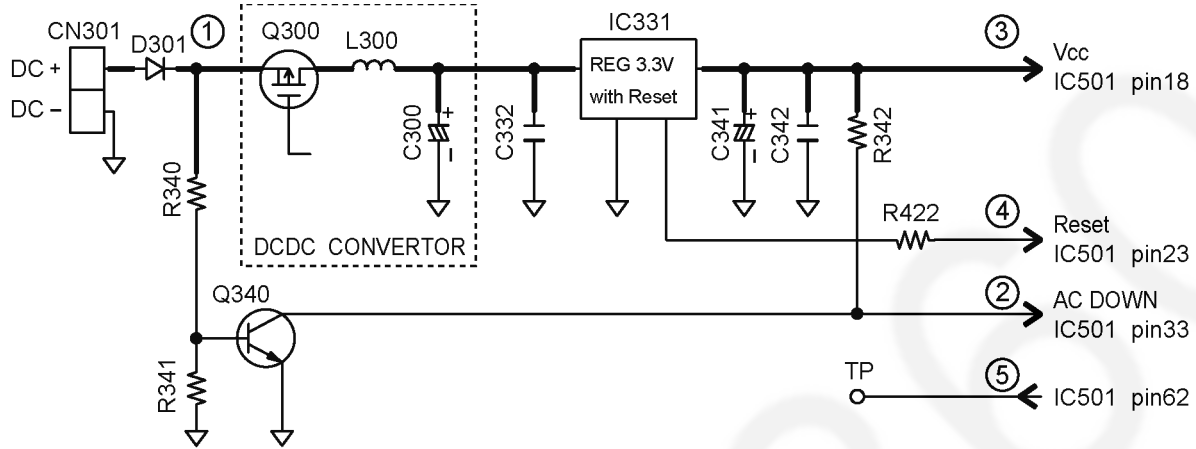
4.5.4. Reset Circuit

Function:

This circuit is used to initialize the microcomputer when it incorporates an AC adaptor.

Circuit Operation:

When the AC Adaptor is inserted into the unit, then the voltage is shifted by IC331 and power is supplied to the DSP. The set starts to operate when VCC goes up to 3.0 V or more in the circuit voltage diagram.



Note:

(*1) The initializing time of the DSP chip is 28 ms under normal conditions.

4.5.5. Telephone Line Interface

Telephone Line Interface Circuit:

Function

- Bell signal detection
- ON/OFF hook and pulse dial circuit
- Side tone circuit

4.5.5.1. Line 1

Bell signal detection and OFF HOOK circuit:

In the idle mode, Q141 and Q142 are open to cut the DC loop current and the ring load. When ring voltage appears at the Tip (T) and Ring (R) leads (When the telephone rings), the AC ring voltage is transferred as follows:

T → L101 → R111 → PC111 → DSP pin 72 [BELL]

To provide an off-hook condition (active DC current flow through the circuit), CPU turns Q145 on.

Thus Q141 and Q142 turn on. Following signal flow is the DC current flow.

T → L101 → D101 → Q141 → Q161 → R163 → Q142 → D101 → L102 → P101 → R

ON HOOK Circuit:

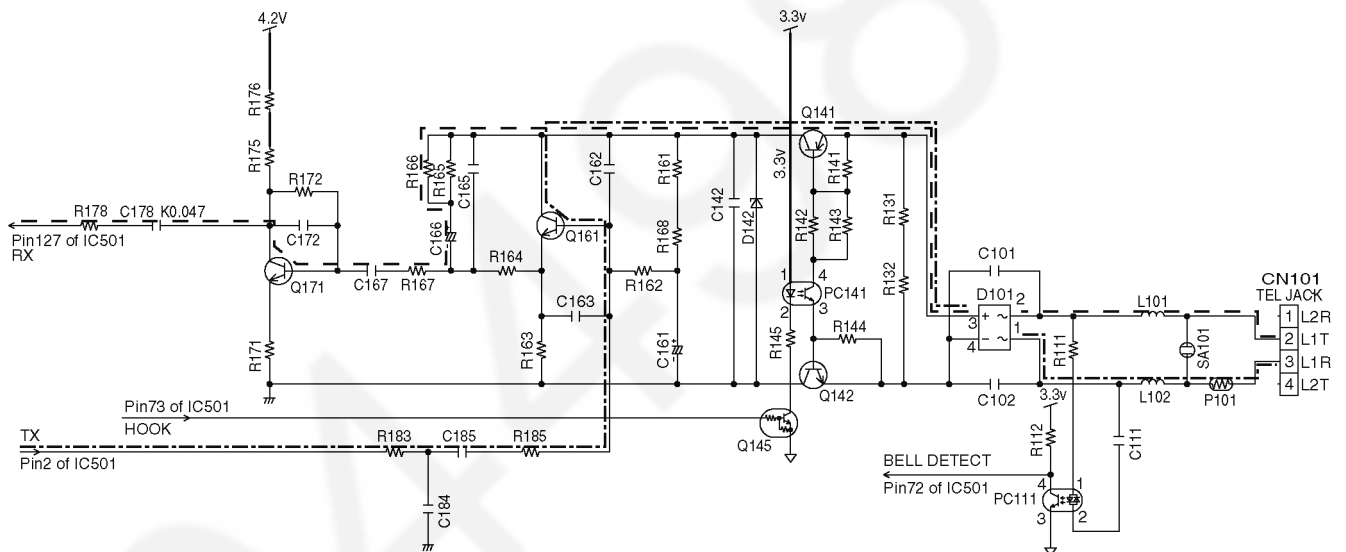
Q141 is open, Q141 is connected as to cut the DC loop current and to cut the voice signal. The unit is consequently in on-hook condition.

Pulse Dial Circuit:

Pin 73 of DSP turns Q145 ON/OFF to make the pulse dialing.

Side Tone Circuit:

Basically this circuit prevents the TX signal from feeding back to RX signal. As for this unit, TX signal feed back from Q161 is canceled by the canceller circuit of DSP.



4.5.5.2. Line 2

Bell signal detection and OFF HOOK circuit:

In the idle mode, Q241 is open to cut the DC loop current and the ring load. When ring voltage appears at the Tip (T) and Ring (R) leads (When the telephone rings), the AC ring voltage is transferred as follows:

T → L201 → R211 → PC211 → DSP pin 85 [L2_BELL]

To provide an off-hook condition (active DC current flow through the circuit), CPU turns Q246 on.

Thus Q241 turns on. Following signal flow is the DC current flow.

T → L201 → D201 → Q241 → Q261 → R263 → D201 → L202 → P201 → R

ON HOOK Circuit:

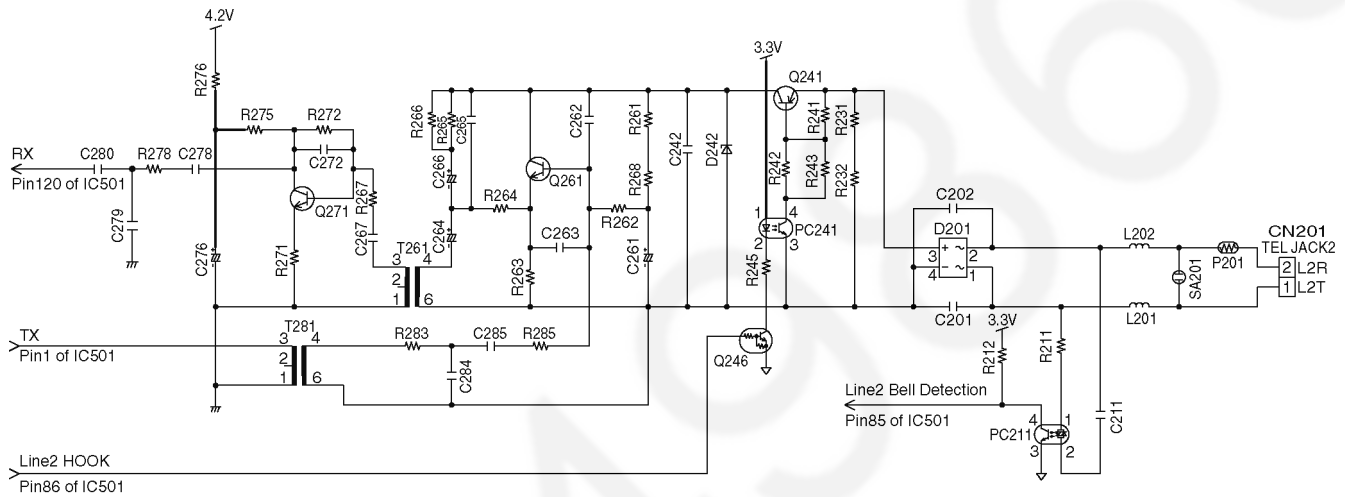
Q241 is open, Q241 is connected as to cut DC loop current and to cut the voice signal. The unit is consequently in on-hook condition.

Pulse Dial Circuit:

Pin86 of DSP turns Q246 ON/OFF to make the pulse dialing.

Side Tone Circuit:

Basically this circuit prevents the TX signal from feeding back to RX signal. As for this unit, TX signal feed back from Q261 is canceled by the canceller circuit of DSP.



4.5.6. Auto Disconnect Circuit

Function:

This circuit is used to detect the fact that another telephone connected to the same line is OFF-HOOK while the unit is in message receiving, OGM transmitting and Hold status.

Circuit Operation:

Operational amplifier with high value resistors is used in order to isolate both lines.

This circuit gain is controlled by the signal (inverse RLY). When the base unit is in off-hook condition, the control signal logic is zero.

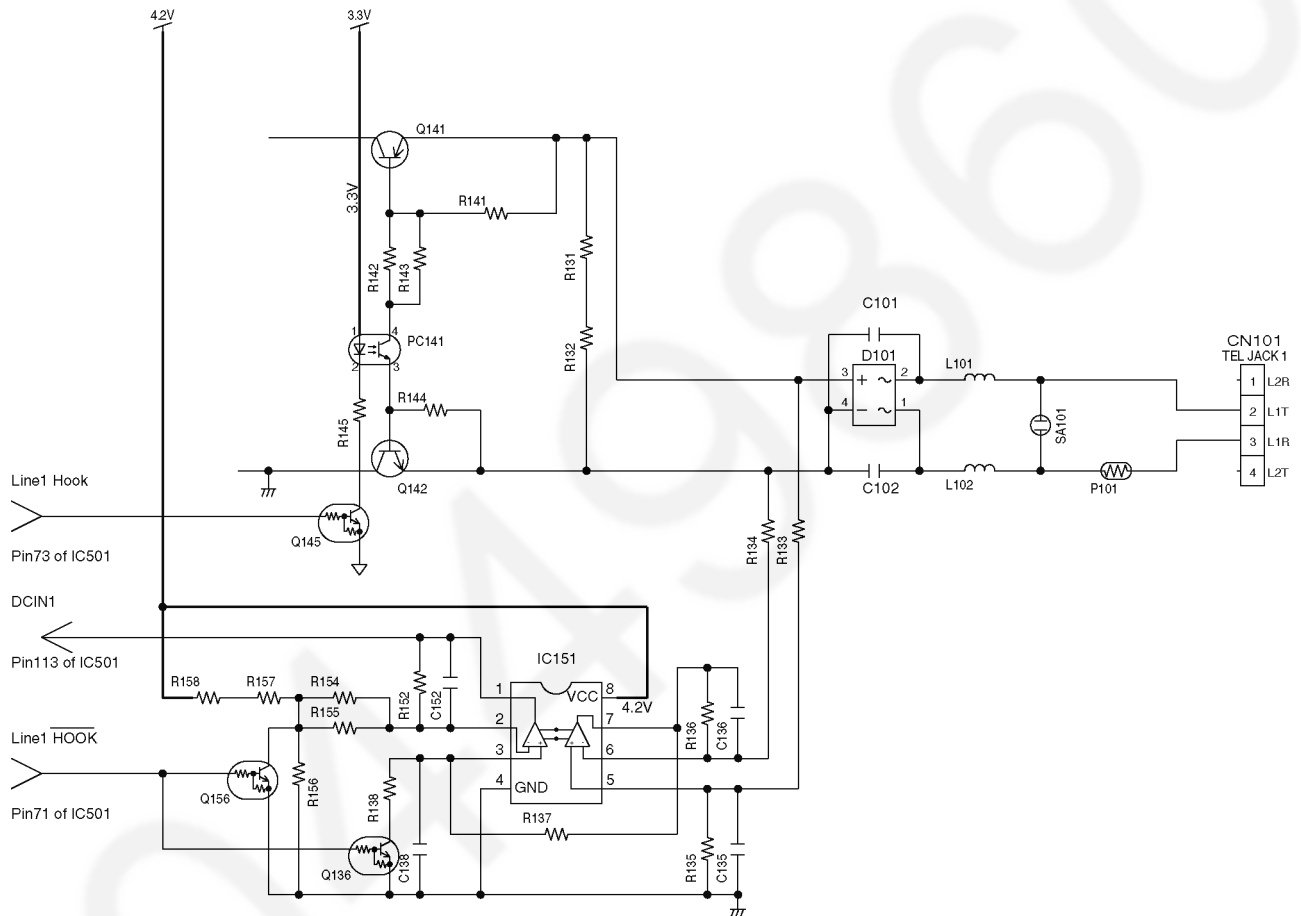
This circuit transforms the voltage of the line and DSP monitors the result of the transformation.

When the DSP detects the voltage drop 0.2 V or more by parallel-connected telephone off-hook, the unit will disconnect the line.

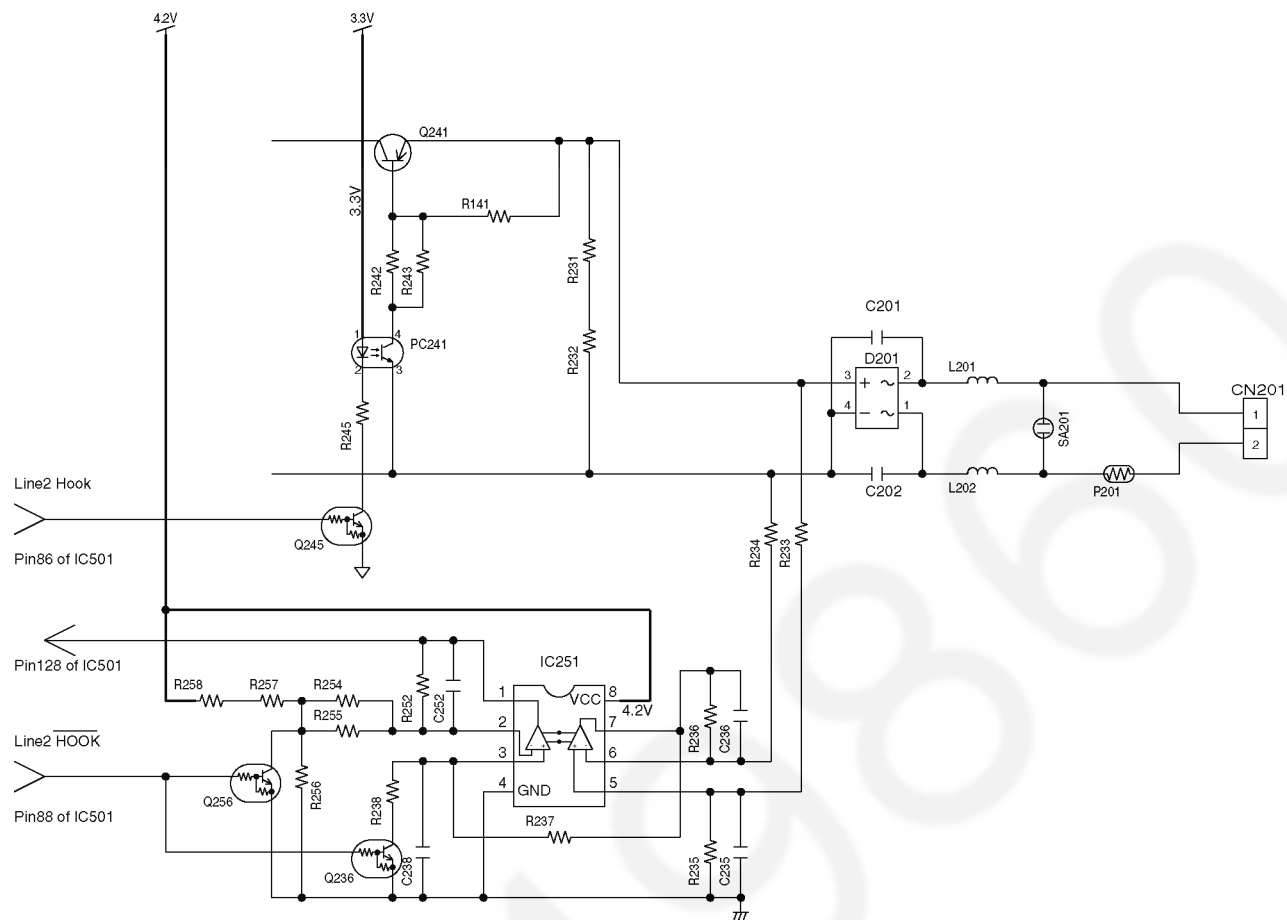
Pin 113 is for Line 1.

Pin 128 is for Line 2.

Line 1



Line 2



You can enable or disable the Auto Disconnect function.
See **Check Record** (P.66)

4.5.7. Parallel Connection Detect Circuit

Function:

This circuit is used to detect the fact that another telephone connected to the same line is OFF-HOOK while the unit is in idle state; to catch the empty line automatically.

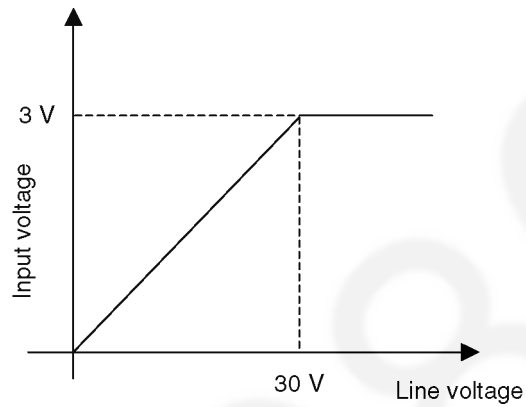
Circuit Operation:

The circuit is same as Auto Disconnect circuit.

But this circuit is controlled by inverse RLY signal. In on-hook state, the input signal logic is "high", then the transistors (Line 1: Q156 and Q136, Line 2: Q256 and Q236) turn on.

As a result, the circuit gain is different from off-hook state.

If the input signal to DSP is 1.65 V or higher, DSP will judge there is no use of the telephones connected in parallel.



Transformation Characteristics

4.5.8. Calling Line Identification (Caller ID)/Call Waiting Caller ID

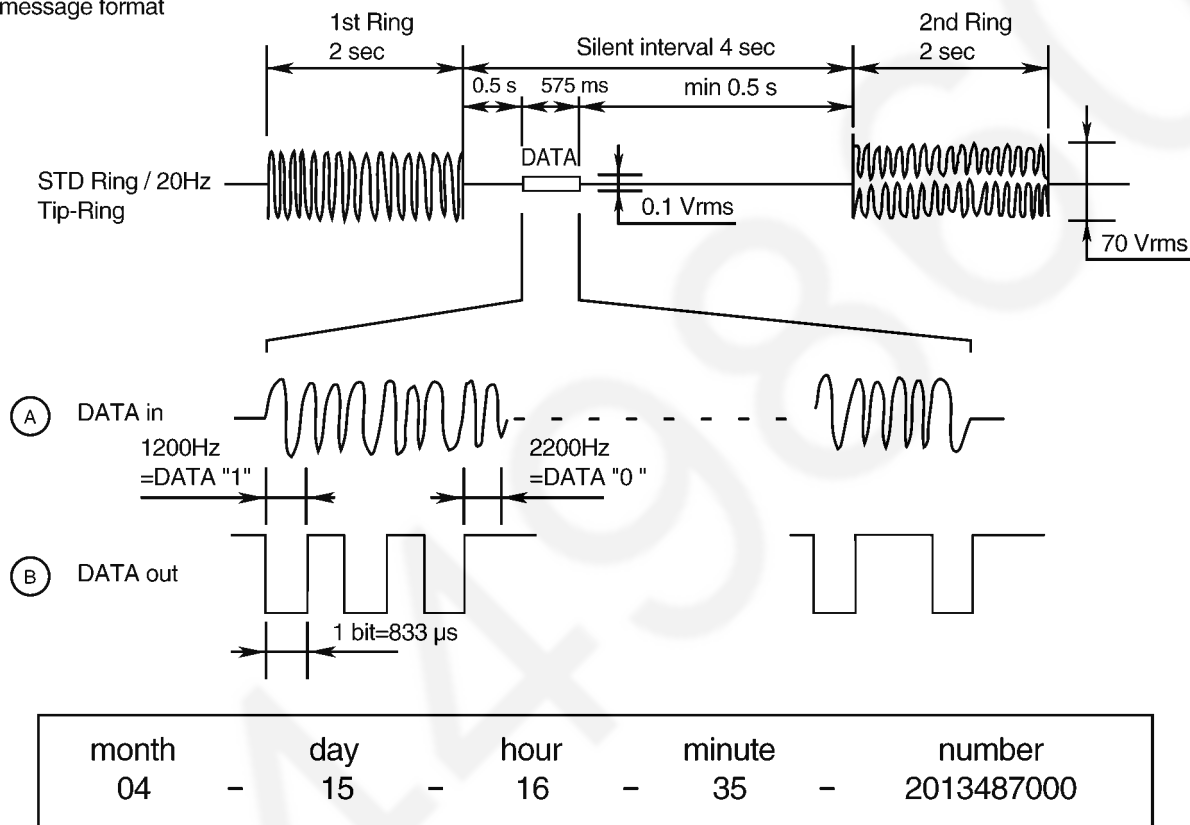
Function:

Caller ID

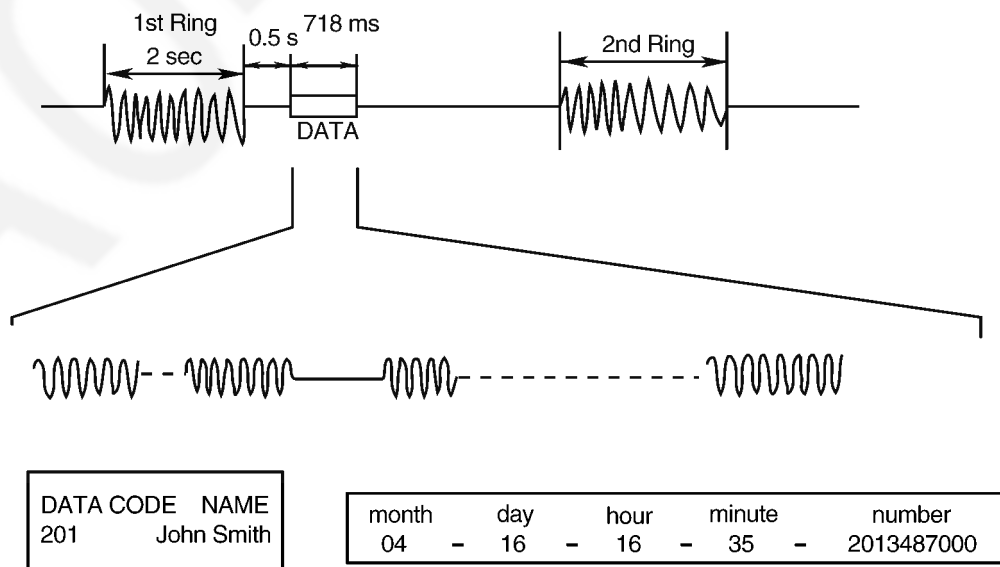
The caller ID is a chargeable ID which the user of a telephone circuit obtains by entering a contract with the telephone company to utilize a caller ID service. For this reason, the operation of this circuit assumes that a caller ID service contract has been entered for the circuit being used. The data for the caller ID from the telephone exchange is sent during the interval between the first and second rings of the bell signal. The data from the telephone exchange is a modem signal which is modulated in an FSK (Frequency Shift Keying) * format. Data "1" is a 1200 Hz sine wave, and data "0" is a 2200 Hz sine wave. There are two types of the message format which can be received: i.e. the single message format and plural message format. The plural message format allows to transmit the name and data code information in addition to the time and telephone number data.

*: Also the telephone exchange service provides other formats.

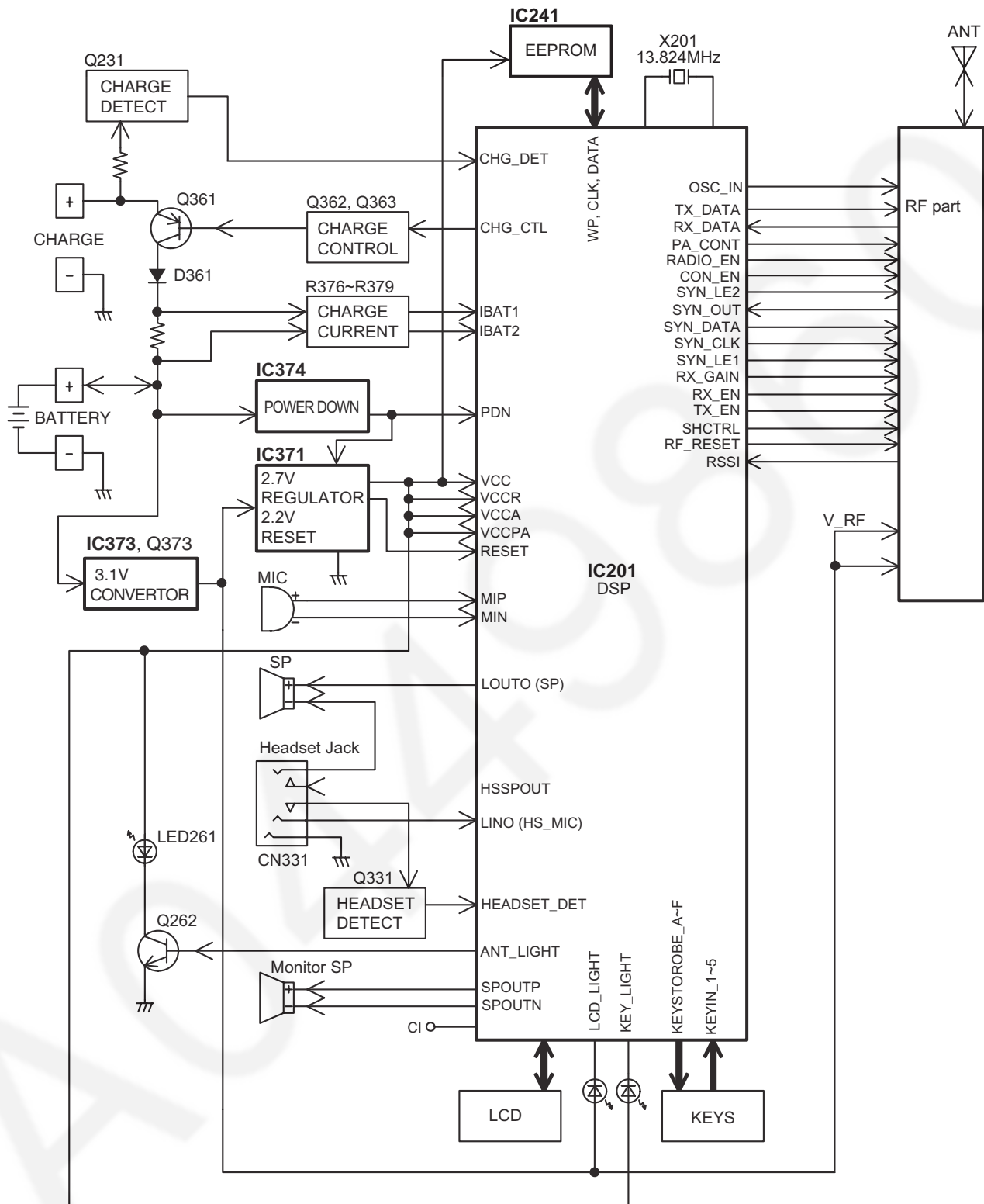
• Single message format



• Plural message format

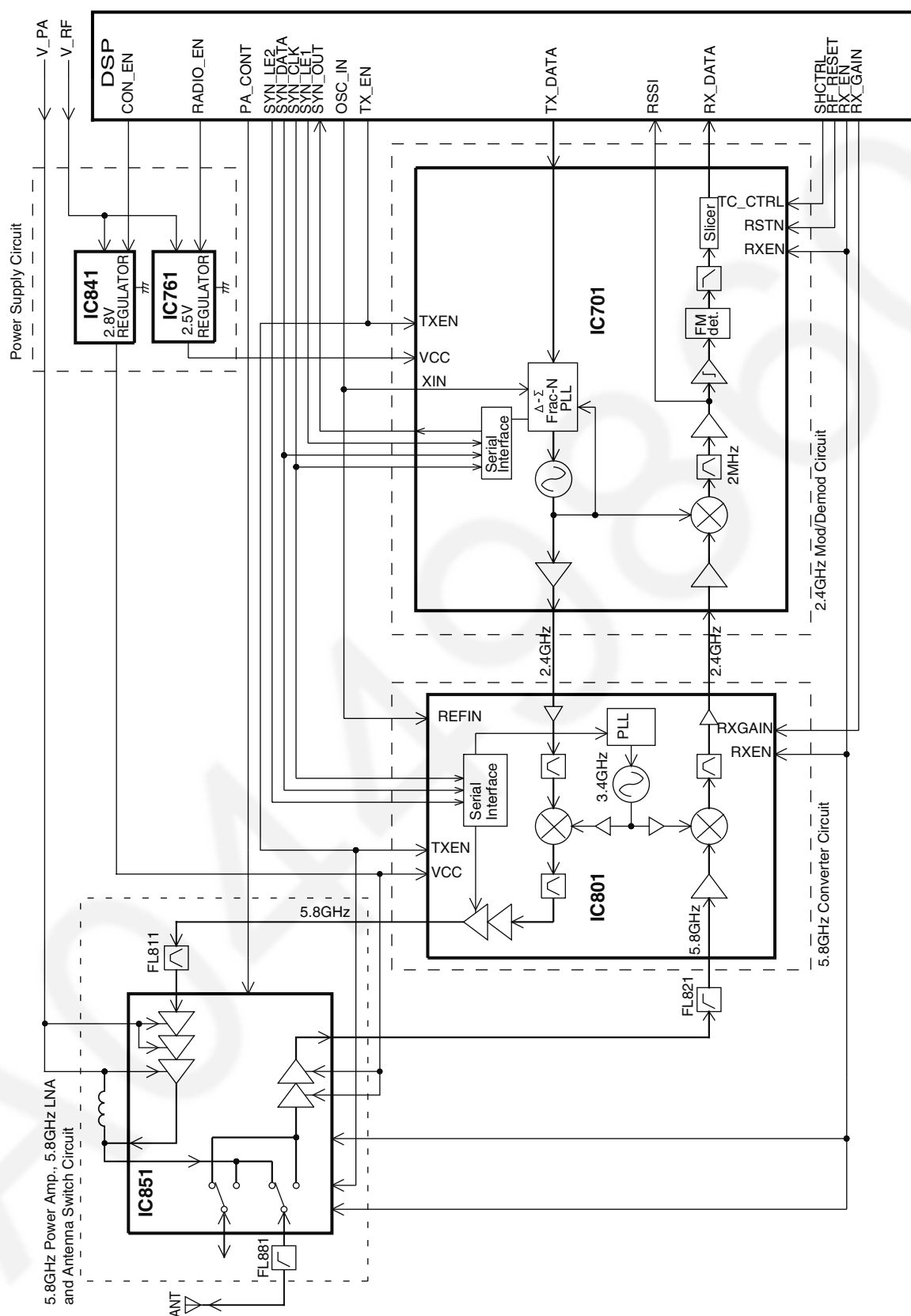


4.6. Block Diagram (Handset_Main)



KX-TGA670 BLOCK DIAGRAM (Handset)

4.7. Block Diagram (Handset_RF Part)



KX-TGA670 BLOCK DIAGRAM (Handset_RF Part)

4.8. Circuit Operation (Handset)

4.8.1. Construction

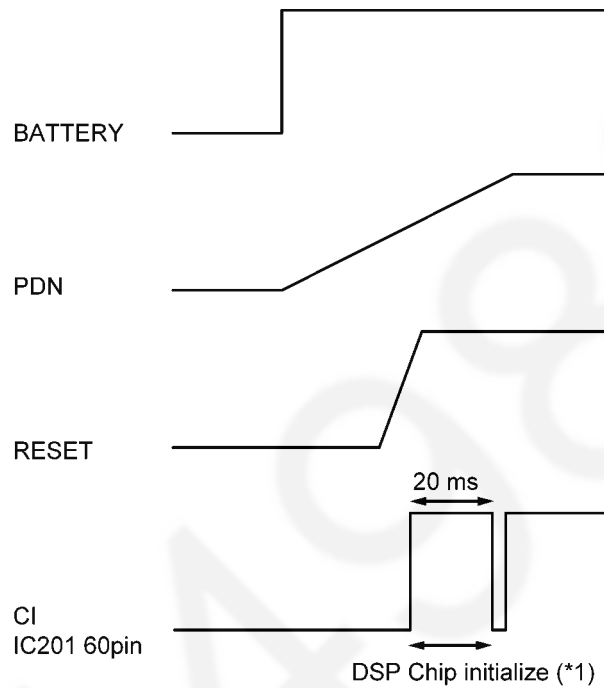
The circuit mainly consists of DSP and RF part as shown in the block diagram.

4.8.1.1. DSP: IC201

Function

- Battery Low, Power down detect circuit
 - Ringer Generation
 - Interface circuit
- RF part, Speaker, Mic, LED, Key scan, LCD, Headset

Initialize



Note:

(*1) The initializing time of the DSP chip is 20 ms under normal conditions.

4.8.1.2. RF part

Mainly voice signal is modulated to RF, or it goes the other way.

4.8.1.3. EEPROM: IC241

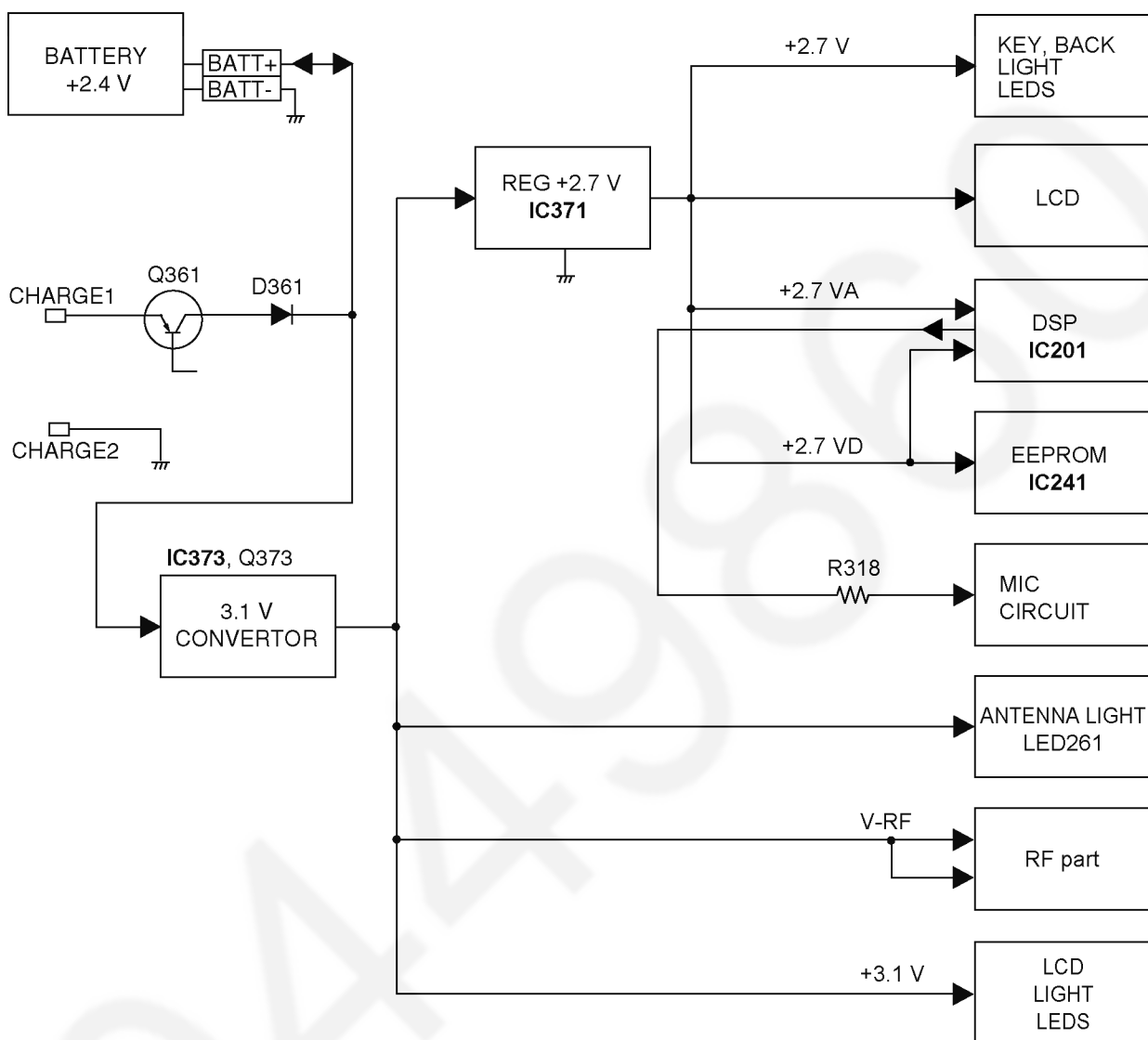
All setting data is stored.

ex: ID code, user setting (Phonebook, Caller ID data)

4.8.2. Power Supply Circuit

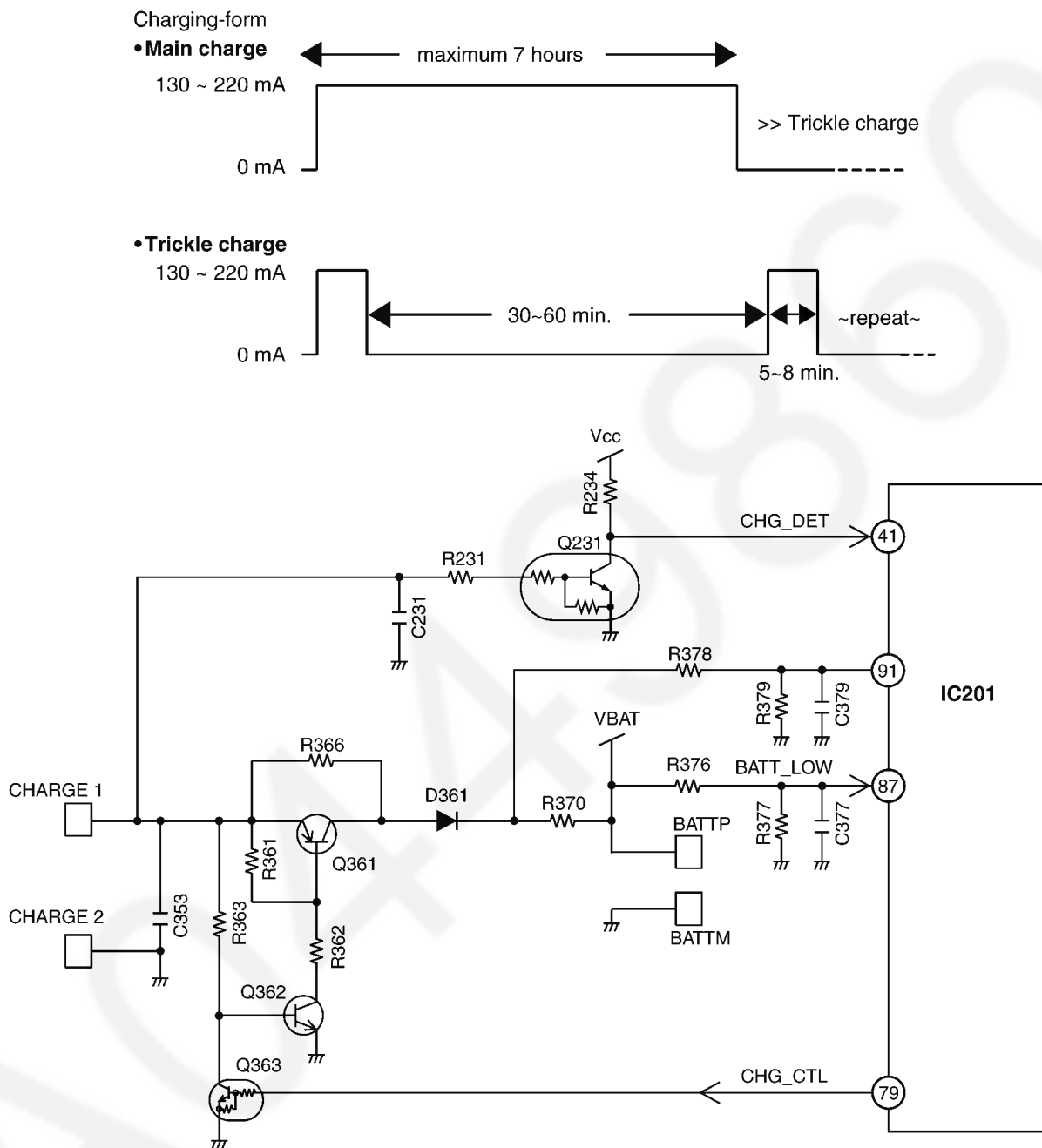
Voltage is supplied separately to each block.

Block Diagram (Handset Power)



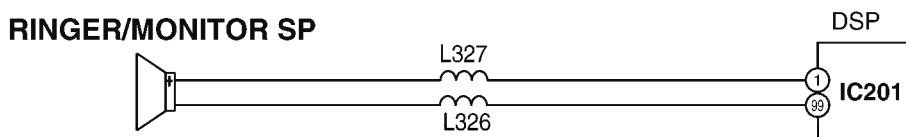
4.8.3. Charge Circuit

When the Handset is put on the cradle of the Base Unit or the charger, the power is supplied from CHARGE+ and CHARGE- terminals to charge the battery via Q361 or R366, and D361. The voltage between CHARGE+ and CHARGE- flows R231 → Q231 → pin 41 of IC201, where the charge is detected. Then IC201 calculates the battery consumption amount from the previous charge, and it controls Q361/Q362/Q363 by pin 79 of IC201 until charging is complete. When charging is complete, the control pattern is switched to Trickle charging form from Operational charging form.



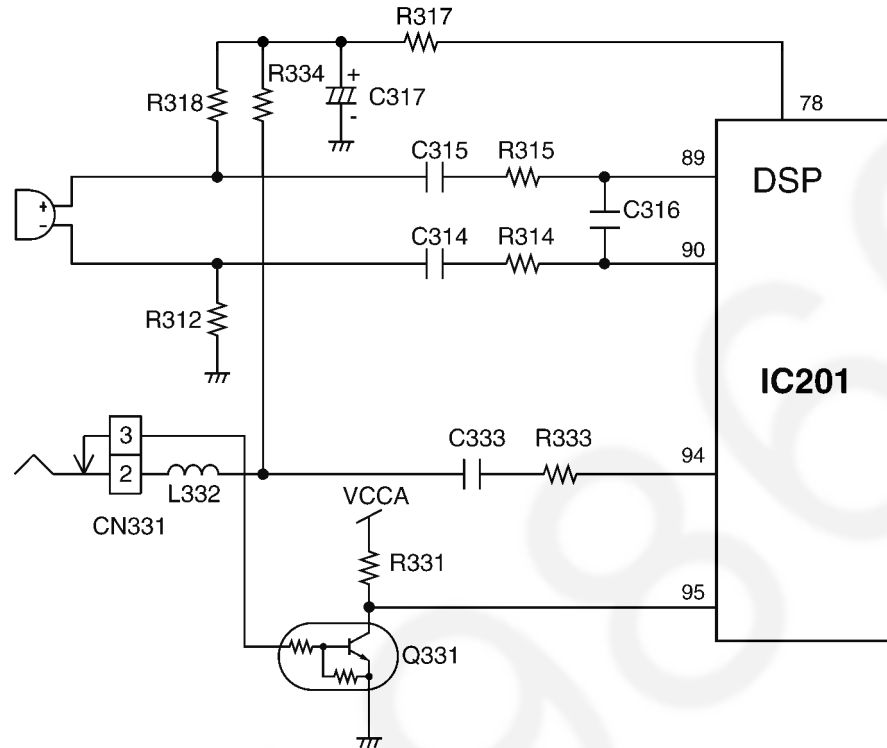
Pin 87 of IC201 monitors the battery voltage and detect BATT LOW at 2.34 V.

4.8.4. Ringer and Handset SP-Phone



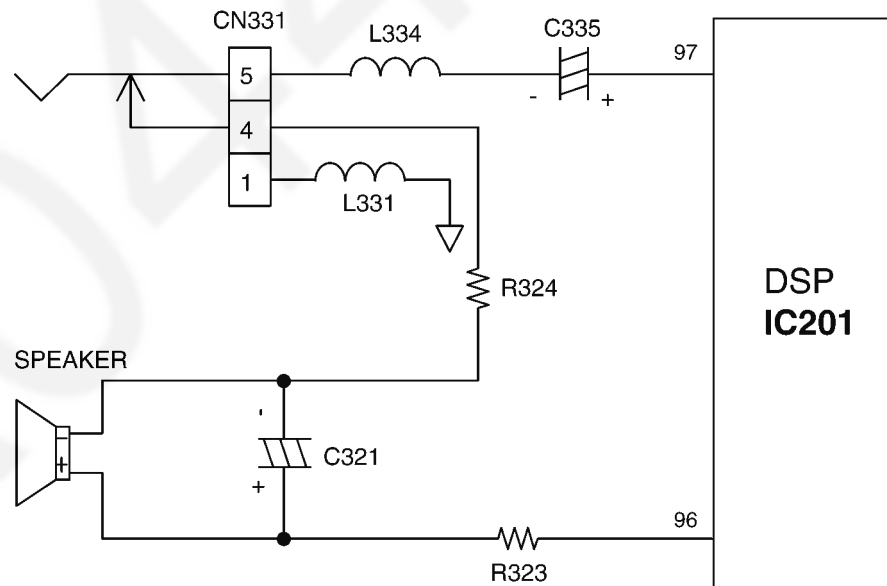
4.8.5. Sending Signal

The voice signal from the microphone is input to DSP (89, 90). CN331 is the headset jack. When the headset is connected, the Q331 detect it. The input from the microphone of the Handset (MIN, MIP) is cut and the microphone signal from the headset is input to DSP (94). Also the power for the microphone is supplied from DSP (78) and the power is turned OFF on standby.



4.8.6. Reception Signal

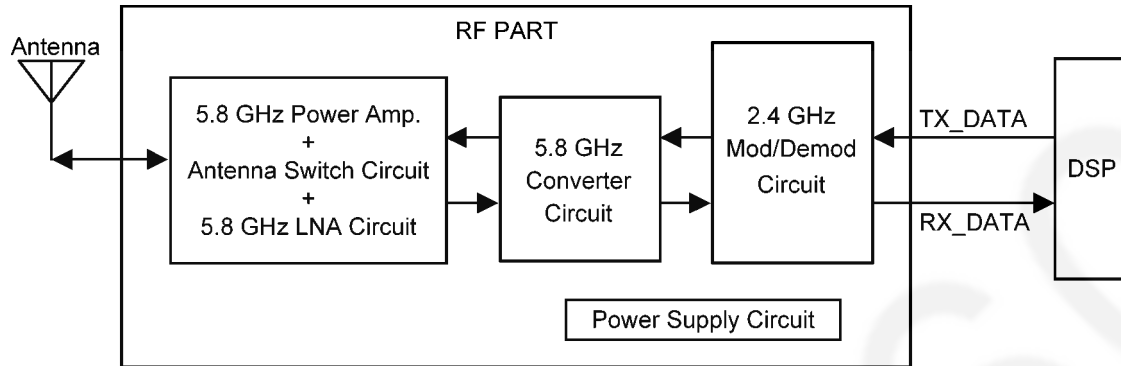
The voice signal from the Base Unit is output to DSP (97). This signal is led to the headset jack (CN331). The signal through the headset jack and the other signal output from DSP (96) drives the speaker. When the headset is inserted to the jack, the voice signal is cut at the jack, so the sound does not come out from the speaker, but from the headset only.



4.9. Circuit Operation (RF Part)

General Description:

RF part includes Transmitter and Receiver functions. Digital signals (Mainly voice data) that come from DSP, are modulated and are transmitted. On the other hand, received signals are demodulated and go out to DSP.



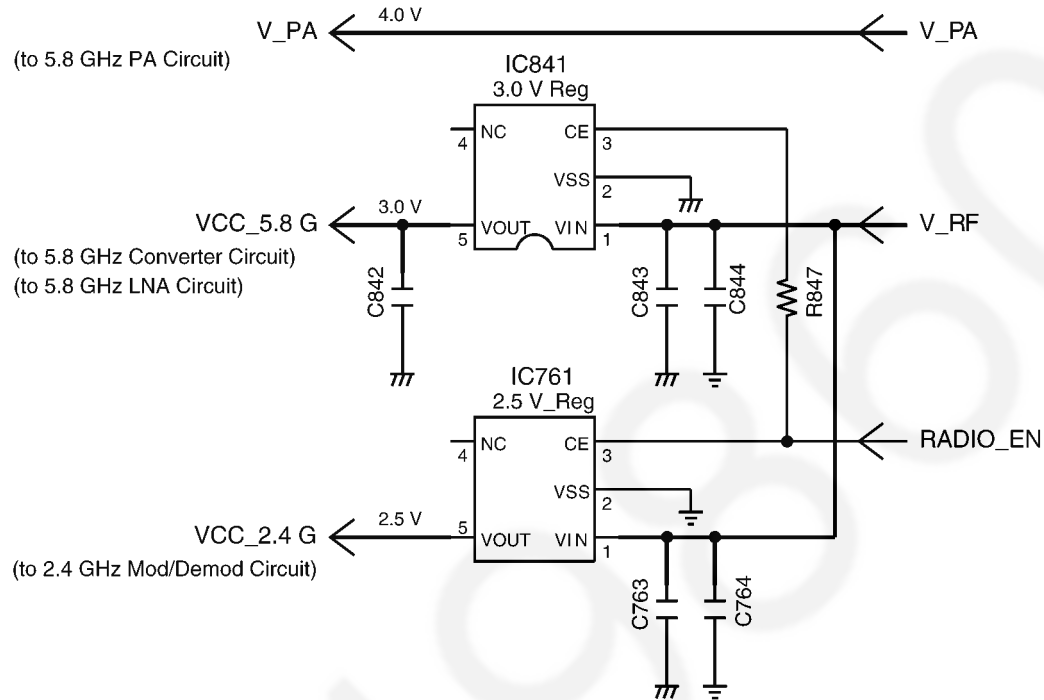
4.9.1. Power Supply Circuit

As indicated below, the various voltages are supplied to each block.

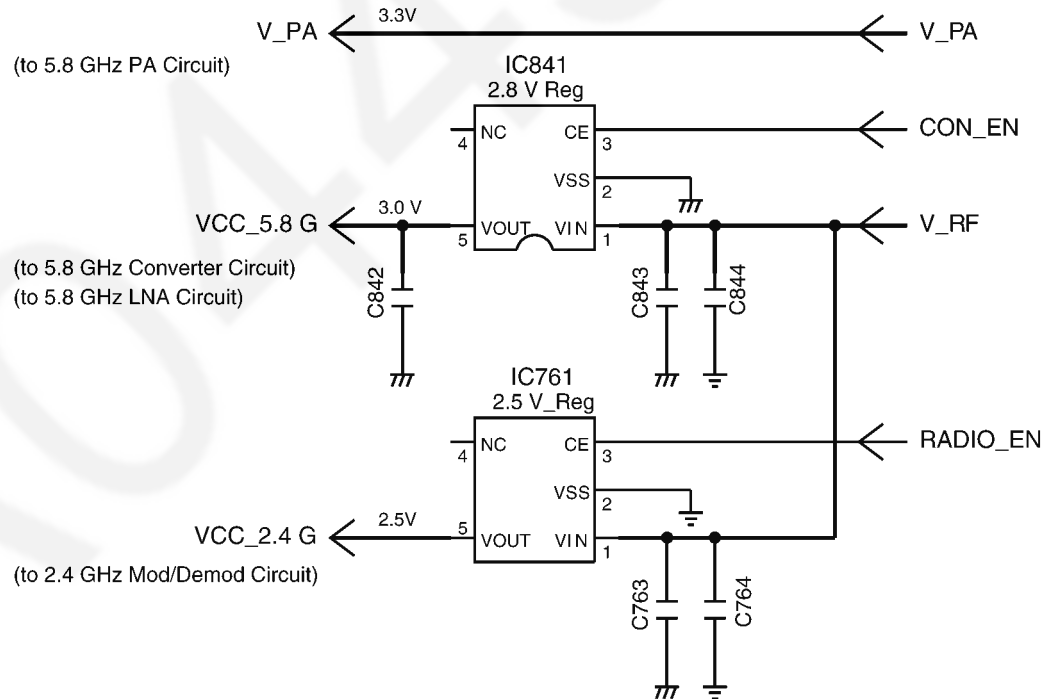
V_PA, about 4.0 V at Base Unit or 3.1 V at Handset, is supplied to the Power amplifier in 5.8 GHz PA circuit.

IC841 is 3.0 V (Base Unit) or 2.8 V (Handset) Regulators, and IC761 is a 2.5 V Regulator. They output Vcc_5.8 GHz, and Vcc_2.4 GHz respectively by order of RADIO_EN signal or CON_EN signal. V_RF is approximately 4.0 V (Base Unit) or 3.1 V (Handset).

<Base Unit>

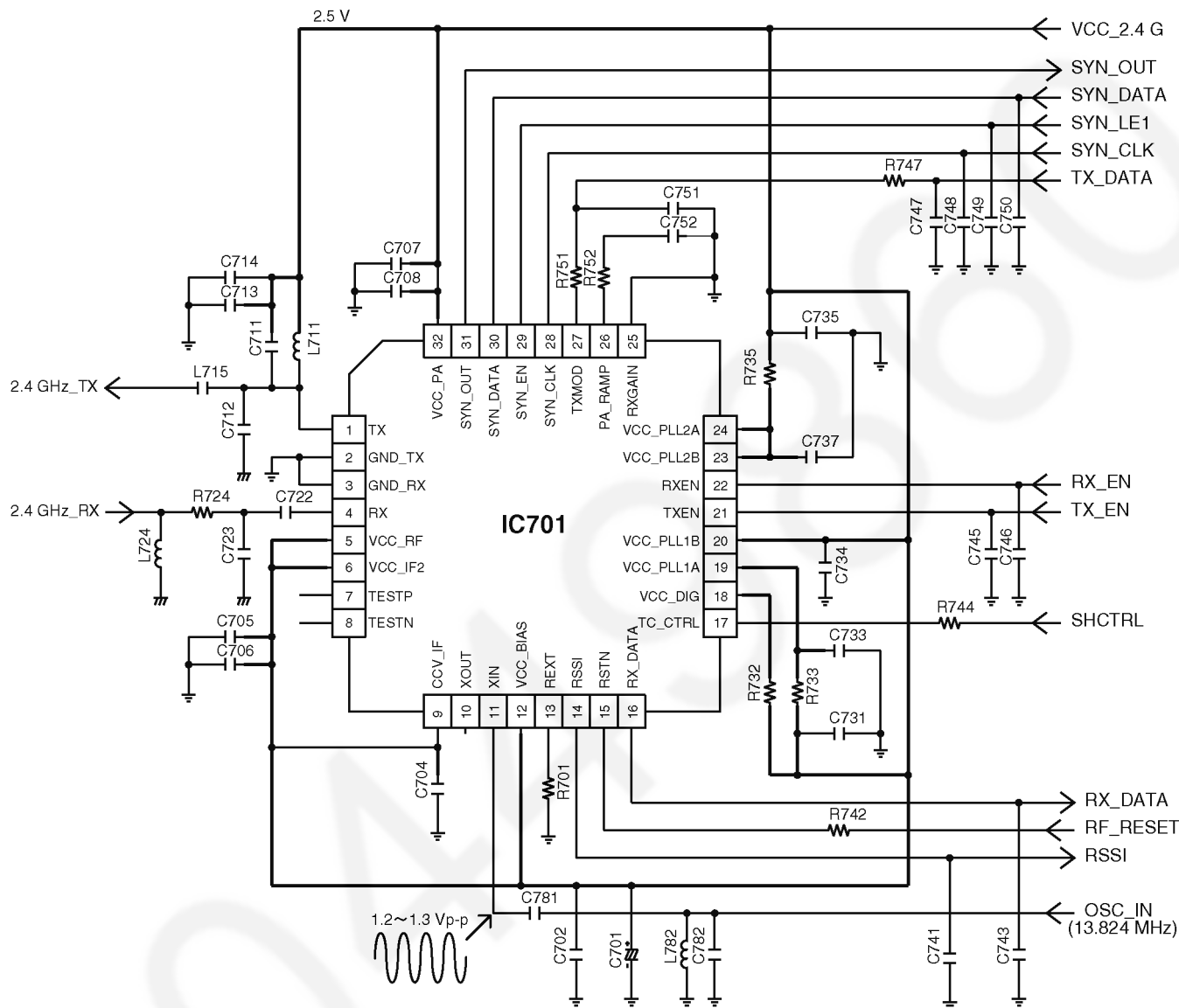


<Handset>



4.9.2. 2.4 GHz Mod/Demod Circuit

IC701 incorporates all of the modulation and demodulation functions. TX Digital data (TX_DATA) from DSP is supplied to pin 27 of IC701, and then 2.4 GHz TX modulated signal is output from pin 1. This TX signal goes into the 5.8 GHz Converter circuit. 2.4 GHz RX signal from 5.8 GHz Converter circuit is passed through matching circuit and supplied to pin 4 of IC701, then demodulated signal (RX_DATA) comes out from pin 16. At the same time, RSSI (Received Signal Strength Indicator) outputs from the pin 14. Reference clock (13.824 MHz) from DSP block is supplied to pin 11 of IC701. VCC_2.4 G supplies 2.5 V regulated voltage.



Note:

The exposed GND_PLATE on the bottom of the IC701 supplies the circuit ground(s) for the entire chip. It is very important that a good solder connection is made between this GND_PLATE and the ground plane of the PCB underlying the IC701.

4.9.3. 5.8 GHz Converter Circuit

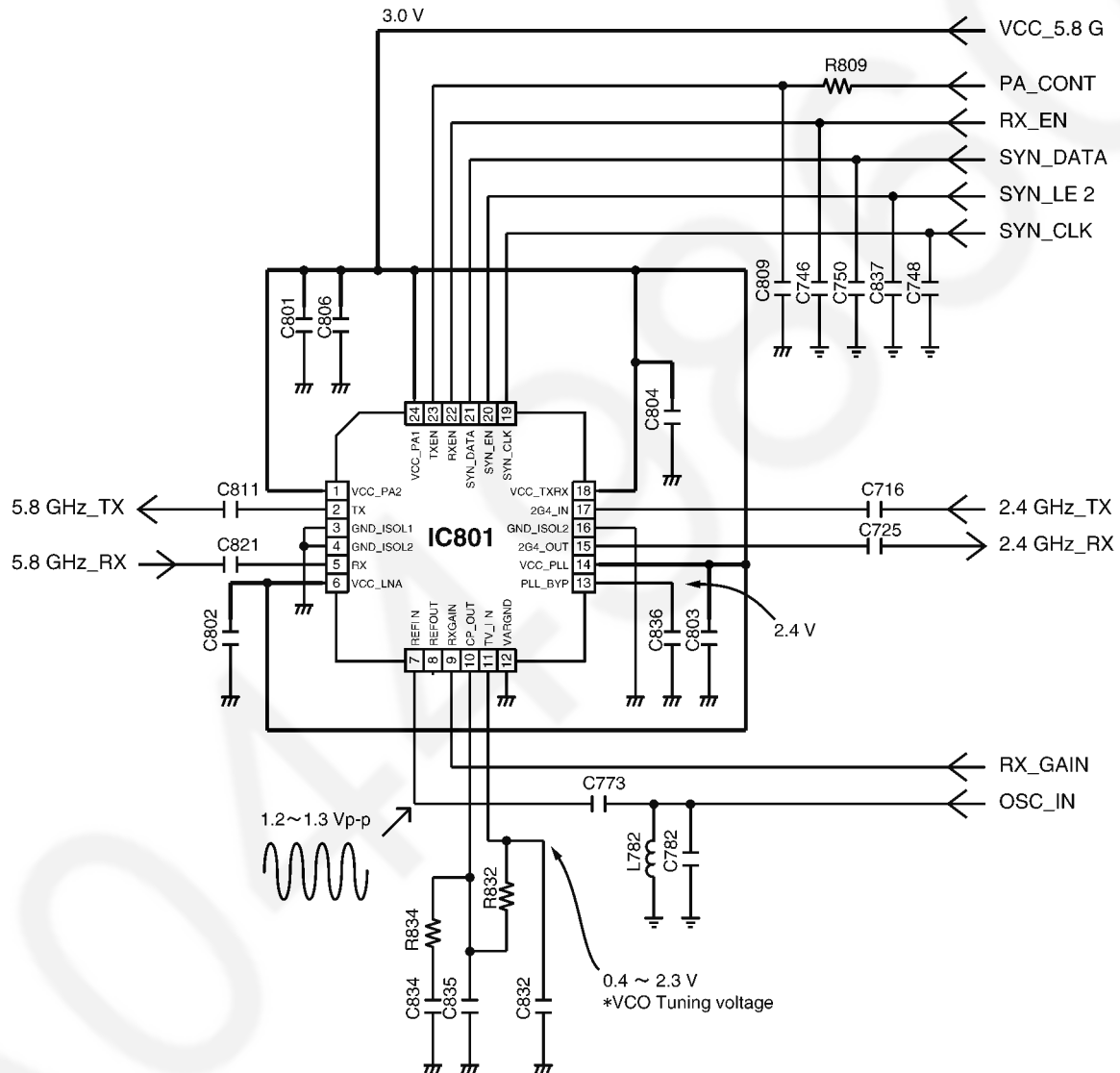
This block converts frequency of TX signal and RX signal.

IC801 includes TX-MIXER, RX-MIXER, PLL and VCO modules internally.

The VCO module is tuned by PLL synthesizer module, and generates 3.4 GHz Local signal. Reference clock (13.824 MHz) from DSP block is supplied to pin 7 of IC701.

2.4 GHz TX signal from 2.4 GHz Mod/Demod circuit is supplied to pin 17 of IC801, and internal TX-MIXER multiplies it by 3.4 GHz Local signal from internal VCO module, and up-converts into 5.8 GHz TX signal. This 5.8 GHz TX signal is output from pin 2, and goes into the 5.8 GHz PA circuit.

5.8 GHz RX signal from 5.8 GHz LNA circuit supplied to pin 5 of IC801, and internal RX-MIXER multiplies it by 3.4 GHz Local signal from internal VCO module, and down-converts into 2.4 GHz RX signal. This 2.4 GHz RX signal is output from pin 15, and goes into the 2.4 GHz Mod/Demod circuits.



Note:

The exposed GND_PLATE on the bottom of the IC801 supplies the circuit ground(s) for the entire chip. It is very important that a good solder connection is made between this GND_PLATE and the ground plane of the PCB underlying the IC801.

4.9.4. 5.8 GHz PA (Power Amplifier), 5.8 GHz LNA (Low Noise Amplifier) and Antenna Switch Circuit

PA block amplifies power of 5.8 GHz TX signal.

5.8 GHz TX signal from 5.8 GHz Converter circuit is filtered by 5.8 GHz-BPF FL811, and amplified by Power amplifier (PA) block of IC851. After that, it is supplied to Antenna Switch block of IC851. V_PA is approximately 4.0 V at Base Unit, and 3.1 V at Handset.

LNA block amplifies receiving 5.8 GHz signal.

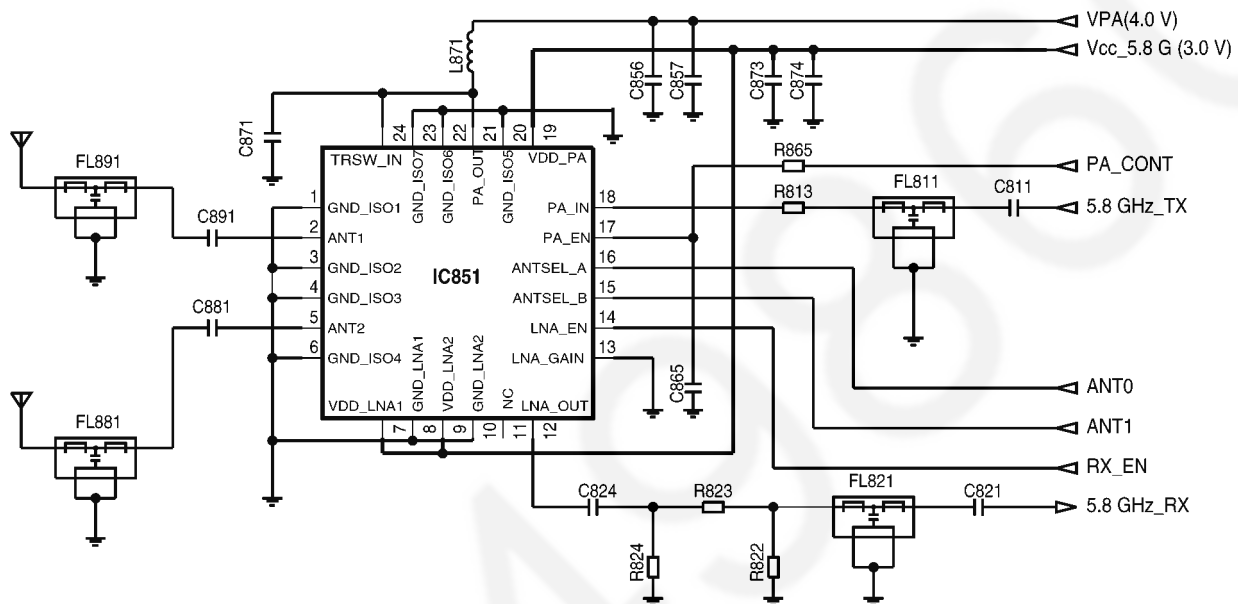
5.8 GHz RX signal from Antenna Switch block of IC851 amplified by LNA (Low Noise Amplifier) block of IC851 and filtered by HPF (FL821), and then supplied to 5.8 GHz Converter circuit.

Antenna Switch block selects the TX 5.8 GHz signal or RX 5.8 GHz signal, and connect to Antenna terminal.

Note:

The exposed GND_PLATE on the bottom of the IC851 supplies the circuit ground(s) for the entire chip. It is very important that a good solder connection is made between this GND_PLATE and the ground plane of the PCB underlying the IC851.

<Base Unit>

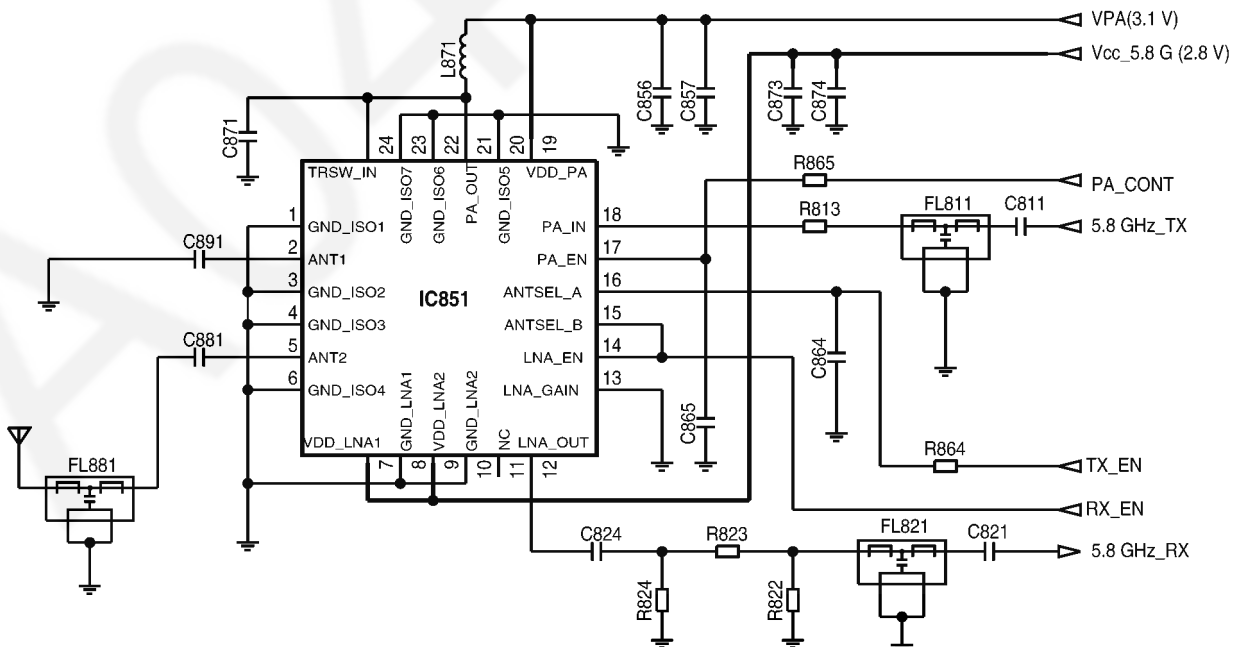


IC851 includes Switches for High frequency signals, and controlled by ANT0 signal and ANT1 signal from DSP.

DSP is checking RSSI (Received Signal Strength Indicator) signal, and selects better condition Antenna from two antennas.

At the TX mode 5.8 GHz TX signal from 5.8 GHz PA block leads to selected Antenna terminal, at the RX mode 5.8 GHz RX signal from selected Antenna terminal leads to 5.8 GHz LNA block.

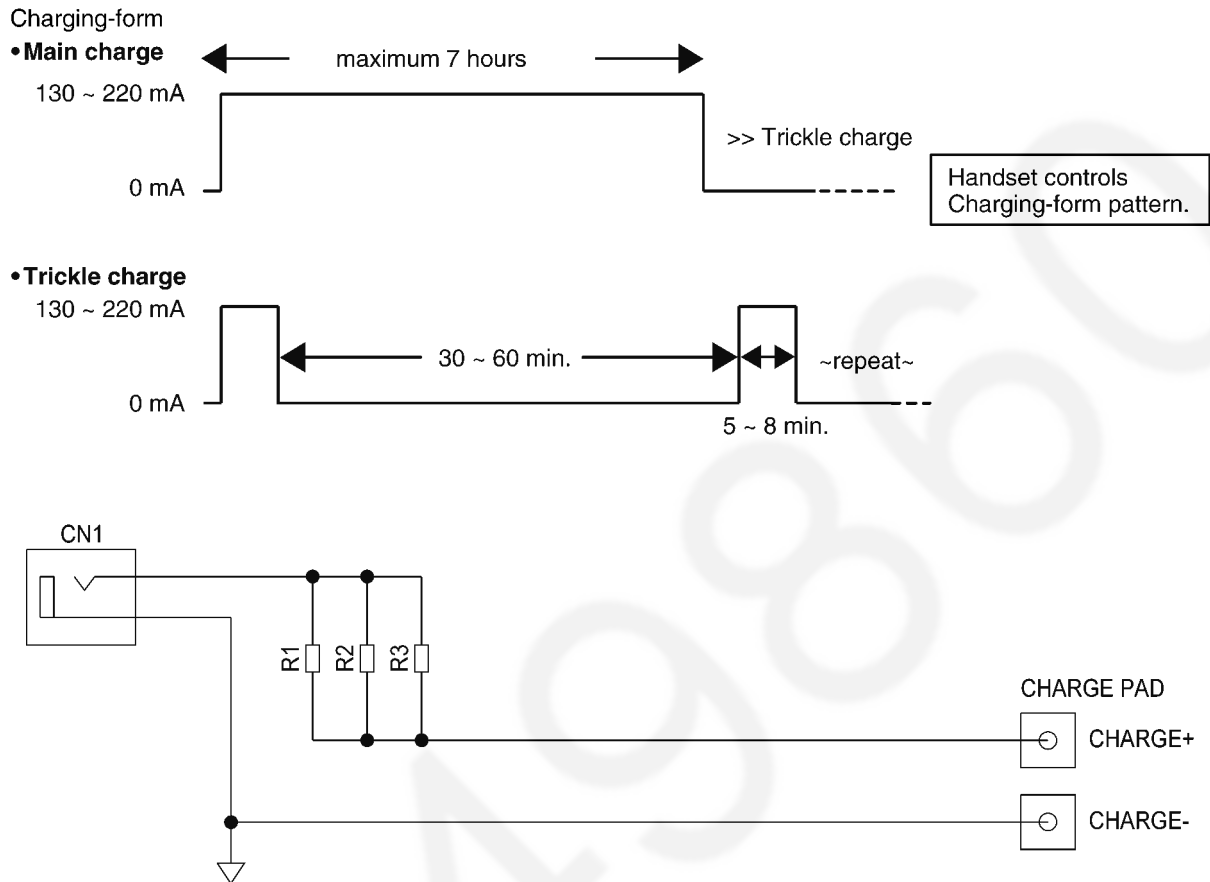
<Handset>



IC851 includes Switch for High frequency signals, and controlled by PA_CONT signal and RX_EN signal from DSP. At the TX mode 5.8 GHz TX signal from 5.8 GHz PA block leads to Antenna terminal, at the RX mode 5.8 GHz RX signal from Antenna terminal leads to 5.8 GHz LNA block.

4.10. Circuit Operation (Charger Unit)

The voltage from the AC adaptor is supplied to the charge circuits. Main charge (130 ~ 220 mA at the Battery) of maximum 7- hours is started soon after the Handset is placed on the Charger Unit. Then it changes to Trickle charge to prevent from overcharging.



The route for this is as follows: DC+pin of CN1 → R1 ~ R3 → CHARGE+pad → Handset → CHARGE-pad → DC-pin of CN1.

4.11. Signal Route

Each signal route is as follows.

SIGNAL ROUTE	IN → ROUTE → OUT
HANDSET TX [LINE 1]	HANDSET MIC - C314/C315 - R314/R315 - IC201(89/90 - 23) - <HANDSET_RF_TX_ROUTE> - ANT.-- --ANT. - <BASE_UNIT_RF_RX_ROUTE> - IC501(48 - 2) - R183 - C185 - R185 - Q161 - Q141 - D101 - L101/L102 - CN101(LINE1 TEL LINE)
HANDSET TX [LINE 2]	HANDSET MIC - C314/C315 - R314/R315 - IC201(89/90 - 23) - <HANDSET_RF_TX_ROUTE> - ANT.-- --ANT. - <BASE_UNIT_RF_RX_ROUTE> - IC501(48 - 1) - T281 - R283 - C285 - R285 - Q261 - Q241 - D201 - L201/L202 - CN201(LINE2 TEL LINE)
Headset TX [LINE 1]	HEADSET_JACK(2) - L332 - C333 - R333 - IC201(94 - 23) - <HANDSET_RF_TX_ROUTE> - ANT.-- --ANT. - <BASE_UNIT_RF_RX_ROUTE> - IC501(48 - 2) - R183 - C185 - R185 - Q161 - Q141 - D101 - L101/L102 - CN101(LINE1 TEL LINE)
Headset TX [LINE 2]	HEADSET_JACK(2) - L332 - C333 - R333 - IC201(94 - 23) - <HANDSET_RF_TX_ROUTE> - ANT.-- --ANT. - <BASE_UNIT_RF_RX_ROUTE> - IC501(48 - 1) - T281 - R283 - C285 - R285 - Q261 - Q241 - D201 - L201/L202 - CN201(LINE2 TEL LINE)
HANDSET Sp-phone TX [LINE 1]	HANDSET MIC - C314/C315 - R314/R315 - IC201(89/90 - 23) - <HANDSET_RF_TX_ROUTE> - ANT.-- --ANT. - <BASE_UNIT_RF_RX_ROUTE> - IC501(48 - 2) - R183 - C185 - R185 - Q161 - Q141 - D101 - L101/L102 - CN101(LINE1 TEL LINE)
HANDSET Sp-phone TX [LINE 2]	HANDSET MIC - C314/C315 - R314/R315 - IC201(89/90 - 23) - <HANDSET_RF_TX_ROUTE> - ANT.-- --ANT. - <BASE_UNIT_RF_RX_ROUTE> - IC501(48 - 1) - T281 - R283 - C285 - R285 - Q261 - Q241 - D201 - L201/L202 - CN201(LINE2 TEL LINE)
HANDSET RX [LINE 1]	CN101(Line1 TEL LINE) - L101/L102 - D101 - Q141 - C165 - R167 - C167 - Q171 - C178 - R178 - IC501(127 - 30) - <BASE_UNIT_RF_TX_ROUTE> -ANT.-- --ANT. - <HANDSET_RF_TX_ROUTE> - IC201(38 - 97/96) - [C335 - L334 - HEADSET_JACK(5 - 4) - R324/R323 - HANDSET SPEAKER
HANDSET RX [LINE 2]	CN201(Line2 TEL LINE) - L201/L202 - D201 - Q241 - C265 - C264 - T261 - C267 - R267 - Q271 - C278 - R278 - C280 - IC501(120 - 30) --ANT. - <HANDSET_RF_TX_ROUTE> - IC201(38 - 97/96) - [C335 - L334 - HEADSET_JACK(5 - 4) - R324/R323 - HANDSET SPEAKER
Headset RX [LINE 1]	CN101(Line1 TEL LINE) - L101/L102 - D101 - Q141 - C165 - R167 - C167 - Q171 - C178 - R178 - IC501(127 - 30) - <BASE_UNIT_RF_TX_ROUTE> -ANT.-- --ANT. - <HANDSET_RF_RX_ROUTE> - IC201(38 - 97) - C335 - L334 - HEADSET_JACK(5)
Headset RX [LINE 2]	CN201(Line2 TEL LINE) - L201/L202 - D201 - Q241 - C265 - C264 - T261 - C267 - R267 - Q271 - C278 - R278 - C280 - IC501(120 - 30) --ANT. - <HANDSET_RF_RX_ROUTE> - IC201(38 - 97) - C335 - L334 - HEADSET_JACK(5)
HANDSET Sp-phone RX [LINE 1]	CN101(Line1 TEL LINE) - L101/L102 - D101 - Q141 - C165 - R167 - C167 - Q171 - C178 - R178 - IC501(127 - 30) - <BASE_UNIT_RF_TX_ROUTE> -ANT.-- --ANT. - <HANDSET_RF_RXS_ROUTE> - IC201(38 - 99/1) - L326/L327 - MONITOR SP
HANDSET Sp-phone RX [LINE 2]	CN201(Line2 TEL LINE) - L201/L202 - D201 - Q241 - C265 - C264 - T261 - C267 - R267 - Q271 - C278 - R278 - C280 - IC501(120 - 30) --ANT. - <HANDSET_RF_RXS_ROUTE> - IC201(38 - 99/1) - L326/L327 - MONITOR SP
INTERCOM HS to BU	HANDSET MIC - C314/C315 - R314/R315 - IC201(89/90 - 23) - <HANDSET_RF_TX_ROUTE> - ANT.-- --ANT. - <BASE_UNIT_RF_RX_ROUTE> - IC501(48 - 6/8) - R472/R473 - L472/L473 - SPEAKER

Note:

; inside of Handset

SIGNAL ROUTE	IN	→	ROUTE	→	OUT
INTERCOM BS to HS	MIC - C457/C458 - R459/R460 - IC501(115/116 - 30) - <BASE_UNIT_RF_TX_ROUTE>-ANT.-				-ANT. - <HANDSET_RF_RXS_ROUTE> - IC201(38 - 99/1) - L326/L327 - MONITOR SP
BASE UNIT Sp-phone TX [LINE 1]	MIC - C457/C458 - R459/R460 - IC501(115/116 - 2) - R183 - C185 - R185 - Q161 - Q141 - D101 - L101/L102 - CN101(LINE1 TEL LINE)				
BASE UNIT Sp-phone TX [LINE 2]	MIC - C457/C458 - R459/R460 - IC501(115/116 - 1) - T281 - R283 - C285 - R285 - Q261 - Q241 - D201 - L201/L202 - CN201(LINE2 TEL LINE)				
BASE UNIT Sp-phone RX [LINE 1]	CN101(Line1_TEL_Line) - L101/L102 - D101 - Q141 - C165 - R167 - C167 - Q171 - C178 - R178 - IC501(127 - 6/8) - R472/R473 - L472/L473 - SPEAKER				
BASE UNIT Sp-phone RX [LINE 2]	CN201(Line2 TEL LINE) - L201/L202 - D201 - Q241 - C265 - C264 - T261 - C267 - R267 - Q271 - C278 - R278 - C280 - IC501(120 - 6/8) - R472/R473 - L472/L473 - SPEAKER				
GREETING RECORDING	MIC - C457/C458 - R459/R460 - IC501(115/116 - 25/26) - IC601				
GREETING PLAY TO Line1	IC601 - IC501(25/26 - 2) - R183 - C185 - R185 - Q161 - Q141 - D101 - L101/L102 - CN101(LINE1 TEL LINE)				
GREETING PLAY TO Line2	IC601 - IC501(25/26 - 1) - T281 - R283 - C285 - R285 - Q261 - Q241 - D201 - L201/L202 - CN201(LINE2 TEL LINE)				
ICM RECORDING [Line1]	CN101(Line1 TEL LINE) - L101/L102 - D101 - Q141 - C165 - R167 - C167 - Q171 - C178 - R178 - IC501(127 - 25/26) - IC601				
ICM RECORDING [Line2]	CN201(Line2 TEL LINE) - L201/L202 - D201 - Q241 - C265 - C264 - T261 - C267 - R267 - Q271 - C278 - R278 - C280 - IC501(120 - 25/26) - IC601				
ICM PLAY TO SPEAKER	IC601 - IC501(25/26 - 6/8) - R472/R473 - L472/L473 - SPEAKER				
DTMF SIGNAL TO Line1	IC501(2) - R183 - C185 - R185 - Q161 - Q141 - D101 - L101/L102 - CN101(LINE1 TEL LINE)				
DTMF SIGNAL TO Line2	IC501(1) - T281 - R283 - C285 - R285 - Q261 - Q241 - D201 - L201/L202 - CN201(LINE2 TEL LINE)				
CALLER ID [Line1]	CN101(Line1 TEL LINE) - L101/L102 - C121/C122 - R121/R122 - IC501(122/123)				
CALLER ID [Line2]	CN201(T/R) - L201/L202 - C213/C214 - R213/R214 - R215/R216 - IC291(5/6 - 7) - R291 - R292 - C292 - IC291(2 - 1) - C297 - C298 - IC501(118)				

Note:
☐ : inside of Handset
RF part signal route

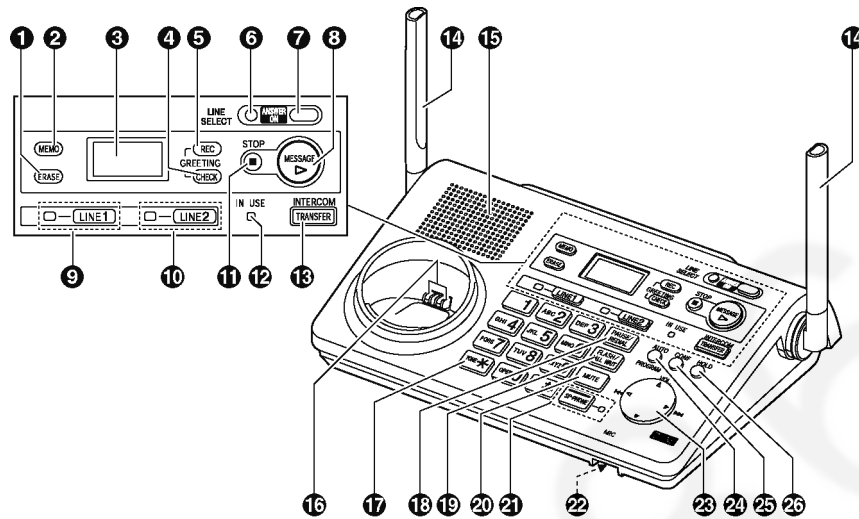
SIGNAL ROUTE	IN	→	ROUTE	→	OUT
HANDSET RF [TX_ROUTE]	< R747 - R751 - IC701(27 - 1) - L751 - C716 - IC801(17 - 2) - FL811 - R813 - IC851(18 - 5) - C881 - FL881 >				
HANDSET RF [RX_ROUTE]	< FL881 - C881 - IC851(5 - 12) - C824 - R823 - FL821 - C821 - IC801(5 - 15) - C725 - R724 - C722 - IC701(4 - 16) >				
BASE UNIT RF [TX_ROUTE]	< R747 - R751 - IC701(27 - 1) - L751 - C716 - IC801(17 - 2) - R813 - IC851(18 - 5/2) - C881/C891 - FL881/FL891 >				
BASE UNIT RF [RX_ROUTE]	< FL881/FL891 - C881/C891 - IC851(5/2 - 12) - C824 - R823 - FL821 - C821 - IC801(5 - 15) - C725 - R724 - C722 - IC701(4 - 16) >				

Note:
☐ : inside of Handset

5 Location of Controls and Components

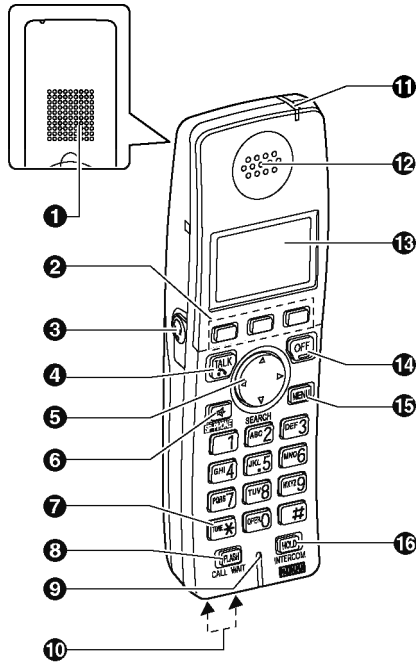
5.1. Controls

5.1.1. Base Unit



- | | |
|------------------------------|-------------------------------------|
| ① [ERASE] | ⑭ Antenna |
| ② [MEMO] | ⑮ Speaker |
| ③ Display | ⑯ Charge contacts |
| ④ [GREETING CHECK] | ⑰ [✖] (TONE) |
| ⑤ [GREETING REC] (Recording) | ⑱ [PAUSE] [REDIAL] |
| ⑥ [LINE SELECT] | ⑲ [FLASH] [CALL WAIT] |
| ⑦ [ANSWER ON] | ⑳ [MUTE] |
| ⑧ [MESSAGE] | ㉑ [SP-PHONE] (Speakerphone) |
| ⑨ [LINE1] | SP-PHONE indicator |
| ⑩ [LINE2] | ㉒ MIC (Microphone) |
| LINE1 indicator | ㉓ Navigator key ([▲] [▼] [◀◀] [▶▶]) |
| ⑪ [STOP] | ㉔ [AUTO] [PROGRAM] |
| ⑫ IN USE indicator | ㉕ [CONF] (Conference) |
| ⑬ [TRANSFER] [INTERCOM] | ㉖ [HOLD] |

5.1.2. Handset



- ① Speaker
- ② Soft keys
- ③ Headset jack
- ④ [TALK]
- ⑤ Navigator key ([▲] [▼] [←] [→])/
SEARCH ([▲] [▼])
- ⑥ [SP-PHONE]
- ⑦ [TONE]
- ⑧ [FLASH] [CALL WAIT]
- ⑨ Microphone
- ⑩ Charge contacts
- ⑪ Charge indicator
Ringer indicator
Message indicator
- ⑫ Receiver
- ⑬ Display
- ⑭ [OFF]
- ⑮ [MENU]
- ⑯ [HOLD] [INTERCOM]

5.2. Displays

5.2.1. Base Unit Display Items

Displayed item	Meaning
⌚	Flashes when the date and time need to be set.
LINE 1 LINE 2	Indicates the selected line(s) for the answering system or ringer setting. Flashing: the answering system is answering a call or playing a message on the line.
FULL	Flashes when message memory is full.
L1	Indicates the line 1 ringer on the base unit is off.
L2	Indicates the line 2 ringer on the base unit is off.
E	Greeting or memo message recording error
g	Answering system is in greeting only mode (caller message cannot be recorded). It is displayed when you turn the answering system on.
Example: H	Handset number: displayed when the base unit is on intercom call, monitoring, or monitored by a handset.
H	Paging all handsets
P	Base unit is in programming mode.

5.2.2. Handset Display Items

Displayed item	Meaning
VE	Voice enhancer is on.
■■■	Battery level
L1 L2	The line is in use. Flashing: – the call is put on hold on that line. – the answering system is answering a call on that line. Flashing rapidly: a call is being received on that line.
SP	Speaker is on.
PRIV.	Call privacy mode is on.
Example: 1	Handset's extension number.

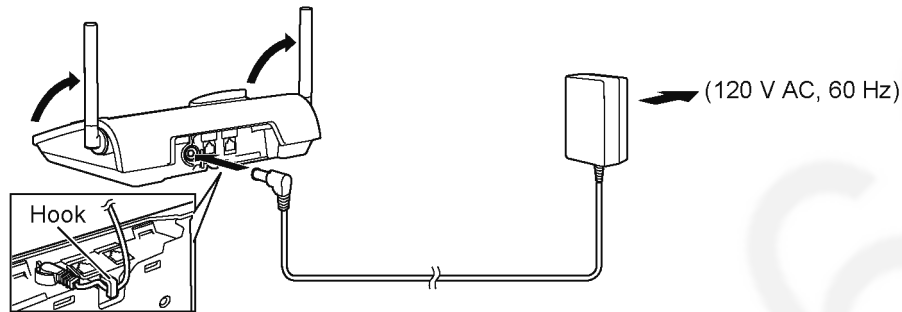
6 Installation Instructions

6.1. Setting Up the Base Unit

6.1.1. Connecting the AC Adaptor

Connect the AC adaptor, then raise the antennas.

- Use only the included Panasonic AC adaptor PQLV207Z.



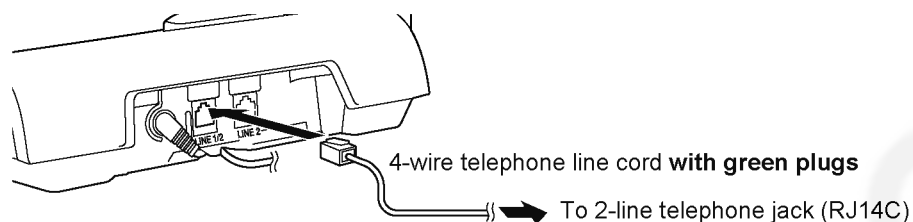
Note:

- The AC adaptor must remain connected at all times. (It is normal for the adaptor to feel warm during use.)
- The AC adaptor should be connected to a vertically oriented or floor-mounted AC outlet. Do not connect the AC adaptor to a ceiling-mounted AC outlet, as the weight of the adaptor may cause it to become disconnected.
- The unit will not work during a power failure. We recommend connecting a corded telephone to the same telephone line or to the same telephone jack using a Panasonic T-adaptor.

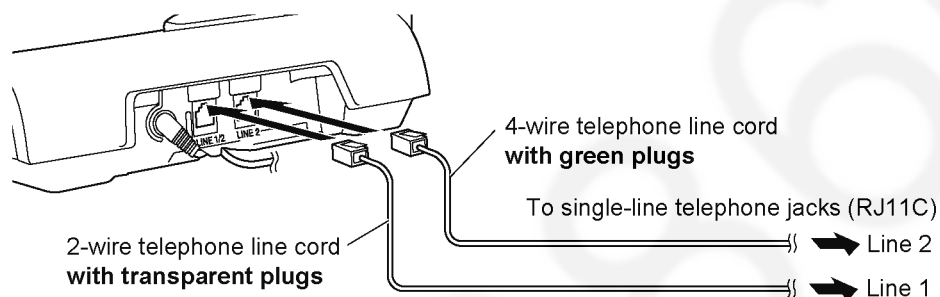
6.1.2. Connecting the Telephone Line Cord

Connect the telephone line cord until it clicks into the telephone jack.

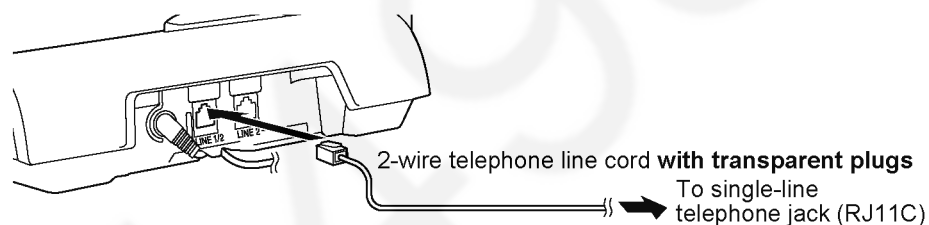
To connect to a 2-line telephone jack



To connect to 2 single-line telephone jacks



To connect to a single-line telephone jack



Note:

- Make sure you connect the telephone line cord into LINE 1/2 telephone jack.

6.1.2.1. If you subscribe to a DSL service

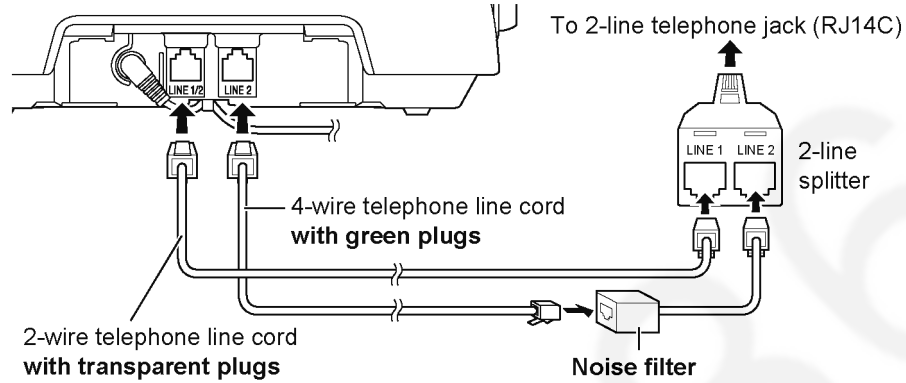
Please attach a noise filter (contact your DSL provider) to the telephone line between the base unit and the telephone line jack in the event of the following:

- Noise is heard during conversations.
- Caller ID features do not function properly.

To connect to a 2-line telephone jack

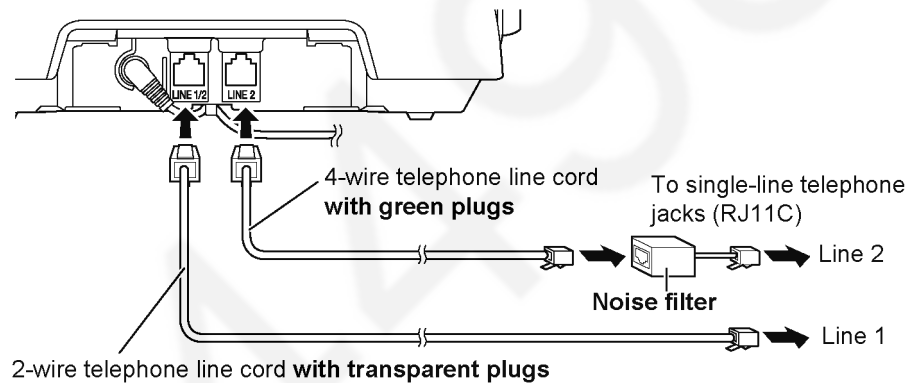
For this connection, please purchase a Panasonic 2-line splitter.

Example: DSL line is line 2



To connect to 2 single-line telephone jacks

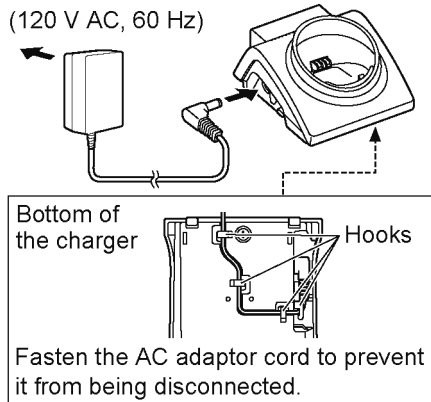
Example: DSL line is line 2



6.2. Setting Up the Handset

6.2.1. Connecting the Charger (KX-TG6702 only)

- Use only the included Panasonic AC adaptor PQLV207Z.

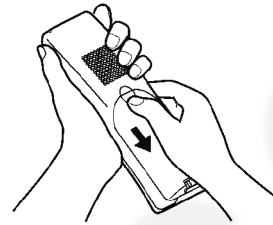


Note:

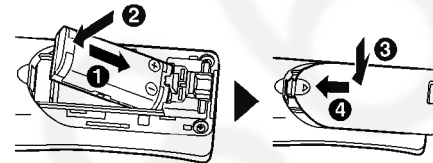
- The AC adaptor must remain connected at all times. (It is normal for the adaptor to feel warm during use.)
- The AC adaptor should be connected to a vertically oriented or floor-mounted AC outlet. Do not connect the AC adaptor to a ceiling-mounted AC outlet, as the weight of the adaptor may cause it to become disconnected.

6.3. Battery Installation/Replacement

- 1 Press the notch of the handset cover firmly, and slide it in the direction of the arrow.
 - If necessary, remove the old battery.



- 2 Insert the battery (1), and press it down until it snaps into position (2). Then close the handset cover (3, 4).



Important:

- Use only the rechargeable Panasonic battery HHR-P105.

Attention:



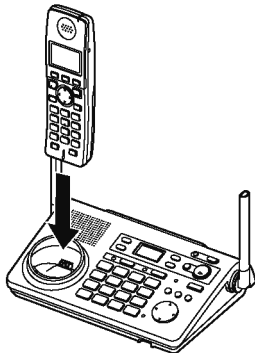
A nickel metal hydride battery that is recyclable powers the product you have purchased.

Please call 1-800-8-BATTERY (1-800-822-8837) for information on how to recycle this battery.

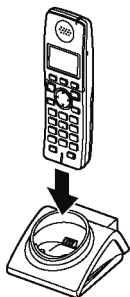
6.4. Battery Charge

Place the handset on the base unit or charger for **7 hours** before initial use. While charging, the charge indicator on the handset lights in amber. When the battery is fully charged, "**Charge completed**" is displayed.

Base unit



Charger (KX-TG6702 only)



Note:

- If you want to use the handset immediately, charge the battery for at least 15 minutes.
- To ensure that the battery charges properly, clean the charge contacts of the handset, base unit, and charger with a soft, dry cloth once a month. Clean more often if the unit is subject to the exposure of grease, dust, or high humidity.

Note for service:

The battery strength may not be indicated correctly if the battery is disconnected and connected again, even after it is fully charged. In that case, by recharging the battery as mentioned above, you will get a correct indication of the battery strength.

6.4.1. Battery Level

Battery icon	Battery level
	Fully charged
	Medium
	Low Flashing: needs to be recharged.
	Empty

Note:

- When the battery needs to be charged, the handset beeps intermittently during use.

6.4.2. Panasonic Battery Performance

Operation	Operating time
While in use (talking)	Up to 5 hours
While not in use (standby)	Up to 7 days
While using the clarity booster feature	Up to 3 hours

Note:

- Battery operating time may be shortened over time depending on usage conditions and surrounding temperature.
- Battery power is consumed whenever the handset is off the base unit or charger, even when the handset is not in use. Hence the longer you leave the handset off the base unit or charger, the less time you may actually talk using the handset.
- After the handset is fully charged, displaying "**Charge completed**", it may be left on the base unit or charger without any ill effect on the battery.
- The battery level may not be displayed correctly after you replace the battery. In this case, place the handset on the base unit or charger and let charge for 7 hours.

7 Operation Instructions

7.1. Symbols Used in These Operating Instructions

Symbol	Meaning
[] : button name/soft key name Example: Unit keys: [↶] , [OFF] Soft keys: [CID] , [📖]	The words in the brackets indicate button names/soft key names on the handset and base unit.
→	Proceed to the next operation.
Example: "Ringer tone"	The words in quotations indicate the menu on the display.
Example: 1 [MENU] → [0][2] 2 Select the desired setting. 3 [SAVE] → [OFF]	1 Press [MENU] , then press [0] , [2] . 2 Press [▲] or [▼] to select the desired setting. 3 Press [SAVE] , then press [OFF] .
Handset: [▲] [▼] [◀] [▶]	Press up, down, left, or right on the handset navigator key.
Base unit: [▲] [▼] [◀◀] [▶▶]	Press up, down, left, or right on the base unit navigator key.

7.2. Programmable Settings

You can customize the unit by programming the following features using the handset.
To access the features, there are 2 methods:

- scrolling through the display menus
- using the direct commands
- The direct command method is mainly used in this Service Manual.

7.2.1. Programming by Scrolling through the Display Menus

1 [MENU]

2 Press [▲] or [▼] to select the desired menu. → [SELECT]

- If there are sub-menu(s), press [▲] or [▼] to select the desired item. → [SELECT]

Example: To access the handset ringer volume setting

Press [▲] or [▼] to select "**Ringer setting**". → [SELECT]

Then press [▲] or [▼] to select "**Ringer volume**". → [SELECT]

3 Press [▲] or [▼] to select desired line.

- This step may not be necessary depending on the feature being programmed.

4 Press [▲] or [▼] to select the desired setting.

- This step may vary depending on the feature being programmed.

5 [SAVE] → [OFF]

Main menu	Sub-menu 1	Sub-menu 2
Message playback	–	–
Phonebook	–	–
Ringer setting	Ringer volume	–
	Ringer tone	–
	Interrupt tone	–
Date and time ^{*1}	–	–
Voice enhancer	–	–
Copy phonebook	Copy 1 item	–
	Copy all items	–

Main menu	Sub-menu 1	Sub-menu 2
Initial setting	Set answering	Ring count ^{*1}
		Recording time ^{*1}
		Remote code ^{*1}
		Recording mode ^{*1}
	Message alert	—
	LCD contrast	—
	Key tone	—
	Auto talk	—
	Room monitor	—
	Caller ID edit	—
	Set tel line	Line select
		Set dial mode ^{*1}
		Set flash time ^{*1}
		Set line mode ^{*1}
	Set base unit	Ringer volume ^{*1}
		Ringer tone ^{*1}
		Interrupt tone ^{*1}
		Room monitor ^{*1}
		Line select ^{*1}
	Registration	HS registration
		Deregistration
	Change language	—

^{*1} If you program these settings using one of the handsets, you do not need to program the same item using another handset.

7.2.2. Programming Using the Direct Commands

1 [MENU]

2 Enter the desired feature code.

3 Enter the desired setting code.

- This step may vary depending on the feature being programmed.

4 [SAVE] → [OFF]

Note:

- In the following table, < > indicates the default setting.
- If you make a mistake or enter the wrong code, press [OFF], then start again from step 1.

Feature	Feature code	Setting code
Auto talk ^{*2*3}	[0][3]	[1]: On [0]: <Off>
Caller ID edit (Caller ID number auto edit)	[0][4]	[1]: <On> [0]: off
Change language (Display language)	[0][8]	[1]: <English> [2]: Español
Copy phonebook (Copy 1 item)	[#][1]	—
Copy phonebook (Copy all items)	[#][2]	—
Date and time ^{*1}	[4]	—
Deregistration	[0][0][2]	—
HS registration (Handset registration)	[0][0][1]	—
Interrupt tone ^{*4} (Handset)	[1][3]	[1]: On [2]: <2> [0]: off
Interrupt tone ^{*1*4} (Base unit)	[0][*][2]	
Key tone ^{*5}	[0][2]	[1]: <On> [0]: off
LCD contrast (Display contrast)	[0][1]	[1]–[6]: Level 1–6 <3>
Line select (Handset)	[0][5][5]	[1]: Line1 [2]: Line2 [0]: <Auto>
Line select ^{*1} (Base unit)	[0][*][5]	
Message alert	[0][#]	[1]: On [0]: <Off>
Message playback	[2]	—
Phonebook	[*]	—
Recording mode ^{*1}	[0][6][4]	[1]: <Standard recording 60min> [2]: Enhanced recording 30min
Recording time ^{*1}	Line1	[1]: 1min [2]: 2min [3]: <3min> [0]: Greeting only
	Line2	
Remote code ^{*1}	[0][6][3]	Default: 11
Ring count ^{*1}	Line1	[2]–[7]: 2–7 rings <4> [0]: Toll saver
	Line2	
Ringer tone ^{*6} (Handset)	Line1	[1]–[4]: Tone 1–4 [5]–[8]: Melody 1–4 Line 1: <Tone 1> Line 2: <Tone 2>
	Line2	
Ringer tone ^{*1*6} (Base unit)	Line1	[0][*][1][1] [0][*][1][2]
	Line2	

Feature		Feature code	Setting code
Ringer volume (Handset)	Line1	[1][1][1]	[1]–[3]: Level 1–3 <3> [0]: off
	Line2	[1][1][2]	
Ringer volume ^{*1} (Base unit)	Line1	[0][*][6][1]	
	Line2	[0][*][6][2]	
Room monitor (Handset)		[0][9]	[1]: On [0]: <Off>
Room monitor ^{*1} (Base unit)		[0][*][3]	
Set dial mode ^{*1}		[0][5][1]	[1]: Pulse [2]: <Tone>
Set flash time ^{*1*7}	Line1	[0][5][2][1]	[1]: <700ms> [2]: 600ms [3]: 400ms [4]: 300ms [5]: 250ms [6]: 110ms [7]: 100ms [8]: 90ms
	Line2	[0][5][2][2]	
Set line mode ^{*1*8}	Line1	[0][5][3][1]	[1]: A [2]:
	Line2	[0][5][3][2]	
Voice enhancer		[5]	[1]: On [0]: <Off>

*1 If you program these settings using one of the handsets, you do not need to program the same item using another handset.

*2 If you set the line selection mode from “Auto” to “Line1” or “Line2”, the auto talk feature will function for that line only. If the other line receives a call, the auto talk feature does not function.

*3 If you subscribe to Caller ID service and want to view the caller’s information after lifting up the handset to answer a call, turn off this feature.

*4 This tone lets you know when you receive a call while you are on the other line, on an intercom call, or monitoring a room. If you select “On”, the tone sounds repeatedly for as long as the line rings. If you select “2”, the tone only sounds 2 times.

*5 Turn this feature off if you prefer not to hear key tones while you are dialing or pressing any keys, including confirmation tones and error tones.

*6 If you subscribe to a distinctive ring service (such as IDENT-A-RING), select a tone (tone 1 to 4). If you select a melody, you cannot distinguish lines by their ringers.

*7 The flash time depends on your telephone exchange or host PBX. Consult your PBX supplier if necessary. The setting should stay at “700ms” unless pressing **[FLASH]** fails to pick up the call waiting call.

*8 Generally, the line mode setting should not be adjusted. If **L1** or **L2** is not displayed on the handset or the LINE1 or LINE2 indicator on the base unit does not light properly when another phone connected to the same line is in use, you need to change the line mode to “A”.

7.3. Error Messages

If the unit detects a problem, one of the following messages is shown on the display.

Display message	Cause/solution
Busy	• The called handset or base unit is in use. • Other users are using the line(s). Wait until the line status icon goes out. • Privacy mode is on for the call you tried to join. • The handset you tried to copy phonebook items to is in use. • The handset you are calling is too far from the base unit.
Denied	• The room monitor feature is turned off on the destination handset or base unit and the room cannot be monitored.
Error!!	• The handset's registration has failed. Move the handset and base unit away from all electrical appliances and try again. • Another handset user tried to send phonebook items to you but there was an error. Have the other user re-send the items to you.
Error!! All handsets registered. Maximum is 8.	• 8 handsets have already been registered to the base unit. A previously deregistered handset number may still be retained in the base unit. To register an additional handset, erase the unnecessary handset number using the base unit: Press and hold [INTERCOM] until the IN USE indicator flashes. → Press and hold the handset's extension number ([1] – [8]) that you want to cancel/delete from the base unit until a beep sounds.
---Incomplete---	• The destination handset's phonebook memory is full. Erase unnecessary items from the destination handset's phonebook. • The destination handset is out of area. • The destination handset user may have pressed [↶] or [↷].
Invalid	• There is no handset registered to the base unit matching the extension number you entered. • You selected your own extension number.
Invalid. Please register to the base unit	• The handset is not registered to the base unit. Register the handset.
No items stored	• Your phonebook or redial list is empty.
No link to base. Move closer to base, try again.	• The handset has lost communication with the base unit. Move closer to the base unit, and try again. • Confirm that the base unit's AC adaptor is plugged in. • Raise the base unit antennas. • The handset's registration may have been canceled. Re-register the handset.
Phonebook full	• There is no space to store new items in the phonebook. Erase unnecessary items.
Please lift up and try again.	• A handset button was pressed while the handset was on the base unit or charger. Lift the handset and press the button again.
System is busy. Please try again later.	• Other units are in use and the system is busy. Try again later. • Another user is listening to messages. Try again later.

7.4. Troubleshooting

If the display shows error messages, see “**Error Messages** (P.50)” for the Cause & Solution.

General use

Problem	Cause/solution
The unit does not work.	• Make sure the battery is installed correctly and fully charged. • Check the connections. • Unplug the base unit's AC adaptor to reset the unit. Reconnect the adaptor and try again. • The handset has not been registered to the base unit. Register the handset.
I cannot hear a dial tone.	• Confirm the telephone line cord is properly connected. • Disconnect the unit from the telephone line and connect a known working telephone. If the working telephone operates properly, contact our service personnel to have the unit repaired. If the working telephone does not operate properly, contact your telephone service provider.

Programmable settings

Problem	Cause/solution
I cannot program items.	• While another user is listening to messages, or the answering system is answering a call, you cannot program items. Try again later.
While programming, the handset starts to ring.	• A call is being received. Answer the call and start again after hanging up.

Battery recharge

Problem	Cause/solution
I fully charged the battery, but  continues to flash, or  is displayed.	• Clean the charge contacts and charge again. • The battery may need to be replaced with a new one.
The handset display is blank.	• Confirm that the battery is properly installed. • Fully charge the battery.

Making/answering calls, intercom

Problem	Cause/solution
Static is heard, sound cuts in and out. Interference from other electrical units.	• Move the handset and base unit away from other electrical appliances. • Move closer to the base unit. • Raise the base unit antennas. • Turn on the clarity booster feature. • If your unit is connected to a telephone line with DSL service, we recommend connecting a noise filter between the base unit and the telephone line jack. Contact your DSL provider for details.
The handset and base unit do not ring.	• The ringer volume is turned off. Adjust it.
I cannot make a call.	• The dialing mode may be set incorrectly. Change the setting. • The base unit (including answering system) or another handset is in use. Try again later.
I cannot redial by pressing [REDIAL] .	• If the last number dialed was more than 48 digits long, the number will not be redialed correctly. Dial the number manually.
I cannot have a conversation using the headset.	• Make sure that an optional headset is connected properly. • If "SP-phone" is displayed on the handset, press [↶] to switch to the handset.
I cannot make long distance calls.	• Make sure that you have long distance service.
I cannot page the handset or base unit.	• The called handset is too far from the base unit. • The called unit is in use. Try again later.
I cannot turn the clarity booster on.	• Another handset is already using this feature.

Caller ID

Problem	Cause/solution
The handset does not display the caller's name and/or phone number.	• You have not subscribed to Caller ID service. Contact your telephone service provider to subscribe. • If your base unit is connected to any additional telephone equipment such as a Caller ID box or cordless telephone jack, disconnect the base unit from the equipment and plug the base unit directly into the wall jack. • If your base unit is connected to a telephone line with DSL service, we recommend connecting a noise filter between the base unit and the telephone line jack. Contact your DSL provider for details. • The name display service may not be available in some areas. Contact your telephone service provider for details. • Other telephone equipment may be interfering with this unit. Disconnect the other equipment and try again. • The caller requested not to send caller information. • If a call is being transferred to you, the caller information is not displayed. • Generally, caller information is displayed from the 2nd ring.
The caller list/incoming phone numbers are not edited automatically.	• The Caller ID number auto edit feature is turned off. Turn it on and try again. • You need to call back the edited number to activate Caller ID number auto edit.
I cannot dial the phone number edited in the caller list.	• The phone number you dialed might have an incorrectly edited pattern (for example, the long distance "1" or the area code is missing). Edit the phone number with another pattern.
The 2nd caller's information is not displayed during an outside call.	• In order to use Caller ID, Call Waiting, or Call Waiting Caller ID (CWID), you must first contact your telephone service provider and subscribe to the desired service. After subscribing, you may need to contact your telephone service provider again to activate this specific service, even if you already subscribed to both Caller ID and Call Waiting with Caller ID services (CWID).

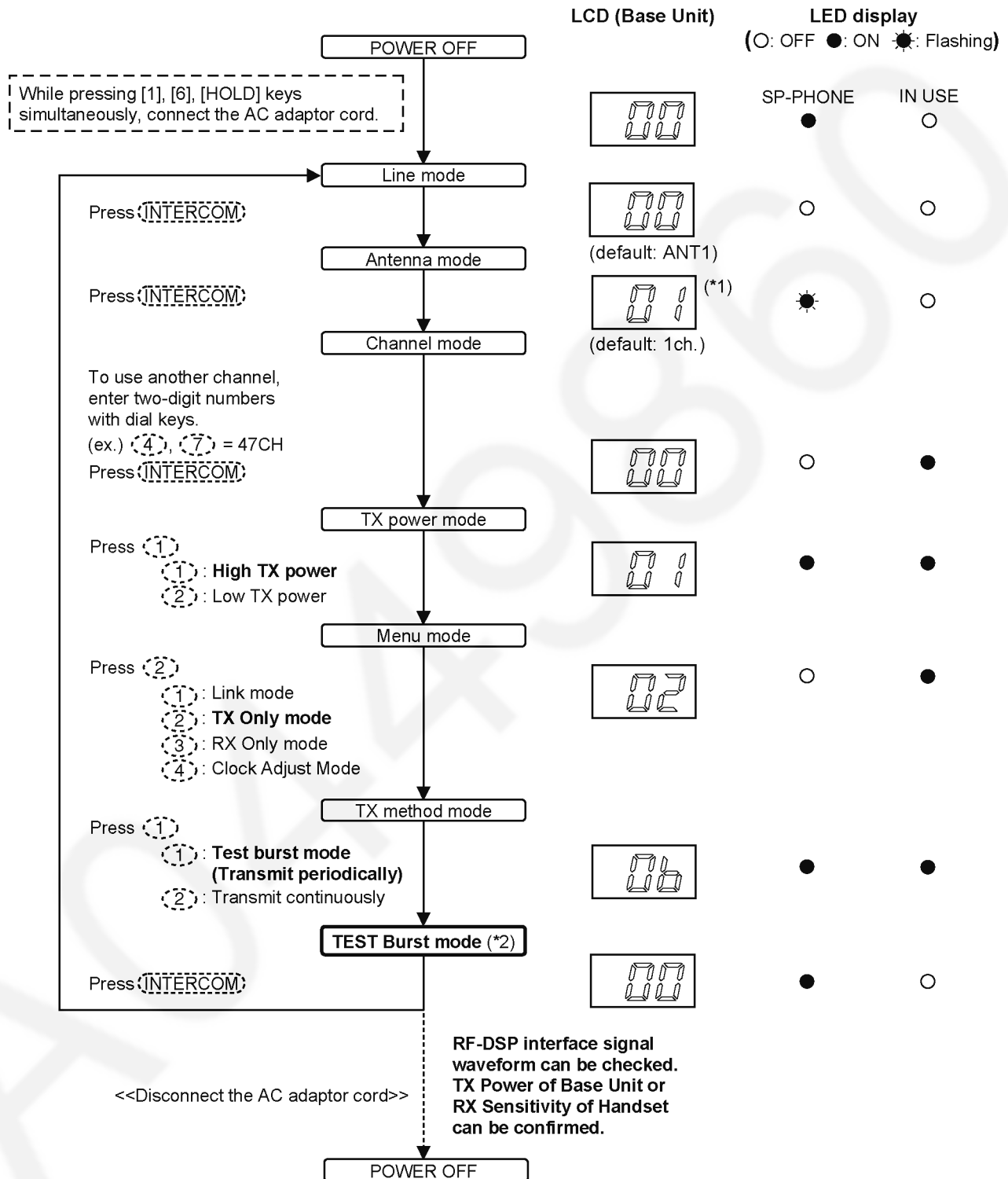
Answering system

Problem	Cause/solution
I cannot listen to messages from a remote location.	• A touch tone phone is required for remote operation. • Enter the remote code correctly. • The answering system is off. Turn it on.
The unit does not record new messages.	• The answering system is not turned on for the line you wish to record messages from. Select the desired line or both lines by pressing [LINE SELECT] repeatedly, then turn the answering system on. • The recording time is set to "Greeting only". Select a different setting. • The message memory is full. Erase unnecessary messages. • The answering system is activated for both lines, and the 1st caller is leaving a voice message. The 2nd caller cannot leave a message, but the caller information will be stored. • If you subscribe to the Voice Mail service, messages are recorded by the telephone service provider not your telephone.
I cannot operate the answering system.	• Someone is operating the answering system. • If someone is talking on a conference call, you cannot operate the answering system. Try again later.
The message indicator on the handset slowly flashes in amber.	• New messages have been recorded. Listen to the new messages.

8 Test Mode

8.1. Adjustment and Test Mode Flow Chart

8.1.1. Test Burst Mode for Base Unit

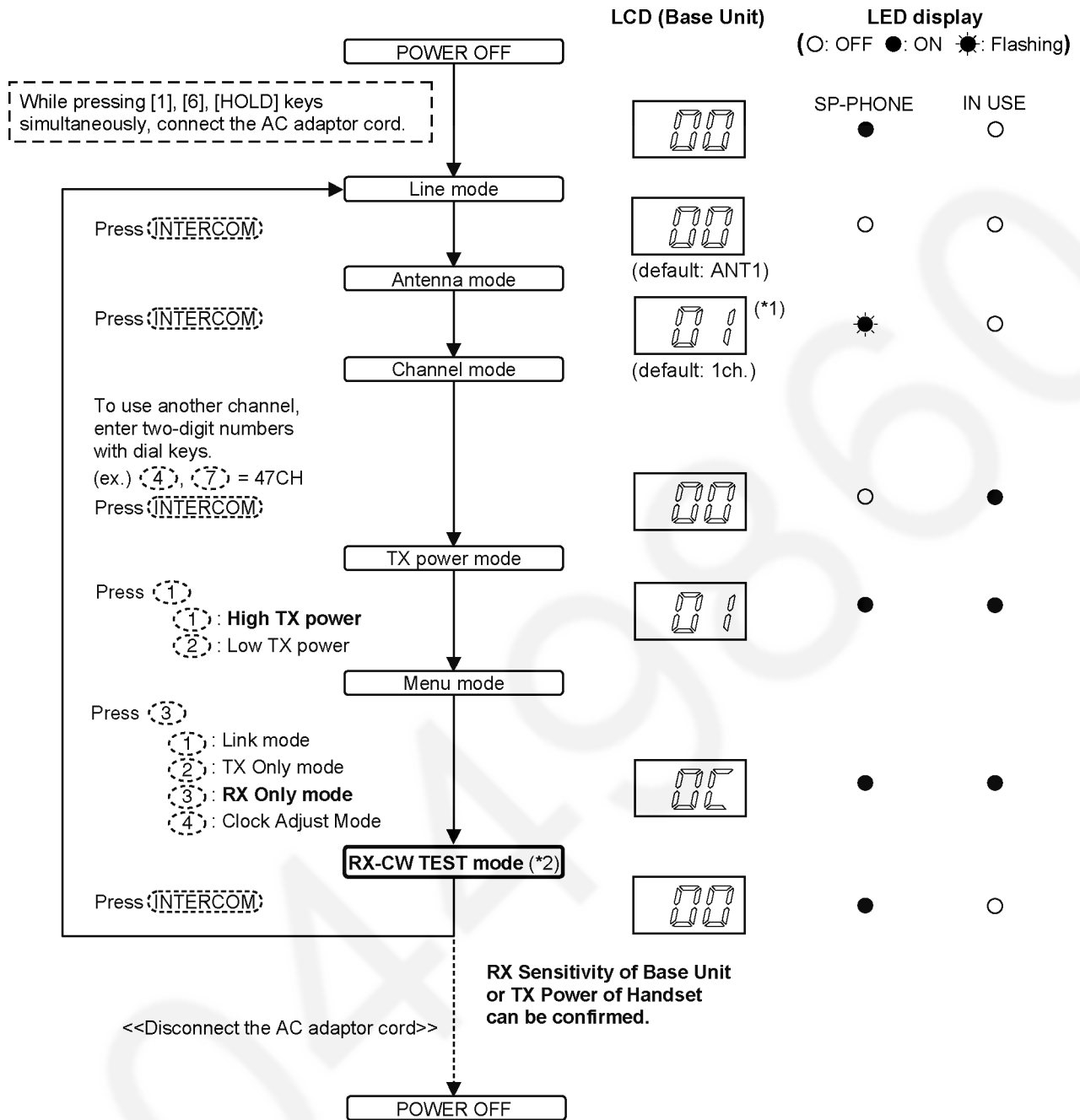


Note:

(*1) LCD displays the Channel number.

(*2) Refer to **Check Table for RF part** (P.72) and **RX-CW Test Mode for Handset** (P.60) for proper Handset settings.

8.1.2. RX-CW Test Mode for Base Unit

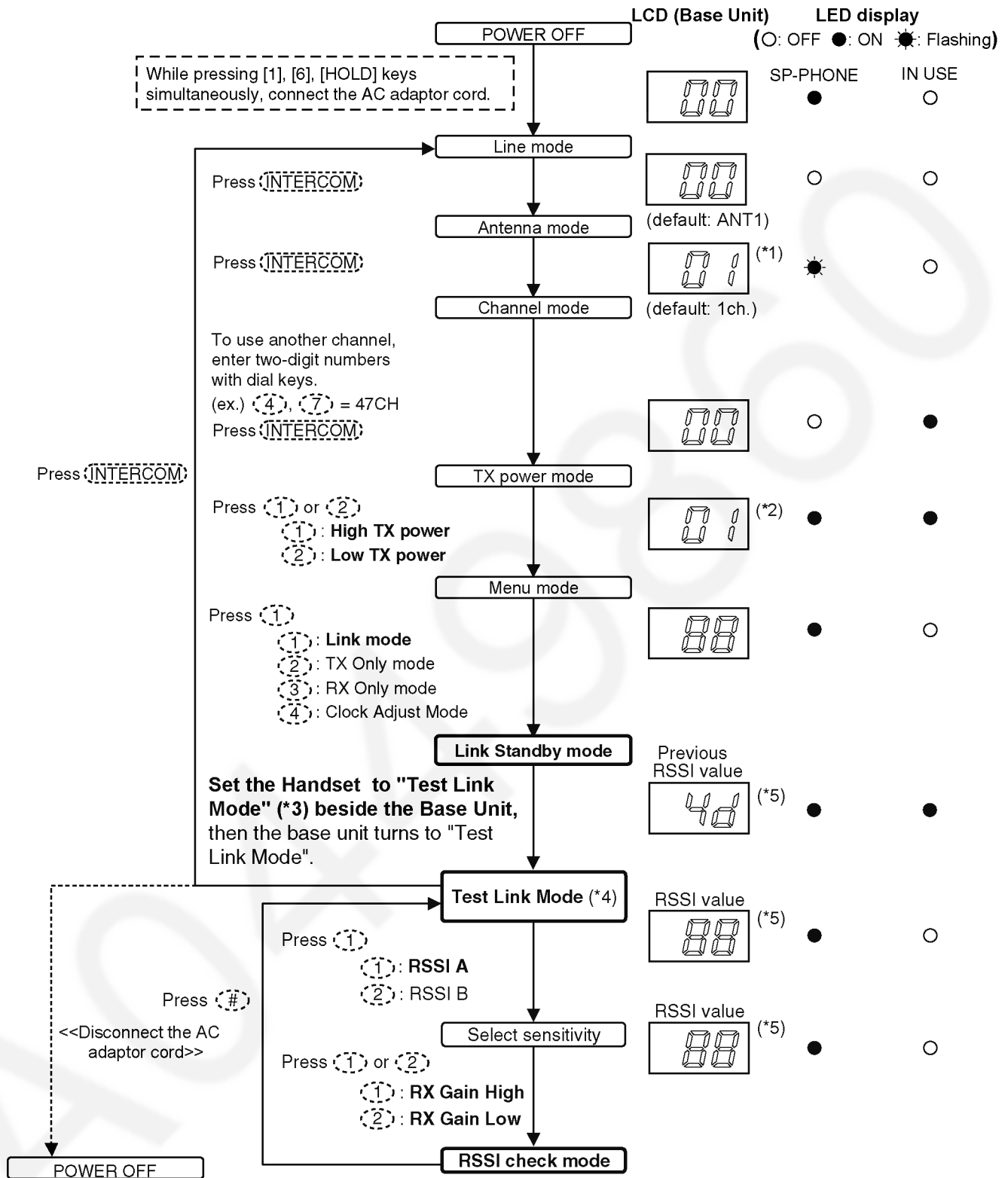


Note:

(*1) LCD displays the Channel number.

(*2) Refer to **Check Table for RF part** (P.72) and **Test Burst Mode for Handset** (P.59) for proper Handset settings.

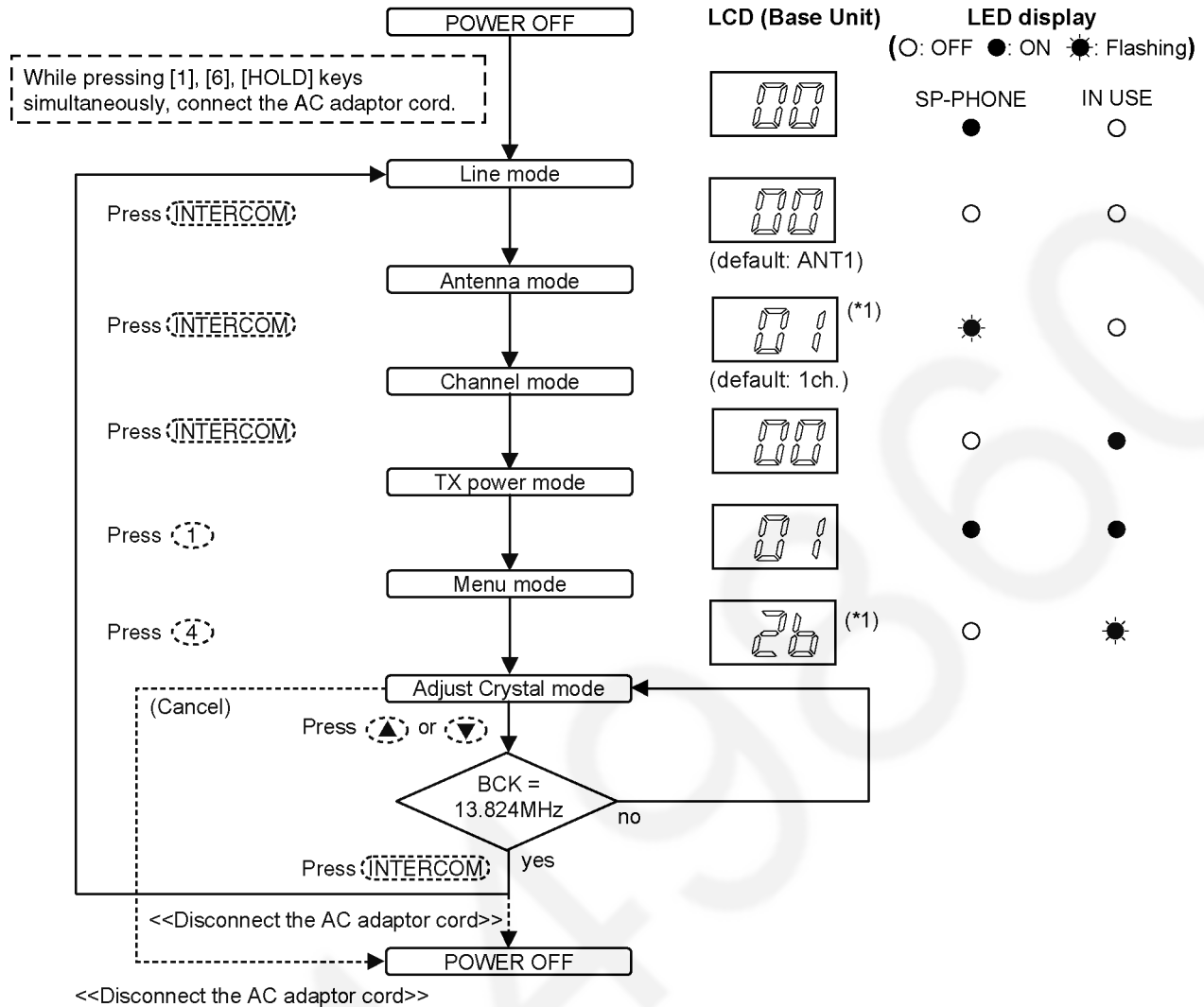
8.1.3. Test Link Mode for Base Unit



Note:

- (*1) LCD displays the Channel number.
- (*2) LCD displays the number of selected power.
- (*3) Refer to **Test Link Mode for Handset** (P.61). If can not proceed to the next step, refer to **Registering a Handset** (P.70).
- (*4) Refer to **Check Table for RF part** (P.72) and **Test Burst Mode for Handset** (P.59) for proper Handset settings.
- (*5) Display may vary according to the receiving sensitivity.

8.1.4. Adjustment Mode for Base Unit



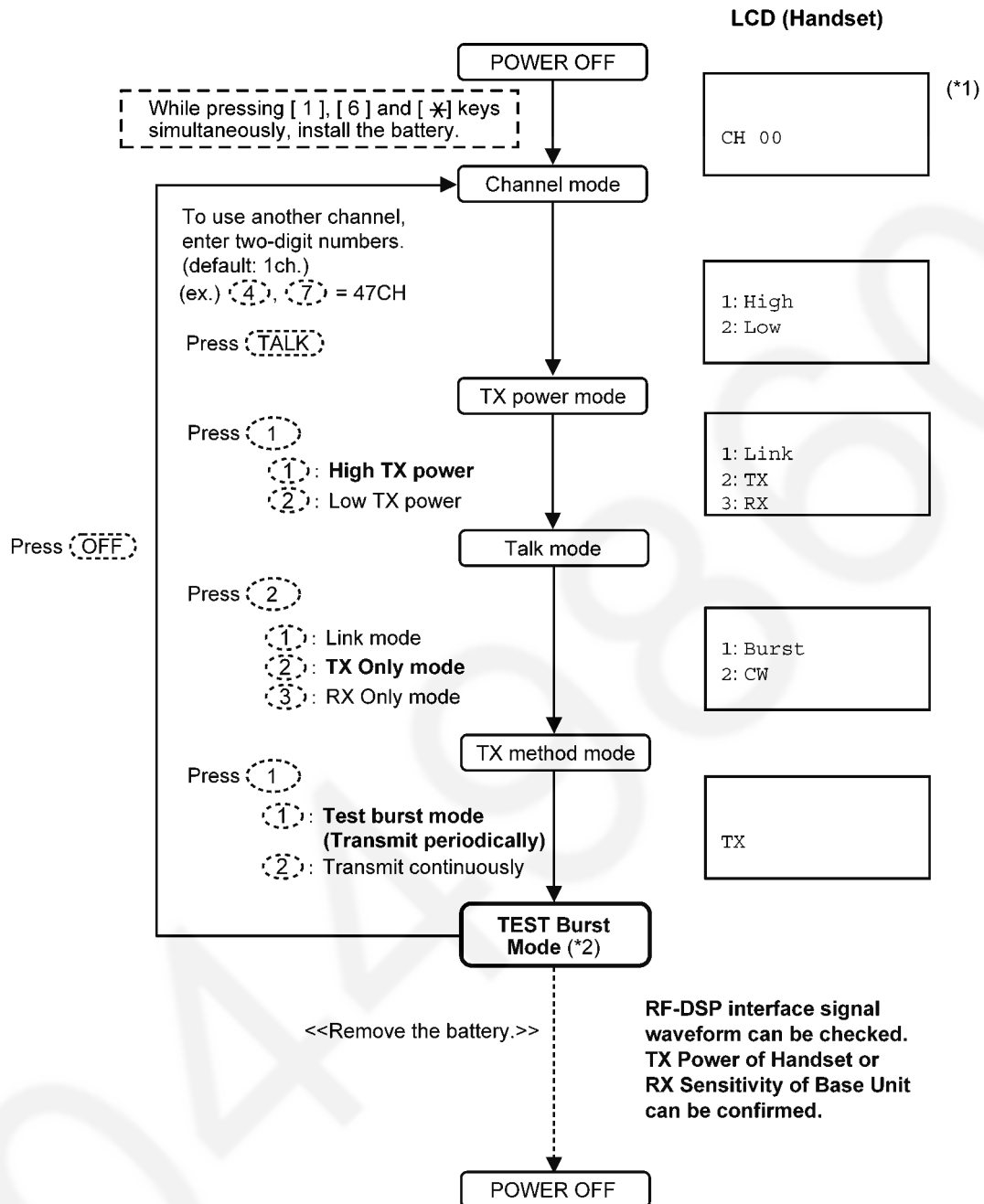
Cross Reference

Check and Adjust X501 (Base Unit) Frequency (P.85)

Note:

(*1) This is an adjustment value (hex.).

8.1.5. Test Burst Mode for Handset

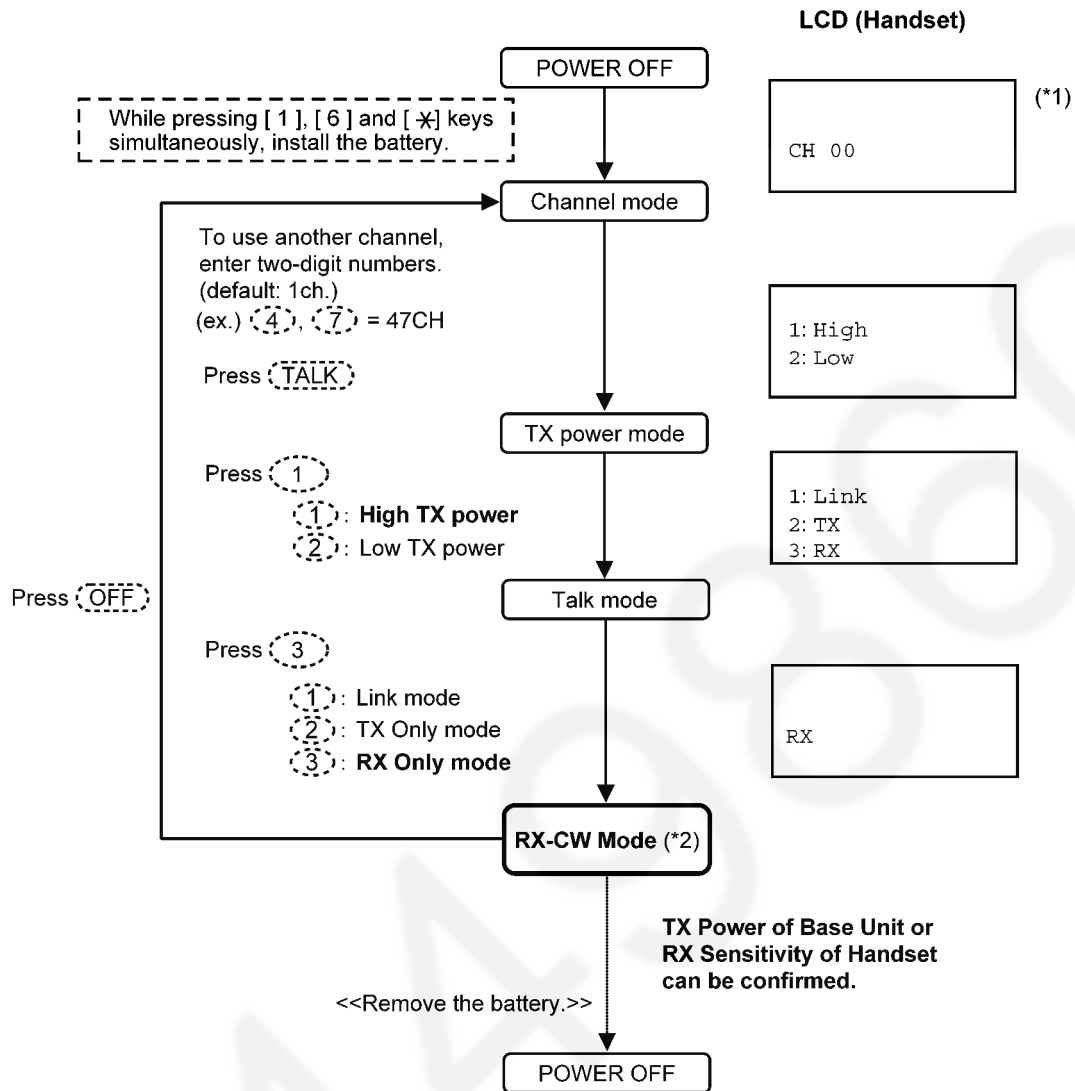


Note:

(*1) LCD displays the Channel number.
(exception: default/ CH00 = 1ch.)

(*2) Refer to **Check Table for RF part** (P.72) and **RX-CW Test Mode for Base Unit** (P.56) for proper Base Unit settings.

8.1.6. RX-CW Test Mode for Handset

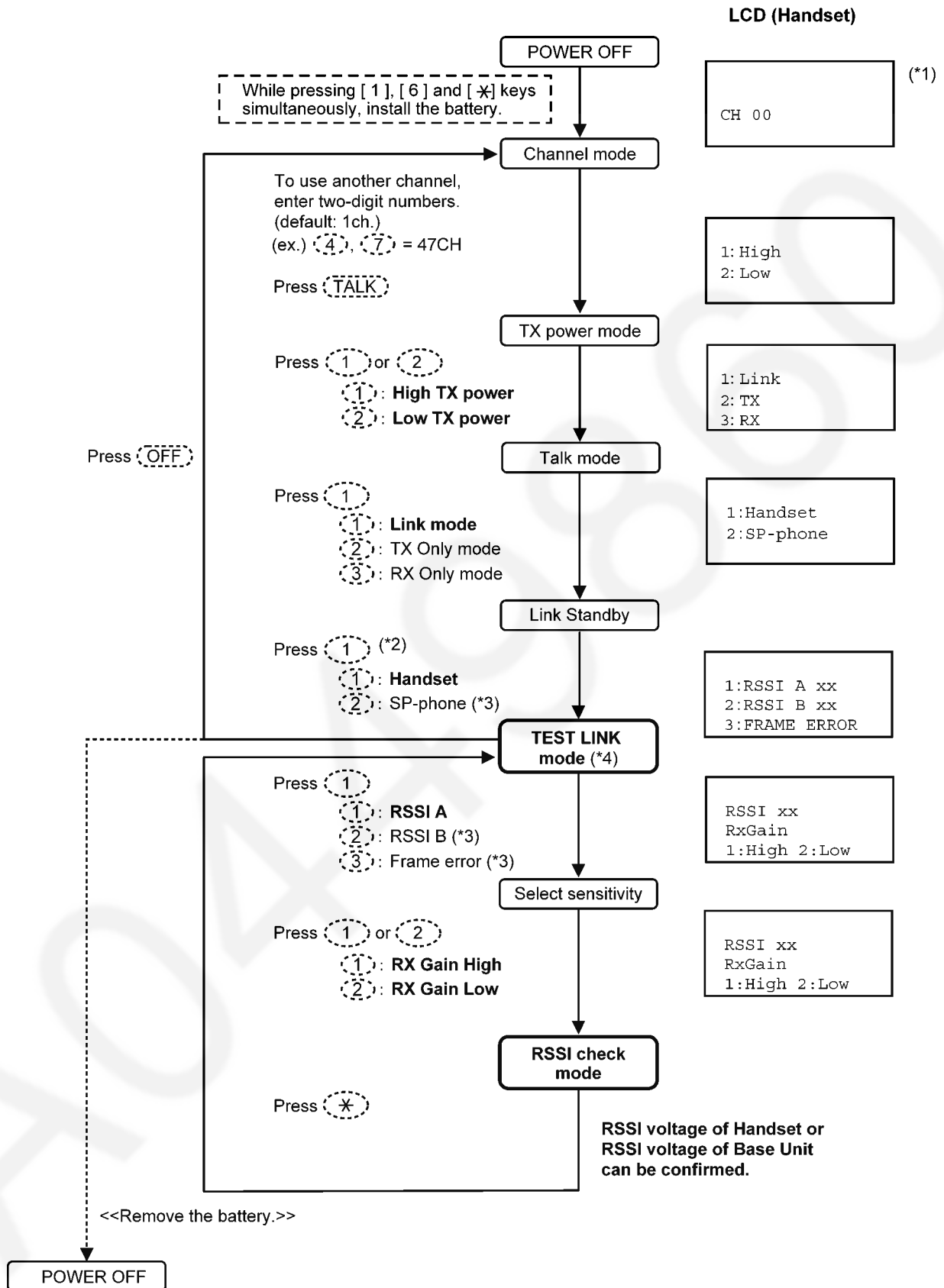


Note:

(*) LCD displays the Channel number.
(exception: default/ CH00 = 1ch.)

(*) Refer to **Check Table for RF part** (P.72) and **Test Burst Mode for Base Unit** (P.55) for proper Base Unit settings.

8.1.7. Test Link Mode for Handset



Note:

(*)1 LCD displays the Channel number.

(exception: default/ CH00 = 1ch.)

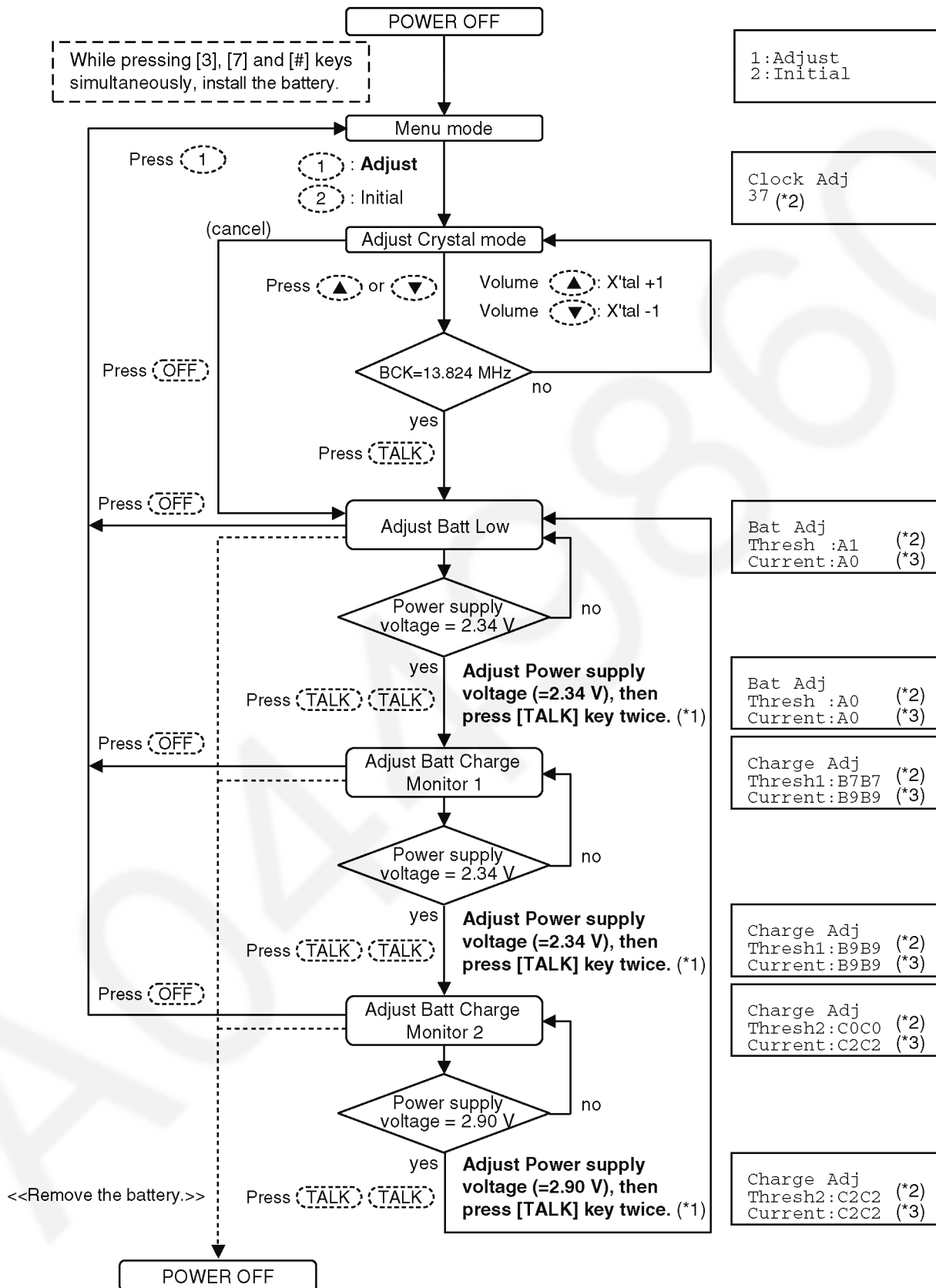
(*)2 If can not proceed to the next step, refer to **Registering a Handset** (P.70).

(*)3 for factory use only.

(*)4 Refer to **Check Table for RF part** (P.72) and **Test Link Mode for Base Unit** (P.57) for proper Base Unit settings.

8.1.8. Adjustment Mode for Handset

LCD (Handset)



Cross Reference

(*1) **Adjust Battery Low Detector Voltage (Handset) (P.85)**

Note:

(*2) These are the default values.

(*3) These values may not be fixed depending on the battery strength.

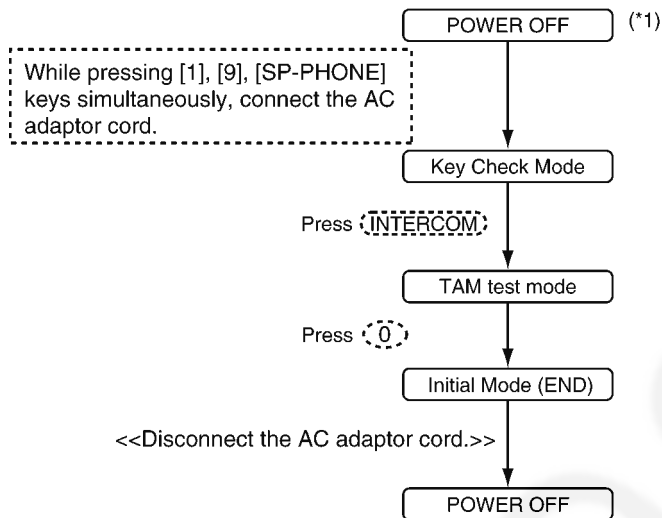
9 Service Mode

9.1. How to Clear User Setting

Units are reset to the Factory settings by this operation (Erase recorded Voice messages, stored Phone numbers, Caller list and etc.).

This operation should not be performed for a usual repair.

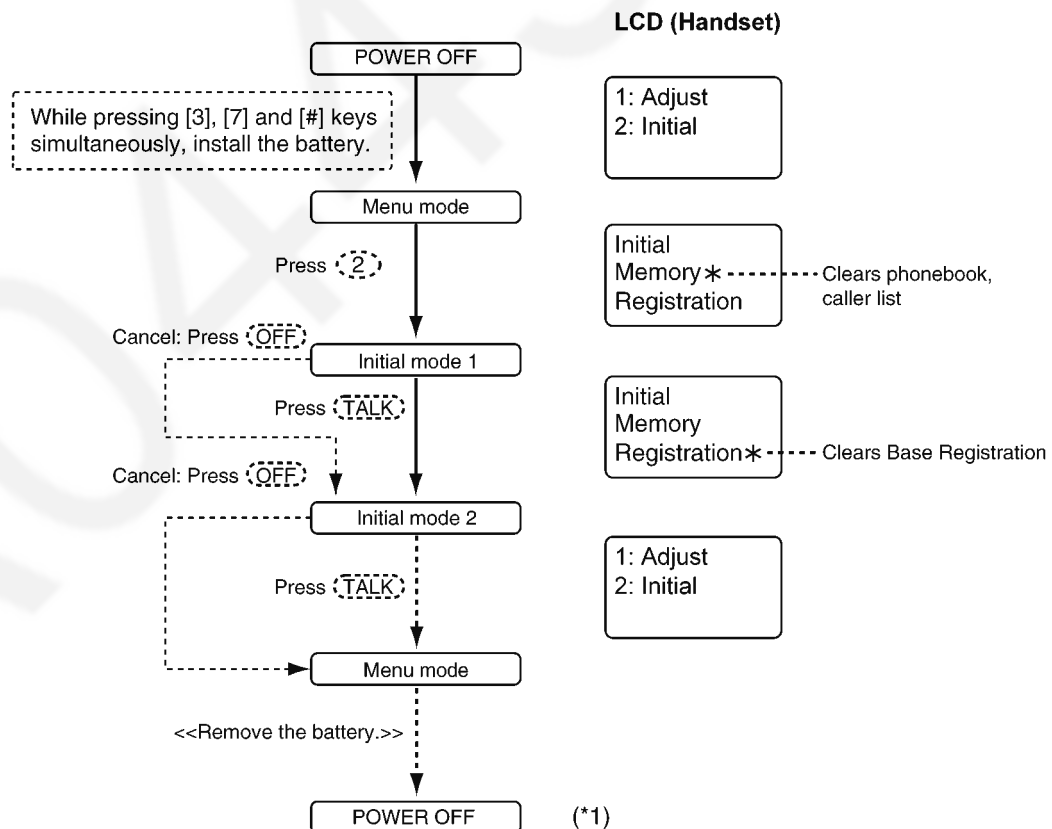
9.1.1. Base Unit



Note:

(*1) Telephone line must be connected.

9.1.2. Handset



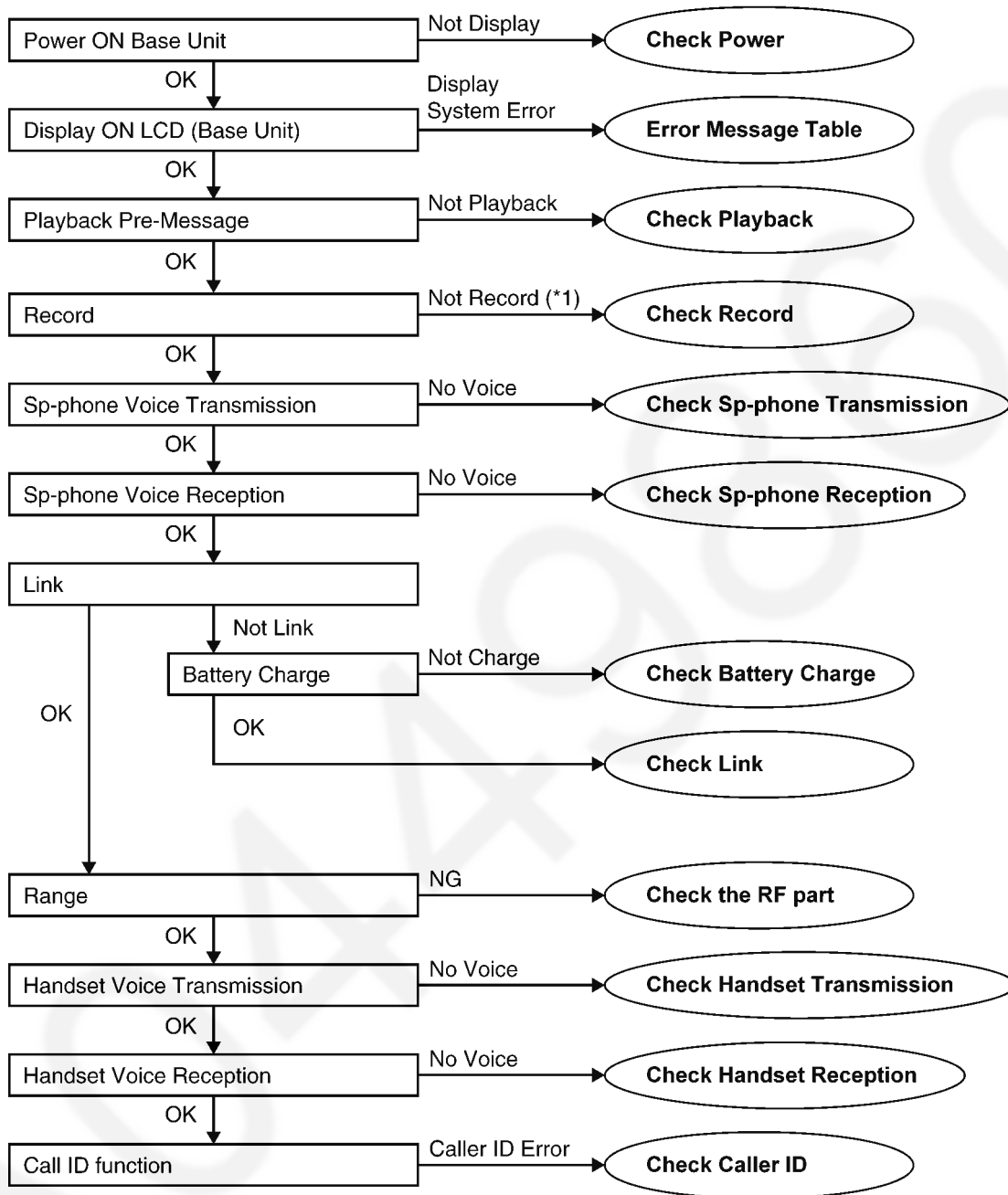
Note:

(*1) Be sure to short the battery terminals of the Handset with a lead wire, etc. for 2 seconds for discharge after removing the battery.

10 Troubleshooting Guide

10.1. Troubleshooting Flowchart

FLOW CHART



Cross Reference:

Check Power (P.65)
Error Message Table (P.65)
Check Playback (P.67)
Check Record (P.66)
Check Sp-phone Transmission (P.67)
Check Sp-phone Reception (P.67)
Check Battery Charge (P.68)
Check Link (P.69)
Check the RF part (P.70)
Check Handset Transmission (P.76)
Check Handset Reception (P.76)
Check Caller ID (P.76)

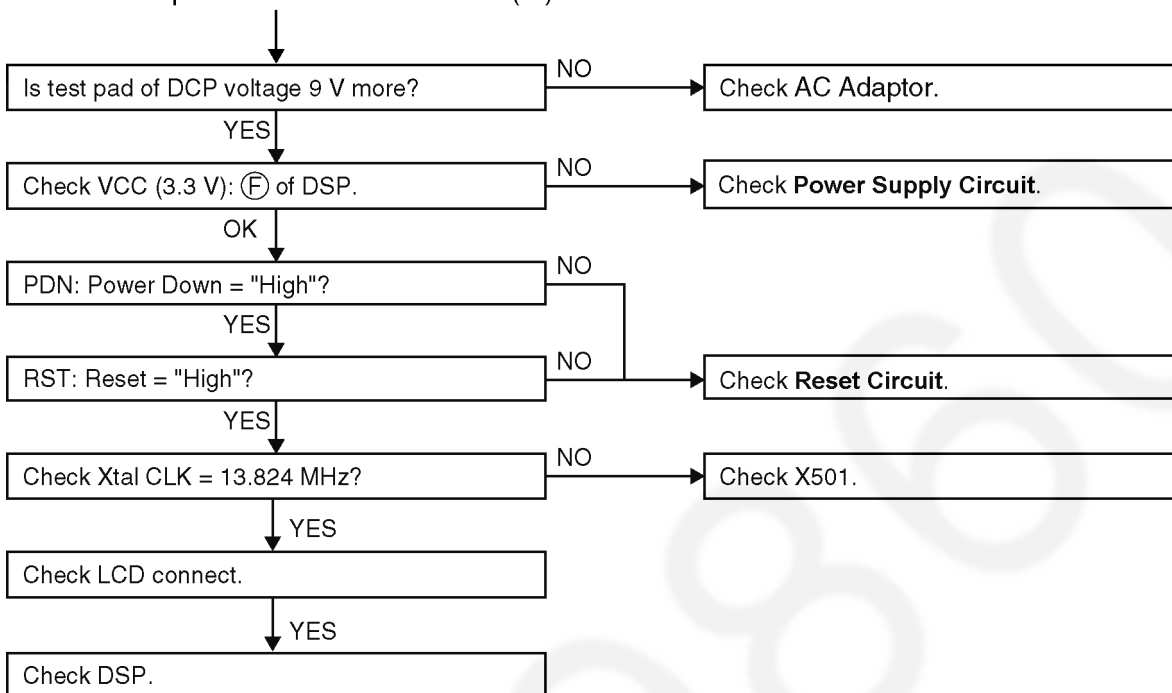
Note:

(*1) When a user claims that the unit disconnects a call right after the greeting message and no incoming messages can be recorded, this symptom can not be reappeared with TEL simulator in the service center. So in that case try **Check Record** (P.66) item (C), (D).

10.1.1. Check Power

BASE UNIT

Is the AC Adaptor inserted into AC outlet? (*1)



Cross Reference:

Power Supply Circuit (P.14)

Reset Circuit (P.16)

Note:

Flash Memory is IC601.

DSP is IC501.

(*1) Refer to **Specifications** (P.6) for part number and supply voltage of AC adaptor.

10.1.2. Error Message Table

Display	Symptom	Remedy
E1	The initialization was tried, but it could not be done.	1. Check the peripheral circuit of Flash Memory visually. 2. Confirm that the voltage is added to the power supply pin. If no voltage is detected, replace the Flash Memory because it might be defect. 3. Solder the Flash Memory again.
E3	When the adjustment data was checked, an error was detected. (The adjustment data may not be written.)	
E9		

Note:

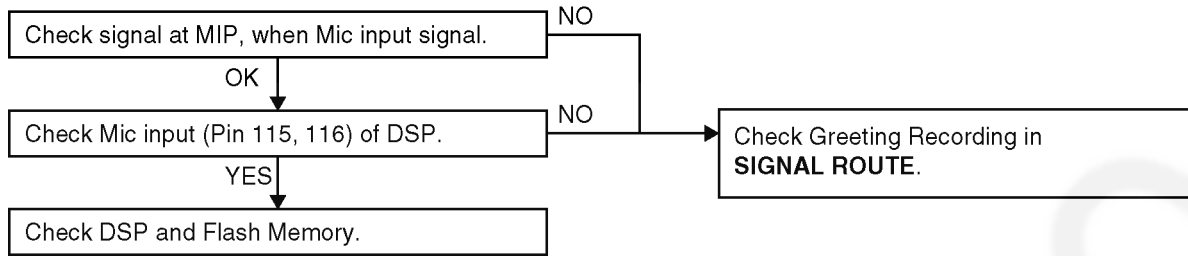
Flash Memory is IC601.

DSP is IC501.

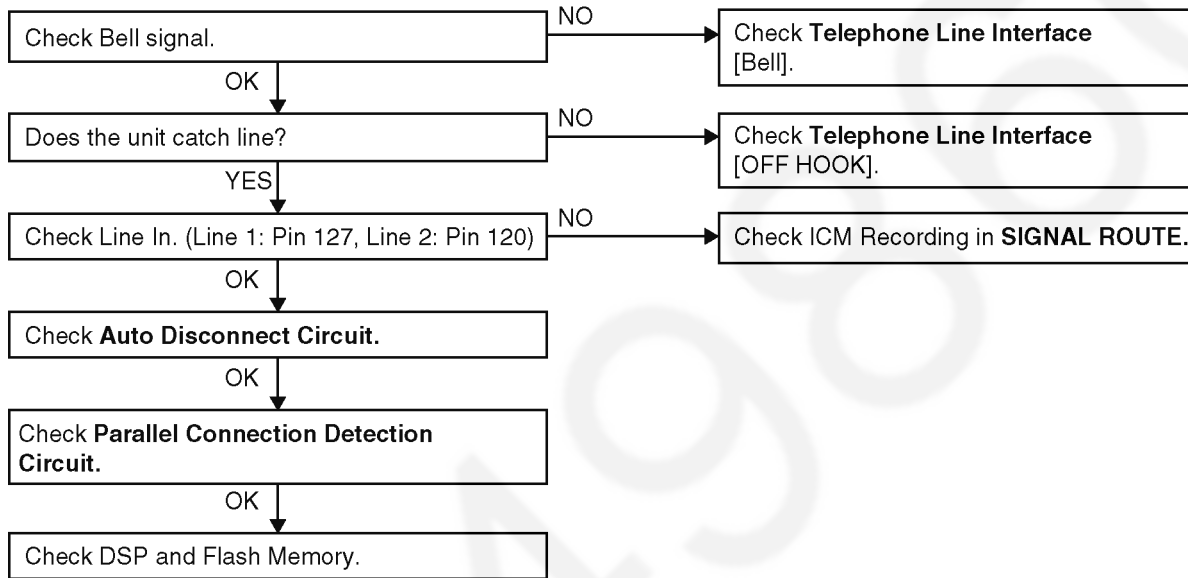
10.1.3. Check Record

BASE UNIT

A) Not record Greeting Message



B) Not record Incoming Message



C) How to change the Auto Disconnect activation (time)

Some Telephone Company lines (fiber or cable) ON Hook and OFF Hook voltages are lower than conventional lines, which may cause a malfunction of Auto Disconnect detection. To solve this problem, try changing the Auto Disconnect activation through the procedures below.

Auto Disconnect detect	CPC detect	PROCEDURE at Stand-by mode
Enable*1		"STOP"+"INTERCOM"+"ERASE" simultaneously
Enable*1 [default]	Disable	"STOP"+"INTERCOM"+"MEMO" simultaneously
Disable*2		"STOP"+"INTERCOM"+"ANSWER ON" simultaneously

Note:

*1 Both Auto Disconnect and CPC don't detect for the first 2 seconds.

*2 If the "Disable" is selected, even if the parallel-connected telephone is OFF HOOK, the line isn't disconnected.

D) How to change the VOX level

It makes easier to detect a small voice (caller) by raising the sensitivity of VOX level. Therefore, the recording of TAM is not turned off during a detection.

VOX Level sensitivity	PROCEDURE
Normal [default]	"STOP"+"VOL. [▼]"+"MEMO" simultaneously
10 dB Up	"STOP"+"VOL. [▼]"+"ANSWER ON" simultaneously

Cross Reference:

Signal Route (P.36)

Telephone Line Interface (P.17)

Auto Disconnect Circuit (P.19)

Parallel Connection Detect Circuit (P.21)

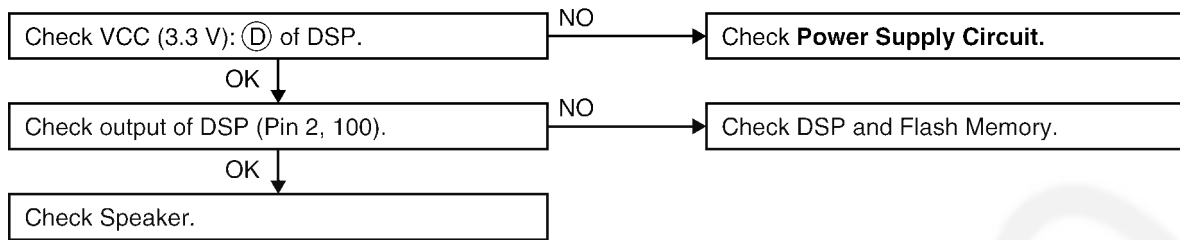
Note:

Flash Memory is IC601.

DSP is IC501.

10.1.4. Check Playback

BASE UNIT

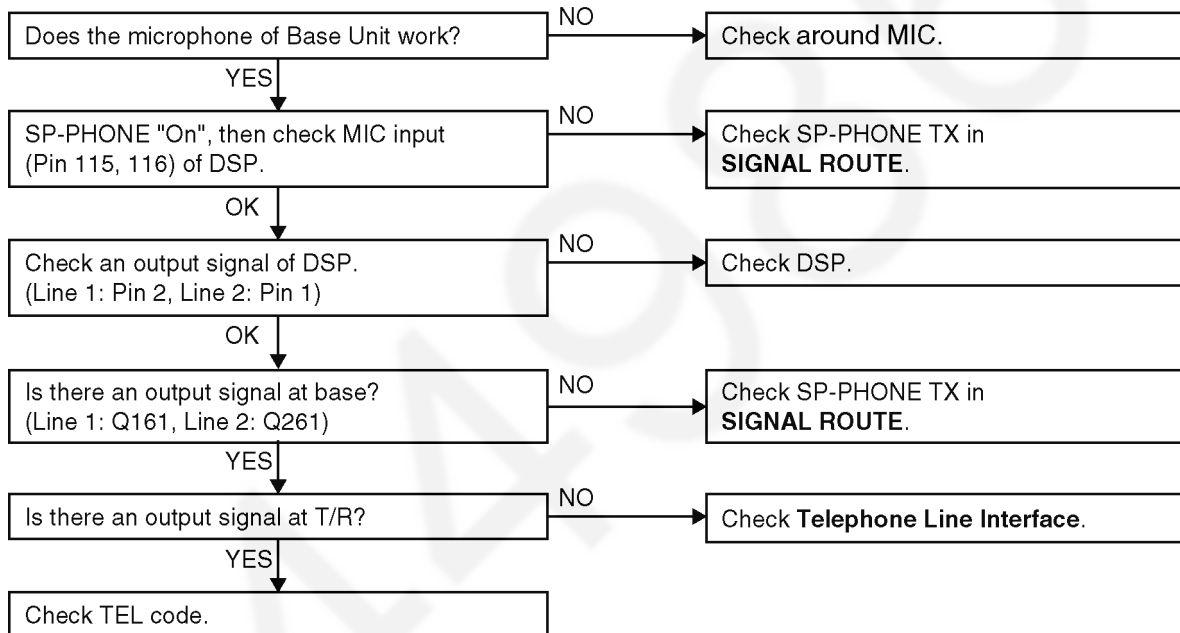


Cross Reference:
Power Supply Circuit (P.14)

Note:
Flash Memory is IC601.
DSP is IC501.

10.1.5. Check Sp-phone Transmission

BASE UNIT

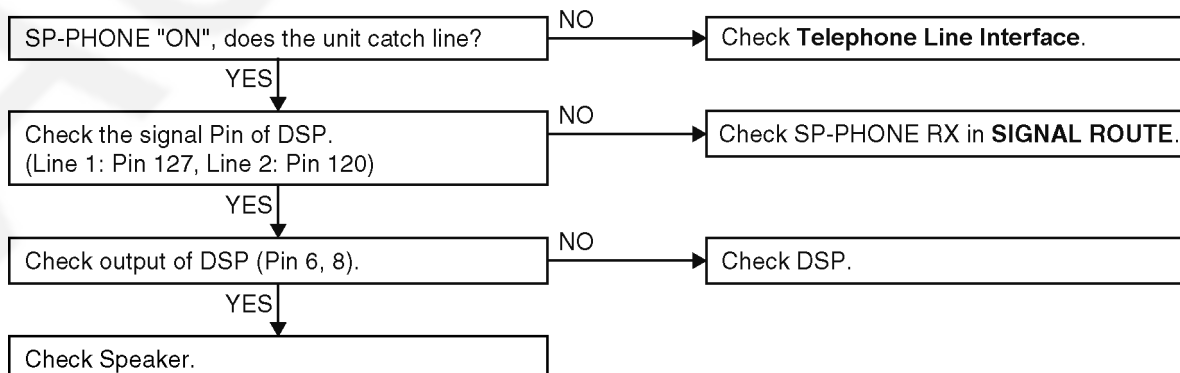


Cross Reference:
Signal Route (P.36)
Telephone Line Interface (P.17)

Note:
Flash Memory is IC601.
DSP is IC501.

10.1.6. Check Sp-phone Reception

BASE UNIT

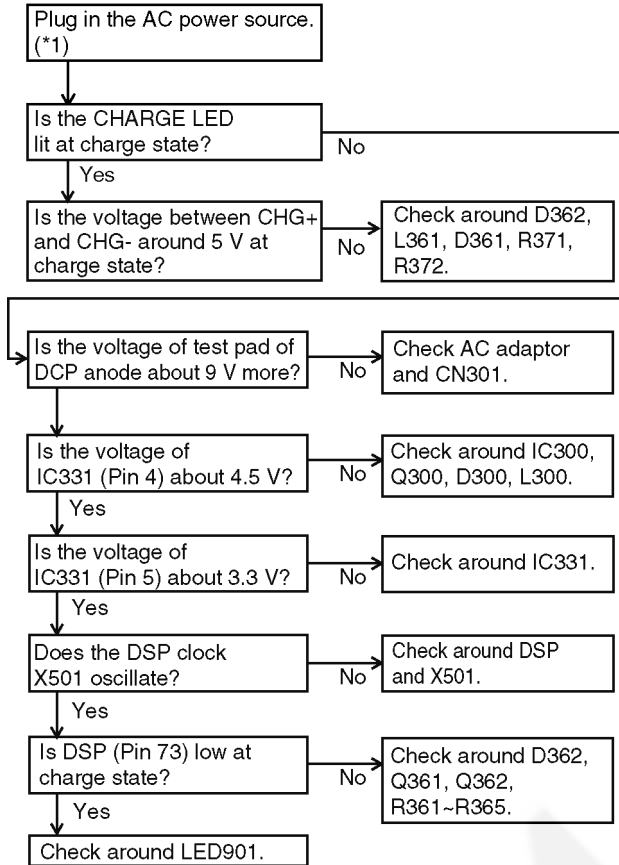


Cross Reference:
Telephone Line Interface (P.17)
Signal Route (P.36)

Note:
Flash Memory is IC601.
DSP is IC501.

10.1.7. Check Battery Charge

BASE UNIT



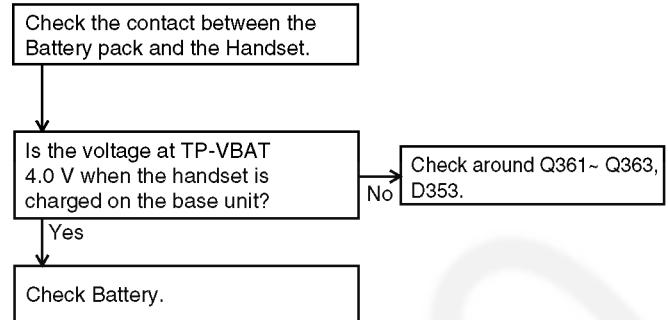
Note:

Flash Memory is IC601.

DSP is IC501.

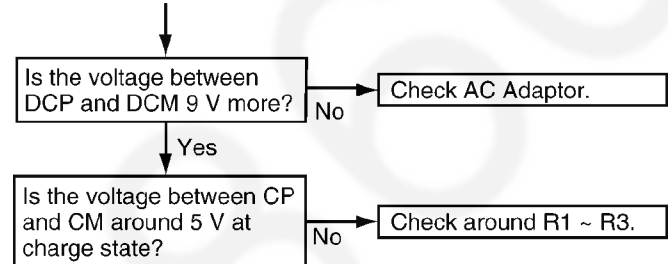
(*1) Refer to **Specifications** (P.6) for part number and supply voltage of AC adaptor.

HANDSET



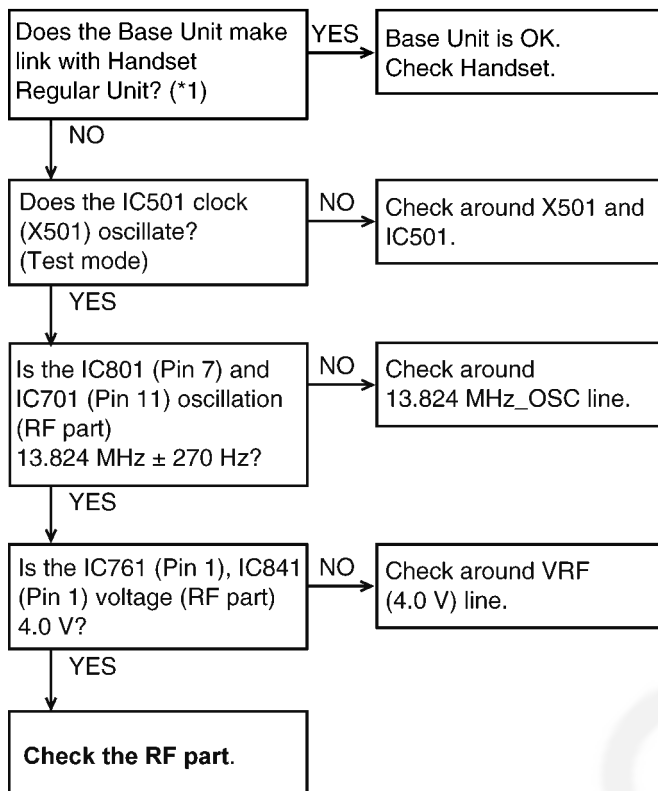
CHARGER UNIT

Is the AC Adaptor inserted into AC outlet? (*1)



10.1.8. Check Link

BASE UNIT



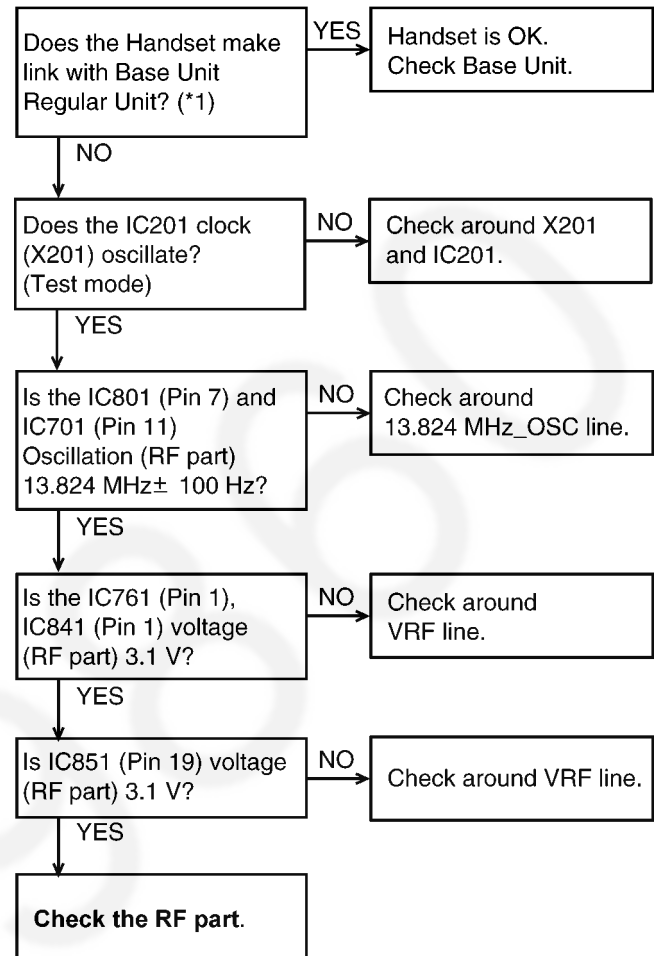
Note:

Flash Memory is IC601.

DSP is IC501.

(*1) Refer to **Finding out the Defective part** (P.70).

HANDSET



Cross Reference:

Check the RF part (P.70)

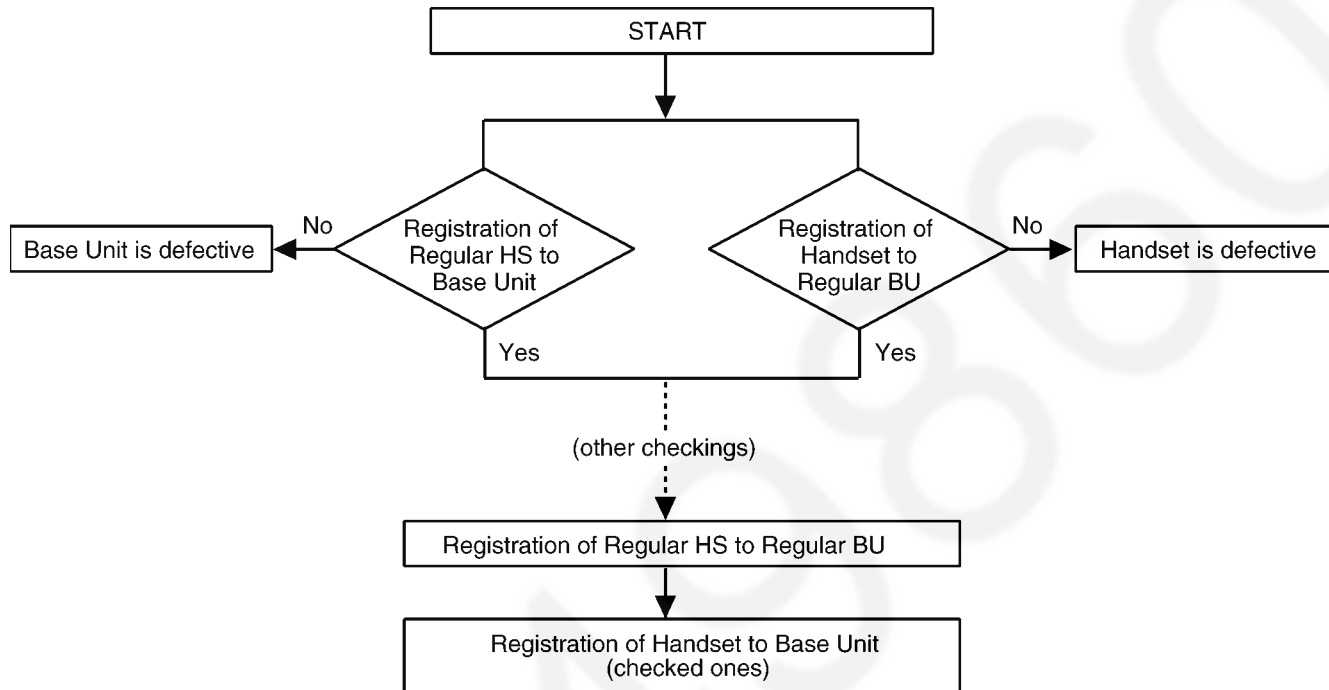
10.1.9. Check the RF part

10.1.9.1. Finding out the Defective part

1. Prepare Regular HS(*1) and Regular BU(*2).
2. a. Re-register regular HS (Normal mode) to Base Unit (to be checked).
If this operation fails in some ways, the Base Unit is defective.
- b. Re-register Handset (to be checked) to regular BU (Normal mode).
If this operation fails in some ways, the Handset is defective.

After All the Checkings or Repairing

1. Re-register the checked Handset to the checked Base Unit, and Regular HS to Regular BU.



Note:

- (*1) HS: Handset
- (*2) BU: Base Unit

10.1.9.1.1. Registering a Handset

The included handset and base unit are preregistered. If for some reason the handset is not registered to the base unit, register the handset.

Important:

- If you have already deregistered the handset, perform steps 2 and 3 only.

1 Handset:

[MENU] → [0][0][1]

2 Base unit:

Press and hold [INTERCOM] until the IN USE indicator flashes.

- After the IN USE indicator starts flashing, the rest of the procedure must be completed within 1 minute.

3 Handset:

Press [OK], then wait until a beep sounds.

4 [OFF]

If you have not canceled the handset's registration at the previous base unit, the handset number remains in that base unit's memory. To erase the handset number from the previous base unit, follow the next procedure.

- (1) Press and hold [INTERCOM/TRANSFER] for 3 seconds.
- (2) Press and hold the handset number [1] to [8] that you do not want for 5 seconds.
A long beep sounds, then the handset number is erased.

10.1.9.1.2. Deregistering a Handset

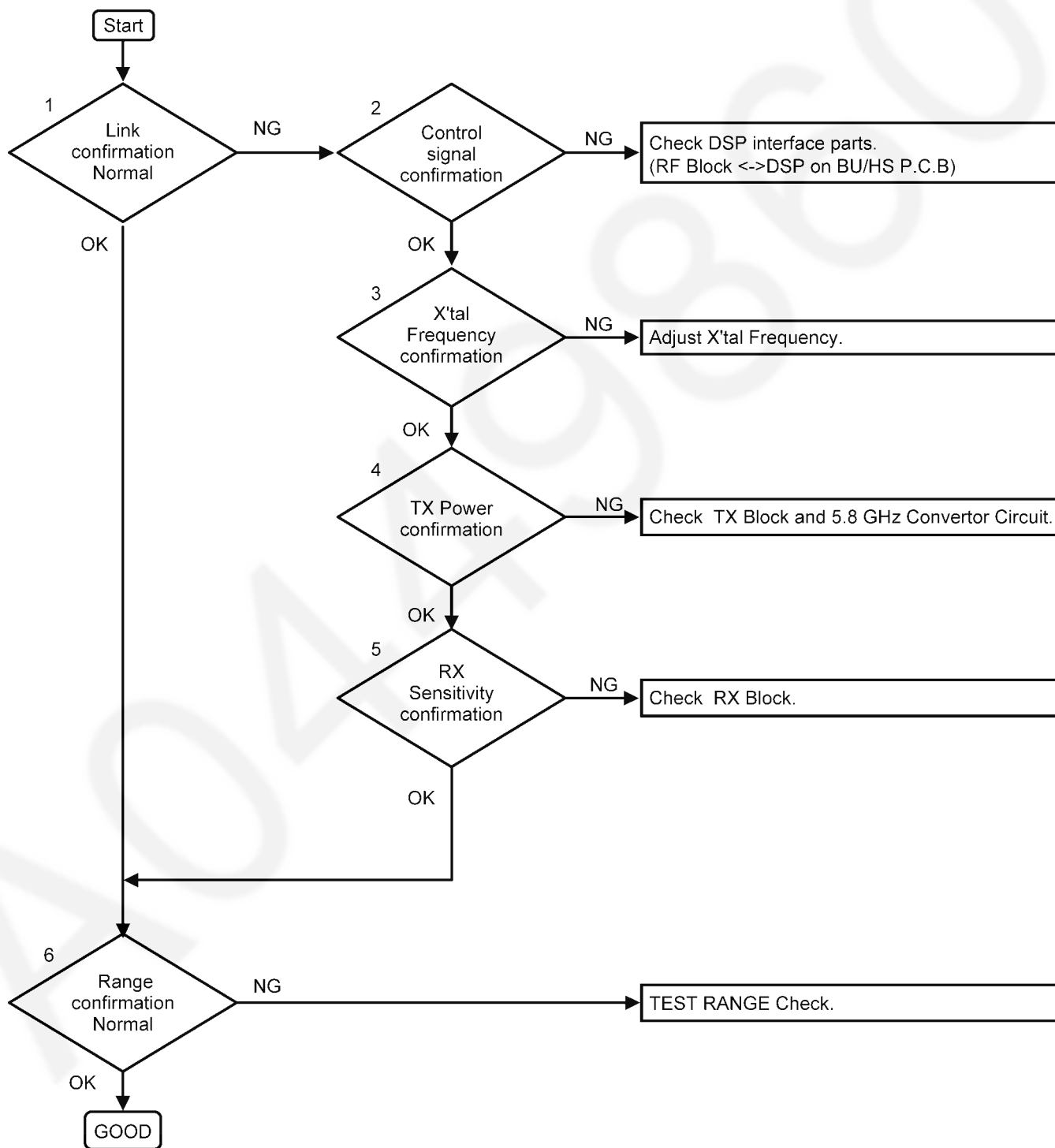
Handset

1 [MENU] → [0][0][2]

2 [3][3][5] → [OK]

10.1.9.2. RF Check Flowchart

Each item (1 ~ 6) of RF Check Flowchart corresponds to **Check Table for RF part** (P.72).
Please refer to the each item.



10.1.9.3. Check Table for RF part

No.	Item	BU (Base Unit) Check	HS (HandSet) Check
1	Link Confirmation Normal HS, BU Mode [Normal Mode]	1. Register Regular HS to BU (to be checked). 2. Press [Talk] key of the Regular HS to establish link.	1. Register HS (to be checked) to Regular BU. 2. Press [Talk] key of the HS to establish link.
2	Control signal confirmation HS, BU Mode: [Test Burst Mode] (*1)	Check DSP interface. (*2)	Check DSP interface. (*2)
3	X'tal Frequency confirmation (*7) HS, BU Mode: [Adjustment] (*3)	Check X'tal Frequency. (13.824000 MHz $\pm$ 270 Hz)	Check X'tal Frequency. (13.824000 MHz $\pm$ 100 Hz)
4	TX Power confirmation Regular HS, BU Mode: [RX-CW Mode.] (*4) HS, BU (to be checked) Mode: [Test Burst Mode.] (*1)	1. Place the Regular HS about 15 cm away from the BU. 2. Confirm that RSSI of the Regular HS is approximately 2 V by Oscilloscope. (*5)	1. Place the HS about 15 cm away from the Regular BU. 2. Confirm that RSSI of the Regular BU is approximately 2 V by Oscilloscope. (*6)
5	RX Sensitivity confirmation Regular HS, BU Mode: [Test Burst Mode.] (*1) HS, BU (to be checked) Mode: [RX-CW Mode.] (*4)	1. Place the Regular HS about 15cm away from the BU. 2. Confirm that RSSI of the BU is approximately 2 V by Oscilloscope. (*5)	1. Place the HS about 15 cm away from the Regular BU. 2. Confirm that RSSI of the HS is approximately 2 V by Oscilloscope. (*6)
6	Range Confirmation Normal HS, BU Mode: [Normal Mode]	1. Register Regular HS to BU (to be checked). 2. Press [Talk] key of the Regular HS to establish link. 3. Compare the range of the BU (being checked) with that of the Regular BU.	1. Register HS (to be checked) to Regular BU. 2. Press [Talk] key of the HS to establish link. 3. Compare the range of the HS (being checked) with that of the Regular HS.

Note:

 (*1)(*3)(*4) **Adjustment and Test Mode Flow Chart** (P.55)

 (*2) **RF-DSP Interface Signal Wave Form** (P.74)

 (*5) **Base Unit Reference Drawing** (P.86)

 (*6) **Handset Reference Drawing** (P.87)

 (*7) **X501 (Base Unit), X201 (Handset) Check** (P.85)

10.1.9.4. TEST RANGE Check

Circuit block which range is defective can be found by the following check.

Item	BU (Base Unit) Check	HS (HandSet) Check
Range Confirmation TX TEST (TX Power check) HS, BU Mode: [Test Link Mode] (*1)	1. Register Regular HS to BU (to be checked). 2. Set BU to "Test Link mode". 3. Set Regular HS to "Test Link mode". *Set TX Power and RX Sensitivity of the BU and the Regular HS by CHART1. * At distance of about 20 m between HS and BU, Link OK = TX Power of the BU is OK. No Link = TX Power of the BU is NG.	1. Register HS (to be checked) to Regular BU. 2. Set Regular BU to "Test Link mode". 3. Set HS to "Test Link mode". *Set TX Power and RX Sensitivity of the HS and the Regular BU by CHART1. * At distance of about 20 m between HS and BU, Link OK = TX Power of the HS is OK. No Link = TX Power of the HS is NG.
Range Confirmation RX TEST (RX sensitivity check) HS, BU Mode: [Test Link Mode] (*1)	1. Register Regular HS to BU (to be checked). 2. Set BU to "Test Link mode". 3. Set Regular HS to "Test Link mode". *Set TX Power and RX Sensitivity of the BU and Regular HS by CHART1. * At distance of about 20 m between HS and BU, Link OK= RX Sensitivity of the BU is OK. No Link = RX Sensitivity of the BU is NG.	1. Register HS (to be checked) to Regular BU. 2. Set Regular BU to "Test Link mode". 3. Set HS to "Test Link mode". * Set TX Power and RX Sensitivity of Checking_HS and Regular_BU by CHART1. * At distance of about 20 m between HS and BU, Link OK= RX Sensitivity of the HS is OK. No Link = RX Sensitivity of the HS is NG

CHART1: Setting of TX Power and RX Sensitivity in Range Confirmation TX TEST, RX TEST

	BU (to be checked)		Regular_HS	
	TX Power	RX Sens.	TX Power	RX Sens.
BU (Base Unit) TX Power Check	High	High	High	Low
BU (Base Unit) RX Sensitivity Check	High	High	Low	High

	HS (to be checked)		Regular_BU	
	TX Power	RX Sens.	TX Power	RX Sens.
HS (Handset) TX Power Check	High	High	High	Low
HS (Handset) RX Sensitivity Check	High	High	Low	High

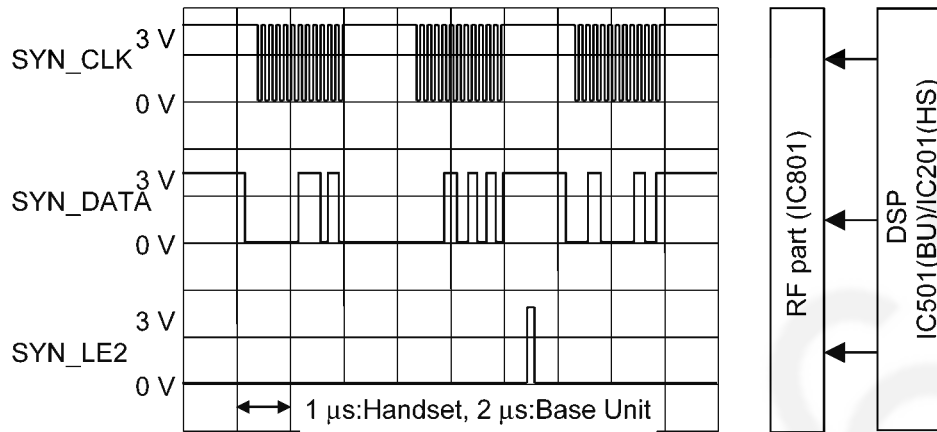
Note:

(*1) **Adjustment and Test Mode Flow Chart (P.55)**

10.1.9.5. RF-DSP Interface Signal Wave Form

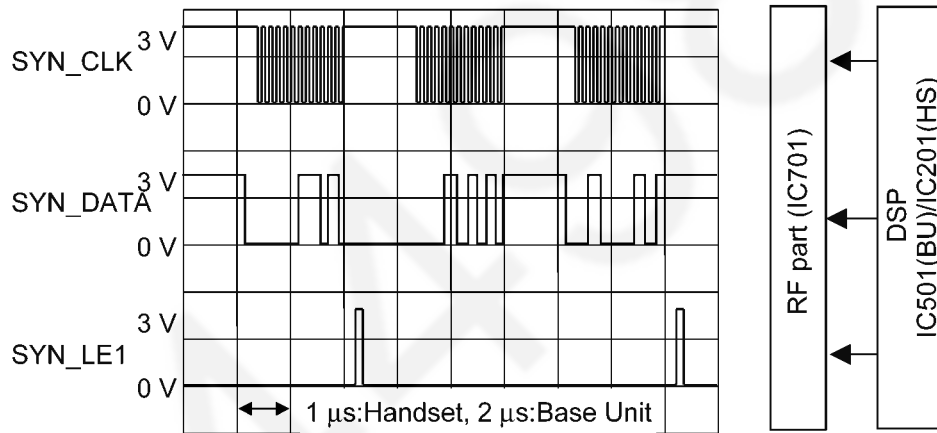
Test Burst Mode:

SYN_CLK & SYN_DATA



(Length variable)

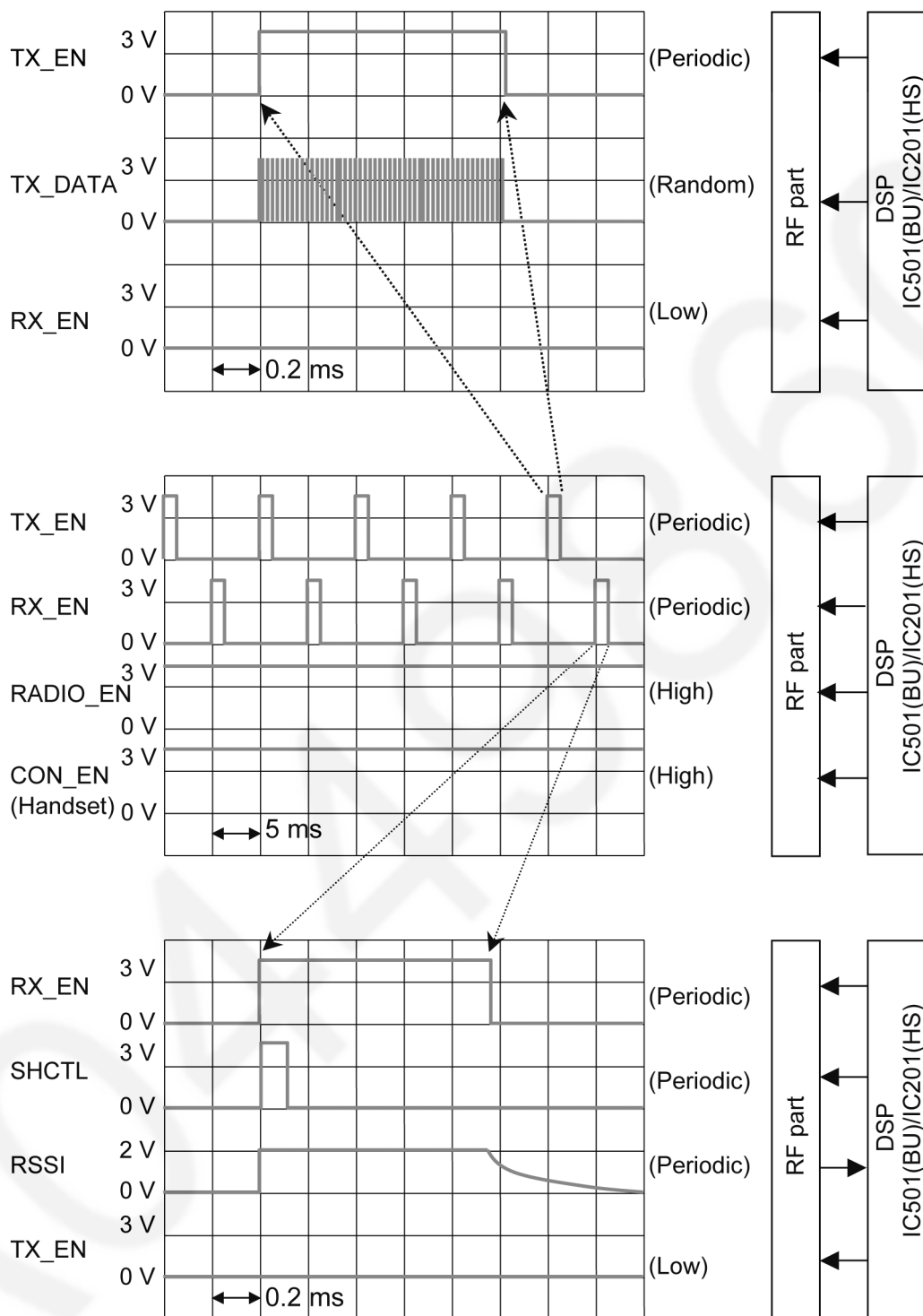
This wave form can be seen only at the Handset, because DSP of the BU, IC501, writes these signals just once. Therefore, check the DC Voltage of IC801 (pin11) is 0.4-2.3 V at the BU.



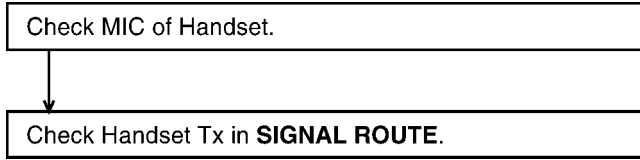
(Length variable)

Test Burst Mode:

TX & RX



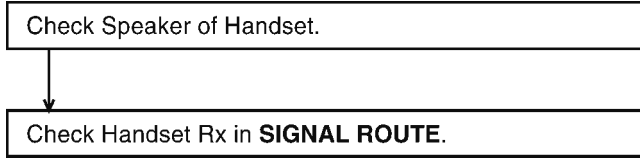
10.1.10. Check Handset Transmission



Cross Reference:

Signal Route (P.36).

10.1.11. Check Handset Reception



Cross Reference:

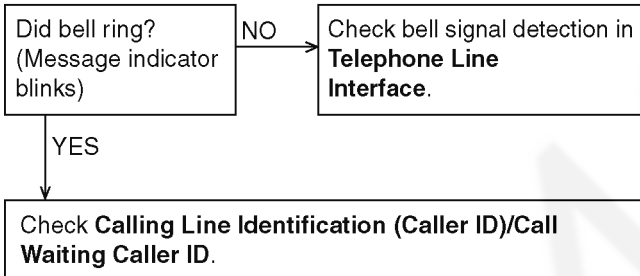
Signal Route (P.36).

Note:

When checking the RF part, Refer to **Check the RF part** (P.70)

10.1.12. Check Caller ID

BASE UNIT



Cross Reference:

Telephone Line Interface (P.17)

Calling Line Identification (Caller ID)/Call Waiting Caller ID (P.22).

Note:

- Make sure the format of the Caller ID or Call Waiting Caller ID service of the Telephone company that the customer subscribed to.
- Also we recommend to confirm that the customer is really a subscriber of the service.

10.2. How to Replace the Flat Package IC

Even if you do not have the special tools (for example, a spot heater) to remove the Flat IC, with some solder (large amount), a soldering iron and a cutter knife, you can easily remove the ICs that have more than 100 pins.

10.2.1. Preparation

- PbF (: Pb free) Solder
- Soldering Iron

Tip Temperature of $700^{\circ}\text{F} \pm 20^{\circ}\text{F}$ ($370^{\circ}\text{C} \pm 10^{\circ}\text{C}$)

Note: We recommend a 30 to 40 Watt soldering iron. An expert may be able to use a 60 to 80 Watt iron where someone with less experience could overheat and damage the PCB foil.

- Flux

Recommended Flux: Specific Gravity $\rightarrow 0.82$.

Type $\rightarrow$ RMA (lower residue, non-cleaning type)

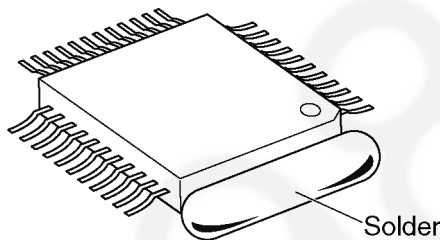
Note: See **About Lead Free Solder (Pbf: Pb free)** (P.4)

10.2.2. How to Remove the IC

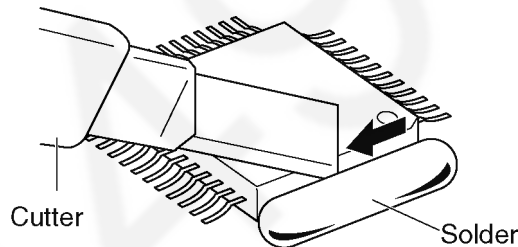
1. Put plenty of solder on the IC pins so that the pins can be completely covered.

Note:

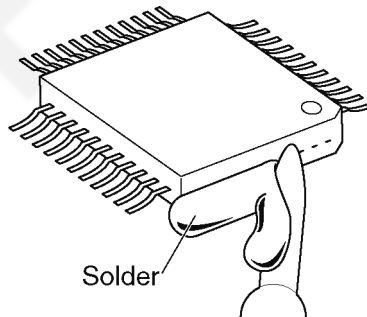
If the IC pins are not soldered enough, you may give pressure to the P.C. board when cutting the pins with a cutter.



2. Make a few cuts into the joint (between the IC and its pins) first and then cut off the pins thoroughly.



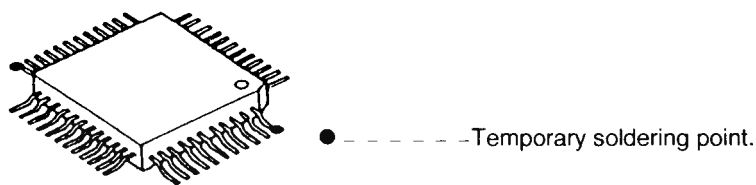
3. While the solder melts, remove it together with the IC pins.



When you attach a new IC to the board, remove all solder left on the land with some tools like a soldering wire. If some solder is left at the joint on the board, the new IC will not be attached properly.

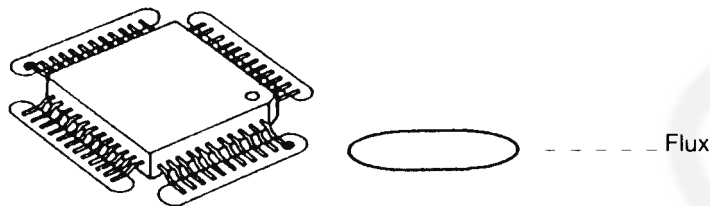
10.2.3. How to Install the IC

1. Temporarily fix the FLAT PACKAGE IC, soldering the two marked pins.

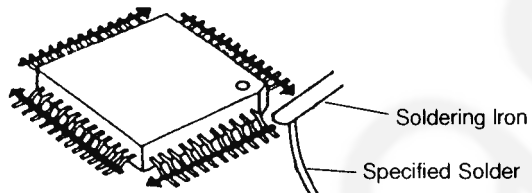


*Check the accuracy of the IC setting with the corresponding soldering foil.

2. Apply flux to all pins of the FLAT PACKAGE IC.

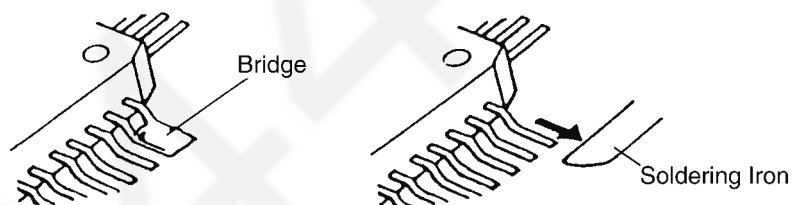


3. Solder the pins, sliding the soldering iron in the direction of the arrow.



10.2.4. How to Remove a Solder Bridge

1. Lightly resolder the bridged portion.
2. Remove the remaining solder along the pins using a soldering iron as shown in the figure below.



10.3. How to Replace the LLP (Leadless Leadframe Package) IC

10.3.1. Preparation

- PbF (: Pb free) Solder
- Soldering Iron
Tip Temperature of $700^{\circ}\text{F} \pm 20^{\circ}\text{F}$ ($370^{\circ}\text{C} \pm 10^{\circ}\text{C}$)

Note:

We recommend a 30 to 40 Watt soldering iron. An expert may be able to use a 60 to 80 Watt iron where someone with less experience could overheat and damage the PCB foil.

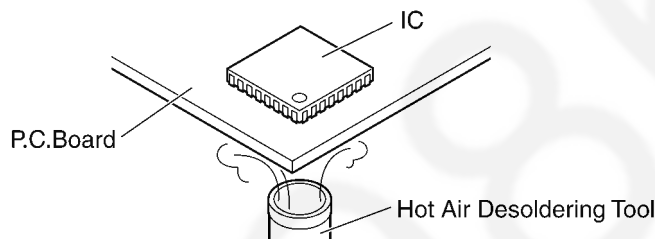
- Hot Air Desoldering Tool
Temperature: $608^{\circ}\text{F} \pm 68^{\circ}\text{F}$ ($320^{\circ}\text{C} \pm 20^{\circ}\text{C}$)

10.3.2. Caution

- To replace the IC efficiently, choose the right sized nozzle of the hot air desoldering tool that matches the IC package.
- Be careful about the temperature of the hot air desoldering tool not to damage the PCB and/or IC.

10.3.3. How to Remove the IC

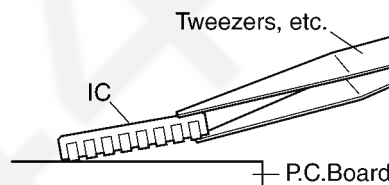
1. Heat the IC with a hot air desoldering tool through the P.C.Board.



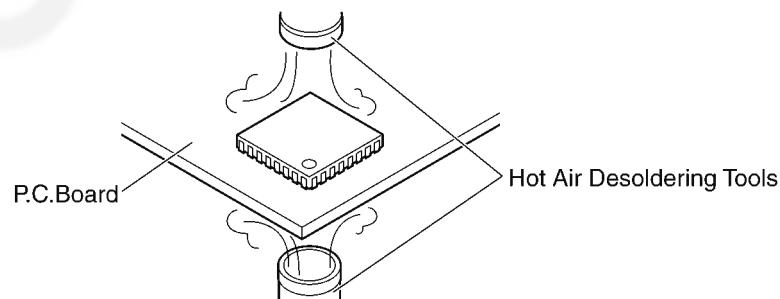
2. Pick up the IC with tweezers, etc. when the solder is melted completely.

Note:

- Be careful not to touch the peripheral parts with tweezers, etc. They are unstable.



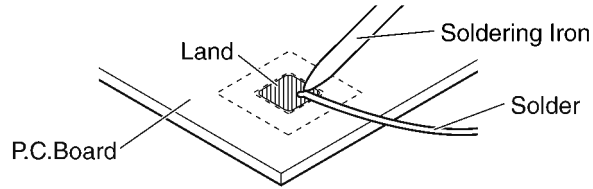
When it is hard to melt the solder completely, heat it with a hot air desoldering tool through the IC besides through the P.C.Board.



3. After removing the IC, clean the P.C.Board of residual solder.

10.3.4. How to Install the IC

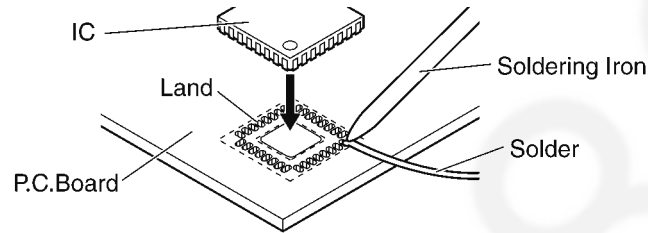
1. Place the solder a little on the land where the radiation GND pad on IC bottom is to be attached.



2. Place the solder a little on the land where IC pins are to be attached, then place the IC.

Note:

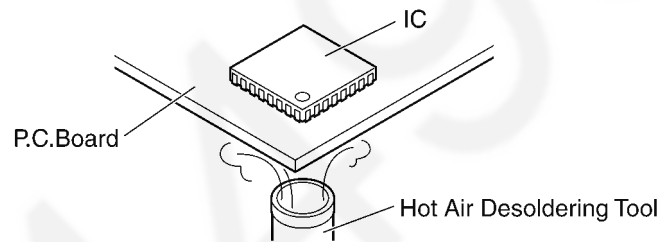
- When placing the IC, the positioning should be done very carefully.



3. Heat the IC with a hot air desoldering tool through the P.C. Board until the solder on IC bottom is melted.

Note:

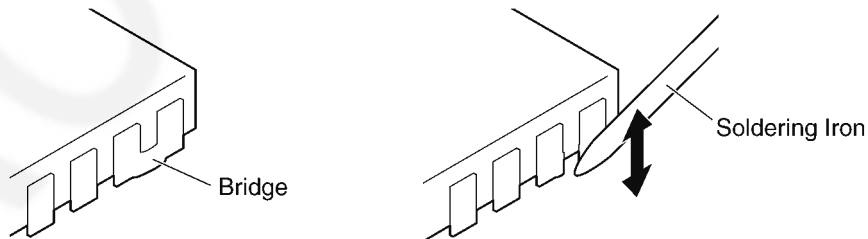
- Be sure to place it precisely, controlling the air volume of the hot air desoldering tool.



4. After soldering, confirm there are no short and open circuits with visual inspection.

10.3.5. How to Remove a Solder Bridge

When a Solder Bridge is found after soldering the bottom of the IC, remove it with a soldering iron.

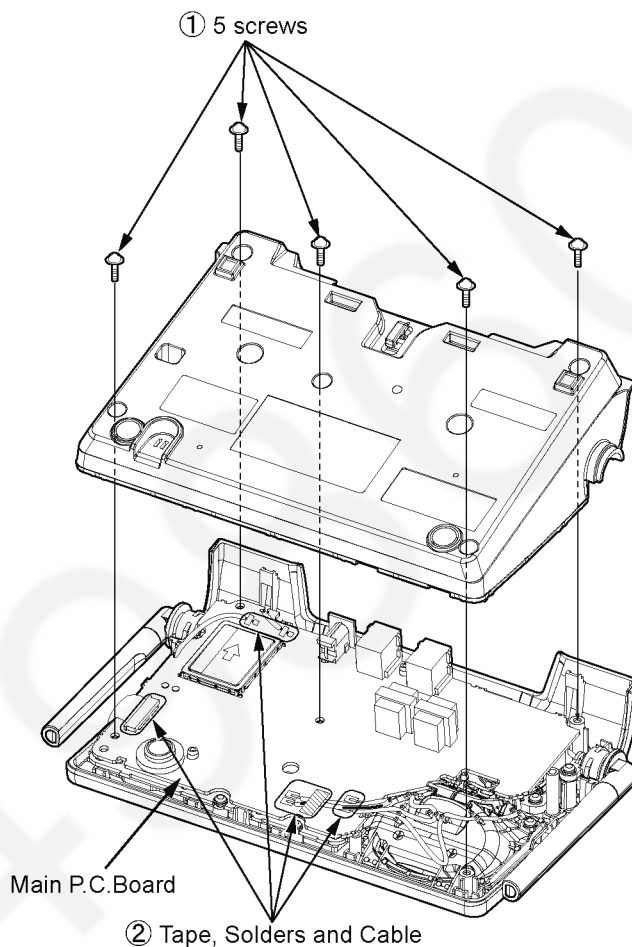


11 Disassembly and Assembly Instructions

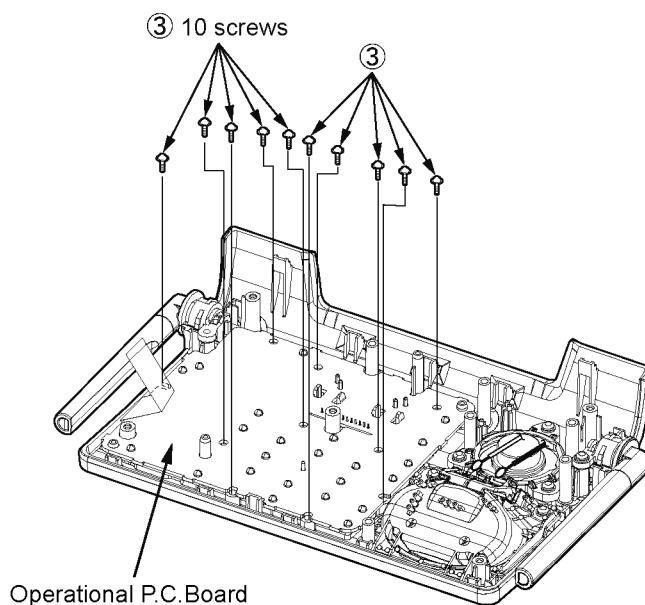
11.1. Disassembly Instructions

11.1.1. Base Unit

- ① Remove the 5 screws to remove the Cabinet Cover.
- ② Remove the Tape, Solders and Cable to remove the Main P.C.Board.

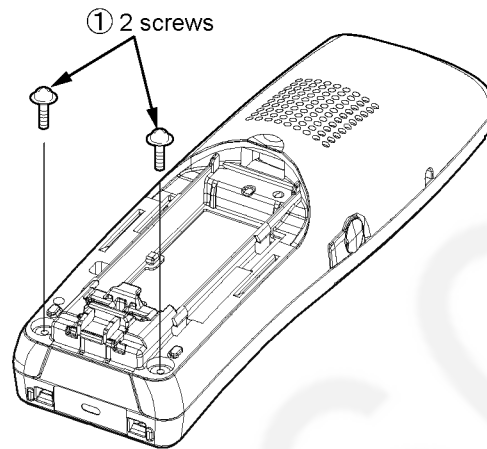


- ③ Remove the 10 screws to remove the Operational P.C.Board.

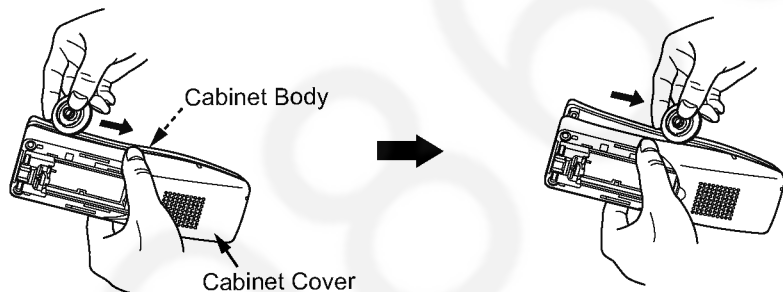


11.1.2. Handset

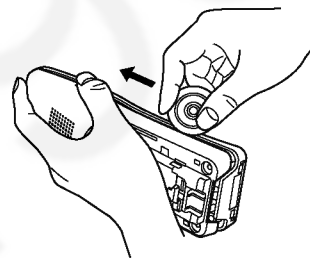
- ① Remove the 2 screws.



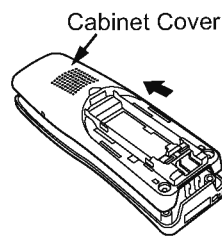
- ② Insert a JIG (PQDJ10006Y) between the Cabinet Body and the Cabinet Cover, then pull it along the gap to open the Cabinet.



- ③ Likewise, open the other side of the Cabinet.



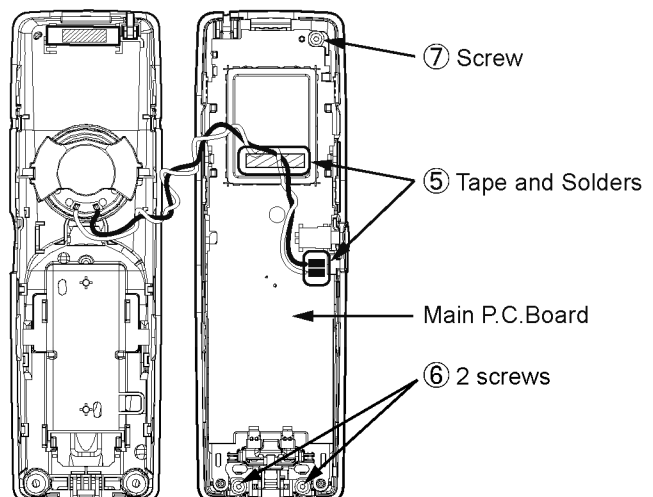
- ④ Remove the Cabinet Cover by pushing it upward.



- ⑤ Remove the Tape and Solders.

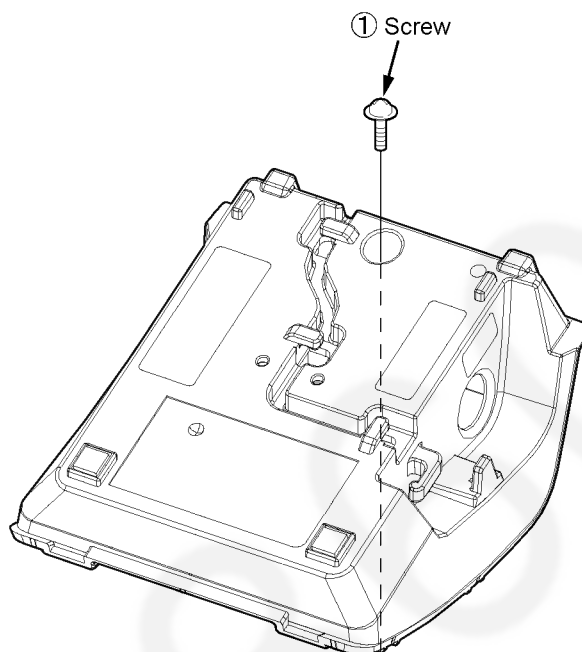
- ⑥ Remove the 2 screws to remove the 2 Charge Terminals.

- ⑦ Remove the screw to remove the Main P. C. Board.

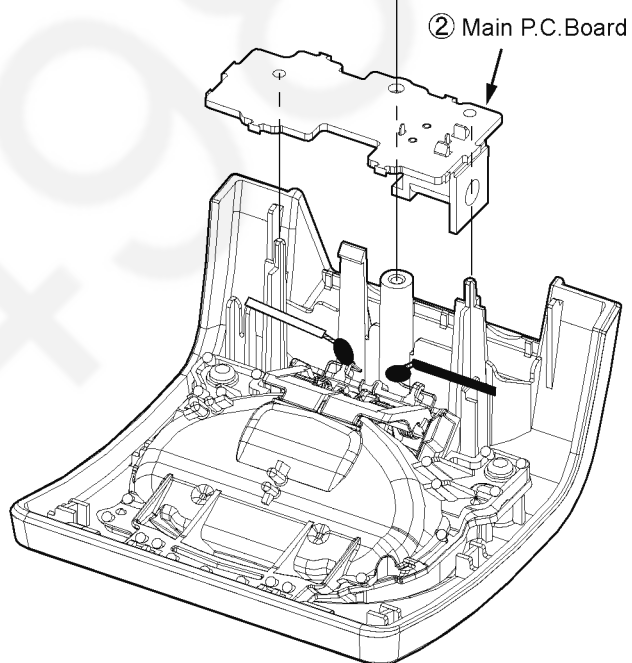


11.1.3. Charger Unit

- ① Remove the screw to remove the Cabinet Cover.

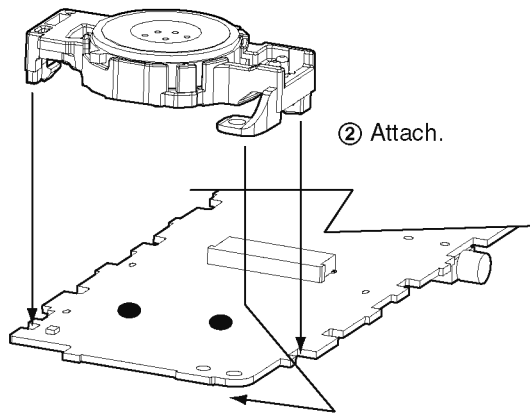


- ② Remove the Main P.C.Board.



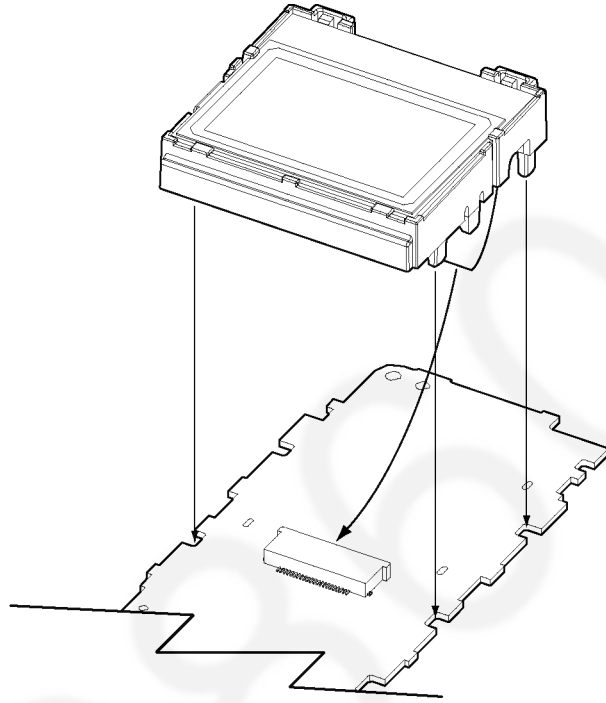
11.2. Fix the LCD and the Receiver Guide to the Main P.C.Board (Handset)

③ Set hook surely.



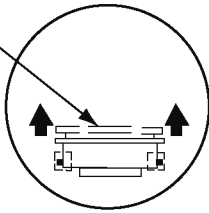
② Attach.

① Be careful not to break a hook and slide.



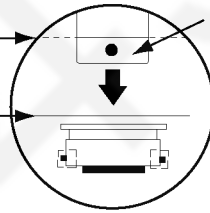
①

Release the
Connector
Lock.



②

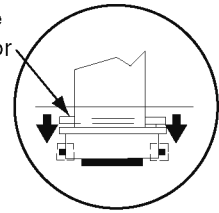
"Line A"
Silk printed line



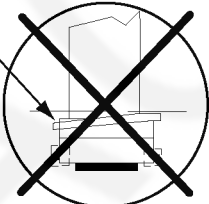
Insert FFC of LCD into
Connector surely until "Line A"
reaches the silk printed line on P.C.B.

③

Close the
Connector
Lock.

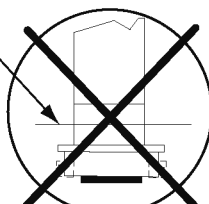


Connector is not
completely
locked.



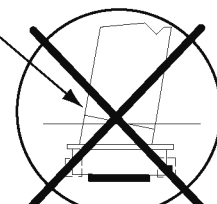
NG

FFC is not
completely
inserted.



NG

FFC is not
inserted
straight.



NG

12 Measurements and Adjustments

12.1. Things to Do after Replacing IC

12.1.1. X501 (Base Unit), X201 (Handset) Check

Equipment: Frequency counter

Check Point for measurement: BCK

Checking tolerance: 13.824 MHz $\pm$ 270 Hz (Base Unit)/13.824 MHz $\pm$ 100 Hz (Handset)

12.1.1.1. Check and Adjust X501 (Base Unit) Frequency

1. Set up Base Unit in TEST mode.
2. Press following keys in order to Adjust Crystal mode. [INTERCOM], [INTERCOM], [INTERCOM], [1], [4]. Check BCK frequency.
3. If the BCK frequency is out of the checking tolerance ($\pm$ 270 Hz), adjust to Adjustment tolerance ($\pm$ 30 Hz) by pressing [▲] or [▼] key.
Adjustment Tolerance: 13.824 MHz $\pm$ 30 Hz
4. Press [INTERCOM] key to write the new frequency factor in Memory.
5. Turn the power off. Then this value is available.

When you have replaced IC501 and IC601, adjust X501 by the procedure above.

Cross Reference:

Adjustment Mode for Base Unit (P.58)

12.1.1.2. Check and Adjust X201 (Handset) Frequency

1. Set DC power supply to 2.6 V.
2. Set up Handset in TEST mode (Adjustment flow).
3. Press [1] key to Adjust Crystal mode ("Clock Adj." is displayed on LCD). Check BCK frequency.
4. If the BCK frequency is out of the checking tolerance ($\pm$ 100 Hz), adjust to Adjustment tolerance ($\pm$ 30 Hz) by pressing [▲] or [▼] key.
Adjustment Tolerance: 13.824 MHz $\pm$ 30 Hz
5. Press [TALK] key to write the new frequency factor in EEPROM.
6. Turn the power off. Then this value is available.

When you have replaced IC201 and IC241, adjust X201 by the procedure above.

Cross Reference:

Adjustment Mode for Handset (P.62)

12.1.2. Adjust Battery Low Detector Voltage (Handset)

After Handset's DSP (IC201) or EEPROM (IC241) replacement, Re-writing Battery Low voltage to EEPROM is required. With following Handset Adjustment Flow, adjust DC power supply and DC voltmeter by the procedure below.

1. Set DC power supply to 2.6 V.
2. Set up Handset in TEST mode (Adjustment flow).
3. Press [1] key and [OFF] key to Adjust Batt Low mode. ("Bat Adj." is displayed on LCD)
4. Change the voltage of the DC power supply to 2.34 V accurately. Check the voltage at P.C. board pads because some voltage drops occur due to the usage of long or thin cables.
5. Press [TALK] key twice to write voltage value in EEPROM.
6. Press [TALK] key twice to write charge value 1 in EEPROM.
7. Change the voltage of the DC power supply to 2.90 V accurately.
8. Press [TALK] key twice to write charge value 2 in EEPROM.
9. Turn the power off. Then this value is available.

Note:

Refer to **Handset Reference Drawing (P.87)** for connection of DC power supply and voltmeter.

Cross Reference:

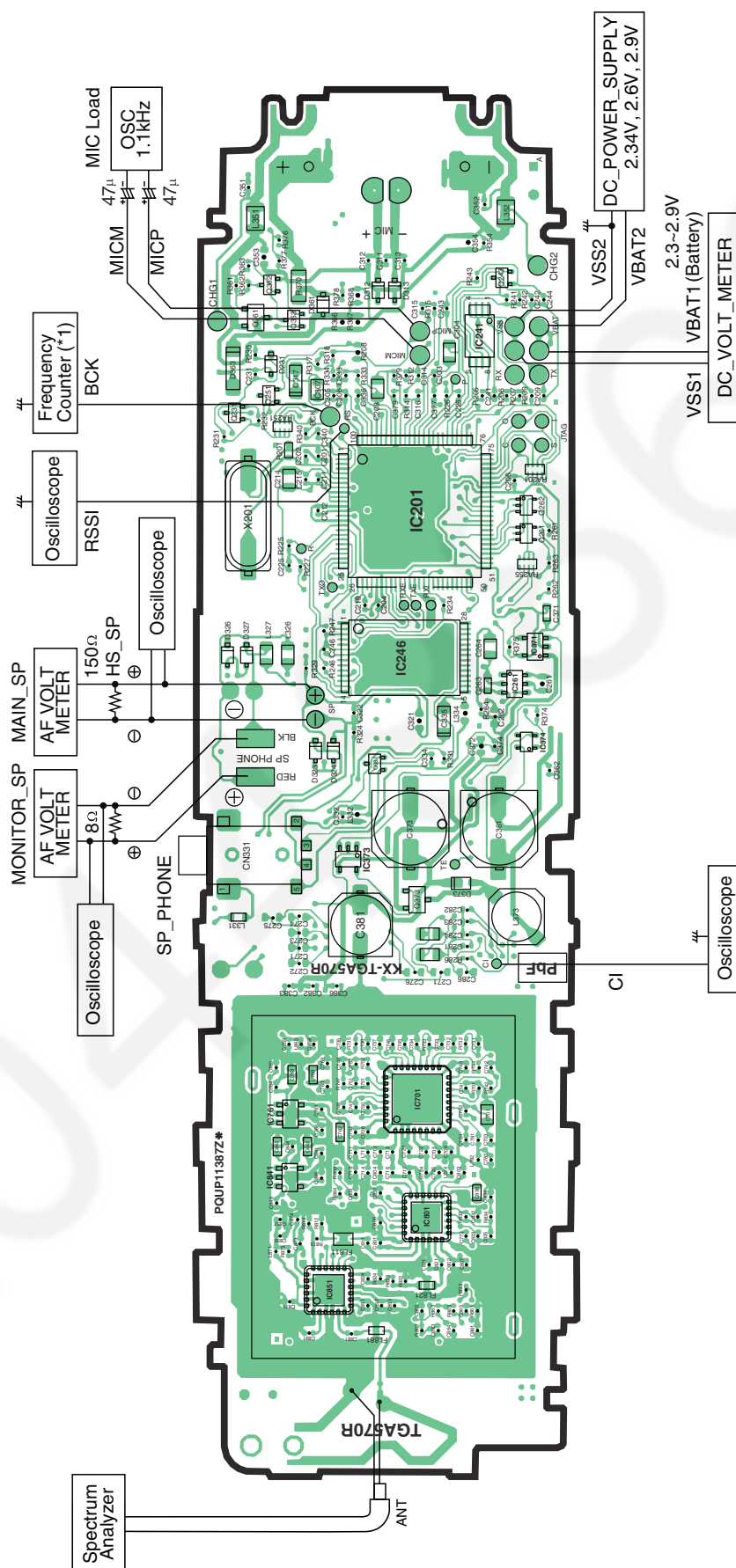
Adjustment Mode for Handset (P.62)

[illegible]

(*1) is referred to No.3 of **Check Table for RF part** (P.72)

12.3. Handset Reference Drawing

When connecting the Simulator Equipment for checking, please refer to below.



Note:

(*1) is referred to No.3 of **Check Table for RF part (P.72)**

12.4. Frequency Table

12.4.1. Base Unit

Channel	TX/RX Frequency (MHz)	Channel	TX/RX Frequency (MHz)	Channel	TX/RX Frequency (MHz)
1	5759.702398	33	5788.242242	65	5816.782086
2	5760.592291	34	5789.132135	66	5817.671978
3	5761.486139	35	5790.025982	67	5818.565826
4	5762.376031	36	5790.915875	68	5819.455719
5	5763.269879	37	5791.809723	69	5820.349566
6	5764.159771	38	5792.699615	70	5821.239459
7	5765.053619	39	5793.593463	71	5822.133307
8	5765.943512	40	5794.483355	72	5823.023199
9	5766.837359	41	5795.377203	73	5823.917047
10	5767.727252	42	5796.267096	74	5824.806939
11	5768.621100	43	5797.160943	75	5825.700787
12	5769.510992	44	5798.050836	76	5826.590680
13	5770.404840	45	5798.944684	77	5827.484527
14	5771.294732	46	5799.834576	78	5828.374420
15	5772.188580	47	5800.728424	79	5829.268268
16	5773.078473	48	5801.618316	80	5830.158160
17	5773.972320	49	5802.512164	81	5831.052008
18	5774.862213	50	5803.402057	82	5831.941900
19	5775.756060	51	5804.295904	83	5832.835748
20	5776.645953	52	5805.185797	84	5833.725641
21	5777.539801	53	5806.079644	85	5834.619488
22	5778.429693	54	5806.969537	86	5835.509381
23	5779.323541	55	5807.863385	87	5836.403228
24	5780.213434	56	5808.753277	88	5837.293121
25	5781.107281	57	5809.647125	89	5838.186969
26	5781.997174	58	5810.537018		
27	5782.891021	59	5811.430865		
28	5783.780914	60	5812.320758		
29	5784.674762	61	5813.214605		
30	5785.564654	62	5814.104498		
31	5786.458502	63	5814.998346		
32	5787.348394	64	5815.888238		

12.4.2. Handset

Channel	TX/RX Frequency (MHz)	Channel	TX/RX Frequency (MHz)	Channel	TX/RX Frequency (MHz)
1	5759.700425	33	5788.240269	65	5816.780113
2	5760.594273	34	5789.134117	66	5817.673960
3	5761.484165	35	5790.024009	67	5818.563853
4	5762.378013	36	5790.917857	68	5819.457701
5	5763.267906	37	5791.807749	69	5820.347593
6	5764.161753	38	5792.701597	70	5821.241441
7	5765.051646	39	5793.591490	71	5822.131333
8	5765.945494	40	5794.485337	72	5823.025181
9	5766.835386	41	5795.375230	73	5823.915074
10	5767.729234	42	5796.269078	74	5824.808921
11	5768.619126	43	5797.158970	75	5825.698814
12	5769.512974	44	5798.052818	76	5826.592662
13	5770.402867	45	5798.942710	77	5827.482554
14	5771.296714	46	5799.836558	78	5828.376402
15	5772.186607	47	5800.726451	79	5829.266294
16	5773.080455	48	5801.620298	80	5830.160142
17	5773.970347	49	5802.510191	81	5831.050035
18	5774.864195	50	5803.404039	82	5831.943882
19	5775.754087	51	5804.293931	83	5832.833775
20	5776.647935	52	5805.187779	84	5833.727623
21	5777.537828	53	5806.077671	85	5834.617515
22	5778.431675	54	5806.971519	86	5835.511363
23	5779.321568	55	5807.861412	87	5836.401255
24	5780.215415	56	5808.755259	88	5837.295103
25	5781.105308	57	5809.645152	89	5838.184996
26	5781.999156	58	5810.538999		
27	5782.889048	59	5811.428892		
28	5783.782896	60	5812.322740		
29	5784.672789	61	5813.212632		
30	5785.566636	62	5814.106480		
31	5786.456529	63	5814.996373		
32	5787.350376	64	5815.890220		

13 Schematic Diagram

13.1. For Schematic Diagram

13.1.1. Base Unit (Schematic Diagram (Base Unit_Main))

Notes:

1. DC voltage measurements are taken with voltmeter from the negative voltage line.

Important Safety Notice:

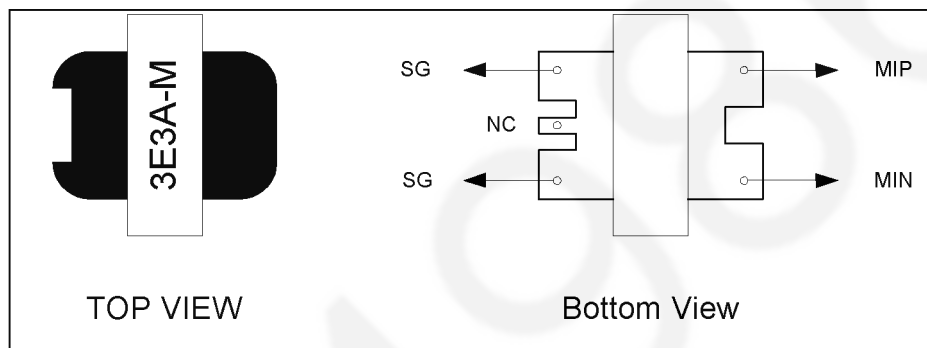
Components identified by ⚠ mark have special characteristics important for safety. When replacing any of these components, use only the manufacturer's specified parts.

2. The schematic diagrams may be modified at any time with the development of new technology.

13.1.1.1. Microphone Input Level (Base Unit)

Adjust the signal level to -47 dBm (11 mVp-p) with no load.

Then input the signal to MIP and MIN of the base unit through PQLT3E3A-M.



13.1.1.2. Acoustic Testing Mode

Press "1", "6" and "FLASH" simultaneously, and insert the plug of AC adaptor.

- No beep sound.

It is easier to measure the transmit level with acoustic testing mode.

13.1.2. Handset (Schematic Diagram (Handset_Main))

Notes:

1. DC voltage measurements are taken with an oscilloscope or a tester with a ground.
2. The schematic diagrams may be modified at any time with the development of new technology.

13.1.2.1. Microphone Input Level (Handset)

Handset Mode

Adjust the signal level to -40 dBm with 600 ohm load.

Then input the signal to MICP and MICN of the handset through the 47 μ F capacitors.

Headset Mode

Adjust the signal level to -44 dBm with 600 ohm load.

Then input the signal to MICP and MICN of the handset through the 47 μ F capacitor.

13.1.3. Charger Unit (Schematic Diagram (Charger Unit))

Notes:

1. DC voltage measurements are taken with voltmeter from the negative voltage line.

Important Safety Notice:

Components identified by ⚠ mark have special characteristics important for safety. When replacing any of these components, use only the manufacturer's specified parts.

2. The schematic diagram may be modified at any time with the development of new technology.

13.1.4. Level Relationship

	Line Input Level	Output Level	Remarks
Base SP RX	-25 dBm	-5 dBm	8 ohm terminal, volume max
Handset RX	-25 dBm	-11 dBm	150 ohm terminal, volume max
Handset SP RX	-35 dBm	-4 dBm	8 ohm terminal, volume max
Headset RX	-25 dBm	-20.5 dBm	150 ohm terminal, volume max

	Line Input Level	Output Level	Remarks
Base SP TX	-47 dBm	-15.5 dBm	Refer to Microphone Input Level (Base Unit) (P.90).
Handset TX	-40 dBm	-15.5 dBm	Refer to Microphone Input Level (Handset) (P.90).
Headset TX	-44 dBm	-15.5 dBm	Refer to Microphone Input Level (Handset) (P.90).

4.0V

3.3V

SP Phone TX

PQLT3E3A

-47dBm/No load
10mVp-p

SP Phone RX

1.2Vp-p
8Ω (Vol. MAX)

IC381

IC501

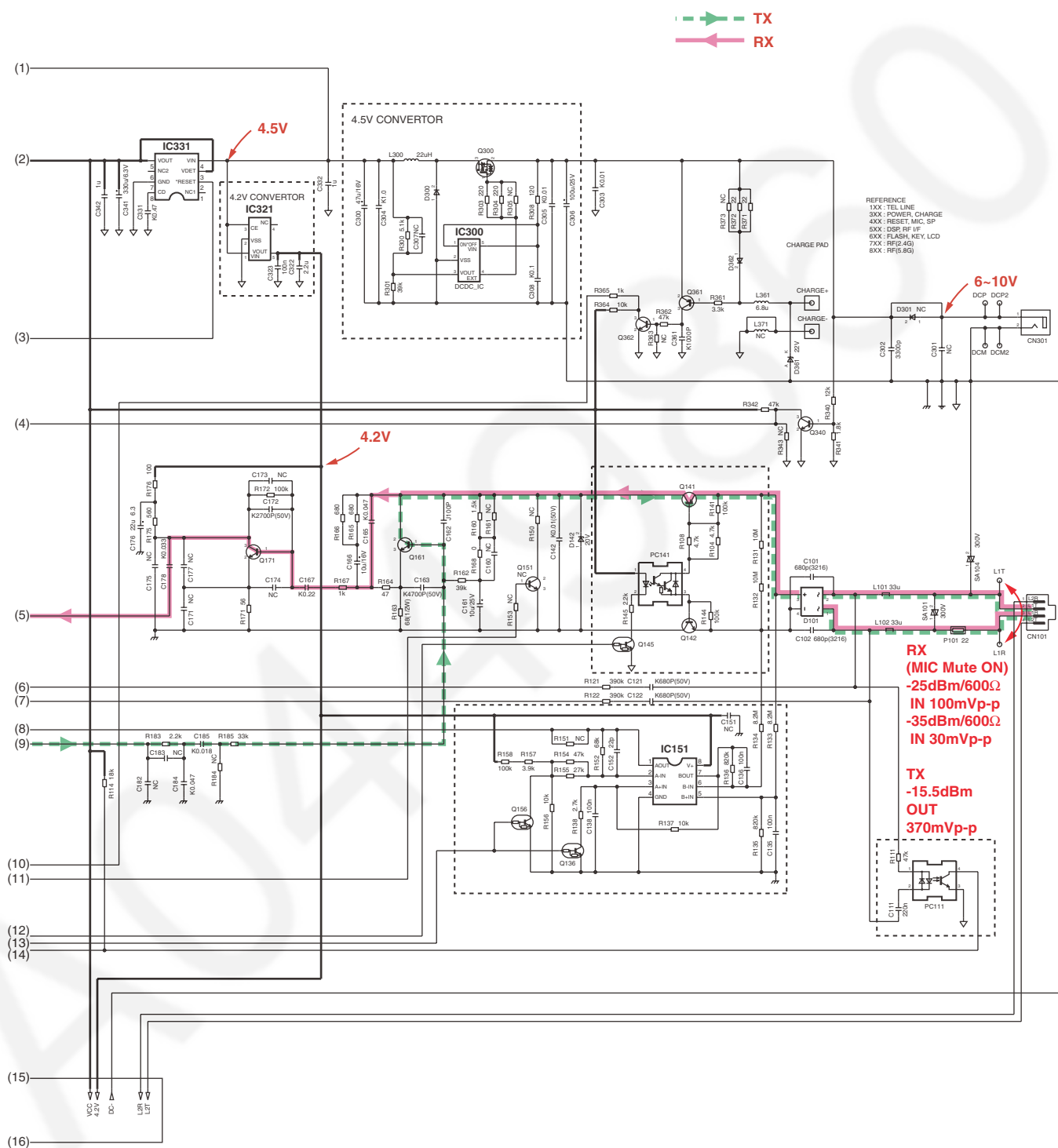
IC609

IC601

32pin Connector

NC: No Components

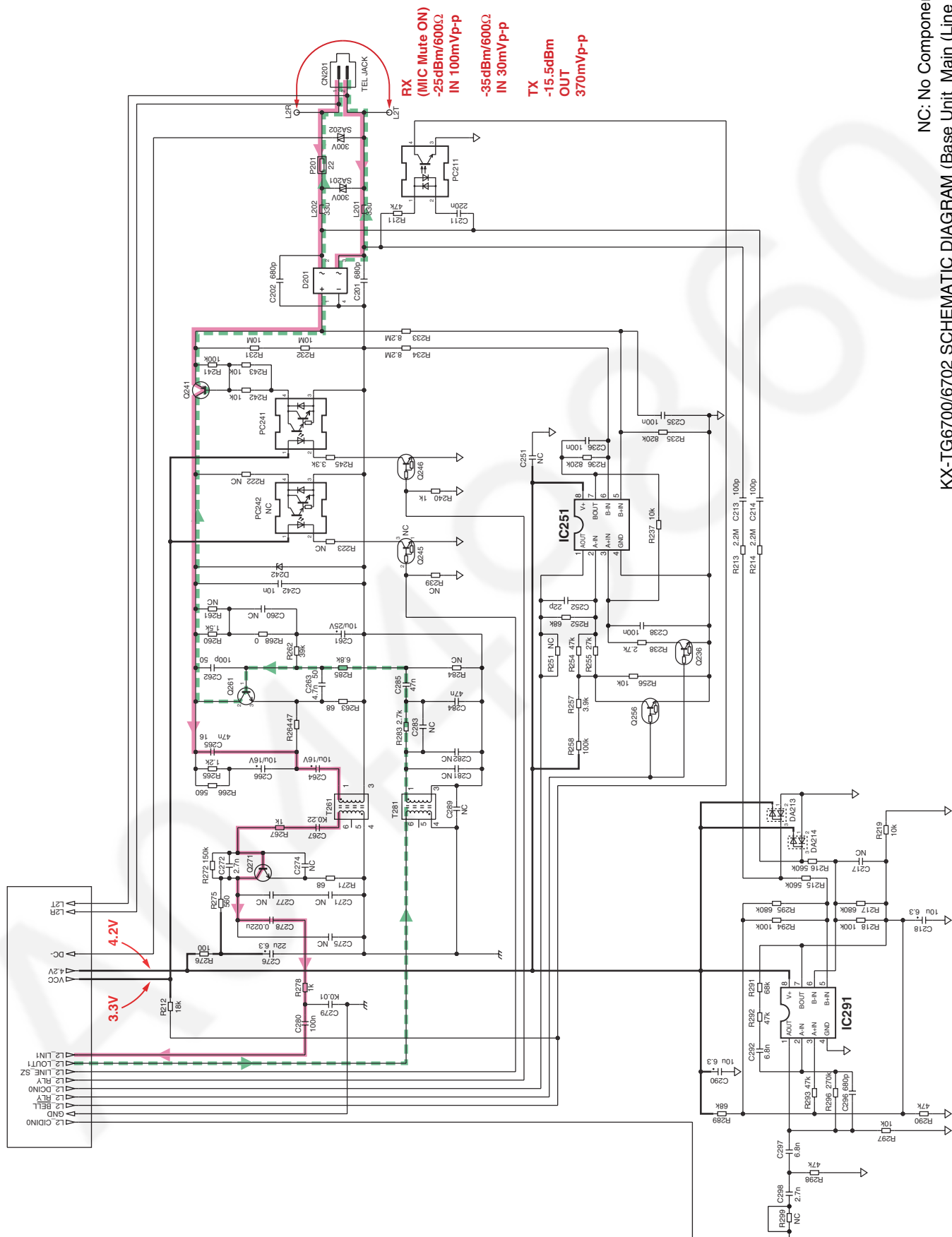
CN661
32pin Connector



NC: No Components

KX-TG6700/6702 SCHEMATIC DIAGRAM (Base Unit_Main (Line 1))

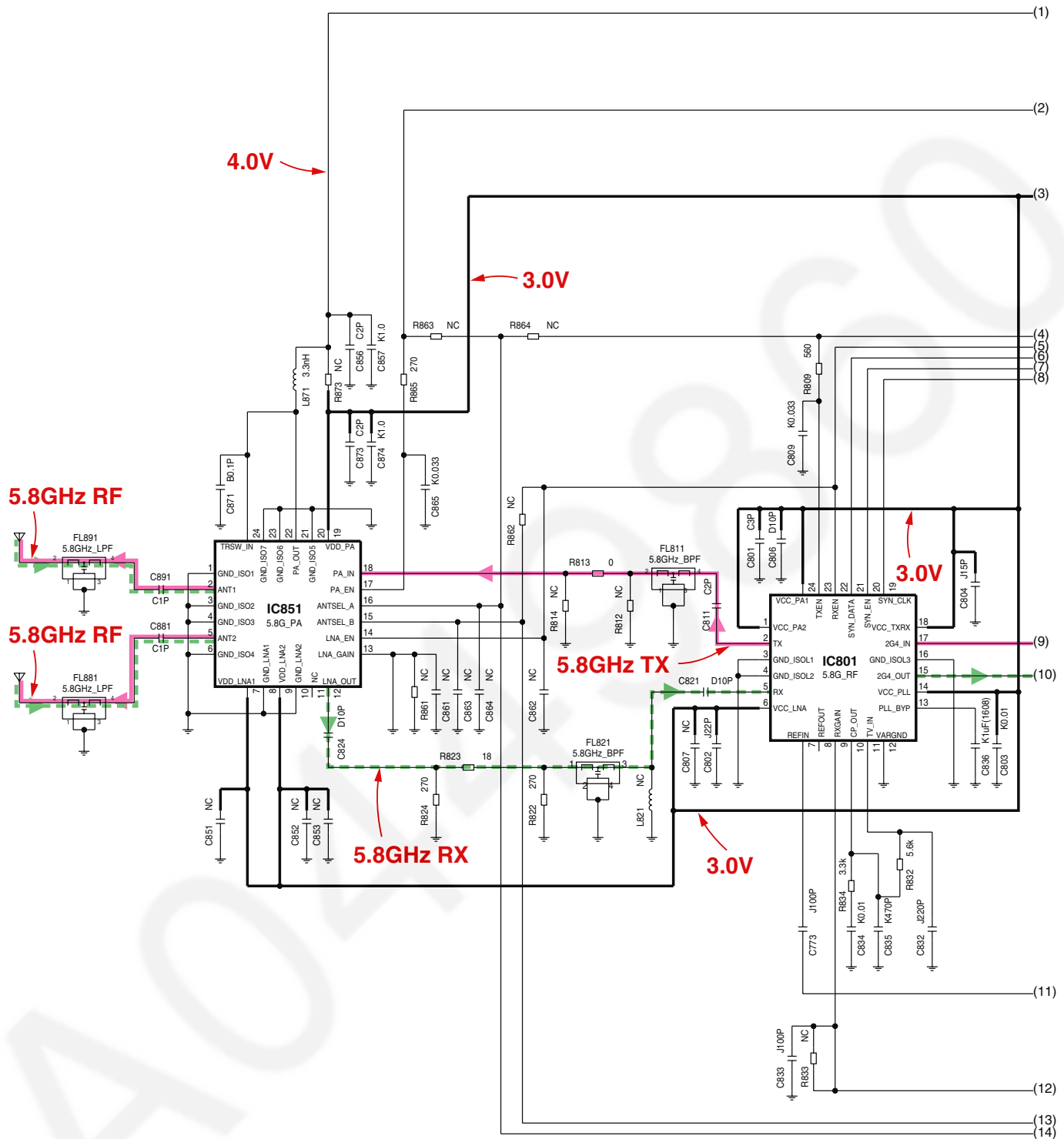
13.2.2. Line 2



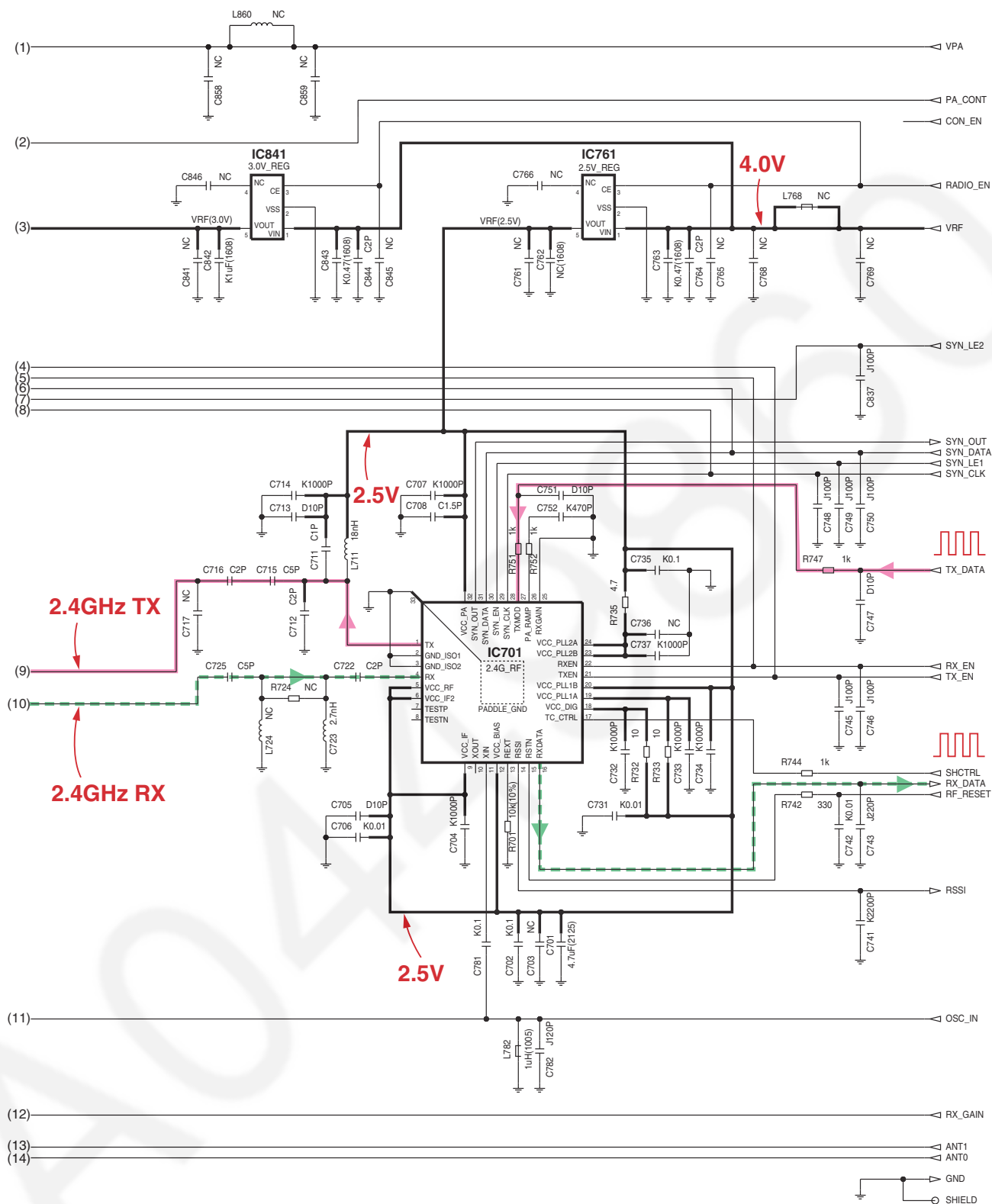
Memo

A0449860

13.3. Schematic Diagram (Base Unit_RF Part)



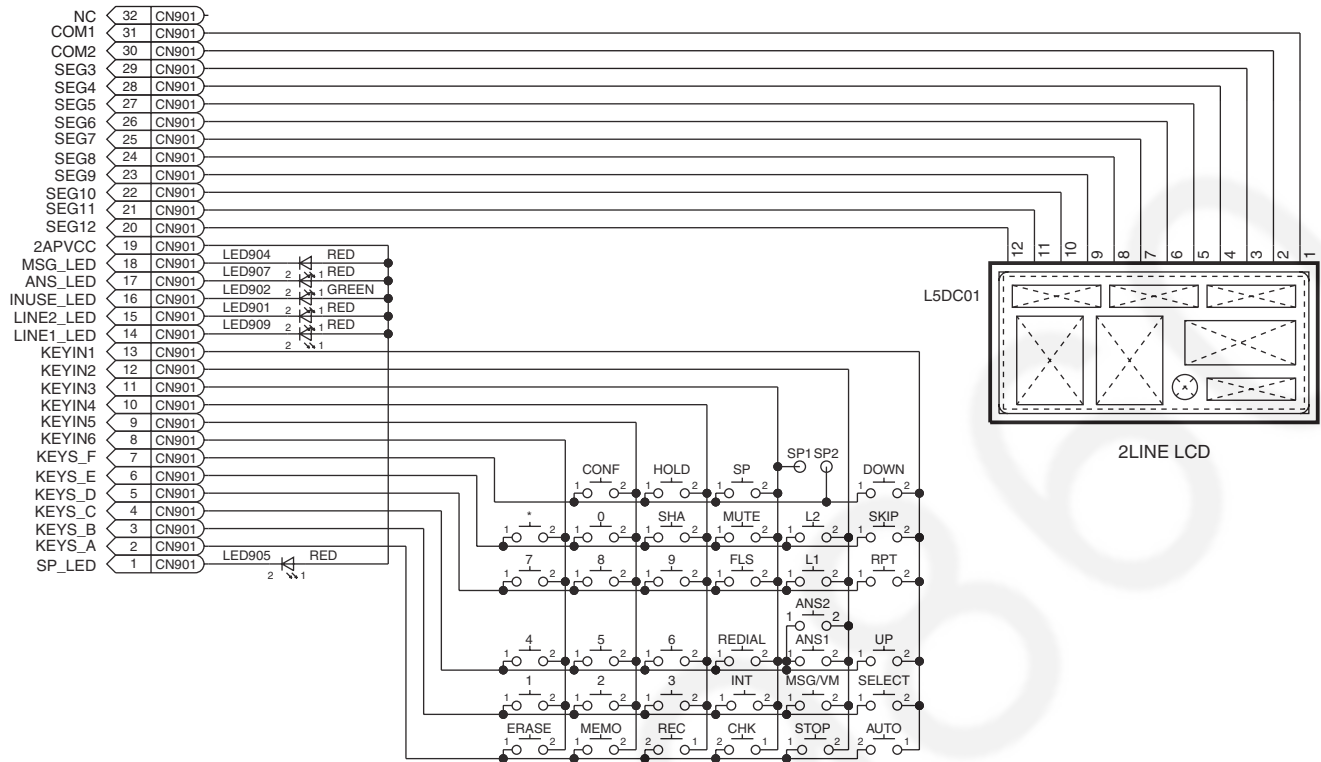
NC: No Components



NC: No Components

KX-TG6700/6702 SCHEMATIC DIAGRAM (Base Unit_RF Part)

13.4. Schematic Diagram (Base Unit_Operation)



NC: No Components

KX-TG6700/6702 SCHEMATIC DIAGRAM (Base Unit_Operation)

Memo

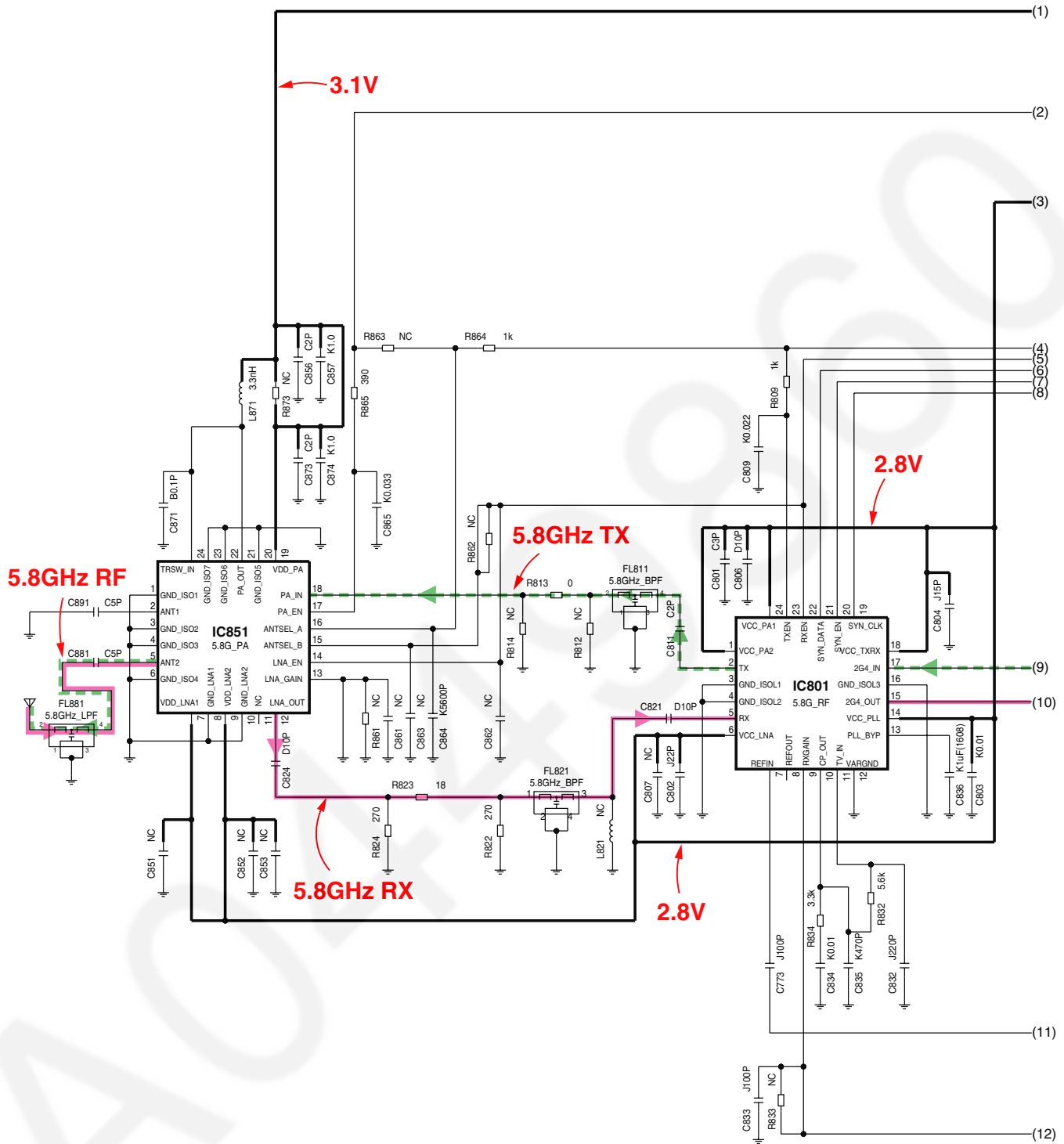
A0449860



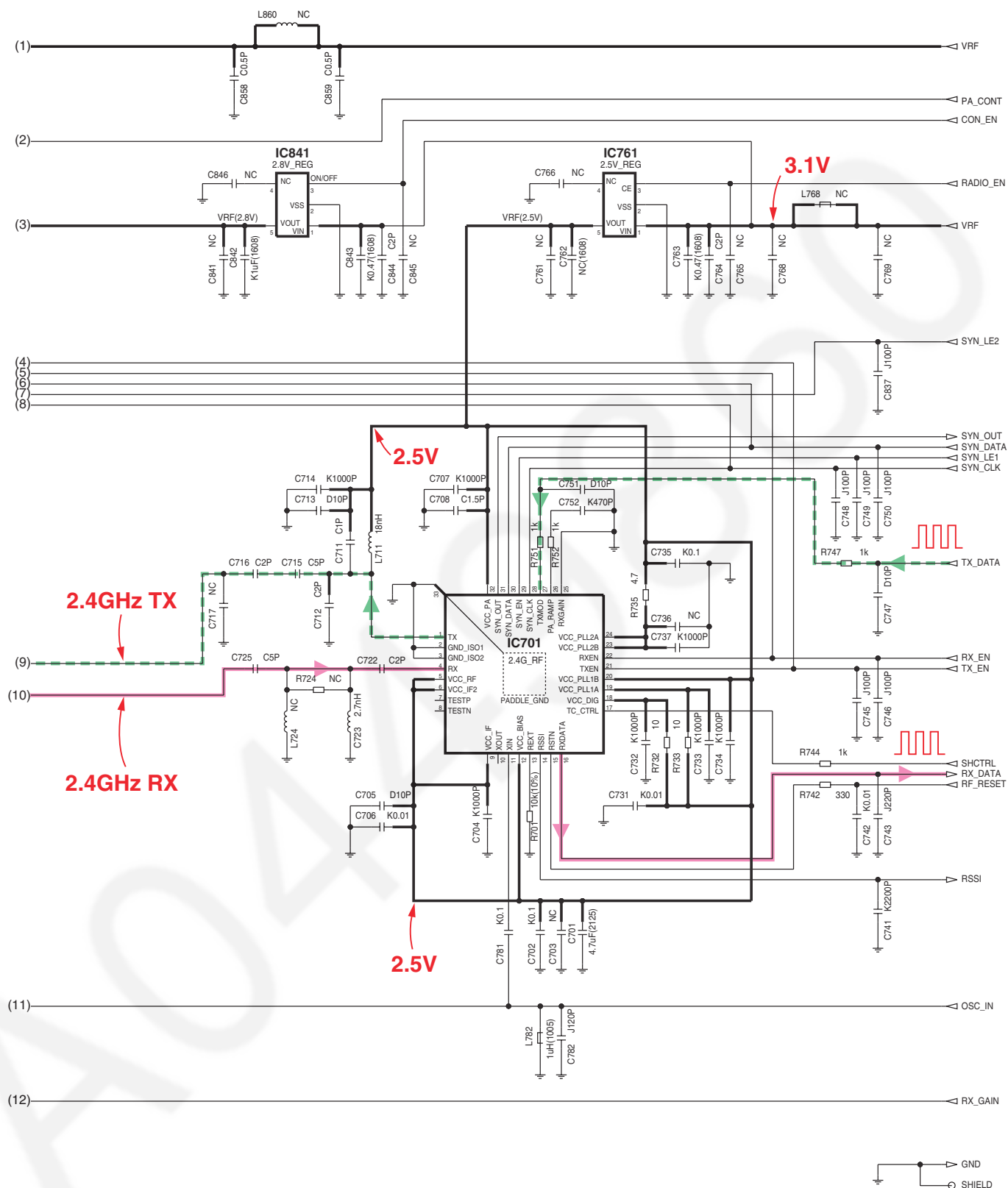


101

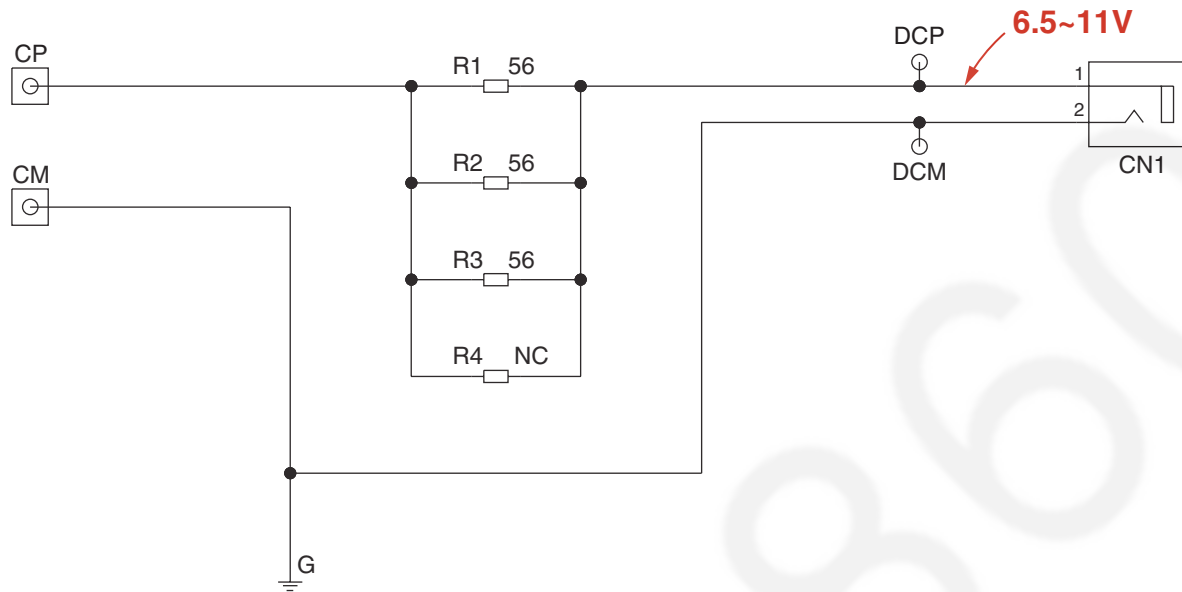
13.6. Schematic Diagram (Handset_RF Part)



NC: No Components



13.7. Schematic Diagram (Charger Unit)

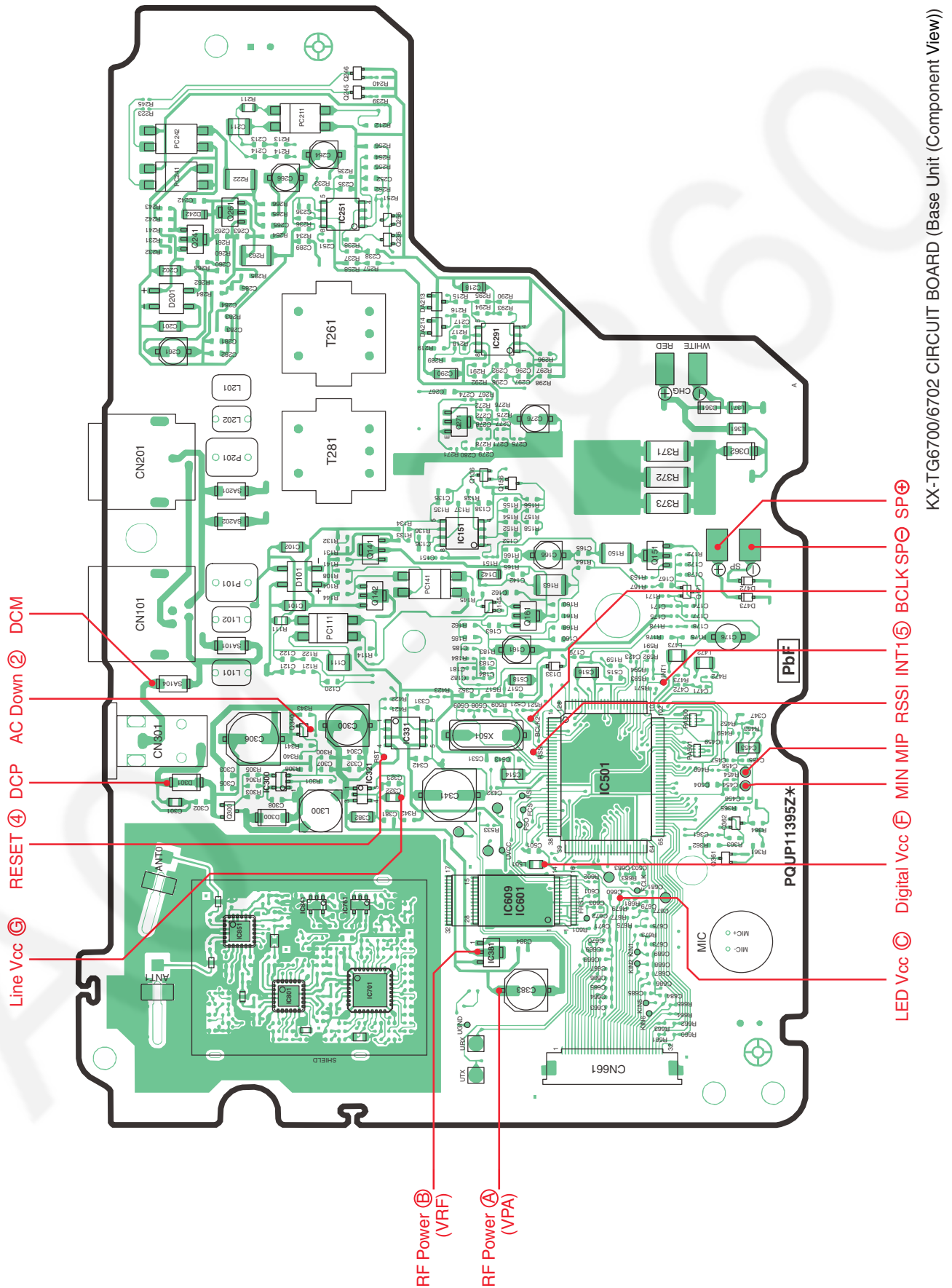


NC: No Components
SCHEMATIC DIAGRAM (Charger Unit)

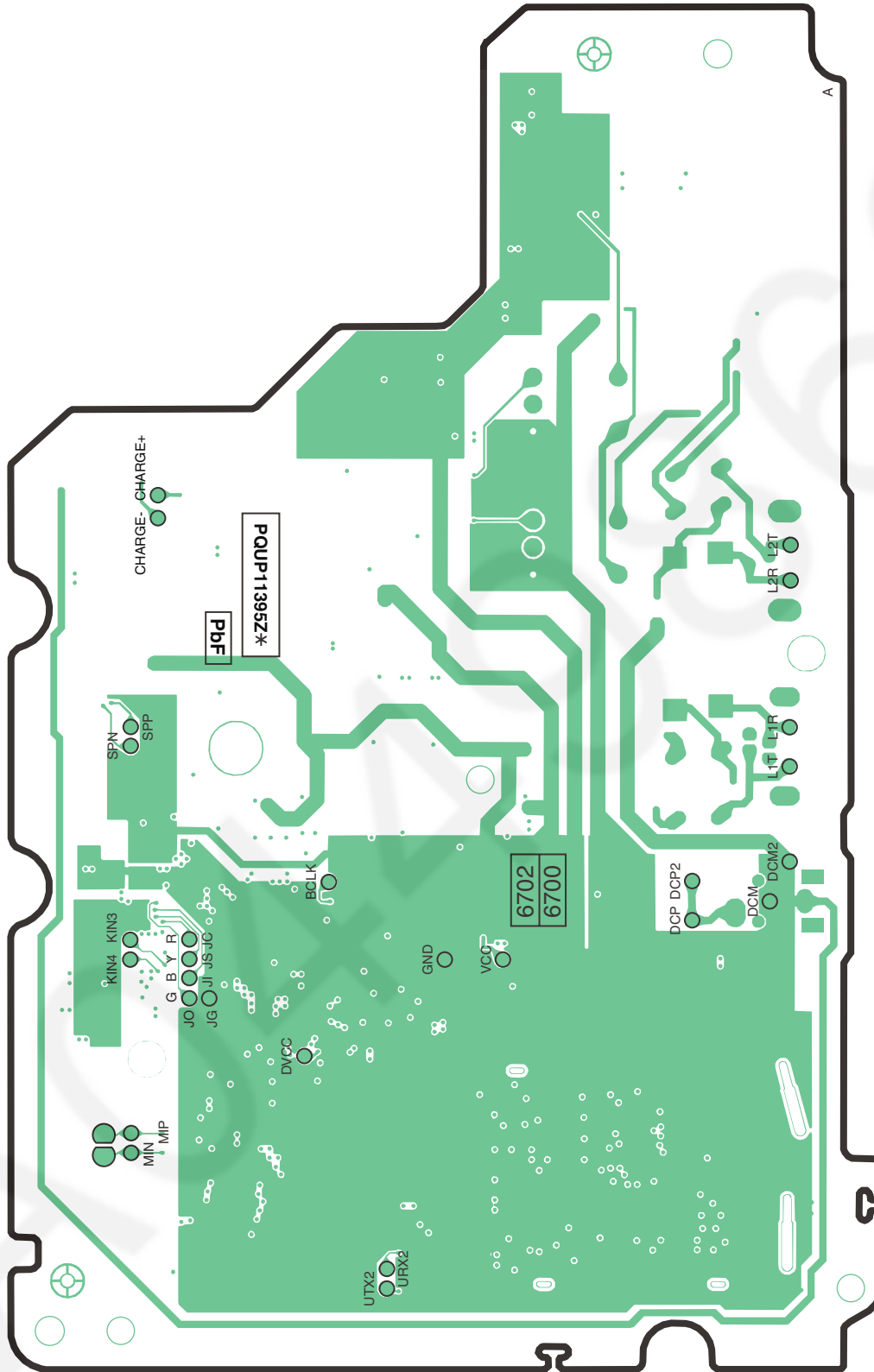
14 Printed Circuit Board

14.1. Circuit Board (Base Unit_Main)

14.1.1. Component View

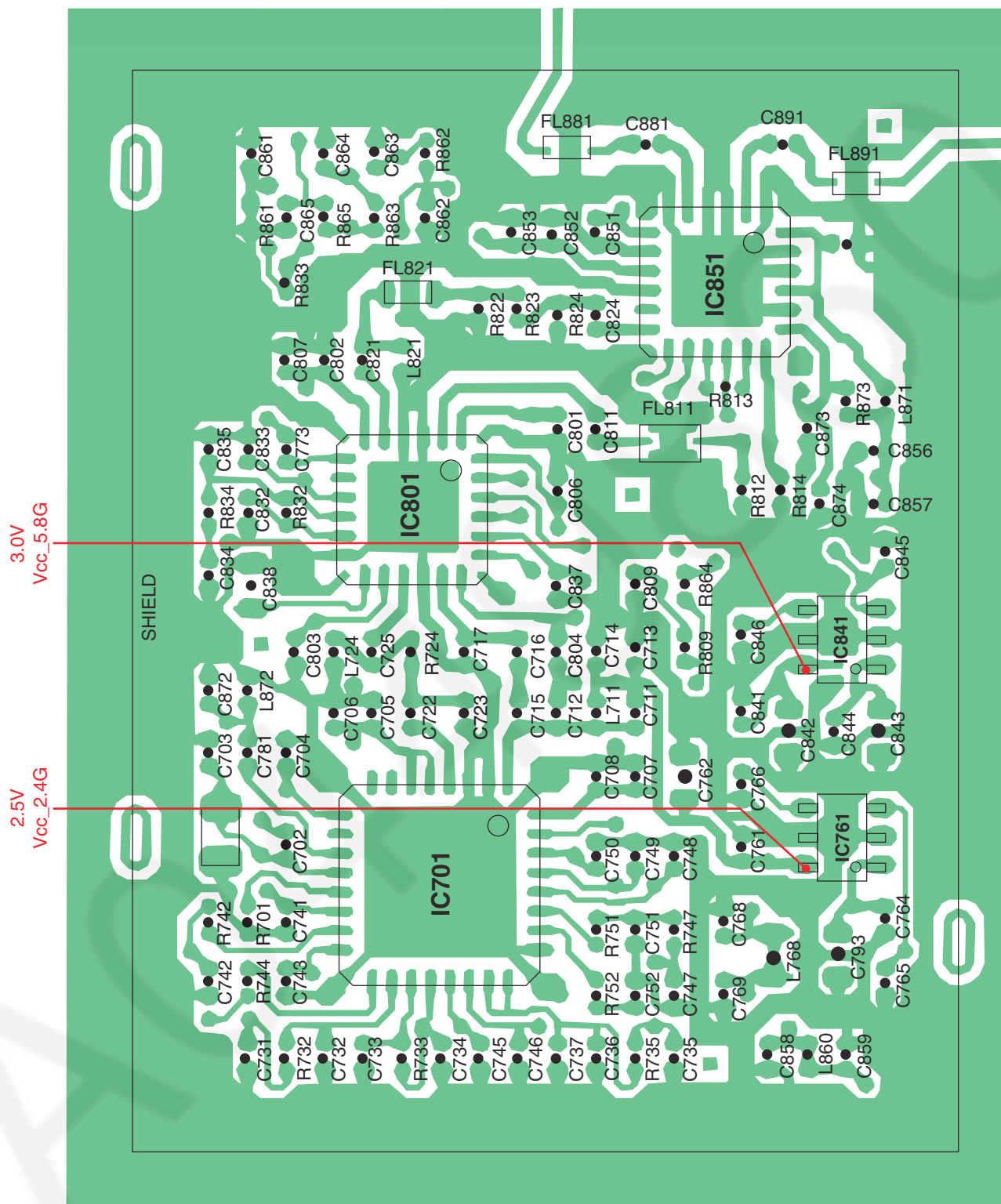


14.1.2. Flow Solder Side View



KX-TG6700/6702 CIRCUIT BOARD (Base Unit (Flow Solder Side View))

14.2. Circuit Board (Base Unit_RF Part)



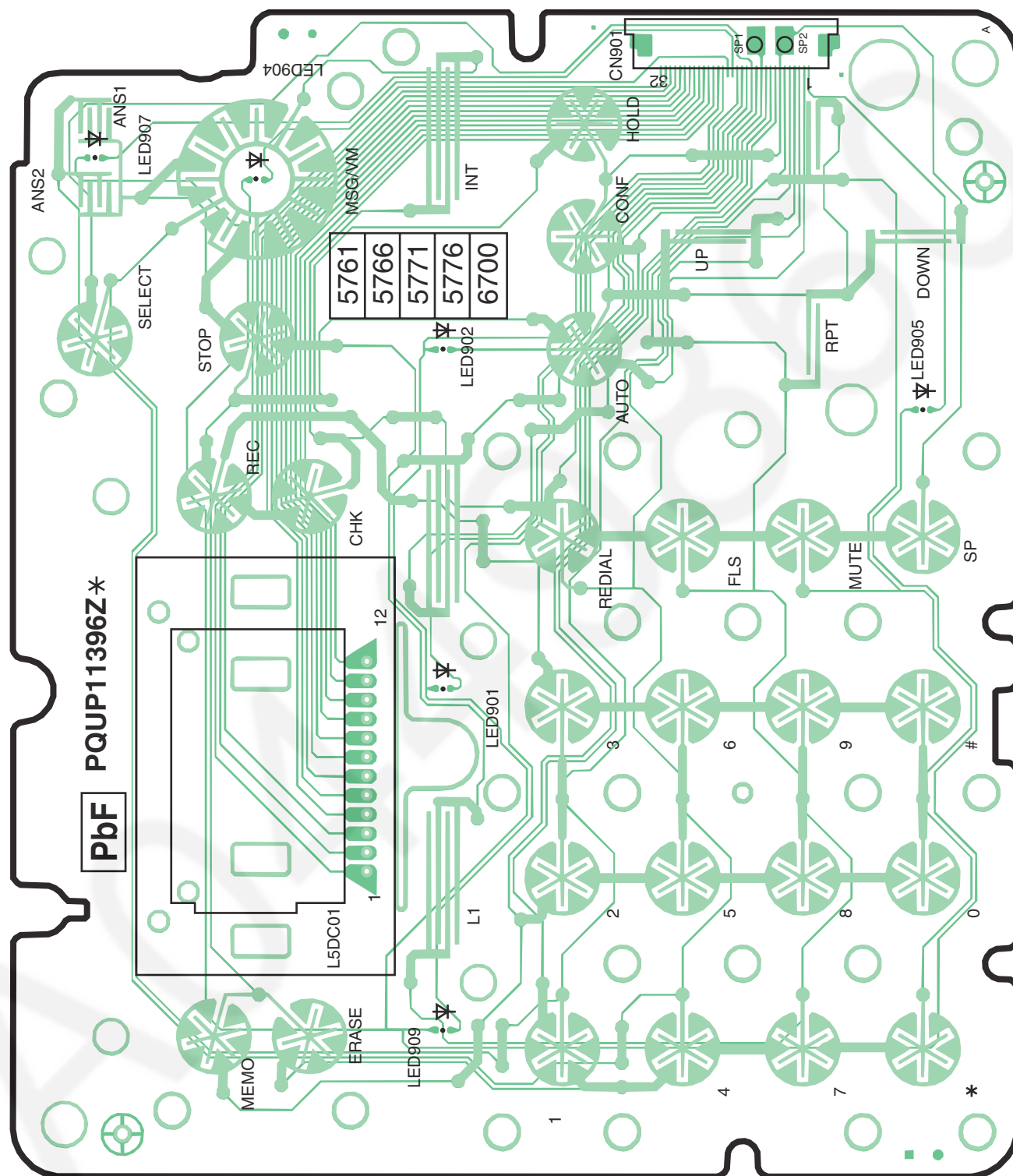
KX-TG6700/6702 CIRCUIT BOARD (Base Unit_RF Part (Component View))

Memo

A0449860

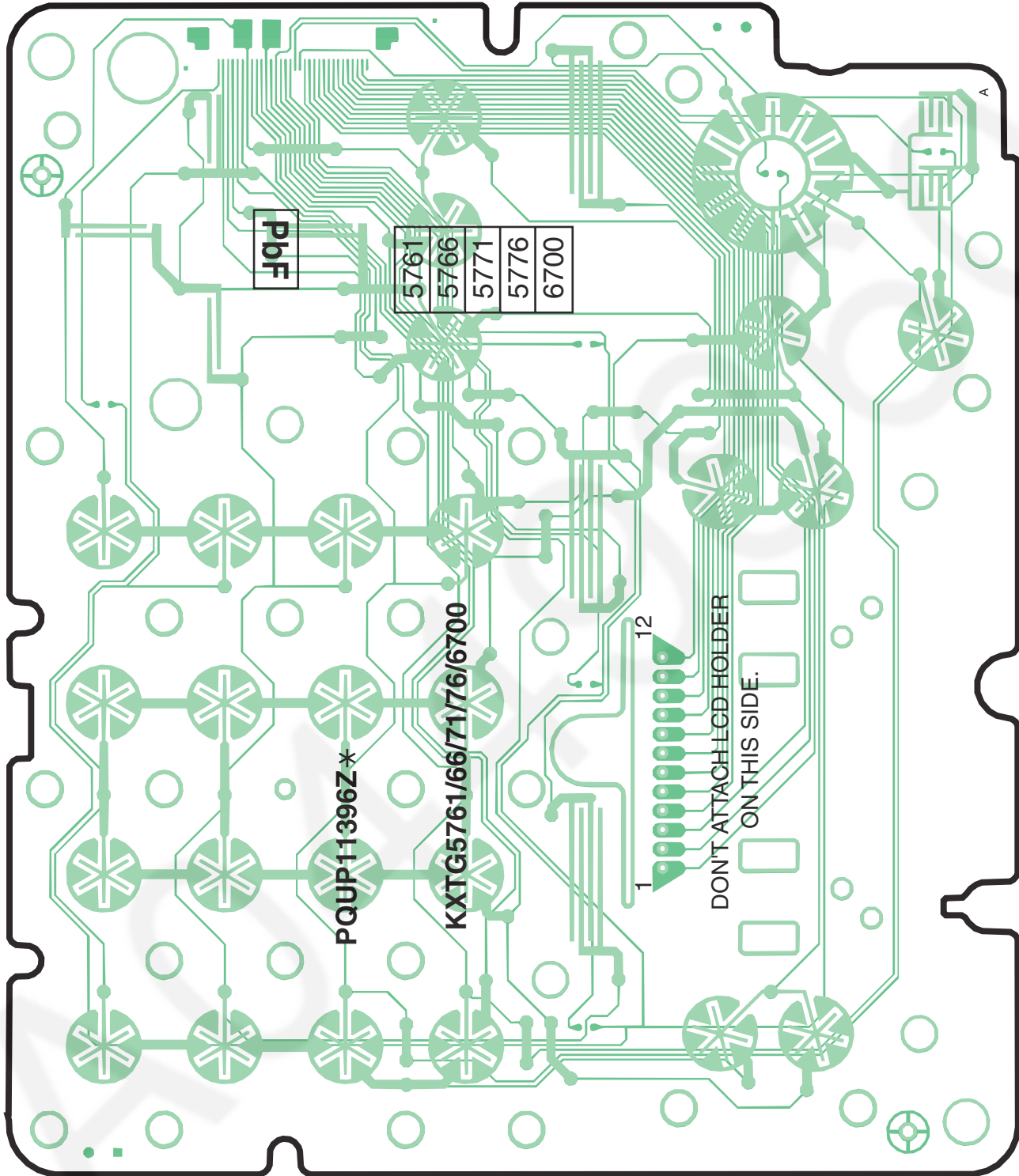
14.3. Circuit Board (Base Unit_Operation)

14.3.1. Component View



KX-TG6700/6702 CIRCUIT BOARD (Base Unit_Operation (Component View))

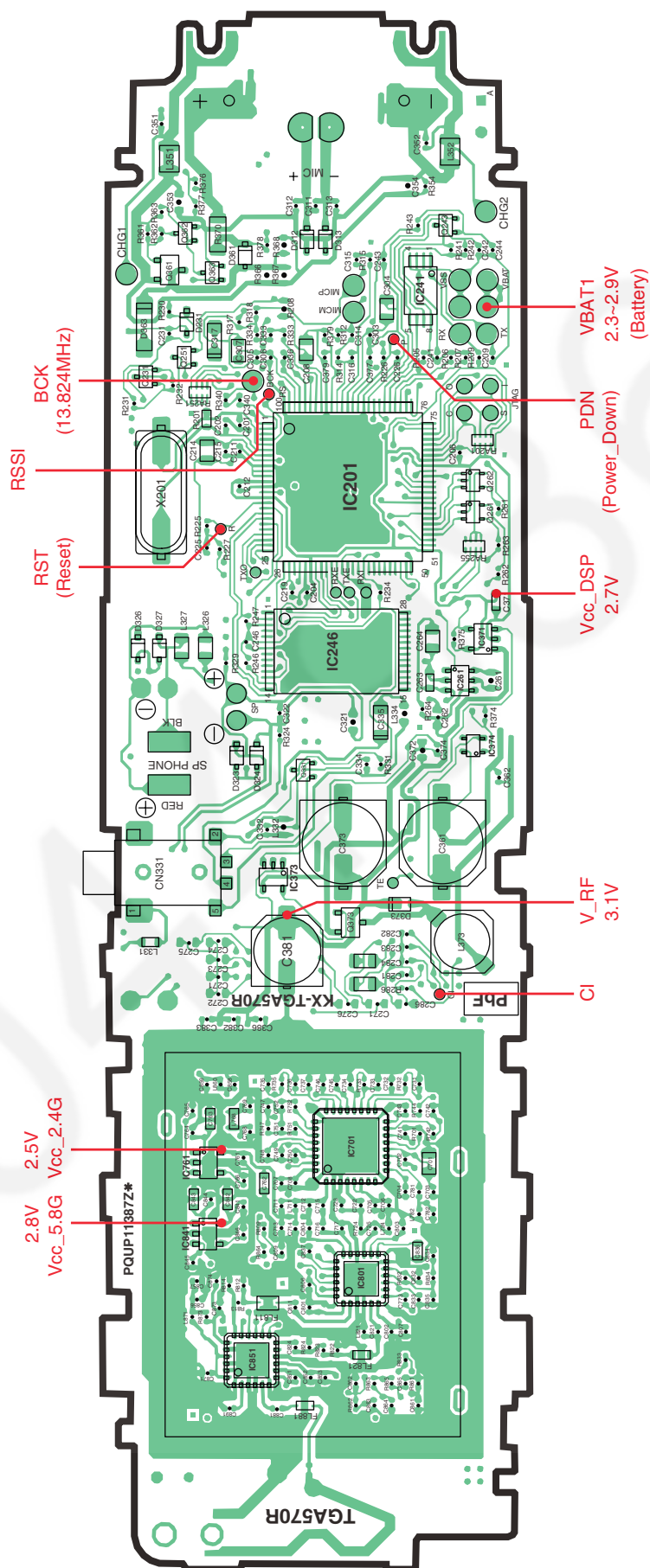
14.3.2. Flow Solder Side View



KX-TG6700/6702 CIRCUIT BOARD (Base Unit_Operation (Flow Solder Side View))

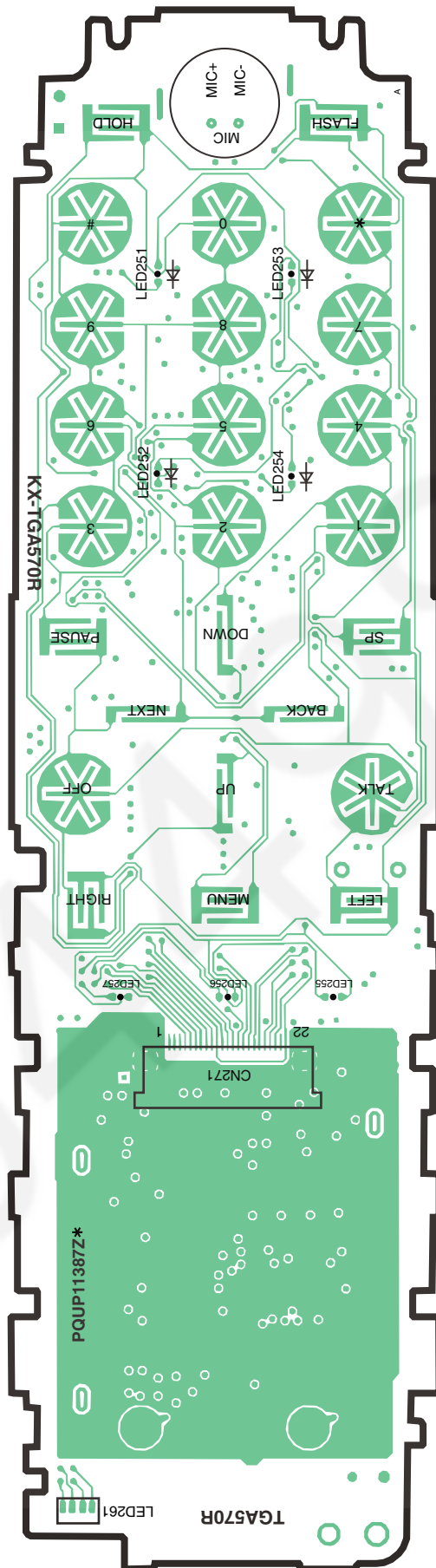
14.4. Circuit Board (Handset_Main)

14.4.1. Component View



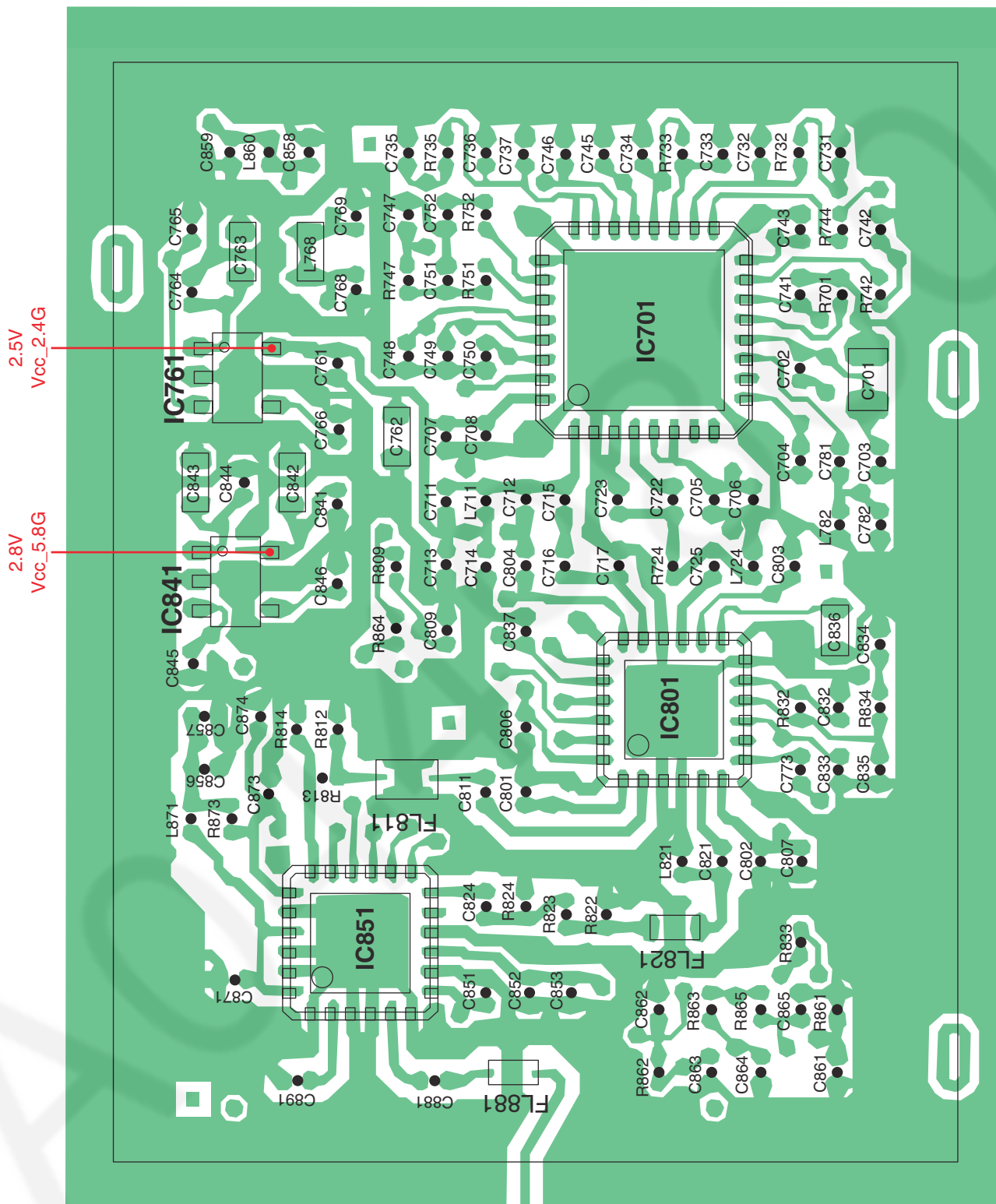
KX-TGA670 CIRCUIT BOARD (Handset_Main (Component View))

14.4.2. Flow Solder Side View



KX-TGA670 CIRCUIT BOARD (Handset_Main (Flow Solder Side View))

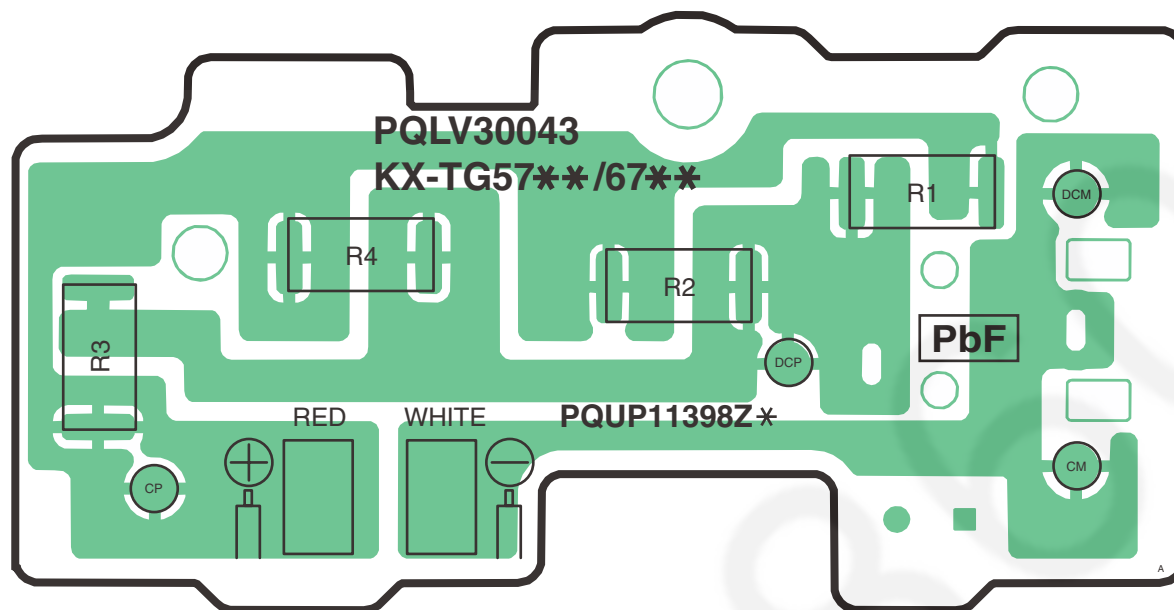
14.5. Circuit Board (Handset_RF Part)



KX-TGA670 CIRCUIT BOARD (Handset_RF Part (Component View))

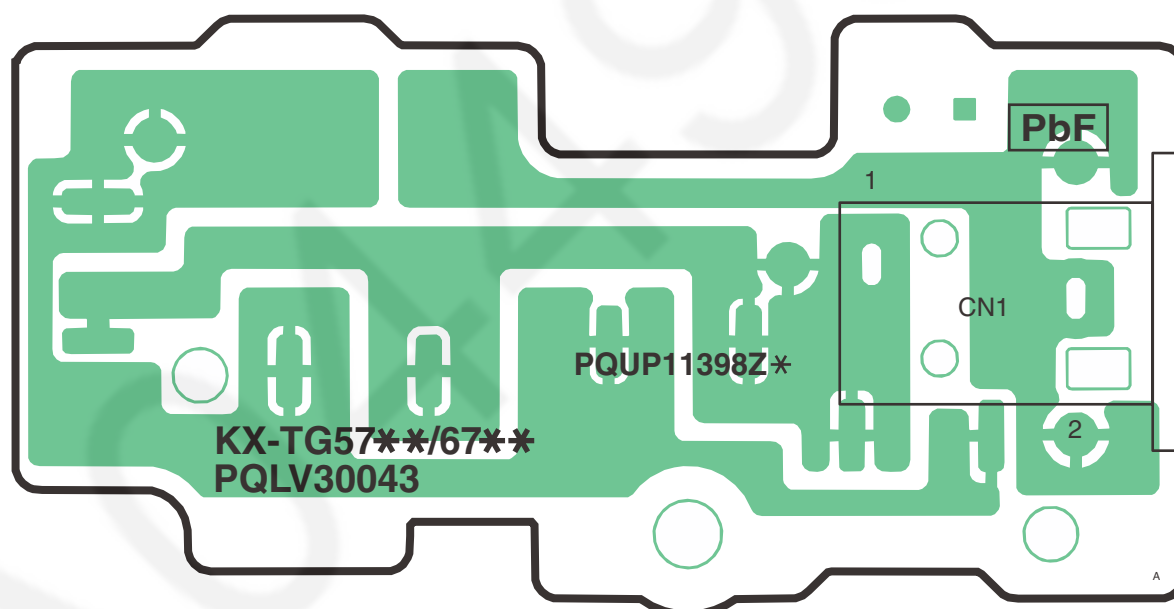
14.6. Circuit Board (Charger Unit)

14.6.1. Component View



CIRCUIT BOARD (Charger Unit (Component View))

14.6.2. Flow Solder Side View



CIRCUIT BOARD (Charger Unit (Flow Solder Side View))

15 Appendix Information of Schematic Diagram

15.1. CPU Data (Base Unit)

15.1.1. IC501

PIN	Description	I/O	High	High_Z	Low
1	L2_LOUT1	A.O			
2	LOUT0	A.O			
3	NC	A.O			
4	NC	A.O			
5	VCCPA	VCC			
6	SPOUTN	A.O			
7	GNDPA	GND			
8	SPOUTP	A.O			
9	NC	A.O			
10	BMCCLK	A.O			
11	NC	A.O			
12	NC	A.O			
13	RSSI	A.I			
14	NC	A.O			
15	XIN	A.I			
16	XOUT	A.O			
17	VDD	VDD			
18	VCCIN	VCC			
19	GND	GND	--	--	GND
20	NC	D.O	--	--	--
21	NC	D.O	--	--	--
22	VCC	VCC	VCC	--	--
23	Reset	D.I	Normal	--	Reset
24	FLASH_RST	*	High	Middle	Low
25	FLASH_SO	*	High	Middle	Low
26	FLASH_SI	*	High	Middle	Low
27	FLASH_CS	*	High	Middle	Low
28	NC	D.O	--	--	--
29	SYN_OUT	D.I	High	--	Low
30	TX_OUT	D.O	High	--	Low
31	PA_CONT	D.O	Low Power	--	High Power
32	SYN_LE2	D.O	Not	--	Active
33	AC_DOWN_DET	D.I	High	--	Low
34	RF_RST	D.O	Normal	--	WakeUp
35	RADIO_EN	D.O	Active	--	Not
36	NC	D.O	--	--	--
37	SHCTRL	D.O	Active	--	Not
38	ANT0	D.O	On	--	Off
39	ANT1	D.O	On	--	Off
40	GND	GND	--	--	GND
41	VCC	VCC	VCC	--	--
42	SYN_LE1	D.O	Not	--	Active
43	SYN_CLK	D.O	High	--	Low
44	SYN_DATA	D.O	High	--	Low
45	RXEN	D.O	Active	--	Off
46	TXEN	D.O	Active	--	Off
47	RXGAIN	D.O	High	--	Low
48	RX_DATA	D.I	High	--	Low
49	SEG12	D.O	High	--	Low
50	SEG11	D.O	High	--	Low
51	SEG10	D.O	High	--	Low
52	SEG9	D.O	High	--	Low
53	SEG8	D.O	High	--	Low
54	SEG7	D.O	High	--	Low
55	SEG6	D.O	High	--	Low
56	SEG5/ EROM_DATA	D.O	High	--	Low
57	SEG4/EROM_CLK	D.O	High	--	Low
58	SEG3/EROM_WP	D.O	High	--	Low

PIN	Description	I/O	High	High_Z	Low
59	SP_LED	D.I.O	--	Off	On
60	GND	GND	--	--	GND
61	VCC	VCC	VCC	--	--
62	INT0 (NC)	D.O	--	--	--
63	FLASH_CLK	*	High	Middle	Low
64	KEY_STB_F	D.O	Active	Not	--
65	KEY_STB_E	D.O	Active	Not	--
66	KEY_STB_D	D.O	Active	Not	--
67	KEY_STB_C	D.O	Active	Not	--
68	KEY_STB_B	D.O	Active	Not	--
69	KEY_STB_A	D.O	Active	Not	--
70	LINE_SZ	D.O	On	--	Off
71	NOT_RLY	D.O	On Hook	--	Off Hook
72	BELL	D.I	OFF	--	ON
73	RLY	D.O	Off Hook	--	On Hook
74	KEYIN6	D.I	Non	--	Key In
75	KEYIN5	D.I	Non	--	Key In
76	KEYIN4	D.I	Non	--	Key In
77	GND	GND	--	--	GND
78	VCC	VCC	VCC	--	--
79	KEYIN3	D.I	Non	--	Key In
80	KEYIN2	D.I	Non	--	Key In
81	KEYIN1	D.I	Non	--	Key In
82	VDD	D.O	--	--	--
83	NC	D.O	--	--	--
84	NC	D.O	--	--	--
85	L2_BELL	D.I	OFF	--	ON
86	L2_RLY	D.O	Off Hook	--	On Hook
87	L2_LINE_SZ	D.O	On	--	Off
88	L2_NOT_RLY	D.O	On Hook	--	Off Hook
89	NC	D.O	--	--	--
90	NC	D.O	--	--	--
91	NC	D.O	--	--	--
92	GND	GND	--	--	GND
93	VCC	VCC	VCC	--	--
94	T_CLK (JTAG)	D.I	--	--	--
95	T_MODE_SEL (JTAG)	D.I	--	--	--
96	T_D_IN (JTAG)	D.I	--	--	--
97	T_D_OUT (JTAG)	D.O	--	--	--
98	L2_LED	D.I.O	--	Off	On
99	CHARGE_DET	D.I	Off Charge	--	On Charge
100	L1_LED	D.I.O	--	Off	On
101	COM1	D.I.O	High	Middle	Low
102	COM2	D.I.O	High	Middle	Low
103	INT1	D.O	--	--	--
104	NC	D.O	--	--	--
105	INUSE_LED	D.I.O	--	Off	On
106	ANS_LED	D.I.O	--	Off	On
107	UART_TX	D.O	High	--	Low
108	UART_RX	D.I	High	--	Low
109	MSG_LED	D.I.O	--	Off	On
110	NC	D.O	--	--	--
111	GND	GND	--	--	GND
112	PDN	A.I			
113	DCIN1	A.I			
114	VREF	A.O			
115	MIP	A.I			
116	MIN	A.I			
117	NC	A.O			
118	L2_CID IN0	A.I			
119	L2_CID IN1	A.I			

PIN	Description	I/O	High	High_Z	Low
120	L2_LIN1	A.I			
121	GND A	GND			
122	CID IN0	A.I			
123	CID IN1	A.I			
124	VCCA	VCC			
125	NC	A.O			
126	NC	A.O			
127	LIN0	A.I			
128	L2_DCIN0	A.I			

Note:

- The mark “*” in the I/O column means the port is controlled by the firmware.
- Data in the blank columns are omitted because of the Analog I/O.

15.2. CPU Data (Handset)

15.2.1. IC201

PIN	Description	I/O	High	High_Z	Low
1	SPOUTP	A.O			
2	BCLK	A.O			
3	NC	A.O			
4	RSSI	A.I			
5	XIN	A.I			
6	XOUT	A.O			
7	VDD	VDD	--	--	VDD
8	VCC	VCC	VCC	--	--
9	GND	GND	--	--	GND
10	GND	I/O	--	--	--
11	GND	I/O	--	--	--
12	VCC	VCC	VCC	--	--
13	DCDCGND	A.O			
14	KEY_BL	A.O	--	On	Off
15	DCDCOUT	A.O			
16	RSTN	D.I	Normal	--	Reset
17	NC (FLASH_RESET)	D.O	--	--	Low
18	NC (FLASH_DO)	D.O	--	--	Low
19	NC (FLASH_DI)	D.O	--	--	Low
20	NC (FLASH_CS)	D.O	--	--	Low
21	NC	D.O	--	--	Low
22	SERIAL_DI	D.I	High	--	Low
23	TXOUT	D.O	High	--	Low
24	PA_CTRL	D.O	High	--	Low
25	SYN_LE2	D.O	Latch	--	Normal
26	CON_EN	D.O	High	--	Low
27	RF_RESET	D.O	Normal	--	Reset
28	NC	D.O	--	--	Low
29	SHCTRL	D.O	On	--	Off
30	GND	GND	--	--	GND
31	VCC	VCC	VCC	--	--
32	SERIAL_LE	D.O	Latch	--	Normal
33	SERIAL_CLK	D.O	High	--	Low
34	SERIAL_DATA	D.O	High	--	Low
35	RXEN	D.O	Active	--	Off
36	TXEN	D.O	Active	--	Off
37	RXGAIN	D.O	High	--	Low
38	RXI	D.I	High	--	Low
39	NC	D.O	High	--	--
40	NC	D.O	High	--	--
41	CHG_DET	D.I	Off Charge	--	On Charge
42	NC	D.O	--	--	Low
43	NC	D.O	--	--	Low
44	NC	D.O	--	--	Low
45	NC	D.O	--	--	Low
46	NC	D.O	--	--	Low
47	NC	D.O	--	--	Low
48	LCD_SCL	D.O	High	--	Low
49	LCD_SI	D.O	High	--	Low
50	GND	GND	--	--	GND
51	VCC	VCC	VCC	--	--
52	LCD_RESET	D.O	Normal	--	Reset
53	NC (FLASH_CLK)	D.O	High	--	--
54	NC (ANT_LED1)	D.O	--	--	Low
55	NC (ANT_LED2)	D.O	--	--	Low
56	ANT_LED	D.O	On	--	Off
57	LCD_BL	D.O	On	--	Off
58	LCD_CS	D.O	High	--	Low
59	NC	D.O	--	--	Low
60	LCD_A0	D.O	High	--	Low

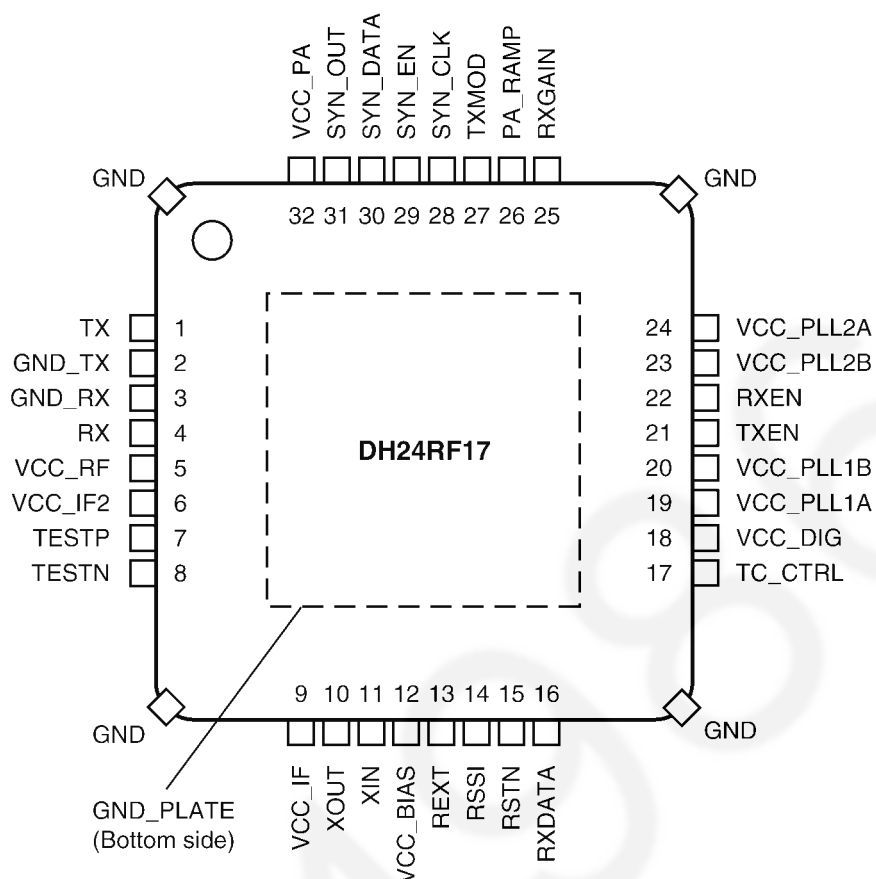
PIN	Description	I/O	High	High_Z	Low
61	NC (LED_CTRL)	D.O	--	--	Low
62	STB_E	D.O	--	Not	Active
63	STB_D	D.O	--	Not	Active
64	STB_C	D.O	--	Not	Active
65	STB_B	D.O	--	Not	Active
66	STB_A	D.O	--	Not	Active
67	GND	GND	--	--	GND
68	VCC	VCC	VCC	--	--
69	TCK	D.I	--	--	--
70	TMS	D.I	--	--	--
71	TDI	D.I	--	--	--
72	TDO	D.O	--	--	--
73	KIN_1	D.I	Non	--	Key In
74	KIN_2	D.I	Non	--	Key In
75	KIN_3	D.I	Non	--	Key In
76	KIN_4	D.I	Non	--	Key In
77	KIN_5	D.I	Non	--	Key In
78	MICPWR	D.O	On	--	Off
79	CHG_CTRL	D.O	Trickle	--	Normal
80	EEP_SCL	D.O	High	--	Low
81	EEP_SDA	D.I.O	High	--	Low
82	UART_TX	D.O	--	--	--
83	UART_RX	D.I	--	--	--
84	EEP_WP	D.O	WP	--	Write
85	GND	GND	--	--	GND
86	PDN	A.I			
87	IBAT1	A.I			
88	VREF	A.O			
89	MIP	A.O			
90	MIN	A.O			
91	IBAT2	A.I.O			
92	GNDA	GNDA	--	--	GNDA
93	VCCA	VCCA	VCCA	--	--
94	HEADSET_MIN	A.I			
95	HEADSET_DET	A.I			
96	HSSPOUTN	A.O			
97	HSSPOUTP	A.O			
98	VCCPA	VCCPA	VCCPA	--	--
99	SPOUTN	A.O			
100	GNDDPA	GNDDPA	--	--	GNDDPA

Note:

- Data in the blank columns are omitted because of the Analog I/O.

15.3. Explanation of IC Terminals (RF Part)

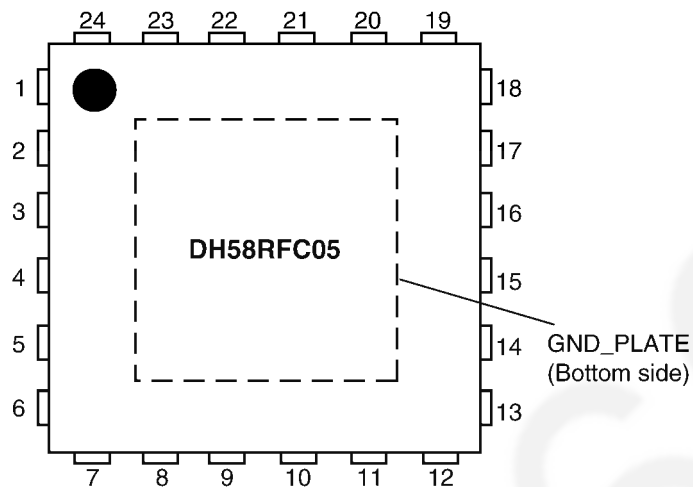
15.3.1. IC701



Pin	Description	I/O
1	TX	O & VCC
2	GND_TX	GND
3	GND_RX	GND
4	RX	I
5	VCC_RF	VCC
6	VCC_IF2	VCC
7	TESTP	O
8	TESTN	O
9	VCC_IF	VCC
10	XOUT	XI/XO
11	XIN	XI/XO
12	VCC_BIAS	VCC
13	REXT	I
14	RSSI	O
15	RSTN	I
16	RXDATA	O
17	TC_CTRL	I

Pin	Description	I/O
18	VCC_DIG	VCC
19	VCC_PLL1A	VCC
20	VCC_PLL1B	VCC
21	TXEN	I
22	RXEN	I
23	VCC_PLL2B	VCC
24	VCC_PLL2A	VCC
25	RXGAIN	I
26	PA_RAMP	I
27	TXMOD	I
28	SYN_CLK	I
29	SYN_EN	I
30	SYN_DATA	I
31	SYN_OUT	O
32	VCC_PA	VCC
	GND_PLATE	GND

15.3.2. IC801

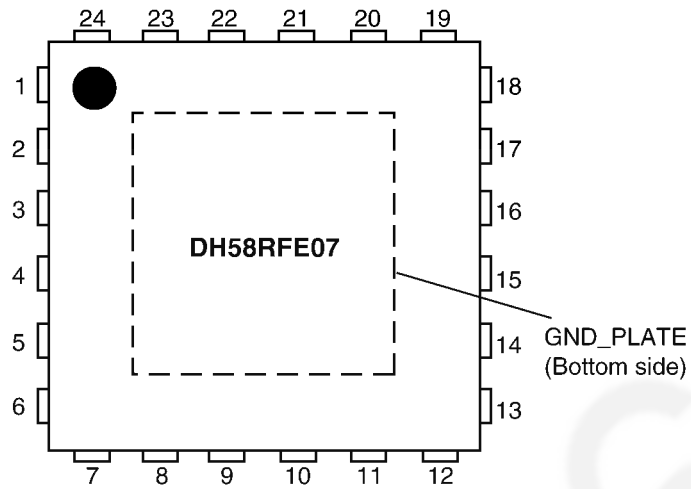


Pin	Description	I/O
1	VCC_PA2	VCC
2	TX	O
3	GND_ISOL1	GND
4	GND_ISOL2	GND
5	RX	I
6	VCC_LNA	VCC
7	REFIN	I
8	REFOUT	O
9	RXGAIN	I
10	CP_OUT	O
11	TV_IN	I
12	VARGND	GND
13	PLL_BYP	O

Pin	Description	I/O
14	VCC_PLL	VCC
15	2G4_OUT	O
16	GND_ISOL3	GND
17	2G4_IN	I
18	VCCTXRX	VCC
19	SYN_CLK	I
20	SYN_EN	I
21	SYN_DATA	I
22	RXEN	I
23	TXEN	I
24	VCC_PA1	VCC
GND_PLATE		GND

Backside Terminal: GND

15.3.3. IC851



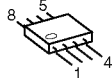
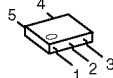
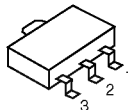
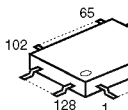
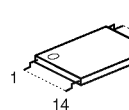
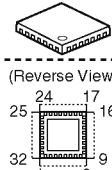
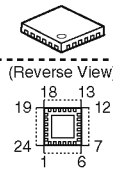
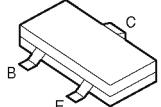
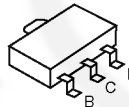
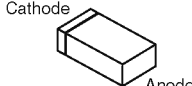
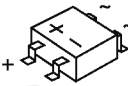
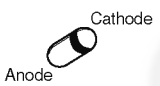
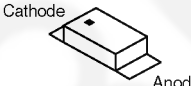
Pin	Description	I/O
1	GND_ISO	GND
2	ANT1	I/O
3 & 4	GND_ISO	GND
5	ANT2	I/O
6	GND_ISO	GND
7	VDD_LNA1	VDD
8	GND_LNA1	GND
9	VDD_LNA2	VDD
10	GND_LNA2	GND
11	NC	-
12	LNA_OUT	O
13	LNA_GAIN	I

Pin	Description	I/O
14	LNA_EN	I
15	ANTSEL_B	I
16	ANTSEL_A	I
17	PA_EN	I
18	PA_IN	I
19	VDD_PA	VDD
20	GND_ISO	GND
21	PA_OUT	VDD/O
22 & 23	GND_ISO	GND
24	TRSW_IN	I
GND_PLATE		GND

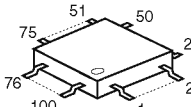
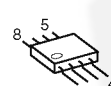
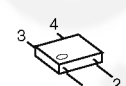
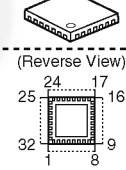
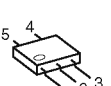
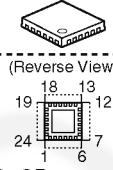
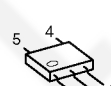
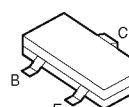
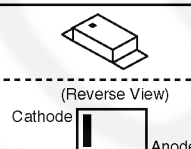
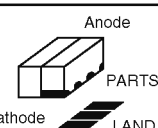
Backside Terminal: GND

15.4. Terminal Guide of the ICs, Transistors and Diodes

15.4.1. Base Unit

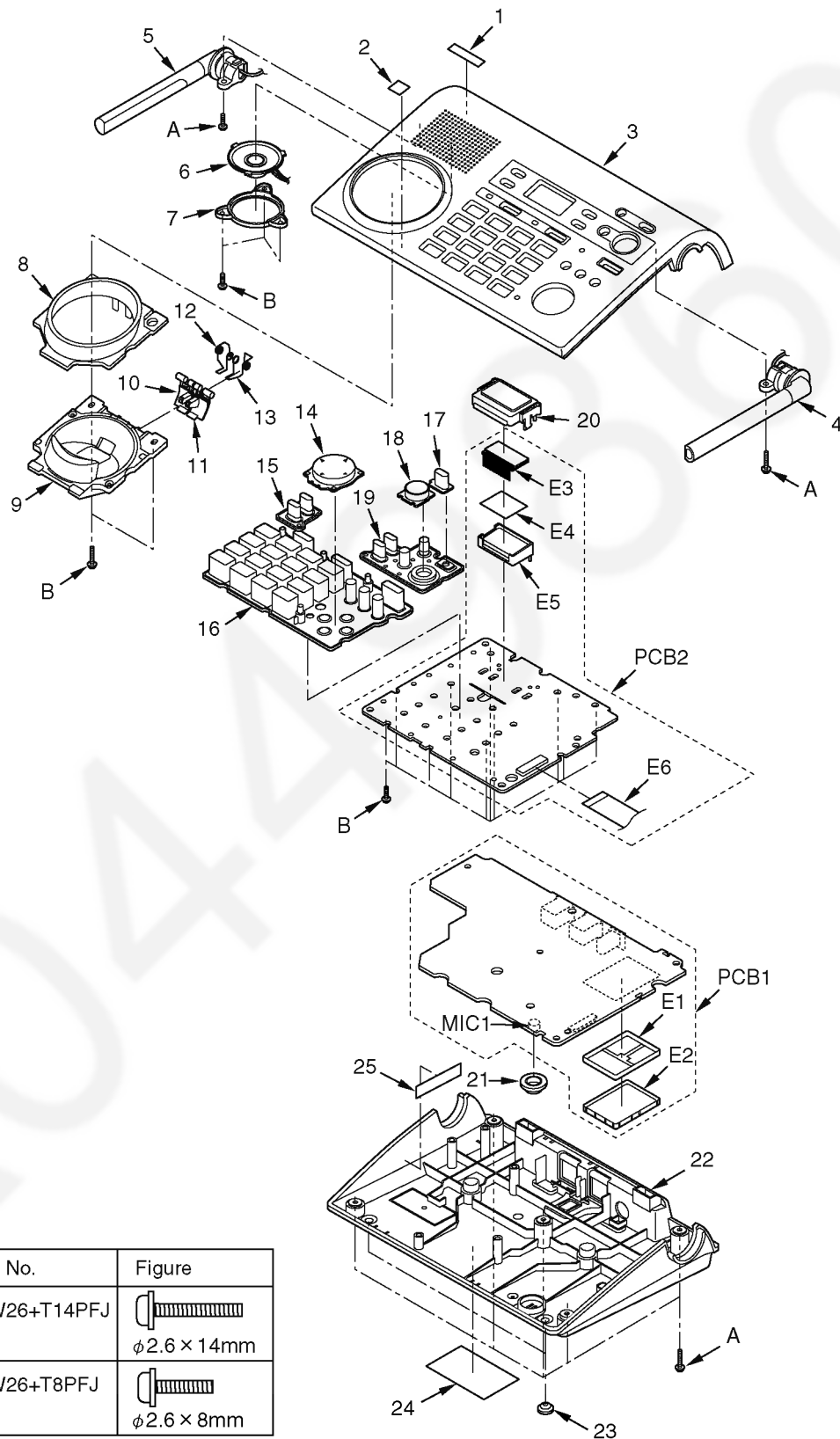
 C0ABBA000024 C0DBFGD00017	 C0CBCCC00035 C0DBAGZ00023 C0CBAAC00083 C0CBABE00029	 C0CBABD00028	 C2HBBY000041	 PQWITG6700BH
 (Reverse View) C1CB00001657	 (Reverse View) C1CB00001682 C1CB00002281	 UN5213, B1CHND000004 2SD1819A, 2SB1218A		 B1ADGP000008 2SD0874AS B1BBAP000021
 MA111, MA8220 B0JCME000035 B0ECKM000008	 MAZ805100L PQVDMDS B0EDER000009	 PQVDRLZ20A	 LNJ326W83RA LNJ826W83RA	 MA153

15.4.2. Handset

 C2HBBY000040	 PQWITG6700BR	 C0EBD0000355	 C1CB00001657	 C0CBCAC00253 C0EBY0000115 C0DBAYY00067 C0CBAAC00083
 C1CB00001682 C1CB00002281	 PSVTUMG11NTR	Cathode  Anode MA8047 MA2ZD0200L MA21D3400L B0BC5R400010	 PQVTDTC114TU, UN521 PQVTDTC143E, 2SD1819A PQVTDTC144TU, 2SB1197KQ PQVTDTC123JU, PQVTP151A13	
 Cathode Anode B3ACB0000115	Anode  Cathode LAND B3ACB0000175			

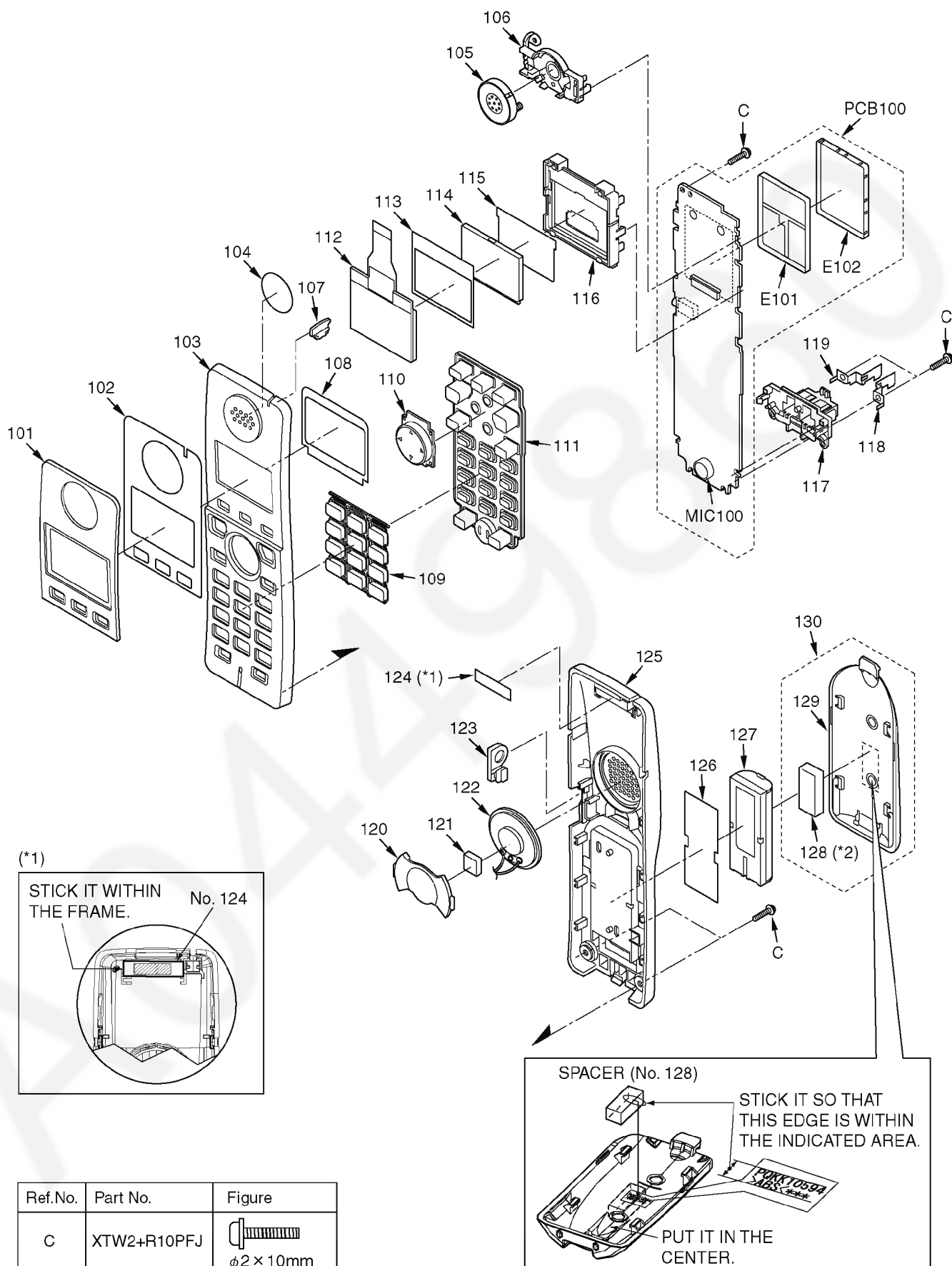
16 Exploded View and Replacement Parts List

16.1. Cabinet and Electrical Parts (Base Unit)



Ref.No.	Part No.	Figure
A	XTW26+T14PFJ	 φ2.6 × 14mm
B	XTW26+T8PFJ	 φ2.6 × 8mm

16.2. Cabinet and Electrical Parts (Handset)

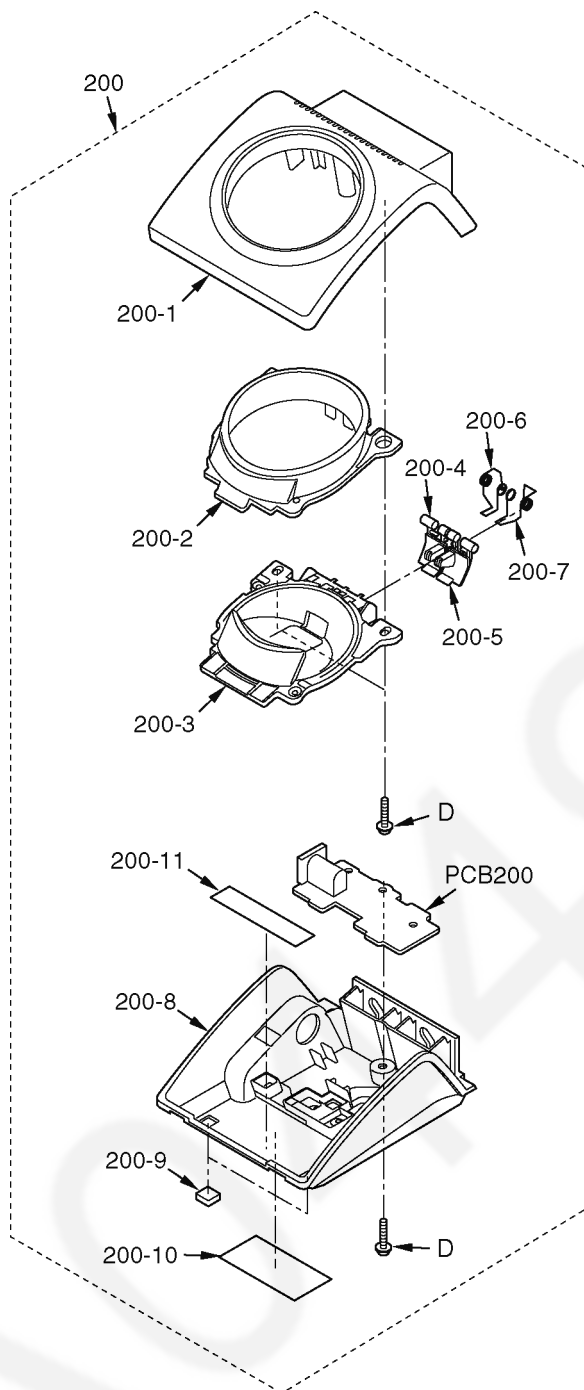


Note:

(*1) Stick the magnetic shield (No. 124) to the exact location described above.

(*2) Attach the cushion (No. 128) to the exact location described above.

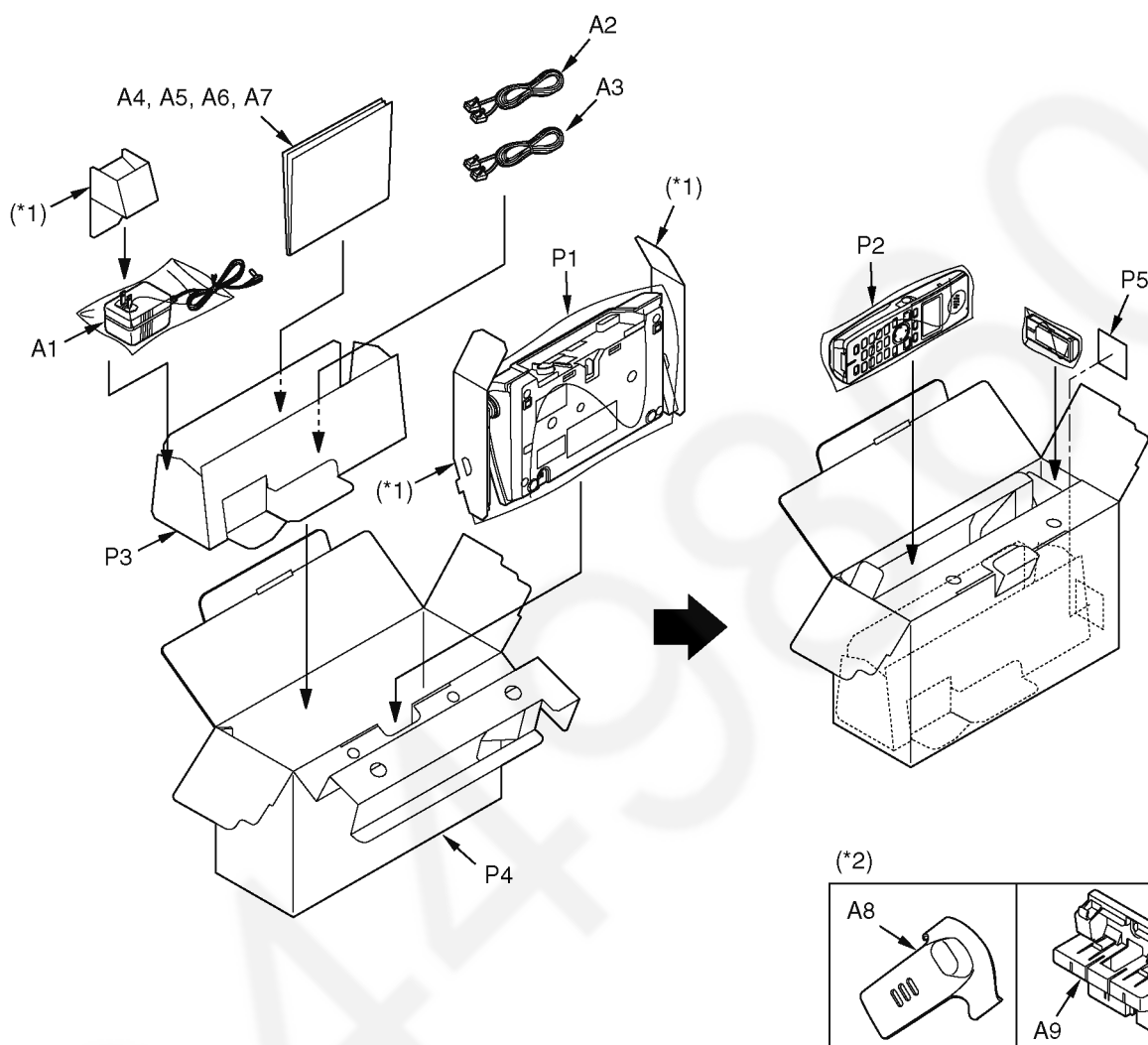
16.3. Cabinet and Electrical Parts (Charger Unit)



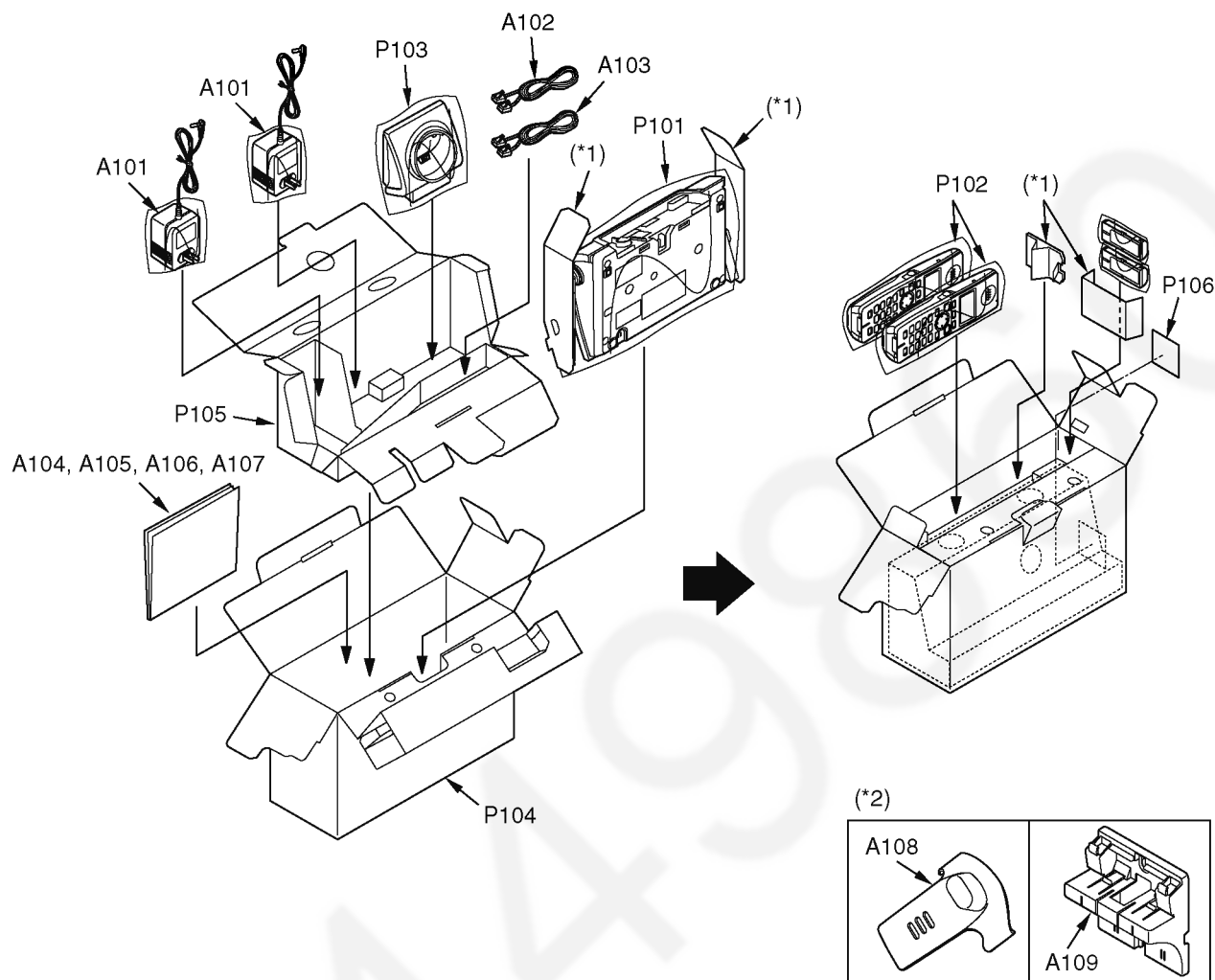
Ref.No.	Part No.	Figure
D	XTW26+T10PFJ	 φ2.6 × 10mm

16.4. Accessories and Packing Materials

16.4.1. KX-TG6700B



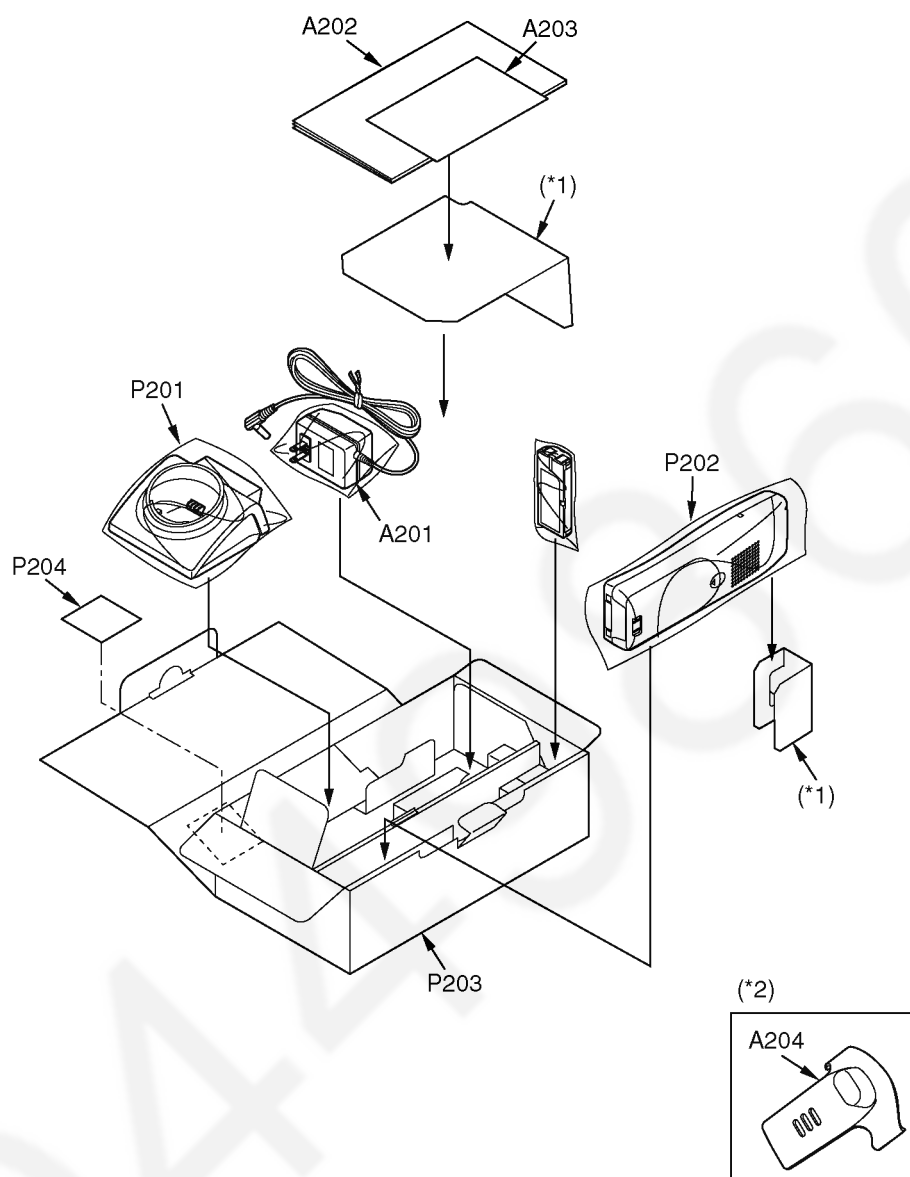
16.4.2. KX-TG6702B

**Note:**

(*) These pads are pieces of Ref No. P105 (ACCESSORY BOX).

(*) for Service

16.4.3. KX-TGA670B

**Note:**

(*)1 These pads are pieces of Ref No. P203 (GIFT BOX).

(*)2 for Service

16.5. Replacement Parts List

Note:

1. RTL (Retention Time Limited)

The marking (RTL) indicates that the Retention Time is limited for this item.

After the discontinuation of this assembly in production, the item will continue to be available for a specific period of time. The retention period of availability depends on the type of assembly and the laws governing parts and product retention.

At the end of this period, the assembly will no longer be available.

2. Important safety notice

Components identified by the Δ mark indicates special characteristics important for safety. When replacing any of these components, only use specified manufacture's parts.

3. The S mark means the part is one of some identical parts.

For that reason, it may be different from the installed part.

4. ISO code (Example: ABS-94HB) of the remarks column shows quality of the material and a flame resisting grade about plastics.

5. RESISTORS & CAPACITORS

Unless otherwise specified;

All resistors are in ohms (Ω) K=1000 Ω , M=1000k Ω

All capacitors are in MICRO FARADS (μ F) P= μ F

*Type & Wattage of Resistor

Type

ERC:Solid	ERX:Metal Film	PQ4R:Chip
ERDS:Carbon	ERG:Metal Oxide	ERS:Fusible Resistor
ERJ:Chip	ER0:Metal Film	ERF:Cement Resistor

Wattage

10,16:1/8W	14,25:1/4W	12:1/2W	1:1W	2:2W	3:3W
------------	------------	---------	------	------	------

*Type & Voltage Of Capacitor

Type

ECFD:Semi-Conductor	ECDD,ECKD,ECBT,F1K,ECUV: Ceramic
ECQS:Styrol	ECQE,ECQV,ECQG:Polyester
ECUV,PQCUV, ECUE:Chip	ECEA,ECST,EEE:Electlytic
EQMS:Mica	ECQP:Polypropylene

Voltage

ECQ Type	ECQG ECQV Type	ECSZ Type	Others		
1H:50V	05:50V	0F:3.15V	0J :6.3V	1V :35V	
2A:100V	1:100V	1A:10V	1A :10V	50,1H:50V	
2E:250V	2:200V	1V:35V	1C :16V	1J :16V	
2H:500V		0J:6.3V	1E,25:25V	2A :100V	

16.5.1. Base Unit

16.5.1.1. Cabinet and Electrical Parts

Ref. No.	Part No.	Part Name & Description	Remarks
1	PQQT23130Z	LABEL, URL	
2	PQQT23193Z	LABEL, CHARGE	
3	PQKM10717W2	CABINET BODY (for KX-TG6700B)	PS-HB
3	PQKM10717L2	CABINET BODY (for KX-TG6702B)	PS-HB
4	PFSA1060Z	ANTENNA (R)	
5	PFSA1061Z	ANTENNA (L)	
6	L0AA04A00028	SPEAKER	
7	PQHR11082Z	GUIDE, SP HOLDER	POM-HB
8	PQGG10411Z1	GRILLE, CRADLE	ABS-HB
9	PQKE10440Z2	CASE, CHARGE TERMINAL	PS-HB
10	PQKE10437Z1	HOLDER, CHARGE TERMINAL (L)	POM-HB
11	PQKE10438Z1	HOLDER, CHARGE TERMINAL (R)	POM-HB

Ref. No.	Part No.	Part Name & Description	Remarks
12	PQJT10241Z	CHARGE TERMINAL (L)	
13	PQJT10242Z	CHARGE TERMINAL (R)	
14	PQBC10473Y2	BUTTON, NAVI KEY	ABS-HB
15	PQSX10322Y	KEYBOARD SWITCH, MEMO	
16	PQSX10332Z	KEYBOARD SWITCH, DIAL	
17	PQBC10471Z1	BUTTON, ANSWER ON	ABS-HB
18	PQBC10472Z1	BUTTON, MESSAGE	ABS-HB
19	PQSX10321Z	KEYBOARD SWITCH, TAM	
20	PQGP10306Z1	PANEL, LCD	AS-HB
21	PQMG10025Z	RUBBER PARTS, MIC	
22	PQKF10707Y2	CABINET COVER	PS-HB
23	PQHA10011Z	RUBBER PARTS, FOOT CUSHION	
24	PQGT18754Z	NAME PLATE (for KX-TG6700B)	
24	PQGT19092Z	NAME PLATE (for KX-TG6702B)	
25	PQXDZLDRS1	LABEL, SECURITY TAG (for KX-TG6700B)	

16.5.1.2. Main P.C. Board Parts

Note:

(*1) When you have replaced IC501 or IC601, adjust X501.

Refer to **Check and Adjust X501 (Base Unit) Frequency (P.85)**.

(*2) When replacing IC701, IC801, or IC851, refer to **How to Replace the LLP (Leadless Leadframe Package) IC (P.79)**.

Ref. No.	Part No.	Part Name & Description	Remarks
PCB1	PQWP1TG6700H	MAIN P.C.BOARD ASS'Y (RTL)	
		(ICs)	
IC151	C0ABBA000024	IC	
IC251	C0ABBA000024	IC	
IC291	C0ABBA000024	IC	
IC300	C0DBAGZ00023	IC	S
IC321	C0CBCCC00035	IC	
IC331	C0DBFGD00017	IC	
IC381	C0CBABD00028	IC	
IC501	C2HBBY000041	IC (*1)	
IC601	PQWITG6700BH	IC (*1)	
IC701	C1CB00001657	IC (*2)	S
IC761	C0CBAAC00083	IC	
IC801	C1CB00001682	IC (*2)	
IC841	C0CBABE00029	IC	
IC851	C1CB00002281	IC (*2)	
		(TRANSISTORS)	
Q136	UN5213	TRANSISTOR (SI)	S
Q141	B1ADGP000008	TRANSISTOR (SI)	
Q142	B1BBAP000021	TRANSISTOR (SI)	
Q145	UN5213	TRANSISTOR (SI)	S
Q156	UN5213	TRANSISTOR (SI)	S
Q161	2SD0874AS	TRANSISTOR (SI)	
Q171	2SD1819A	TRANSISTOR (SI)	
Q236	UN5213	TRANSISTOR (SI)	S
Q241	B1ADGP000008	TRANSISTOR (SI)	
Q246	UN5213	TRANSISTOR (SI)	S
Q256	UN5213	TRANSISTOR (SI)	S
Q261	2SD0874AS	TRANSISTOR (SI)	
Q271	2SD0874AS	TRANSISTOR (SI)	
Q300	B1CHND000004	TRANSISTOR (SI)	
Q340	2SD1819A	TRANSISTOR (SI)	
Q361	2SB1218A	TRANSISTOR (SI)	
Q362	2SD1819A	TRANSISTOR (SI)	
		(DIODES)	
D101	PQVDM5S	DIODE (SI)	
D133	MA111	DIODE (SI)	S
D142	PQVDRLE220A	DIODE (SI)	S
D201	B0EDER000009	DIODE (SI)	
D242	PQVDRLE220A	DIODE (SI)	S
D300	B0JCME000035	DIODE (SI)	
D361	MA8220	DIODE (SI)	S

Ref. No.	Part No.	Part Name & Description	Remarks
D362	B0ECKM000008	DIODE (SI)	
D472	MAZ805100L	DIODE (SI)	
D473	MAZ805100L	DIODE (SI)	
DA213	MA153	DIODE (SI)	S
DA214	MA153	DIODE (SI)	S
		(COILS)	
L101	PQLQXF330K	COIL	S
L102	PQLQXF330K	COIL	S
L201	PQLQXF330K	COIL	S
L202	PQLQXF330K	COIL	S
L300	G1C220M00037	COIL	S
L361	G1C6R8MA0072	COIL	
L472	G1C6R8MA0072	COIL	
L473	G1C6R8MA0072	COIL	
L501	PQLQR2KA213	COIL	S
L711	MQLRF18NJFB	COIL	
L782	G1C1R0KA0096	COIL	
L871	MQLRF3N3DFB	COIL	
C723	MQLRF2N7DFB	COIL	
		(JACKS AND CONNECTOR)	
CN101	PQJJ1TB26Z	JACK	S
CN201	K2LB102B0053	JACK	
CN301	K2ECYB000001	JACK	
CN661	K1MY32BA0026	CONNECTOR	
		(LCR FILTERS)	
FL811	J0E5797B0001	LCR FILTER	
FL821	KNCFH165R8Z1	LCR FILTER	
FL881	J0E5797B0002	LCR FILTER	
FL891	J0E5797B0002	LCR FILTER	
		(THERMISTORS)	
P101	PFRT002	THERMISTOR (POSISTOR)	S
P201	PFRT002	THERMISTOR (POSISTOR)	S
		(PHOTO ELECTRIC TRANSDUCERS)	
PC111	ON3181R	PHOTO COUPLER	S
PC141	B3PBB0000039	PHOTO COUPLER	
PC211	ON3181R	PHOTO COUPLER	S
PC241	B3PBB0000039	PHOTO COUPLER	
		(COMPONENTS PARTS)	
RA500	D1H810440003	RESISTOR ARRAY	S
RA501	D1H84724A013	RESISTOR ARRAY	S
		(VARISTORS)	
SA101	J0LE00000047	VARISTOR (SURGE ABSORBER)	
SA104	J0LE00000047	VARISTOR (SURGE ABSORBER)	
SA201	J0LE00000047	VARISTOR (SURGE ABSORBER)	
SA202	J0LE00000047	VARISTOR (SURGE ABSORBER)	
		(I. F. TRANSFORMERS)	
T261	PQLT3E3A	I. F. TRANSFORMER	S
T281	PQLT3E3A	I. F. TRANSFORMER	S
		(RESISTORS)	
R104	ERJ3GEYJ472	4. 7K	
R108	ERJ3GEYJ472	4. 7K	
R111	PQ4R10XJ473	47K	S
R114	ERJ3GEYJ183	18K	
R121	ERJ3GEYJ394	390K	
R122	ERJ3GEYJ394	390K	
R131	ERJ3GEYJ106	10M	
R132	ERJ3GEYJ106	10M	
R133	ERJ3GEYJ825	8. 2M	
R134	ERJ3GEYJ825	8. 2M	
R135	ERJ3GEYJ824	820K	
R136	ERJ3GEYJ824	820K	
R137	ERJ3GEYJ103	10K	
R138	ERJ3GEYJ272	2. 7K	
R141	ERJ3GEYJ104	100K	
R144	ERJ3GEYJ104	100K	
R145	ERJ3GEYJ222	2. 2K	
R152	ERJ3GEYJ683	68K	
R154	ERJ3GEYJ473	47K	
R155	ERJ3GEYJ273	27K	
R156	ERJ3GEYJ103	10K	
R157	ERJ3GEYJ392	3. 9K	
R158	ERJ3GEYJ104	100K	
R159	ERJ3GEYJ102	1K	

Ref. No.	Part No.	Part Name & Description	Remarks
R160	ERJ3GEYJ152	1. 5K	
R162	ERJ3GEYJ393	39K	
R163	ERJ12YJ680	68	
R164	ERJ3GEYJ470	47	
R165	ERJ3GEYJ681	680	
R166	ERJ3GEYJ681	680	
R167	ERJ2GEJ102	1K	
R168	ERJ3GEY0R00	0	
R171	ERJ2GEJ560X	56	
R172	ERJ2GEJ104	100K	
R175	ERJ3GEYJ561	560	
R176	ERJ3GEYJ101	100	
R178	ERJ2GEJ102	1K	
R183	ERJ2GEJ222	2. 2K	
R185	ERJ3GEYJ333	33K	
R211	PQ4R10XJ473	47K	S
R212	ERJ3GEYJ183	18K	
R213	ERJ3GEYJ225	2. 2M	
R214	ERJ3GEYJ225	2. 2M	
R215	ERJ3GEYJ564	560K	
R216	ERJ3GEYJ564	560K	
R217	ERJ3GEYJ684	680K	
R218	ERJ3GEYJ104	100K	
R219	ERJ3GEYJ103	10K	
R231	ERJ3GEYJ106	10M	
R232	ERJ3GEYJ106	10M	
R233	ERJ3GEYJ825	8. 2M	
R234	ERJ3GEYJ825	8. 2M	
R235	ERJ3GEYJ824	820K	
R236	ERJ3GEYJ824	820K	
R237	ERJ3GEYJ103	10K	
R238	ERJ3GEYJ272	2. 7K	
R240	ERJ2GEJ102	1K	
R241	ERJ3GEYJ104	100K	
R242	ERJ3GEYJ103	10K	
R243	ERJ3GEYJ103	10K	
R245	ERJ2GEJ332	3. 3K	
R252	ERJ3GEYJ683	68K	
R254	ERJ3GEYJ473	47K	
R255	ERJ3GEYJ273	27K	
R256	ERJ3GEYJ103	10K	
R257	ERJ3GEYJ392	3. 9K	
R258	ERJ3GEYJ104	100K	
R260	ERJ3GEYJ152	1. 5K	
R262	ERJ3GEYJ393	39K	
R263	ERJ12YJ680	68	
R264	ERJ3GEYJ470	47	
R265	ERJ3GEYJ122	1. 2K	
R266	ERJ3GEYJ561	560	
R267	ERJ2GEJ102	1K	
R268	ERJ3GEY0R00	0	
R271	ERJ2GEJ680	68	
R272	ERJ2GEJ154	150K	
R275	ERJ2GEJ561	560	
R276	ERJ2GEJ101	100	
R278	ERJ2GEJ102	1K	
R283	ERJ3GEYJ272	2. 7K	
R285	ERJ3GEYJ682	6. 8K	
R289	ERJ3GEYJ683	68K	
R290	ERJ3GEYJ473	47K	
R291	ERJ3GEYJ683	68K	
R292	ERJ3GEYJ473	47K	
R293	ERJ3GEYJ473	47K	
R294	ERJ3GEYJ104	100K	
R295	ERJ3GEYJ684	680K	
R296	ERJ3GEYJ274	270K	
R297	ERJ3GEYJ103	10K	
R298	ERJ3GEYJ473	47K	
R300	ERJ3EKF5101	5. 1K	
R301	ERJ3GEYF393	39K	S
R303	ERJ3GEYJ221	220	
R304	ERJ3GEYJ221	220	
R308	ERJ3GEYJ121	120	

Ref. No.	Part No.	Part Name & Description	Remarks
R340	ERJ3GEYJ123	12K	
R341	ERJ3GEYJ182	1.8K	
R342	ERJ3GEYJ473	47K	
R361	ERJ3GEYJ332	3.3K	
R362	ERJ3GEYJ473	47K	
R364	ERJ3GEYJ103	10K	
R365	ERJ3GEYJ102	1K	
R371	ERJ1TYJ220	22	
R372	ERJ1TYJ220	22	
R421	ERJ2GEJ473	47K	
R422	ERJ2GEJ102	1K	
R423	ERJ2GEJ102	1K	
R453	ERJ2GEJ222	2.2K	
R454	ERJ2GEJ222	2.2K	
R459	ERJ2GEJ272	2.7K	
R460	ERJ2GEJ272	2.7K	
R472	ERJ2GEJ1R0	1	
R473	ERJ2GEJ1R0	1	
R517	ERJ3GEYJ100	10	
R533	ERJ2GEJ472X	4.7K	
R673	ERJ2GEJ681	680	
R675	ERJ2GEJ681	680	
R677	ERJ2GEJ221	220	
R679	ERJ2GEJ821	820	
R681	ERJ2GEJ561	560	
R683	ERJ2GEJ821	820	
R701	ERJ2RKF103X	10K	
R732	ERJ2GEJ100	10	
R733	ERJ2GEJ100	10	
R735	ERJ2GEJ4R7	4.7	
R742	ERJ2GEJ331	330	
R744	ERJ2GEJ102	1K	
R747	ERJ2GEJ102	1K	
R751	ERJ2GEJ102	1K	
R752	ERJ2GEJ102	1K	
R809	ERJ2GEJ561	560	
R813	ERJ2GEOR00	0	
R822	ERJ2GEJ271	270	
R823	ERJ2GEJ180	18	
R824	ERJ2GEJ271	270	
R832	ERJ2GEJ562X	5.6K	
R834	ERJ2GEJ332	3.3K	
R865	ERJ2GEJ271	270	
		(CAPACITORS)	
C101	F1K2J681A006	680P	
C102	F1K2J681A006	680P	
C111	F1L2E2240004	0.22	
C120	ECUV1H102KBV	0.001	
C121	ECUV1H681JCV	680P	S
C122	ECUV1H681JCV	680P	S
C135	ECUV1C104KBV	0.1	
C136	ECUV1C104KBV	0.1	
C138	ECUV1C104KBV	0.1	
C142	ECUV1H103KBV	0.01	
C152	ECUV1H220JCV	22P	
C161	EEE1EA100WR	10	
C162	ECUV1H101JCV	100P	
C163	ECUV1H472KBV	0.0047	
C165	ECUV1C473KBV	0.047	
C166	EEE1CA100SR	10	
C167	ECUV1A224KBV	0.22	
C172	F1G1H272A571	0.0027	
C176	EEE0JA220SR	22	
C178	ECJOEB1A333K	0.033	
C184	ECJOEB1A473K	0.047	
C185	ECJOEB1C183K	0.018	
C201	ECUV2H681KB	680P	S
C202	ECUV2H681KB	680P	S
C211	F1L2E2240004	0.22	
C213	ECUV1H101JCV	100P	
C214	ECUV1H101JCV	100P	
C218	ECST0JY106	10	
C235	ECUV1C104KBV	0.1	

Ref. No.	Part No.	Part Name & Description	Remarks
C236	ECUV1C104KBV	0.1	
C238	ECUV1C104KBV	0.1	
C242	ECUV1H103KBV	0.01	
C252	ECUV1H220JCV	22P	
C261	EEE1EA100WR	10	
C262	ECUV1H101JCV	100P	
C263	ECJ1VB1H472K	0.0047	
C264	EEE1CA100SR	10	
C265	ECUV1C473KBV	0.047	
C266	EEE1CA100SR	10	
C267	ECUV1A224KBV	0.22	
C272	F1G1H272A571	0.0027	
C276	EEE0JA220SR	22	
C278	ECUE1C223KBQ	0.022	S
C279	ECJOEB1C103K	0.01	
C280	F1G1A1040003	0.1	
C284	ECUV1C473KBV	0.047	
C285	ECUV1C473KBV	0.047	
C290	ECST0JY106	10	
C292	ECJ1VB1H682K	0.0068	
C296	ECUV1H681JCV	680P	S
C297	ECJ1VB1H682K	0.0068	
C298	ECUV1H272KBV	0.0027	
C300	EEEFK1C470P	47	
C302	ECUV1H332KBV	0.0033	
C303	ECUV1H103KBV	0.01	
C304	ECUV1A105KBV	1	
C305	ECUV1H103KBV	0.01	
C306	F2G1E1010011	100	S
C308	ECUV1E104KBV	0.1	
C322	PQCUV1A225KB	2.2	
C323	ECUV1C104KBV	0.1	
C331	ECUV1C474KBV	0.47	
C332	ECUV1A105KBV	1	
C341	EEE0JA331P	330	
C342	ECUV1A105KBV	1	
C347	ECUV1C104KBV	0.1	
C352	ECUV1C104KBV	0.1	
C361	ECJOEB1H102K	0.001	
C381	ECUV1A105KBV	1	
C382	F1K0J1060020	10	
C383	EEE0JA101SP	100	
C384	ECUV1A105KBV	1	
C422	ECJOEB1A104K	0.1	
C457	ECJOEB1C123K	0.012	
C458	ECJOEB1C123K	0.012	
C459	ECJOEB1C103K	0.01	
C501	ECUV1C104KBV	0.1	
C503	ECUV1C104KBV	0.1	
C504	ECUV1C104KBV	0.1	
C508	ECJOEC1H020C	2P	
C509	ECJOEC1H020C	2P	
C513	ECUV1C104KBV	0.1	
C515	ECUV1A105KBV	1	
C516	ECST0JY106	10	S
C517	ECUV1C104KBV	0.1	
C518	ECST0JY106	10	S
C521	ECJOEB1A104K	0.1	
C531	ECUV1C104KBV	0.1	
C601	ECJOEB1A104K	0.1	
C660	ECUV1C104KBV	0.1	
C663	ECJOEB1H102K	0.001	
C664	ECJOEB1H102K	0.001	
C665	ECJOEB1H102K	0.001	
C666	ECJOEB1H102K	0.001	
C667	ECJOEB1H102K	0.001	
C668	ECJOEB1H102K	0.001	
C669	ECJOEB1H102K	0.001	
C670	ECJOEB1H102K	0.001	
C671	ECJOEB1H102K	0.001	
C672	ECJOEB1H102K	0.001	
C684	ECJOEB1H331K	330P	
C685	ECJOEB1H331K	330P	

Ref. No.	Part No.	Part Name & Description	Remarks
C686	ECJ0EB1H331K	330P	
C687	ECJ0EB1H331K	330P	
C688	ECJ0EB1H331K	330P	
C689	ECJ0EB1H331K	330P	
C701	PQCUV0J475MB	4.7	
C702	ECJ0EB1A104K	0.1	
C704	ECJ0EB1H102K	0.001	
C705	ECJ0EC1H100D	10P	
C706	ECJ0EB1C103K	0.01	
C707	ECJ0EB1H102K	0.001	
C708	ECJ0EC1H1R5C	1.5P	
C711	ECJ0EC1H010C	1P	
C712	ECJ0EC1H020C	2P	
C713	ECJ0EC1H100D	10P	
C714	ECJ0EB1H102K	0.001	
C715	ECJ0EC1H050C	5P	
C716	ECJ0EC1H020C	2P	
C722	ECJ0EC1H020C	2P	
C725	ECJ0EC1H050C	5P	
C731	ECJ0EB1C103K	0.01	
C732	ECJ0EB1H102K	0.001	
C733	ECJ0EB1H102K	0.001	
C734	ECJ0EB1H102K	0.001	
C735	ECJ0EB1A104K	0.1	
C737	ECJ0EB1H102K	0.001	
C741	ECJ0EB1H222K	0.0022	
C742	ECJ0EB1C103K	0.01	
C743	ECJ0EC1H221J	220P	
C745	ECJ0EC1H101J	100P	
C746	ECJ0EC1H101J	100P	
C747	ECJ0EC1H100D	10P	
C748	ECJ0EC1H101J	100P	
C749	ECJ0EC1H101J	100P	
C750	ECJ0EC1H101J	100P	
C751	ECJ0EC1H100D	10P	
C752	ECJ0EB1H471K	470P	
C763	ECUV1A474KBV	0.47	
C764	ECJ0EC1H020C	2P	
C773	ECJ0EC1H101J	100P	
C781	ECJ0EB1A104K	0.1	
C782	ECJ0EC1H121J	120P	
C801	ECJ0EC1H030C	3P	
C802	ECJ0EC1H220J	22P	
C803	ECJ0EB1C103K	0.01	
C804	ECJ0EC1H150J	15P	
C806	ECJ0EC1H100D	10P	
C809	ECUE1A333KBQ	0.033	S
C811	ECJ0EC1H020C	2P	
C821	ECJ0EC1H100D	10P	
C824	ECJ0EC1H100D	10P	
C832	ECJ0EC1H221J	220P	
C833	ECJ0EC1H101J	100P	
C834	ECJ0EB1C103K	0.01	
C835	ECJ0EB1H471K	470P	
C836	ECUV1A105KBV	1	
C837	ECJ0EC1H101J	100P	
C842	ECUV1A105KBV	1	
C843	ECUV1A474KBV	0.47	
C844	ECJ0EC1H020C	2P	
C856	ECJ0EC1H020C	2P	
C857	ECJ0EB0J105K	1	
C865	ECUE1A333KBQ	0.033	S
C871	F1G1HR10A561	0.1P	
C873	ECJ0EC1H020C	2P	
C874	ECJ0EB0J105K	1	
C881	ECJ0EC1H010C	1P	
C891	ECJ0EC1H010C	1P	
		(OTHERS)	
MIC1	LOCBAB000052	MICROPHONE	
E1	PQMC10492Z	MAGNETIC SHIELD, FRAME	
E2	PQMC10491Z	MAGNETIC SHIELD, COVER	
X501	H0J138500003	CRYSTAL OSCILLATOR	

16.5.1.3. Operational P.C. Board Parts

Ref. No.	Part No.	Part Name & Description	Remarks
PCB2	PQWP2TG6700H	OPERATIONAL P.C.BOARD ASS'Y (RTL)	
		(DIODES)	
LED901	LNJ826W83RA	LED	
LED902	LNJ326W83RA	LED	
LED904	LNJ826W83RA	LED	
LED905	LNJ826W83RA	LED	
LED907	LNJ826W83RA	LED	
LED909	LNJ826W83RA	LED	
		(CONNECTOR)	
CN901	K1MY32BA0026	CONNECTOR	
		(OTHERS)	
E3	L5ACBCB00001	LIQUID CRYSTAL DISPLAY	
E4	PQHS10327Z	TAPE, LCD	
E5	PQHR11211Z	GUIDE, LCD	PS-HB
E6	PQJE10172X	LEAD WIRE, FFC	

16.5.2. Handset

16.5.2.1. Cabinet and Electrical Parts

Ref. No.	Part No.	Part Name & Description	Remarks
101	PQGP10310Z2	PANEL, LCD	AS-HB
102	PQHS10721Z	TAPE, DOUBLE SIDED	
103	PQKM10715Y2	CABINET BODY	ABS-HB
104	PQHS10658Z	SPACER, RECEIVER	
105	LOAD02A00035	RECEIVER	
106	PQHR11197Z	GUIDE, RECEIVER	ABS-HB
107	PQHR11196Z	OPTIC CONDUCTIVE PARTS, LED LENS	PS-HB
108	PQHS10722Z	SPACER, LCD CUSHION	
109	PQBX10390Z1	BUTTON, 12KEY	PMMA-HB
110	PQBC10458Y2	BUTTON, NAVI KEY	ABS-HB
111	PQSX10318Y	KEYBOARD SWITCH	
112	L5DZBY00003	LIQUID CRYSTAL DISPLAY	
113	PQHX11378Z	COVER, LCD COVER SHEET	
114	PQHR11195Z	TRANSPARENT PLATE, LCD PLATE	
115	PQHX11377Z	PLASTIC PARTS, LCD SHEET	
116	PQHR11194Z	GUIDE, LCD HOLDER	
117	PQWE10044Z	BATTERY TERMINAL	
118	PQJT10239Z	CHARGE TERMINAL (L)	
119	PQJT10240Z	CHARGE TERMINAL (R)	
120	PQHR11198Z	GUIDE, SP HOLDER	ABS-HB
121	PQHG10729Z	RUBBER PARTS, SPEAKER	
122	LOAD02A00026	SPEAKER	
123	PQKE10439Y3	COVER, E/P CAP	
124	PQMC10496Z	MAGNETIC SHIELD, ANTENNA	
125	PQKF10705Z2	CABINET COVER	ABS-HB
126	PQGT18755Z	NAME PLATE	
127	HHR-P105	BATTERY	
128	PQHG10734Z	SPACER, BATTERY	
129	PQKK10594Z2	LID, BATTERY COVER	ABS-HB
130	PQYNTG6700BR	LID, BATTERY COVER ASS'Y	ABS-HB

16.5.2.2. Main P.C. Board Parts

Note:

(*1) When you have replaced IC201 or IC241, adjust X201. Refer to **Check and Adjust X201 (Handset) Frequency (P.85)** and **Adjust Battery Low Detector Voltage (Handset) (P.85)**.

(*2) When replacing IC701, IC801, or IC851, refer to **How to Replace the LLP (Leadless Leadframe Package) IC (P.79)**.

Ref. No.	Part No.	Part Name & Description	Remarks
PCB100	PQWPTG6700BR	MAIN P.C.BOARD ASS'Y (RTL)	
		(ICs)	
IC201	C2HBBY000040	IC (*1)	
IC241	PQWITG6700BR	IC (*1)	
IC371	C0EBY0000115	IC	
IC373	C0DBAYY00067	IC	
IC374	C0EBD0000355	IC	
IC701	C1CB00001657	IC (*2)	S
IC761	C0CBAAC00083	IC	
IC801	C1CB00001682	IC (*2)	
IC841	C0CBCAC00253	IC	
IC851	C1CB00002281	IC (*2)	
		(TRANSISTORS)	
Q231	UN521	TRANSISTOR (SI)	S
Q243	PQVTDTC114TU	TRANSISTOR (SI)	S
Q251	PQVTDTC123JU	TRANSISTOR (SI)	S
Q262	PSVTUMG11NTR	TRANSISTOR (SI)	S
Q331	PQVTDTC143E	TRANSISTOR (SI)	S
Q361	2SB1197KQ	TRANSISTOR (SI)	S
Q362	2SD1819A	TRANSISTOR (SI)	
Q363	PQVTDTC144TU	TRANSISTOR (SI)	S
Q373	PQVTPX151A13	TRANSISTOR (SI)	S
		(DIODES)	
D312	MA8047	DIODE (SI)	S
D313	MA8047	DIODE (SI)	S
D323	MA8047	DIODE (SI)	S
D324	MA8047	DIODE (SI)	S
D326	MA8047	DIODE (SI)	S
D327	MA8047	DIODE (SI)	S
D361	MA2D0200L	DIODE (SI)	
D363	B0BC5R400010	DIODE (SI)	
D373	MA21D3400L	DIODE (SI)	
LED251	B3ACB0000115	LED	
LED252	B3ACB0000115	LED	
LED253	B3ACB0000115	LED	
LED254	B3ACB0000115	LED	
LED255	B3ACB0000115	LED	
LED256	B3ACB0000115	LED	
LED257	B3ACB0000115	LED	
LED261	B3ACB0000175	LED	
		(COILS)	
L326	G1CR47J00005	COIL	
L327	G1CR47J00005	COIL	
L331	PQLQR2KB113T	COIL	S
L332	PQLQR2KB113T	COIL	S
L334	PQLQR2KB113T	COIL	S
L373	G1C100MA0176	COIL	
L711	MQLRF18NJFB	COIL	
L782	G1C1R0KA0096	COIL	
L871	MQLRF3N3DFB	COIL	
C723	MQLRF2N7DFB	COIL	
		(CONNECTOR AND JACK)	
CN271	K1MY22BA0112	CONNECTOR	
CN331	K2HD103D0001	JACK	
		(LCR FILTERS)	
FL811	J0E5797B0001	LCR FILTER	
FL821	KNCFH165R821	LCR FILTER	
FL881	J0E5797B0002	LCR FILTER	
		(COMPONENTS PARTS)	
RA201	D1H84724A013	RESISTOR ARRAY	S
RA251	D1H83314A013	RESISTOR ARRAY	S
RA255	EXB28V221JX	RESISTOR ARRAY	
		(RESISTORS)	
R208	ERJ3GEYJ100	10	
R209	ERJ2GEJ104	100K	
R225	ERJ2GEJ102	1K	
R226	ERJ2GEJ223	22K	
R227	ERJ2GEJ104	100K	
R231	ERJ2GEJ223	22K	
R234	ERJ2GEJ103	10K	
R241	ERJ2GEJ103	10K	
R242	ERJ2GEJ102	1K	

Ref. No.	Part No.	Part Name & Description	Remarks
R243	ERJ2GEJ274	270K	
R261	ERJ2GEJ820	82	
R264	ERJ2GEOR00	0	
R286	ERJ2GEJ102	1K	
R312	ERJ2GEJ222	2.2K	
R314	ERJ2GEJ222	2.2K	
R315	ERJ2GEJ222	2.2K	
R317	ERJ2GEJ101	100	
R318	ERJ2GEJ222	2.2K	
R323	ERJ2GEJ220	22	
R324	ERJ2GEJ220	22	
R331	ERJ2GEJ103	10K	
R333	ERJ2GEJ102	1K	
R334	ERJ2GEJ222	2.2K	
R361	ERJ2GEJ473	47K	
R362	ERJ2GEJ102	1K	
R363	ERJ2GEJ473	47K	
R366	ERJ3GEYJ102	1K	
R370	ERJ8GEYJ1R2	1.2	
R374	ERJ2GEJ224	220K	
R375	ERJ2GEJ224	220K	
R376	ERJ2GEJ105X	1M	
R377	ERJ2GEJ225	2.2M	
R378	ERJ2GEJ105X	1M	
R379	ERJ2GEJ225	2.2M	
R701	ERJ2RKF103X	10K	
R732	ERJ2GEJ100	10	
R733	ERJ2GEJ100	10	
R735	ERJ2GEJ4R7	4.7	
R742	ERJ2GEJ331	330	
R744	ERJ2GEJ102	1K	
R747	ERJ2GEJ102	1K	
R751	ERJ2GEJ102	1K	
R752	ERJ2GEJ102	1K	
R809	ERJ2GEJ102	1K	
R813	ERJ2GEOR00	0	
R822	ERJ2GEJ271	270	
R823	ERJ2GEJ180	18	
R824	ERJ2GEJ271	270	
R832	ERJ2GEJ562X	5.6K	
R834	ERJ2GEJ332	3.3K	
R864	ERJ2GEJ102	1K	
R865	ERJ2GEJ391	390	
		(CAPACITORS)	
C201	ECJ0EC1H060D	6P	
C202	ECJ0EC1H060D	6P	
C204	ECJ0EB1A104K	0.1	
C206	ECJ0EB1A104K	0.1	
C208	PQCUV0J106KB	10	
C212	ECJ0EB1C103K	0.01	
C214	PQCUV0J106KB	10	
C215	ECJ0EB1A104K	0.1	
C225	ECJ0EB1A104K	0.1	
C226	ECJ0EB1A104K	0.1	
C231	ECJ0EB1A104K	0.1	
C241	ECJ0EB1A104K	0.1	
C242	ECJ0EC1H101J	100P	
C262	ECUV1A105KBV	1	
C263	ECUV1A105KBV	1	
C271	ECUV1C474KBV	0.47	
C272	ECUV1A474KBV	0.47	
C273	ECUV1A474KBV	0.47	
C274	ECUV1A474KBV	0.47	
C275	ECUV1A474KBV	0.47	
C276	ECUV1A105KBV	1	
C277	ECUV1A105KBV	1	
C278	PQCUV1C105KB	1	
C279	PQCUV1C105KB	1	
C281	ECJ0EC1H121J	120P	
C282	ECJ0EC1H121J	120P	
C283	ECJ0EC1H121J	120P	
C284	ECJ0EC1H121J	120P	
C286	ECUV1A224KBV	0.22	

Ref. No.	Part No.	Part Name & Description	Remarks
C303	ECJ0EB0J105K	1	
C305	ECJ0EB1C103K	0.01	
C306	ECJ0EB1A104K	0.1	
C314	ECJ0EB1C183K	0.018	
C315	ECJ0EB1C183K	0.018	
C316	ECJ0EB1H332K	0.0033	
C317	ECST0JY226	22	
C321	FlH0J335A005	3.3	
C333	ECJ0EB1E682K	0.0068	
C335	ECST0JY226	22	
C340	ECJ0EB1A104K	0.1	
C353	ECUV1H103KBV	0.01	
C361	EEEFK0J331P	330	
C371	ECUV1A105KBV	1	
C372	ECUV1A105KBV	1	
C373	EEEFK0J331P	330	
C374	ECJ0EB1A104K	0.1	
C377	ECJ0EB1A104K	0.1	
C379	ECJ0EB1A104K	0.1	
C381	EEE0JA101SP	100	
C386	ECJ0EB1A104K	0.1	
C701	PQCUV0J475MB	4.7	
C702	ECJ0EB1A104K	0.1	
C704	ECJ0EB1H102K	0.001	
C705	ECJ0EC1H100D	10P	
C706	ECJ0EB1C103K	0.01	
C707	ECJ0EB1H102K	0.001	
C708	ECJ0EC1H1R5C	1.5P	
C711	ECJ0EC1H010C	1P	
C712	ECJ0EC1H020C	2P	
C713	ECJ0EC1H100D	10P	
C714	ECJ0EB1H102K	0.001	
C715	ECJ0EC1H050C	5P	
C716	ECJ0EC1H020C	2P	
C722	ECJ0EC1H020C	2P	
C725	ECJ0EC1H050C	5P	
C731	ECJ0EB1C103K	0.01	
C732	ECJ0EB1H102K	0.001	
C733	ECJ0EB1H102K	0.001	
C734	ECJ0EB1H102K	0.001	
C735	ECJ0EB1A104K	0.1	
C737	ECJ0EB1H102K	0.001	
C741	ECJ0EB1H222K	0.0022	
C742	ECJ0EB1C103K	0.01	
C743	ECJ0EC1H221J	220P	
C745	ECJ0EC1H101J	100P	
C746	ECJ0EC1H101J	100P	
C747	ECJ0EC1H100D	10P	
C748	ECJ0EC1H101J	100P	
C749	ECJ0EC1H101J	100P	
C750	ECJ0EC1H101J	100P	
C751	ECJ0EC1H100D	10P	
C752	ECJ0EB1H471K	470P	
C763	ECUV1A474KBV	0.47	
C764	ECJ0EC1H020C	2P	
C773	ECJ0EC1H101J	100P	
C781	ECJ0EB1A104K	0.1	
C782	ECJ0EC1H121J	120P	
C801	ECJ0EC1H030C	3P	
C802	ECJ0EC1H220J	22P	
C803	ECJ0EB1C103K	0.01	
C804	ECJ0EC1H150J	15P	
C806	ECJ0EC1H100D	10P	
C809	ECJ0EB1C223K	0.022	
C811	ECJ0EC1H020C	2P	
C821	ECJ0EC1H100D	10P	
C824	ECJ0EC1H100D	10P	
C832	ECJ0EC1H221J	220P	
C833	ECJ0EC1H101J	100P	
C834	ECJ0EB1C103K	0.01	
C835	ECJ0EB1H471K	470P	
C836	ECUV1A105KBV	1	
C837	ECJ0EC1H101J	100P	

Ref. No.	Part No.	Part Name & Description	Remarks
C842	ECUV1A105KBV	1	
C843	ECUV1A474KBV	0.47	
C844	ECJ0EC1H020C	2P	
C856	ECJ0EC1H020C	2P	
C857	ECJ0EB0J105K	1	
C858	ECJ0EC1H0R5C	0.5P	
C859	ECJ0EC1H0R5C	0.5P	
C864	FlG1E562A086	0.0056	
C865	ECUE1A333KBQ	0.033	S
C871	FlG1HR10A561	0.1P	
C873	ECJ0EC1H020C	2P	
C874	ECJ0EB0J105K	1	
C881	ECJ0EC1H050C	5P	
C891	ECJ0EC1H050C	5P	
		(OTHERS)	
MIC100	L0CBAB000052	MICROPHONE	
E101	PQMC10492Z	MAGNETIC SHIELD, FRAME	
E102	PQMC10491Z	MAGNETIC SHIELD, COVER	
X201	H0J138500003	CRYSTAL OSCILLATOR	

16.5.3. Charger Unit

16.5.3.1. Cabinet and Electrical Parts

Ref. No.	Part No.	Part Name & Description	Remarks
200	PQLV30043ZB	CHARGER UNIT	
200-1	PQKM10721Z5	CABINET BODY	PS-HB
200-2	PQGG10410Z1	GRILLE, CRADLE	ABS-HB
200-3	PQKE10436Y3	CASE, CHARGE TERMINAL	PS-HB
200-4	PQKE10437Z1	HOLDER, CHARGE TERMINAL (L)	POM-HB
200-5	PQKE10438Z1	HOLDER, CHARGE TERMINAL (R)	POM-HB
200-6	PQJT10241Z	CHARGE TERMINAL (L)	
200-7	PQJT10242Z	CHARGE TERMINAL (R)	
200-8	PQKF10709Y2	CABINET COVER	ABS-HB
200-9	PQHA10023Z	RUBBER PARTS, FOOT CUSHION	
200-10	PQGT19014Z	NAME PLATE	
200-11	PQXDZLDRS1	LABEL, SECURITY	

16.5.3.2. Main P.C. Board Parts

Ref. No.	Part No.	Part Name & Description	Remarks
PCB200	PQWPTGA570CH	MAIN P.C.BOARD ASS'Y (RTL)	
		(RESISTORS)	
R1	ERJ1TYJ560	56	
R2	ERJ1TYJ560	56	
R3	ERJ1TYJ560	56	
		(OTHERS)	
CN1	K2ECYB000001	JACK	

16.5.4. Accessories and Packing Materials

Note:

(*1) You can download and refer to the Operating Instructions (Instruction book) on TSN Server.

16.5.4.1. KX-TG6700B

Ref. No.	Part No.	Part Name & Description	Remarks
A1	PQLV207Z	AC ADAPTOR	△
A2	PQJA10075Z	CORD, TELEPHONE (6FT/2WIRE)	
A3	PQJA10088Z	CORD, TELEPHONE (6FT/4WIRE)	
A4	PQQX15231Y	INSTRUCTION BOOK (*1)	
A5	PQQW15182Z	QUICK GUIDE (for English)	
A6	PQQW15183Z	QUICK GUIDE (for Spanish)	
A7	PQQV10308Z	CARD, CCP	
A8	PQKE10457Z2	HANGER, BELT CLIP (for Service)	PC+ABS-HB
A9	PQKL10078Z2	STAND, WALL MOUNT (for Service)	ABS-HB

KX-TG6700B/KX-TG6702B/KX-TGA670B

Ref. No.	Part No.	Part Name & Description	Remarks
P1	XZB21X35A03	PROTECTION COVER (for Base Unit)	
P2	XZB10X35A02	PROTECTION COVER (for Hand-set)	
P3	PQPD10716Z	CUSHION	
P4	PQPK15311Z	GIFT BOX	
P5	PQXDDS400-8	PHOTO ELECTRIC TRANSDUCER, SECURITY TAG	

16.5.4.2. KX-TG6702B

Ref. No.	Part No.	Part Name & Description	Remarks
A101	PQLV207Z	AC ADAPTOR	△
A102	PQJA10075Z	CORD, TELEPHONE (6FT/2WIRE)	
A103	PQJA10088Z	CORD, TELEPHONE (6FT/4WIRE)	
A104	PQXK15231Y	INSTRUCTION BOOK (*1)	
A105	PQQW15182Z	QUICK GUIDE (for English)	
A106	PQQW15183Z	QUICK GUIDE (for Spanish)	
A107	PQQV10308Z	CARD, CCP	
A108	PQKE10457Z2	HANGER, BELT CLIP (for Service)	PC+ABS-HB
A109	PQKL10078Z2	STAND, WALL MOUNT (for Service)	ABS-HB
P101	XZB21X35A03	PROTECTION COVER (for Base Unit)	
P102	XZB10X35A02	PROTECTION COVER (for Hand-set)	
P103	XZB15X25A04	PROTECTION COVER (for Charger Unit)	
P104	PQPK15452Z	GIFT BOX	
P105	PQPN11752Z	ACCESSORY BOX	
P106	PQXDDS400-8	PHOTO ELECTRIC TRANSDUCER, SECURITY TAG	

16.5.4.3. KX-TGA670B

Ref. No.	Part No.	Part Name & Description	Remarks
A201	PQLV207Z	AC ADAPTOR	△
A202	PQXK15237Z	INSTRUCTION BOOK (*1)	
A203	PQQW12560Z	LEAFLET	
A204	PQKE10457Z2	HANGER, BELT CLIP (for Service)	PC+ABS-HB
P201	XZB15X25A04	PROTECTION COVER (for Charger Unit)	
P202	XZB10X35A02	PROTECTION COVER (for Hand-set)	
P203	PQPK15403Z	GIFT BOX	
P204	PQXDDS400-8	PHOTO ELECTRIC TRANSDUCER, SECURITY TAG	

G/N
KXTG6700B
KXTG6702B
KXTGA670B